



## MSP430FR688x(1), MSP430FR588x(1) Mixed-Signal Microcontrollers

### 1 Device Overview

#### 1.1 Features

- Embedded Microcontroller
  - 16-Bit RISC Architecture up to 16-MHz Clock
  - Wide Supply Voltage Range From 3.6 V Down to 1.8 V (Minimum Supply Voltage is Restricted by SVS Levels, See the [SVS Specifications](#))
- Optimized Ultra-Low-Power Modes
  - Active Mode: Approximately 100  $\mu$ A/MHz
  - Standby (LPM3 With VLO): 0.4  $\mu$ A (Typical)
  - Real-Time Clock (RTC) (LPM3.5): 0.35  $\mu$ A (Typical) <sup>(1)</sup>
  - Shutdown (LPM4.5): 0.02  $\mu$ A (Typical)
- Ultra-Low-Power Ferroelectric RAM (FRAM)
  - Up to 128KB of Nonvolatile Memory
  - Ultra-Low-Power Writes
  - Fast Write at 125 ns per Word (64KB in 4 ms)
  - Unified Memory = Program + Data + Storage in One Single Space
  - 10<sup>15</sup> Write Cycle Endurance
  - Radiation Resistant and Nonmagnetic
- Intelligent Digital Peripherals
  - 32-Bit Hardware Multiplier (MPY)
  - Three-Channel Internal Direct Memory Access (DMA)
  - RTC With Calendar and Alarm Functions
  - Five 16-Bit Timers With up to 7 Capture/Compare Registers Each
  - 16-Bit and 32-Bit Cyclic Redundancy Checker (CRC16, CRC32)
- High-Performance Analog
  - Extended Scan Interface (ESI) for Background Water, Heat, and Gas Volume Measurement
  - 16-Channel Analog Comparator
  - 12-Bit Analog-to-Digital Converter (ADC) With Internal Reference and Sample-and-Hold and up to 16 External Input Channels
  - Integrated LCD Driver With Contrast Control for up to 320 Segments
- Multifunction Input/Output Ports
  - All P1 to P10 and PJ Pins Support Capacitive Touch Capability Without Need for External Components
- Accessible Bit-, Byte- and Word-Wise (in Pairs)
- Edge-Selectable Wakeup From LPM on Ports P1, P2, P3, and P4
- Programmable Pullup and Pulldown on All Ports
- Code Security
  - True Random Number Seed for Random Number Generation Algorithm
- Enhanced Serial Communication
  - eUSCI\_A0 and eUSCI\_A1 Support:
    - UART With Automatic Baud-Rate Detection
    - IrDA Encode and Decode
    - SPI
  - eUSCI\_B0 and eUSCI\_B1 Support:
    - I<sup>2</sup>C With Multiple-Slave Addressing
    - SPI
  - Hardware UART and I<sup>2</sup>C Bootloader (BSL)
- Flexible Clock System
  - Fixed-Frequency DCO With 10 Selectable Factory-Trimmed Frequencies
  - Low-Power Low-Frequency Internal Clock Source (VLO)
  - 32-kHz Crystals (LFXT)
  - High-Frequency Crystals (HFXT)
- Development Tools and Software
  - Free Professional Development Environments With EnergyTrace++™ Technology
  - Experimenter and Development Kits
- Family Members
  - [Device Comparison](#) Summarizes the Device Variants and Available Packages Types
- For Complete Module Descriptions, See the [MSP430FR58xx](#), [MSP430FR59xx](#), and [MSP430FR6xx Family User's Guide](#)

(1) RTC is clocked by a 3.7-pF crystal.



## 1.2 Applications

- Water Meters
- Heat Meters
- Heat Cost Allocators
- Portable Medical Meters
- Data Logging
- See [Extended Scan Interface \(ESI\) Peripheral](#) for TI Designs

## 1.3 Description

The MSP430™ ultra-low-power (ULP) FRAM platform combines uniquely embedded FRAM and a holistic ultra-low-power system architecture, allowing innovators to increase performance at lowered energy budgets. FRAM technology combines the speed, flexibility, and endurance of SRAM with the stability and reliability of flash at much lower power.

The MSP430 ULP FRAM portfolio consists of a diverse set of devices that feature FRAM, the ULP 16-bit MSP430 CPU, and intelligent peripherals targeted for various applications. The ULP architecture showcases seven low-power modes, which are optimized to achieve extended battery life in energy-challenged applications.

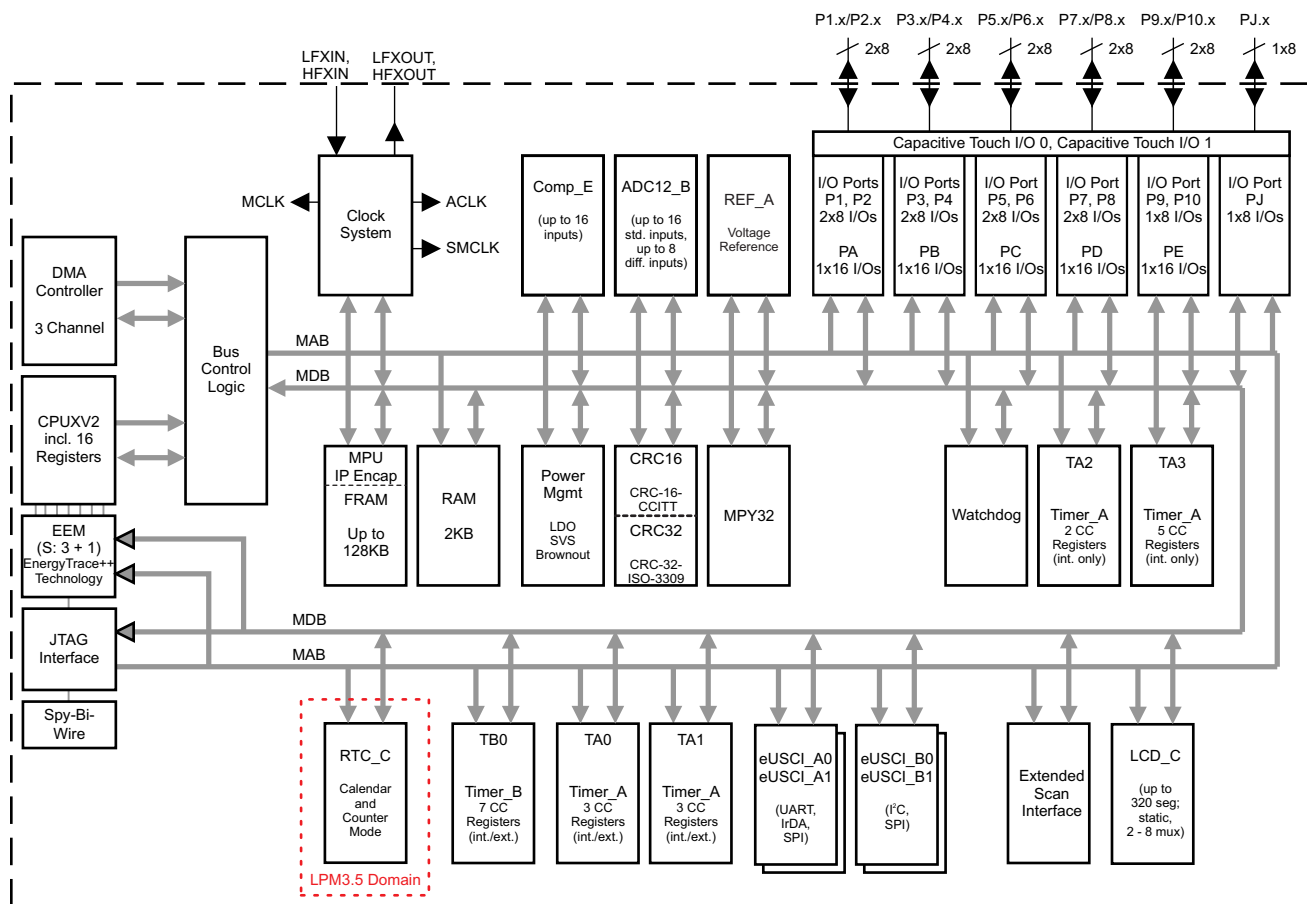
**Device Information<sup>(1)</sup>**

| PART NUMBER      | PACKAGE    | BODY SIZE <sup>(2)</sup> |
|------------------|------------|--------------------------|
| MSP430FR6889IPZ  | LQFP (100) | 14 mm × 14 mm            |
| MSP430FR6889IPN  | LQFP (80)  | 12 mm × 12 mm            |
| MSP430FR5889IPM  | LQFP (64)  | 10 mm × 10 mm            |
| MSP430FR5889IRGC | VQFN (64)  | 9 mm × 9 mm              |

- (1) For the most current part, package, and ordering information, see the *Package Option Addendum* in [Section 9](#), or see the TI website at [www.ti.com](http://www.ti.com).
- (2) The sizes shown here are approximations. For the package dimensions with tolerances, see the *Mechanical Data* in [Section 9](#).

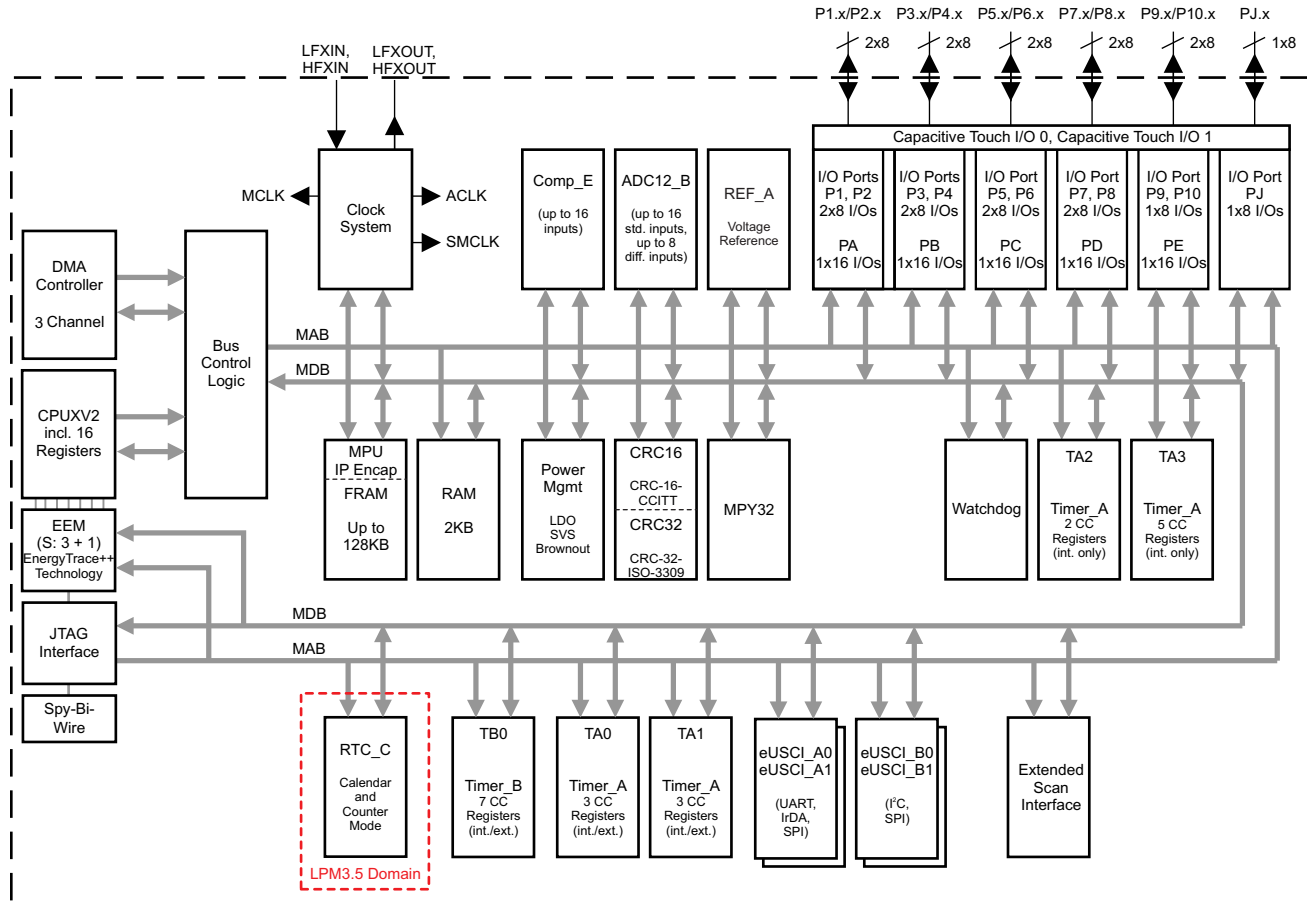
## 1.4 Functional Block Diagram

Figure 1-1 and Figure 1-2 show the functional block diagrams.



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Figure 1-1. Functional Block Diagram – MSP430FR688x, MSP430FR688x1



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**Figure 1-2. Functional Block Diagram – MSP430FR588x, MSP430FR588x1**

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## 2 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from March 10, 2017 to August 29, 2018                                                                                        | Page                |
|---------------------------------------------------------------------------------------------------------------------------------------|---------------------|
| • Updated <a href="#">Section 3.1, Related Products</a> .....                                                                         | <a href="#">8</a>   |
| • Added note (1) to <a href="#">Table 5-2, SVS</a> .....                                                                              | <a href="#">40</a>  |
| • Changed capacitor value from 4.7 $\mu$ F to 470 nF in <a href="#">Figure 7-5, ADC12_B Grounding and Noise Considerations</a> ...    | <a href="#">156</a> |
| • Changed capacitor value from 4.7 $\mu$ F to 470 nF in the last paragraph of <a href="#">Section 7.2.1.2, Design Requirements</a> .. | <a href="#">157</a> |
| • Updates to text and figure in <a href="#">Section 8.2, Device Nomenclature</a> .....                                                | <a href="#">162</a> |

### 3 Device Comparison

Table 3-1 and Table 3-2 summarize the available family members.

**Table 3-1. Device Comparison (With UART BSL)<sup>(1) (2)</sup>**

| DEVICE       | FRAM<br>(KB) | SRAM<br>(KB) | CLOCK<br>SYSTEM     | Timer_A<br>(3)                             | Timer_B<br>(4) | eUSCI            |                  | AES | ADC12_B          | LCD_C              | I/O      | PACKAGE         |
|--------------|--------------|--------------|---------------------|--------------------------------------------|----------------|------------------|------------------|-----|------------------|--------------------|----------|-----------------|
|              |              |              |                     |                                            |                | A <sup>(5)</sup> | B <sup>(6)</sup> |     |                  |                    |          |                 |
| MSP430FR6889 | 128          | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext<br>16 ext | 240 seg<br>320 seg | 63<br>83 | 80 PN<br>100 PZ |
| MSP430FR6888 | 96           | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext<br>16 ext | 240 seg<br>320 seg | 63<br>83 | 80 PN<br>100 PZ |
| MSP430FR6887 | 64           | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext<br>16 ext | 240 seg<br>320 seg | 63<br>83 | 80 PN<br>100 PZ |
| MSP430FR5889 | 128          | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext           | N/A                | 48       | 64 PM<br>64 RGC |
| MSP430FR5888 | 96           | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext           | N/A                | 48       | 64 PM<br>64 RGC |
| MSP430FR5887 | 64           | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext           | N/A                | 48       | 64 PM<br>64 RGC |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/package](http://www.ti.com/package).
- (3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.
- (4) Each number in the sequence represents an instantiation of Timer\_B with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_B, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.
- (5) eUSCI\_A supports UART with automatic baud-rate detection, IrDA encode and decode, and SPI.
- (6) eUSCI\_B supports I<sup>2</sup>C with multiple slave addresses and SPI.
- (7) Timer\_A TA0 and TA1 provide internal and external capture/compare inputs and internal and external PWM outputs.
- (8) Timer\_A TA2 and TA3 provide only internal capture/compare inputs and only internal PWM outputs (if any).

**Table 3-2. Device Comparison (With I<sup>2</sup>C BSL)<sup>(1) (2)</sup>**

| DEVICE        | FRAM<br>(KB) | SRAM<br>(KB) | CLOCK<br>SYSTEM     | Timer_A<br>(3)                             | Timer_B<br>(4) | eUSCI            |                  | AES | ADC12_B          | LCD_C              | I/O      | PACKAGE<br>TYPE |
|---------------|--------------|--------------|---------------------|--------------------------------------------|----------------|------------------|------------------|-----|------------------|--------------------|----------|-----------------|
|               |              |              |                     |                                            |                | A <sup>(5)</sup> | B <sup>(6)</sup> |     |                  |                    |          |                 |
| MSP430FR68891 | 128          | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext<br>16 ext | 240 seg<br>320 seg | 63<br>83 | 80 PN<br>100 PZ |
| MSP430FR58891 | 128          | 2            | DCO<br>HFXT<br>LFXT | 3, 3 <sup>(7)</sup><br>2, 5 <sup>(8)</sup> | 7              | 2                | 2                | no  | 12 ext           | N/A                | 48       | 64 PM<br>64 RGC |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/package](http://www.ti.com/package).
- (3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.
- (4) Each number in the sequence represents an instantiation of Timer\_B with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_B, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.
- (5) eUSCI\_A supports UART with automatic baud-rate detection, IrDA encode and decode, and SPI.
- (6) eUSCI\_B supports I<sup>2</sup>C with multiple slave addresses and SPI.
- (7) Timer\_A TA0 and TA1 provide internal and external capture/compare inputs and internal and external PWM outputs.
- (8) Timer\_A TA2 and TA3 provide only internal capture/compare inputs and only internal PWM outputs (if any).

### 3.1 Related Products

For information about other devices in this family of products or related products, see the following links.

**TI 16-bit and 32-bit microcontrollers** High-performance, low-power solutions to enable the autonomous future

**Products for MSP430 ultra-low-power sensing and measurement microcontrollers** One platform. One ecosystem. Endless possibilities.

**Products for MSP430 ultrasonic and performance sensing microcontrollers** Ultra-low-power single-chip MCUs with integrated sensing peripherals

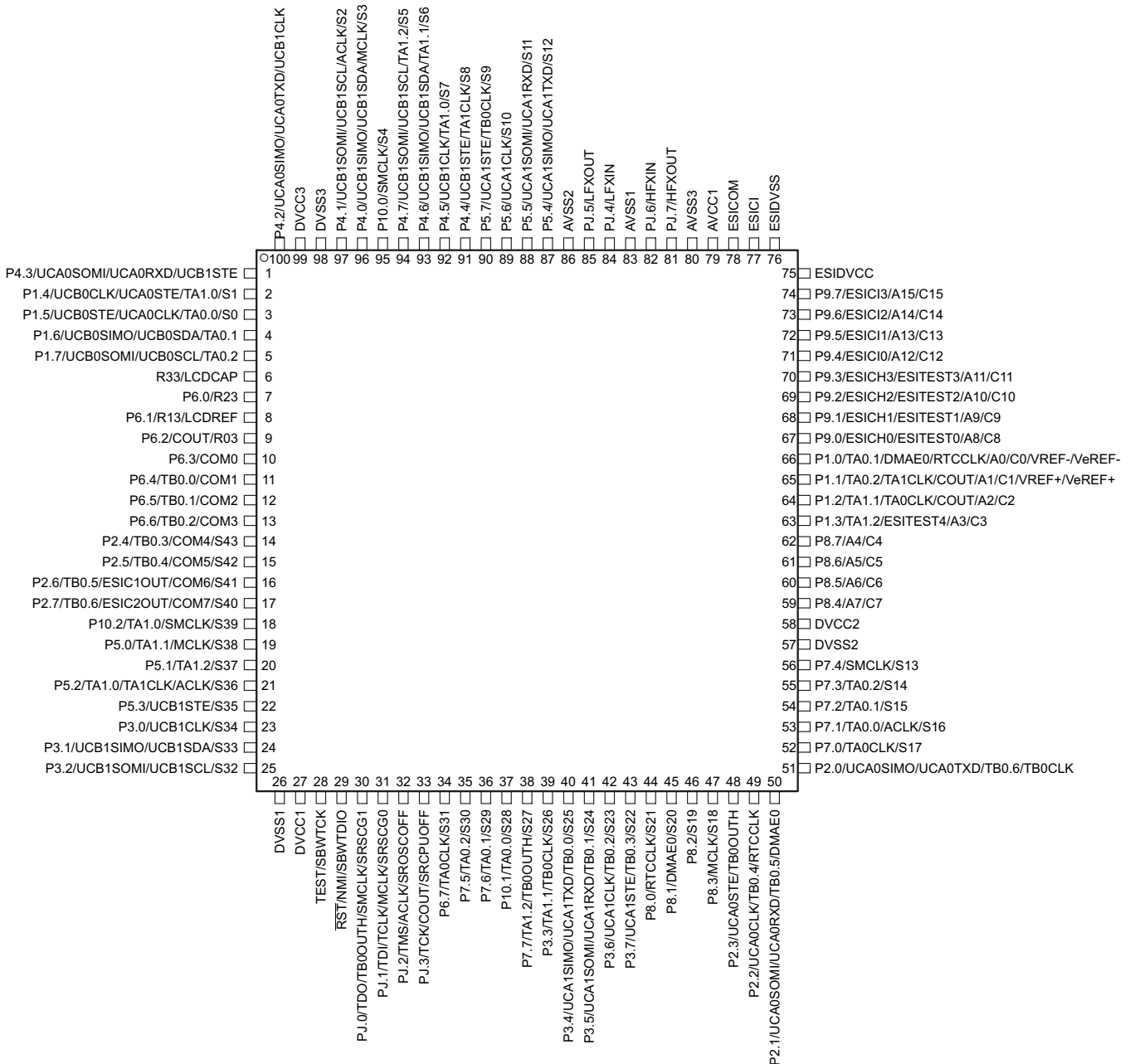
**Companion products for MSP430FR6889** Review products that are frequently purchased or used with this product.

**Reference designs for MSP430FR6889** The TI Designs Reference Design Library is a robust reference design library that spans analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all TI Designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [ti.com/tidesigns](http://ti.com/tidesigns).

## 4 Terminal Configuration and Functions

### 4.1 Pin Diagrams

Figure 4-1 shows the pinout of the 100-pin PZ package for the MSP430FR688x and MSP430FR688x1 MCUs.

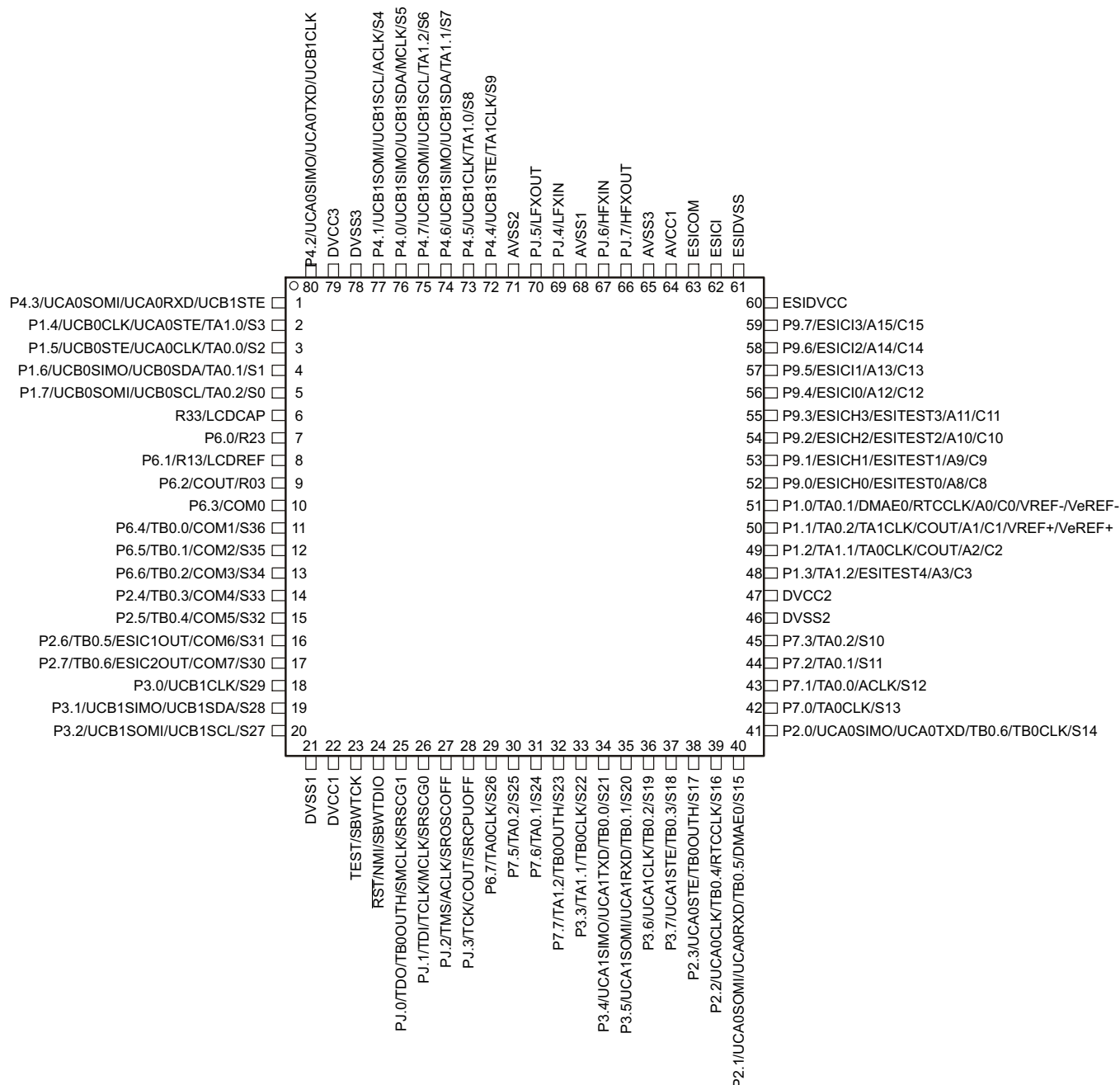


NOTE: On devices with UART BSL: P2.0: BSLTX; P2.1: BSLRX

NOTE: On devices with I<sup>2</sup>C BSL: P1.6: BSLSDA; P1.7: BSLSCL

Figure 4-1. 100-Pin PZ Package (Top View) – MSP430FR688x and MSP430FR688x1

Figure 4-2 shows the pinout of the 80-pin PN package for the MSP430FR688x and MSP430FR688x1 MCUs.



NOTE: On devices with UART BSL: P2.0: BSLTX; P2.1: BSLRX

NOTE: On devices with I<sup>2</sup>C BSL: P1.6: BSLSDA; P1.7: BSLSCL

**Figure 4-2. 80-Pin PN Package (Top View) – MSP430FR688x and MSP430FR688x1**

Figure 4-3 shows the pinout of the 64-pin PM and RGC packages for the MSP430FR588x and MSP430FR588x1 MCUs.



NOTE: TI recommends connecting the RGC package pad to VSS.

NOTE: On devices with UART BSL: P2.0: BSLTX; P2.1: BSLRX

NOTE: On devices with I<sup>2</sup>C BSL: P1.6: BSLSDA; P1.7: BSLSCL

**Figure 4-3. 64-Pin PM or RGC Package (Top View) – MSP430FR588x and MSP430FR588x1**

## 4.2 Signal Descriptions

Table 4-1 and Table 4-2 describe the device signals.

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1**

| TERMINAL                           |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                                                                                      |
|------------------------------------|-----|------|-----|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                               | PZ  |      | PN  |      |                                                                                                                                                                                                                                                                                                  |
|                                    | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                                                                                  |
| P4.3/UCA0SOMI/UCA0RXD/<br>UCB1STE  | 1   |      | 1   |      | General-purpose digital I/O<br>USCI_A0: Slave out, master in (SPI mode)<br>USCI_A0: Receive data (UART mode)<br>USCI_B1: Slave transmit enable (SPI mode)                                                                                                                                        |
| P1.4/UCB0CLK/UCA0STE/<br>TA1.0/Sx  | 2   | S1   | 2   | S3   | General-purpose digital I/O<br>USCI_B0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>USCI_A0: Slave transmit enable (SPI mode)<br>Timer_A TA1 CCR0 capture: CCI0A input, compare: Out0 output<br>LCD segment output (segment number is package specific)        |
| P1.5/UCB0STE/<br>UCA0CLK/TA0.0/Sx  | 3   | S0   | 3   | S2   | General-purpose digital I/O<br>USCI_B0: Slave transmit enable (SPI mode)<br>USCI_A0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_A TA0 CCR0 capture: CCI0A input, compare: Out0 output<br>LCD segment output (segment number is package specific)        |
| P1.6/UCB0SIMO/UCB0SDA/<br>TA0.1/Sx | 4   |      | 4   | S1   | General-purpose digital I/O<br>USCI_B0: Slave in, master out (SPI mode)<br>USCI_B0: I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>BSL data (I <sup>2</sup> C BSL)<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD segment output (segment number is package specific)   |
| P1.7/UCB0SOMI/UCB0SCL/<br>TA0.2/Sx | 5   |      | 5   | S0   | General-purpose digital I/O<br>USCI_B0: Slave out, master in (SPI mode)<br>USCI_B0: I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>BSL clock (I <sup>2</sup> C BSL)<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific) |
| R33/LCDCAP                         | 6   |      | 6   |      | Input/output port of most positive analog LCD voltage (V1)<br>LCD capacitor connection                                                                                                                                                                                                           |
| P6.0/R23                           | 7   |      | 7   |      | General-purpose digital I/O<br>Input/output port of second most positive analog LCD voltage (V2)                                                                                                                                                                                                 |
| P6.1/R13/LCDREF                    | 8   |      | 8   |      | General-purpose digital I/O<br>Input/output port of third most positive analog LCD voltage (V3 or V4)<br>External reference voltage input for regulated LCD voltage                                                                                                                              |
| P6.2/COUT/R03                      | 9   |      | 9   |      | General-purpose digital I/O<br>Comparator output<br>Input/output port of lowest analog LCD voltage (V5)                                                                                                                                                                                          |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                        |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                  |
|---------------------------------|-----|------|-----|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                            | PZ  |      | PN  |      |                                                                                                                                                                                                                              |
|                                 | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                              |
| P6.3/COM0                       | 10  |      | 10  |      | General-purpose digital I/O<br>LCD common output COM0 for LCD backplane                                                                                                                                                      |
| P6.4/TB0.0/COM1/Sx              | 11  |      | 11  | S36  | General-purpose digital I/O<br>Timer_B TB0 CCR0 capture: CCI0B input, compare: Out0 output<br>LCD common output COM1 for LCD backplane<br>LCD segment output (segment number is package specific)                            |
| P6.5/TB0.1/COM2/Sx              | 12  |      | 12  | S35  | General-purpose digital I/O<br>Timer_B TB0 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD common output COM2 for LCD backplane<br>LCD segment output (segment number is package specific)                            |
| P6.6/TB0.2/COM3/Sx              | 13  |      | 13  | S34  | General-purpose digital I/O<br>Timer_B TB0 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD common output COM3 for LCD backplane<br>LCD segment output (segment number is package specific)                            |
| P2.4/TB0.3/COM4/Sx              | 14  | S43  | 14  | S33  | General-purpose digital I/O<br>Timer_B TB0 CCR3 capture: CCI3A input, compare: Out3 output<br>LCD common output COM4 for LCD backplane<br>LCD segment output (segment number is package specific)                            |
| P2.5/TB0.4/COM5/Sx              | 15  | S42  | 15  | S32  | General-purpose digital I/O<br>Timer_B TB0 CCR4 capture: CCI4A input, compare: Out4 output<br>LCD common output COM5 for LCD backplane<br>LCD segment output (segment number is package specific)                            |
| P2.6/TB0.5/ESIC1OUT/<br>COM6/Sx | 16  | S41  | 16  | S31  | General-purpose digital I/O<br>Timer_B TB0 CCR5 capture: CCI5A input, compare: Out5 output<br>ESi Comparator 1 output<br>LCD common output COM6 for LCD backplane<br>LCD segment output (segment number is package specific) |
| P2.7/TB0.6/ESIC2OUT/<br>COM7/Sx | 17  | S40  | 17  | S30  | General-purpose digital I/O<br>Timer_B TB0 CCR6 capture: CCI6A input, compare: Out6 output<br>ESi comparator 2 output<br>LCD common output COM7 for LCD backplane<br>LCD segment output (segment number is package specific) |
| P10.2/TA1.0/SMCLK/Sx            | 18  | S39  |     |      | General-purpose digital I/O<br>Timer_A TA1 CCR0 capture: CCI0B input, compare: Out0 output<br>SMCLK output<br>LCD segment output (segment number is package specific)                                                        |
| P5.0/TA1.1/MCLK/Sx              | 19  | S38  |     |      | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>MCLK output<br>LCD segment output (segment number is package specific)                                                         |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                             |     |      |     |      | DESCRIPTION                                                                                                                                                                                                   |
|--------------------------------------|-----|------|-----|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                 | PZ  |      | PN  |      |                                                                                                                                                                                                               |
|                                      | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                               |
| P5.1/TA1.2/Sx                        | 20  | S37  |     |      | General-purpose digital I/O<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific)                                                         |
| P5.2/TA1.0/TA1CLK/ACLK/Sx            | 21  | S36  |     |      | General-purpose digital I/O<br>Timer_A TA1 CCR0 capture: CCI0B input, compare: Out0 output<br>Timer_A TA1 clock signal TA0CLK input<br>ACLK output<br>LCD segment output (segment number is package specific) |
| P5.3/UCB1STE/Sx                      | 22  | S35  |     |      | General-purpose digital I/O<br>USCI_B1: Slave transmit enable (SPI mode)<br>LCD segment output (segment number is package specific)                                                                           |
| P3.0/UCB1CLK/Sx                      | 23  | S34  | 18  | S29  | General-purpose digital I/O<br>USCI_B1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>LCD segment output (segment number is package specific)                                 |
| P3.1/UCB1SIMO/UCB1SDA/Sx             | 24  | S33  | 19  | S28  | General-purpose digital I/O<br>USCI_B1: Slave in, master out (SPI mode)<br>USCI_B1: I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>LCD segment output (segment number is package specific)                  |
| P3.2/UCB1SOMI/UCB1SCL/Sx             | 25  | S32  | 20  | S27  | General-purpose digital I/O<br>USCI_B1: Slave out, master in (SPI mode)<br>USCI_B1: I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>LCD segment output (segment number is package specific)                 |
| DVSS1                                | 26  |      | 21  |      | Digital ground supply                                                                                                                                                                                         |
| DVCC1                                | 27  |      | 22  |      | Digital power supply                                                                                                                                                                                          |
| TEST/SBWTK                           | 28  |      | 23  |      | Test mode pin - select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock                                                                                                                                    |
| $\overline{\text{RST}}$ /NMI/SBWTDIO | 29  |      | 24  |      | Reset input, active low<br>Nonmaskable interrupt input<br>Spy-Bi-Wire data input/output                                                                                                                       |
| PJ.0/TDO/TB0OUTH/SMCLK/SRSCG1        | 30  |      | 25  |      | General-purpose digital I/O<br>Test data output port<br>Switch all PWM outputs high impedance input - Timer_B TB0<br>SMCLK output<br>Low-power debug: CPU Status register SCG1                                |
| PJ.1/TDI/TCLK/MCLK/SRSCG0            | 31  |      | 26  |      | General-purpose digital I/O<br>Test data input or test clock input<br>MCLK output<br>Low-power debug: CPU Status register SCG0                                                                                |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                           |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                             |
|------------------------------------|-----|------|-----|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                               | PZ  |      | PN  |      |                                                                                                                                                                                                                                         |
|                                    | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                         |
| PJ.2/TMS/ACLK/SROSCOFF             | 32  |      | 27  |      | General-purpose digital I/O<br>Test mode select<br>ACLK output<br>Low-power debug: CPU Status register OSCOFF                                                                                                                           |
| PJ.3/TCK/COUT/SRCPUOFF             | 33  |      | 28  |      | General-purpose digital I/O<br>Test clock<br>Comparator output<br>Low-power debug: CPU Status register CPUOFF                                                                                                                           |
| P6.7/TA0CLK/Sx                     | 34  | S31  | 29  | S26  | General-purpose digital I/O<br>Timer_A TA0 clock signal TA0CLK input<br>LCD segment output (segment number is package specific)                                                                                                         |
| P7.5/TA0.2/Sx                      | 35  | S30  | 30  | S25  | General-purpose digital I/O<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific)                                                                                   |
| P7.6/TA0.1/Sx                      | 36  | S29  | 31  | S24  | General-purpose digital I/O<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD segment output (segment number is package specific)                                                                                   |
| P10.1/TA0.0/Sx                     | 37  | S28  |     |      | General-purpose digital I/O<br>Timer_A TA0 CCR0 capture: CCI0B input, compare: Out0 output<br>LCD segment output (segment number is package specific)                                                                                   |
| P7.7/TA1.2/TB0OUTH/Sx              | 38  | S27  | 32  | S23  | General-purpose digital I/O<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output<br>Switch all PWM outputs high impedance input - Timer_B TB0<br>LCD segment output (segment number is package specific)                      |
| P3.3/TA1.1/TB0CLK/Sx               | 39  | S26  | 33  | S22  | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>Timer_B TB0 clock signal TB0CLK input<br>LCD segment output (segment number is package specific)                                          |
| P3.4/UCA1SIMO/UCA1TXD/<br>TB0.0/Sx | 40  | S25  | 34  | S21  | General-purpose digital I/O<br>USCI_A1: Slave in, master out (SPI mode)<br>USCI_A1: Transmit data (UART mode)<br>Timer_B TB0 CCR0 capture: CCI0A input, compare: Out0 output<br>LCD segment output (segment number is package specific) |
| P3.5/UCA1SOMI/UCA1RXD/<br>TB0.1/Sx | 41  | S24  | 35  | S20  | General-purpose digital I/O<br>USCI_A1: Slave out, master in (SPI mode)<br>USCI_A1: Receive data (UART mode)<br>Timer_B TB0 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD segment output (segment number is package specific)  |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                                 |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                                                                                    |
|------------------------------------------|-----|------|-----|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                     | PZ  |      | PN  |      |                                                                                                                                                                                                                                                                                                |
|                                          | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                                                                                |
| P3.6/UCA1CLK/TB0.2/Sx                    | 42  | S23  | 36  | S19  | General-purpose digital I/O<br>USCI_A1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_B TB0 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific)                                                   |
| P3.7/UCA1STE/TB0.3/Sx                    | 43  | S22  | 37  | S18  | General-purpose digital I/O<br>USCI_A1: Slave transmit enable (SPI mode)<br>Timer_B TB0 CCR3 capture: CCI3B input, compare: Out3 output<br>LCD segment output (segment number is package specific)                                                                                             |
| P8.0/RTCCLK/Sx                           | 44  | S21  |     |      | General-purpose digital I/O<br>RTC clock output for calibration<br>LCD segment output (segment number is package specific)                                                                                                                                                                     |
| P8.1/DMAE0/Sx                            | 45  | S20  |     |      | General-purpose digital I/O<br>DMA external trigger input<br>LCD segment output (segment number is package specific)                                                                                                                                                                           |
| P8.2/Sx                                  | 46  | S19  |     |      | General-purpose digital I/O<br>LCD segment output (segment number is package specific)                                                                                                                                                                                                         |
| P8.3/MCLK/Sx                             | 47  | S18  |     |      | General-purpose digital I/O<br>MCLK output<br>LCD segment output (segment number is package specific)                                                                                                                                                                                          |
| P2.3/UCA0STE/TB0OUTH/Sx                  | 48  |      | 38  | S17  | General-purpose digital I/O<br>USCI_A0: Slave transmit enable (SPI mode)<br>Switch all PWM outputs high impedance input - Timer_B TB0<br>LCD segment output (segment number is package specific)                                                                                               |
| P2.2/UCA0CLK/TB0.4/<br>RTCCLK/Sx         | 49  |      | 39  | S16  | General-purpose digital I/O<br>USCI_A0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_B TB0 CCR4 capture: CCI4B input, compare: Out4 output<br>RTC clock output for calibration<br>LCD segment output (segment number is package specific)               |
| P2.1/UCA0SOMI/UCA0RXD/<br>TB0.5/DMAE0/Sx | 50  |      | 40  | S15  | General-purpose digital I/O<br>USCI_A0: Slave out, master in (SPI mode)<br>USCI_A0: Receive data (UART mode)<br>BSL receive (UART BSL)<br>Timer_B TB0 CCR5 capture: CCI5B input, compare: Out5 output<br>DMA external trigger input<br>LCD segment output (segment number is package specific) |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                                  |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                                                                                                 |
|-------------------------------------------|-----|------|-----|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                      | PZ  |      | PN  |      |                                                                                                                                                                                                                                                                                                             |
|                                           | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                                                                                             |
| P2.0/UCA0SIMO/UCA0TXD/<br>TB0.6/TB0CLK/Sx | 51  |      | 41  | S14  | General-purpose digital I/O<br>USCI_A0: Slave in, master out (SPI mode)<br>USCI_A0: Transmit data (UART mode)<br>BSL transmit (UART BSL)<br>Timer_B TB0 CCR6 capture: CCI6B input, compare: Out6 output<br>Timer_B TB0 clock signal TB0CLK input<br>LCD segment output (segment number is package specific) |
| P7.0/TA0CLK/Sx                            | 52  | S17  | 42  | S13  | General-purpose digital I/O<br>Timer_A TA0 clock signal TA0CLK input<br>LCD segment output (segment number is package specific)                                                                                                                                                                             |
| P7.1/TA0.0/ACLK/Sx                        | 53  | S16  | 43  | S12  | General-purpose digital I/O<br>Timer_A TA0 CCR0 capture: CCI0B input, compare: Out0 output<br>ACLK output<br>LCD segment output (segment number is package specific)                                                                                                                                        |
| P7.2/TA0.1/Sx                             | 54  | S15  | 44  | S11  | General-purpose digital I/O<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD segment output (segment number is package specific)                                                                                                                                                       |
| P7.3/TA0.2/Sx                             | 55  | S14  | 45  | S10  | General-purpose digital I/O<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific)                                                                                                                                                       |
| P7.4/SMCLK/Sx                             | 56  | S13  |     |      | General-purpose digital I/O<br>SMCLK output<br>LCD segment output (segment number is package specific)                                                                                                                                                                                                      |
| DVSS2                                     | 57  |      | 46  |      | Digital ground supply                                                                                                                                                                                                                                                                                       |
| DVCC2                                     | 58  |      | 47  |      | Digital power supply                                                                                                                                                                                                                                                                                        |
| P8.4/A7/C7                                | 59  |      |     |      | General-purpose digital I/O<br>Analog input A7<br>Comparator input C7                                                                                                                                                                                                                                       |
| P8.5/A6/C6                                | 60  |      |     |      | General-purpose digital I/O<br>Analog input A6<br>Comparator input C6                                                                                                                                                                                                                                       |
| P8.6/A5/C5                                | 61  |      |     |      | General-purpose digital I/O<br>Analog input A5<br>Comparator input C5                                                                                                                                                                                                                                       |
| P8.7/A4/C4                                | 62  |      |     |      | General-purpose digital I/O<br>Analog input A4<br>Comparator input C4                                                                                                                                                                                                                                       |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                                            |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                                                                                                   |
|-----------------------------------------------------|-----|------|-----|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                | PZ  |      | PN  |      |                                                                                                                                                                                                                                                                                                               |
|                                                     | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                                                                                               |
| P1.3/ESITEST4/TA1.2/A3/C3                           | 63  |      | 48  |      | General-purpose digital I/O<br>ESI test signal 4<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output<br>Analog input A3<br>Comparator input C3                                                                                                                                                     |
| P1.2/TA1.1/TA0CLK/<br>COUT/A2/C2                    | 64  |      | 49  |      | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>Timer_A TA0 clock signal TA0CLK input<br>Comparator output<br>Analog input A2<br>Comparator input C2                                                                                                            |
| P1.1/TA0.2/TA1CLK/<br>COUT/A1/C1/VREF+/VeREF+       | 65  |      | 50  |      | General-purpose digital I/O<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output<br>Timer_A TA1 clock signal TA1CLK input<br>Comparator output<br>Analog input A1<br>Comparator input C1<br>Output of positive reference voltage<br>Input for an external positive reference voltage to the ADC     |
| P1.0/TA0.1/DMAE0/<br>RTCCLK/A0/C0/ VREF-<br>/VeREF- | 66  |      | 51  |      | General-purpose digital I/O<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>DMA external trigger input<br>RTC clock output for calibration<br>Analog input A0<br>Comparator input C0<br>Output of negative reference voltage<br>Input for an external negative reference voltage to the ADC |
| P9.0/ESICH0/ESITEST0/<br>A8/C8                      | 67  |      | 52  |      | General-purpose digital I/O<br>ESI channel 0 sensor excitation output and signal input<br>ESI test signal 0<br>Analog input A8<br>Comparator input C8                                                                                                                                                         |
| P9.1/ESICH1/ESITEST1/<br>A9/C9                      | 68  |      | 53  |      | General-purpose digital I/O<br>ESI channel 1 sensor excitation output and signal input<br>ESI test signal 1<br>Analog input A9<br>Comparator input C9                                                                                                                                                         |
| P9.2/ESICH2/ESITEST2/<br>A10/C10                    | 69  |      | 54  |      | General-purpose digital I/O<br>ESI channel 2 sensor excitation output and signal input<br>ESI test signal 2<br>Analog input A10; comparator input C10                                                                                                                                                         |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                     |     |      |     |      | DESCRIPTION                                                                                                                                                              |
|------------------------------|-----|------|-----|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                         | PZ  |      | PN  |      |                                                                                                                                                                          |
|                              | NO. | Seg. | NO. | Seg. |                                                                                                                                                                          |
| P9.3/ESICH3/ESITEST3/A11/C11 | 70  |      | 55  |      | General-purpose digital I/O<br>ESI channel 3 sensor excitation output and signal input<br>ESI test signal 3<br>Analog input A11<br>Comparator input C11                  |
| P9.4/ESIC10/A12/C12          | 71  |      | 56  |      | General-purpose digital I/O<br>ESI channel 0 signal input to comparator<br>Analog input A12<br>Comparator input C12                                                      |
| P9.5/ESIC11/A13/C13          | 72  |      | 57  |      | General-purpose digital I/O<br>ESI channel 1 signal input to comparator<br>Analog input A13<br>Comparator input C13                                                      |
| P9.6/ESIC12/A14/C14          | 73  |      | 58  |      | General-purpose digital I/O<br>ESI channel 2 signal input to comparator<br>Analog input A14<br>Comparator input C14                                                      |
| P9.7/ESIC13/A15/C15          | 74  |      | 59  |      | General-purpose digital I/O<br>ESI channel 3 signal input to comparator<br>Analog input A15<br>Comparator input C15                                                      |
| ESIDVCC                      | 75  |      | 60  |      | ESI power supply                                                                                                                                                         |
| ESIDVSS                      | 76  |      | 61  |      | ESI ground supply                                                                                                                                                        |
| ESICI                        | 77  |      | 62  |      | ESI Scan IF input to Comparator                                                                                                                                          |
| ESICOM                       | 78  |      | 63  |      | ESI Common termination for Scan IF sensors                                                                                                                               |
| AVCC1                        | 79  |      | 64  |      | Analog power supply                                                                                                                                                      |
| AVSS3                        | 80  |      | 65  |      | Analog ground supply                                                                                                                                                     |
| PJ.7/HFXOUT                  | 81  |      | 66  |      | General-purpose digital I/O<br>Output terminal of crystal oscillator XT2                                                                                                 |
| PJ.6/HFXIN                   | 82  |      | 67  |      | General-purpose digital I/O<br>Input terminal for crystal oscillator XT2                                                                                                 |
| AVSS1                        | 83  |      | 68  |      | Analog ground supply                                                                                                                                                     |
| PJ.4/LFXIN                   | 84  |      | 69  |      | General-purpose digital I/O<br>Input terminal for crystal oscillator XT1                                                                                                 |
| PJ.5/LFXOUT                  | 85  |      | 70  |      | General-purpose digital I/O<br>Output terminal of crystal oscillator XT1                                                                                                 |
| AVSS2                        | 86  |      | 71  |      | Analog ground supply                                                                                                                                                     |
| P5.4/UCA1SIMO/UCA1TXD/Sx     | 87  | S12  |     |      | General-purpose digital I/O<br>USCI_A1: Slave in, master out (SPI mode)<br>USCI_A1: Transmit data (UART mode)<br>LCD segment output (segment number is package specific) |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                       |     |      |     |      | DESCRIPTION                                                                                                                                                                                                                                                  |
|--------------------------------|-----|------|-----|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                           | PZ  |      | PN  |      |                                                                                                                                                                                                                                                              |
|                                | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                                                                              |
| P5.5/UCA1SOMI/UCA1RXD/Sx       | 88  | S11  |     |      | General-purpose digital I/O<br>USCI_A1: Slave out, master in (SPI mode)<br>USCI_A1: Receive data (UART mode)<br>LCD segment output (segment number is package specific)                                                                                      |
| P5.6/UCA1CLK/Sx                | 89  | S10  |     |      | General-purpose digital I/O<br>USCI_A1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>LCD segment output (segment number is package specific)                                                                                |
| P5.7/UCA1STE/TB0CLK/Sx         | 90  | S9   |     |      | General-purpose digital I/O<br>USCI_A1: Slave transmit enable (SPI mode)<br>Timer_B TB0 clock signal TB0CLK input<br>LCD segment output (segment number is package specific)                                                                                 |
| P4.4/UCB1STE/TA1CLK/Sx         | 91  | S8   | 72  | S9   | General-purpose digital I/O<br>USCI_B1: Slave transmit enable (SPI mode)<br>Timer_A TA1 clock signal TA1CLK input<br>LCD segment output (segment number is package specific)                                                                                 |
| P4.5/UCB1CLK/TA1.0/Sx          | 92  | S7   | 73  | S8   | General-purpose digital I/O<br>USCI_B1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_A TA1 CCR0 capture: CCI0A input, compare: Out0 output<br>LCD segment output (segment number is package specific)                 |
| P4.6/UCB1SIMO/UCB1SDA/TA1.1/Sx | 93  | S6   | 74  | S7   | General-purpose digital I/O<br>USCI_B1: Slave in, master out (SPI mode)<br>USCI_B1: I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>LCD segment output (segment number is package specific)  |
| P4.7/UCB1SOMI/UCB1SCL/TA1.2/Sx | 94  | S5   | 75  | S6   | General-purpose digital I/O<br>USCI_B1: Slave out, master in (SPI mode)<br>USCI_B1: I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output<br>LCD segment output (segment number is package specific) |
| P10.0/SMCLK/Sx                 | 95  | S4   |     |      | General-purpose digital I/O<br>SMCLK output<br>LCD segment output (segment number is package specific)                                                                                                                                                       |
| P4.0/UCB1SIMO/UCB1SDA/MCLK/Sx  | 96  | S3   | 76  | S5   | General-purpose digital I/O<br>USCI_B1: Slave in, master out (SPI mode)<br>USCI_B1: I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>MCLK output<br>LCD segment output (segment number is package specific)                                                  |

**Table 4-1. Signal Descriptions – MSP430FR688x and MSP430FR688x1 (continued)**

| TERMINAL                          |     |      |     |      | DESCRIPTION                                                                                                                                                                                                  |
|-----------------------------------|-----|------|-----|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                              | PZ  |      | PN  |      |                                                                                                                                                                                                              |
|                                   | NO. | Seg. | NO. | Seg. |                                                                                                                                                                                                              |
| P4.1/UCB1SOMI/UCB1SCL/<br>ACLK/Sx | 97  | S2   | 77  | S4   | General-purpose digital I/O<br>USCI_B1: Slave out, master in (SPI mode)<br>USCI_B1: I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>ACLK output<br>LCD segment output (segment number is package specific) |
| DVSS3                             | 98  |      | 78  |      | Digital ground supply                                                                                                                                                                                        |
| DVCC3                             | 99  |      | 79  |      | Digital power supply                                                                                                                                                                                         |
| P4.2/UCA0SIMO/UCA0TXD/<br>UCB1CLK | 100 |      | 80  |      | General-purpose digital I/O<br>USCI_A0: Slave in, master out (SPI mode)<br>USCI_A0: Transmit data (UART mode)<br>USCI_B1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)         |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1**

| TERMINAL                          |           | DESCRIPTION                                                                                                                                                                                                                    |
|-----------------------------------|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                              | PM<br>RGC |                                                                                                                                                                                                                                |
|                                   | NO.       |                                                                                                                                                                                                                                |
| P4.3/UCA0SOMI/<br>UCA0RXD/UCB1STE | 1         | General-purpose digital I/O<br>USCI_A0: Slave out, master in (SPI mode), Receive data (UART mode)<br>USCI_B1: Slave transmit enable (SPI mode)                                                                                 |
| P1.4/UCB0CLK/ UCA0STE/TA1.0       | 2         | General-purpose digital I/O<br>USCI_B0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>USCI_A0: Slave transmit enable (SPI mode)<br>Timer_A TA1 CCR0 capture: CCI0A input, compare: Out0 output |
| P1.5/UCB0STE/ UCA0CLK/TA0.0       | 3         | General-purpose digital I/O<br>USCI_B0: Slave transmit enable (SPI mode)<br>USCI_A0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_A TA0 CCR0 capture: CCI0A input, compare: Out0 output |
| P1.6/UCB0SIMO/ UCB0SDA/TA0.1      | 4         | General-purpose digital I/O<br>USCI_B0: Slave in, master out (SPI mode), I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>BSL Data (I <sup>2</sup> C BSL)<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output       |
| P1.7/UCB0SOMI/ UCB0SCL/TA0.2      | 5         | General-purpose digital I/O<br>USCI_B0: Slave out, master in (SPI mode), I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>BSL Clock (I <sup>2</sup> C BSL)<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output     |
| P2.4/TB0.3                        | 6         | General-purpose digital I/O<br>Timer_B TB0 CCR3 capture: CCI3A input, compare: Out3 output                                                                                                                                     |
| P2.5/TB0.4                        | 7         | General-purpose digital I/O<br>Timer_B TB0 CCR4 capture: CCI4A input, compare: Out4 output                                                                                                                                     |
| P2.6/TB0.5/ESIC1OUT               | 8         | General-purpose digital I/O<br>Timer_B TB0 CCR5 capture: CCI5A input, compare: Out5 output<br>ESI Comparator 1 output                                                                                                          |
| P2.7/TB0.6/ESIC2OUT               | 9         | General-purpose digital I/O<br>Timer_B TB0 CCR6 capture: CCI6A input, compare: Out6 output<br>ESI Comparator 2 output                                                                                                          |
| P5.0/TA1.1/MCLK                   | 10        | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>MCLK output                                                                                                                      |
| P5.1/TA1.2                        | 11        | General-purpose digital I/O<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output                                                                                                                                     |
| P5.2/TA1.0/TA1CLK/ACLK            | 12        | General-purpose digital I/O<br>Timer_A TA1 CCR0 capture: CCI0B input, compare: Out0 output<br>Timer_A TA1 clock signal TA0CLK input<br>ACLK output                                                                             |
| P5.3/UCB1STE                      | 13        | General-purpose digital I/O<br>USCI_B1: Slave transmit enable (SPI mode)                                                                                                                                                       |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1 (continued)**

| TERMINAL                            |           | DESCRIPTION                                                                                                                                                                    |
|-------------------------------------|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                | PM<br>RGC |                                                                                                                                                                                |
|                                     | NO.       |                                                                                                                                                                                |
| P3.0/UCB1CLK                        | 14        | General-purpose digital I/O<br>USCI_B1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)                                                             |
| P3.1/UCB1SIMO/UCB1SDA               | 15        | General-purpose digital I/O<br>USCI_B1: Slave in, master out (SPI mode)<br>USCI_B1: I <sup>2</sup> C data (I <sup>2</sup> C mode)                                              |
| P3.2/UCB1SOMI/UCB1SCL               | 16        | General-purpose digital I/O<br>USCI_B1: Slave out, master in (SPI mode)<br>USCI_B1: I <sup>2</sup> C clock (I <sup>2</sup> C mode)                                             |
| DVSS1                               | 17        | Digital ground supply                                                                                                                                                          |
| DVCC1                               | 18        | Digital power supply                                                                                                                                                           |
| TEST/SBWTCK                         | 19        | Test mode pin - select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock                                                                                                     |
| $\overline{\text{RST}}$ /NMI/SBWTIO | 20        | Reset input, active low<br>Nonmaskable interrupt input<br>Spy-Bi-Wire data input/output                                                                                        |
| PJ.0/TDO/TB0OUTH/<br>SMCLK/SRSCG1   | 21        | General-purpose digital I/O<br>Test data output port<br>Switch all PWM outputs high impedance input - Timer_B TB0<br>SMCLK output<br>Low-power debug: CPU Status register SCG1 |
| PJ.1/TDI/TCLK/MCLK/SRSCG0           | 22        | General-purpose digital I/O<br>Test data input or test clock input<br>MCLK output<br>Low-power debug: CPU Status register SCG0                                                 |
| PJ.2/TMS/ACLK/SROSCOFF              | 23        | General-purpose digital I/O<br>Test mode select<br>ACLK output<br>Low-power debug: CPU Status register OSCOFF                                                                  |
| PJ.3/TCK/COU/SRCPUOFF               | 24        | General-purpose digital I/O<br>Test clock<br>Comparator output<br>Low-power debug: CPU Status register CPUOFF                                                                  |
| P3.3/TA1.1/TB0CLK                   | 25        | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>Timer_B TB0 clock signal TB0CLK input                                            |
| P3.4/UCA1SIMO/UCA1TXD/TB0.0         | 26        | General-purpose digital I/O<br>USCI_A1: Slave in, master out (SPI mode)<br>USCI_A1: Transmit data (UART mode)<br>Timer_B TB0 CCR0 capture: CCI0A input, compare: Out0 output   |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1 (continued)**

| TERMINAL                               |           | DESCRIPTION                                                                                                                                                                                                                                      |
|----------------------------------------|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                   | PM<br>RGC |                                                                                                                                                                                                                                                  |
|                                        | NO.       |                                                                                                                                                                                                                                                  |
| P3.5/UCA1SOMI/UCA1RXD/TB0.1            | 27        | General-purpose digital I/O<br>USCI_A1: Slave out, master in (SPI mode)<br>USCI_A1: Receive data (UART mode)<br>Timer_B TB0 CCR1 capture: CCI1A input, compare: Out1 output                                                                      |
| P3.6/UCA1CLK/TB0.2                     | 28        | General-purpose digital I/O<br>USCI_A1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_B TB0 CCR2 capture: CCI2A input, compare: Out2 output                                                                |
| P3.7/UCA1STE/TB0.3                     | 29        | General-purpose digital I/O<br>USCI_A1: Slave transmit enable (SPI mode)<br>Timer_B TB0 CCR3 capture: CCI3B input, compare: Out3 output                                                                                                          |
| P2.3/UCA0STE/TB0OUTH                   | 30        | General-purpose digital I/O<br>USCI_A0: Slave transmit enable (SPI mode)<br>Switch all PWM outputs high impedance input - Timer_B TB0                                                                                                            |
| P2.2/UCA0CLK/TB0.4/RTCCLK              | 31        | General-purpose digital I/O<br>USCI_A0: Clock signal input (SPI slave mode), Clock signal output (SPI master mode)<br>Timer_B TB0 CCR4 capture: CCI4B input, compare: Out4 output<br>RTC clock output for calibration                            |
| P2.1/UCA0SOMI/UCA0RXD/TB0.5/<br>DMAE0  | 32        | General-purpose digital I/O<br>USCI_A0: Slave out, master in (SPI mode)<br>USCI_A0: Receive data (UART mode)<br>BSL receive (UART BSL)<br>Timer_B TB0 CCR5 capture: CCI5B input, compare: Out5 output<br>DMA external trigger input              |
| P2.0/UCA0SIMO/UCA0TXD/TB0.6/<br>TB0CLK | 33        | General-purpose digital I/O<br>USCI_A0: Slave in, master out (SPI mode)<br>USCI_A0: Transmit data (UART mode)<br>BSL transmit (UART BSL)<br>Timer_B TB0 CCR6 capture: CCI6B input, compare: Out6 output<br>Timer_B TB0 clock signal TB0CLK input |
| DVSS2                                  | 34        | Digital ground supply                                                                                                                                                                                                                            |
| DVCC2                                  | 35        | Digital power supply                                                                                                                                                                                                                             |
| P1.3/ESITEST4/TA1.2/A3/C3              | 36        | General-purpose digital I/O<br>ESI test signal 4<br>Timer_A TA1 CCR2 capture: CCI2A input, compare: Out2 output<br>Analog input A3<br>Comparator input C3                                                                                        |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1 (continued)**

| TERMINAL                                        |           | DESCRIPTION                                                                                                                                                                                                                                                                                                   |
|-------------------------------------------------|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                            | PM<br>RGC |                                                                                                                                                                                                                                                                                                               |
|                                                 | NO.       |                                                                                                                                                                                                                                                                                                               |
| P1.2/TA1.1/TA0CLK/COU/A2/C2                     | 37        | General-purpose digital I/O<br>Timer_A TA1 CCR1 capture: CCI1A input, compare: Out1 output<br>Timer_A TA0 clock signal TA0CLK input<br>Comparator output<br>Analog input A2<br>Comparator input C2                                                                                                            |
| P1.1/TA0.2/TA1CLK/<br>COUT/A1/C1/VREF+ / VeREF+ | 38        | General-purpose digital I/O<br>Timer_A TA0 CCR2 capture: CCI2A input, compare: Out2 output<br>Timer_A TA1 clock signal TA1CLK input<br>Comparator output<br>Analog input A1<br>Comparator input C1<br>Output of positive reference voltage<br>Input for an external positive reference voltage to the ADC     |
| P1.0/TA0.1/DMAE0/ RTCCLK/A0/C0/<br>VREF-/VeREF- | 39        | General-purpose digital I/O<br>Timer_A TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>DMA external trigger input<br>RTC clock output for calibration<br>Analog input A0<br>Comparator input C0<br>Output of negative reference voltage<br>Input for an external negative reference voltage to the ADC |
| P9.0/ESICH0/ESITEST0/ A8/C8                     | 40        | General-purpose digital I/O<br>ESI channel 0 sensor excitation output and signal input<br>ESI test signal 0<br>Analog input A8; comparator input C8                                                                                                                                                           |
| P9.1/ESICH1/ESITEST1/ A9/C9                     | 41        | General-purpose digital I/O<br>ESI channel 1 sensor excitation output and signal input<br>ESI test signal 1<br>Analog input A9<br>Comparator input C9                                                                                                                                                         |
| P9.2/ESICH2/ESITEST2/ A10/C10                   | 42        | General-purpose digital I/O<br>ESI channel 2 sensor excitation output and signal input<br>ESI test signal 2<br>Analog input A10<br>Comparator input C10                                                                                                                                                       |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1 (continued)**

| TERMINAL                      |           | DESCRIPTION                                                                                                                                             |
|-------------------------------|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                          | PM<br>RGC |                                                                                                                                                         |
|                               | NO.       |                                                                                                                                                         |
| P9.3/ESICH3/ESITEST3/ A11/C11 | 43        | General-purpose digital I/O<br>ESI channel 3 sensor excitation output and signal input<br>ESI test signal 3<br>Analog input A11<br>Comparator input C11 |
| P9.4/ESIC10/A12/C12           | 44        | General-purpose digital I/O<br>ESI channel 0 signal input to comparator<br>Analog input A12<br>Comparator input C12                                     |
| P9.5/ESIC11/A13/C13           | 45        | General-purpose digital I/O<br>ESI channel 1 signal input to comparator<br>Analog input A13<br>Comparator input C13                                     |
| P9.6/ESIC12/A14/C14           | 46        | General-purpose digital I/O<br>ESI channel 2 signal input to comparator<br>Analog input A14<br>Comparator input C14                                     |
| P9.7/ESIC13/A15/C15           | 47        | General-purpose digital I/O<br>ESI channel 3 signal input to comparator<br>Analog input A15<br>Comparator input C15                                     |
| ESIDVCC                       | 48        | ESI Power supply                                                                                                                                        |
| ESIDVSS                       | 49        | ESI Ground supply                                                                                                                                       |
| ESICI                         | 50        | ESI Scan IF input to Comparator                                                                                                                         |
| ESICOM                        | 51        | ESI Common termination for Scan IF sensors                                                                                                              |
| AVCC1                         | 52        | Analog power supply                                                                                                                                     |
| AVSS3                         | 53        | Analog ground supply                                                                                                                                    |
| PJ.7/HFXOUT                   | 54        | General-purpose digital I/O<br>Output terminal of crystal oscillator XT2                                                                                |
| PJ.6/HFXIN                    | 55        | General-purpose digital I/O<br>Input terminal for crystal oscillator XT2                                                                                |
| AVSS1                         | 56        | Analog ground supply                                                                                                                                    |
| PJ.4/LFXIN                    | 57        | General-purpose digital I/O<br>Input terminal for crystal oscillator XT1                                                                                |
| PJ.5/LFXOUT                   | 58        | General-purpose digital I/O<br>Output terminal of crystal oscillator XT1                                                                                |
| AVSS2                         | 59        | Analog ground supply                                                                                                                                    |
| P4.0/UCB1SIMO/UCB1SDA/MCLK    | 60        | General-purpose digital I/O<br>USCI_B1: Slave in, master out (SPI mode)<br>USCI_B1: I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>MCLK output        |

**Table 4-2. Signal Descriptions – MSP430FR588x and MSP430FR588x1 (continued)**

| TERMINAL                          |           | DESCRIPTION                                                                                                                                                                                          |
|-----------------------------------|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                              | PM<br>RGC |                                                                                                                                                                                                      |
|                                   | NO.       |                                                                                                                                                                                                      |
| P4.1/UCB1SOMI/UCB1SCL/ACLK        | 61        | General-purpose digital I/O<br>USCI_B1: Slave out, master in (SPI mode)<br>USCI_B1: I <sup>2</sup> C clock (I <sup>2</sup> C mode)<br>ACLK output                                                    |
| DVSS3                             | 62        | Digital ground supply                                                                                                                                                                                |
| DVCC3                             | 63        | Digital power supply                                                                                                                                                                                 |
| P4.2/UCA0SIMO/UCA0TXD/<br>UCB1CLK | 64        | General-purpose digital I/O<br>USCI_A0: Slave in, master out (SPI mode)<br>USCI_A0: Transmit data (UART mode)<br>USCI_B1: Clock signal input (SPI slave mode), Clock signal output (SPI master mode) |
| Thermal pad                       | Pad       | RGC package only. QFN package exposed thermal pad. TI recommends connection to V <sub>SS</sub> .                                                                                                     |

## 4.3 Pin Multiplexing

Pin multiplexing for these devices is controlled by both register settings and operating modes (for example, if the device is in test mode). For details of the settings for each pin and diagrams of the multiplexed ports, see [Section 6.11.23](#).

## 4.4 Connection of Unused Pins

[Table 4-3](#) lists the correct termination of all unused pins.

**Table 4-3. Connection of Unused Pins<sup>(1)</sup>**

| PIN                                          | POTENTIAL                            | COMMENT                                                                                                                                                                                                               |
|----------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AVCC                                         | DV <sub>CC</sub>                     |                                                                                                                                                                                                                       |
| AVSS                                         | DV <sub>SS</sub>                     |                                                                                                                                                                                                                       |
| Px.0 to Px.7                                 | Open                                 | Set to port function, output direction (PxDIR.n = 1)                                                                                                                                                                  |
| R33/LCDCAP                                   | DV <sub>SS</sub> or DV <sub>CC</sub> | If the pin is not used, it can be tied to either supply.                                                                                                                                                              |
| ESIDVCC                                      | DV <sub>CC</sub>                     |                                                                                                                                                                                                                       |
| ESIDVSS                                      | DV <sub>SS</sub>                     |                                                                                                                                                                                                                       |
| ESICOM                                       | Open                                 |                                                                                                                                                                                                                       |
| ESICI                                        | Open                                 |                                                                                                                                                                                                                       |
| $\overline{\text{RST}}$ /NMI                 | DV <sub>CC</sub> or V <sub>CC</sub>  | 47-k $\Omega$ pullup or internal pullup selected with 2.2-nF (10-nF <sup>(2)</sup> ) pulldown                                                                                                                         |
| PJ.0/TDO<br>PJ.1/TDI<br>PJ.2/TMS<br>PJ.3/TCK | Open                                 | The JTAG pins are shared with general-purpose I/O function (PJ.x). If not used as JTAG pins, these pins should be switched to port function, output direction. When used as JTAG pins, these pins should remain open. |
| TEST                                         | Open                                 | This pin always has an internal pulldown enabled.                                                                                                                                                                     |

- (1) Any unused pin with a secondary function that is shared with general-purpose I/O should follow the Px.0 to Px.7 unused pin connection guidelines.
- (2) The pulldown capacitor should not exceed 2.2 nF when using devices in Spy-Bi-Wire mode or in 4-wire JTAG mode with TI tools like FET interfaces or GANG programmers. If JTAG or Spy-Bi-Wire access is not needed, up to a 10-nF pulldown capacitor may be used.

## 5 Specifications

### 5.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                                              | MIN  | MAX                                  | UNIT |
|--------------------------------------------------------------|------|--------------------------------------|------|
| Voltage applied at DVCC and AVCC pins to V <sub>SS</sub>     | −0.3 | 4.1                                  | V    |
| Voltage difference between DVCC and AVCC pins <sup>(2)</sup> |      | ±0.3                                 | V    |
| Voltage applied to any pin <sup>(3)</sup>                    | −0.3 | V <sub>CC</sub> + 0.3 V<br>(4.1 Max) | V    |
| Diode current at any device pin                              |      | ±2                                   | mA   |
| Storage temperature, T <sub>stg</sub> <sup>(4)</sup>         | −40  | 125                                  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Voltage differences between DVCC and AVCC exceeding the specified limits may cause malfunction of the device including erroneous writes to RAM and FRAM.
- (3) All voltages referenced to V<sub>SS</sub>.
- (4) Higher temperature may be applied during board soldering according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

### 5.2 ESD Ratings

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±1000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Pins listed as ±250 V may actually have higher performance.

### 5.3 Recommended Operating Conditions

Typical data are based on V<sub>CC</sub> = 3.0 V, T<sub>A</sub> = 25°C unless otherwise noted.

|                     |                                                                                         | MIN                                                | NOM | MAX               | UNIT              |
|---------------------|-----------------------------------------------------------------------------------------|----------------------------------------------------|-----|-------------------|-------------------|
| V <sub>CC</sub>     | Supply voltage range applied at all DVCC, AVCC, and ESIDVCC pins <sup>(1) (2) (3)</sup> | 1.8 <sup>(4)</sup>                                 |     | 3.6               | V                 |
| V <sub>SS</sub>     | Supply voltage applied at all DVSS, AVSS, and ESIDVSS pins                              |                                                    | 0   |                   | V                 |
| T <sub>A</sub>      | Operating free-air temperature                                                          | −40                                                |     | 85                | °C                |
| T <sub>J</sub>      | Operating junction temperature                                                          | −40                                                |     | 85                | °C                |
| C <sub>DVCC</sub>   | Capacitor value at DVCC and ESIDVCC <sup>(5)</sup>                                      | 1–20%                                              |     |                   | μF                |
| f <sub>SYSTEM</sub> | Processor frequency (maximum MCLK frequency) <sup>(6)</sup>                             | No FRAM wait states (NWAITSx = 0)                  |     | 0                 | 8 <sup>(7)</sup>  |
|                     |                                                                                         | With FRAM wait states (NWAITSx = 1) <sup>(8)</sup> |     | 0                 | 16 <sup>(9)</sup> |
| f <sub>ACLK</sub>   | Maximum ACLK frequency                                                                  |                                                    |     | 50                | kHz               |
| f <sub>SMCLK</sub>  | Maximum SMCLK frequency                                                                 |                                                    |     | 16 <sup>(9)</sup> | MHz               |

- (1) TI recommends powering the DVCC, AVCC, and ESIDVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference between DVCC, AVCC, and ESIDVCC must not exceed the limits specified in [Absolute Maximum Ratings](#). Exceeding the specified limits may cause malfunction of the device including erroneous writes to RAM and FRAM.
- (2) See [Table 5-1](#) for additional important information.
- (3) Modules may have a different supply voltage range specification. See the specification of each module in this data sheet.
- (4) The minimum supply voltage is defined by the supervisor SVS levels. See [Table 5-2](#) for the exact values.
- (5) Connect a low-ESR capacitor with at least the value specified and a maximum tolerance of 20% as close as possible to the DVCC and ESIDVCC pins.
- (6) Modules may have a different maximum input clock specification. See the specification of each module in this data sheet.
- (7) DCO settings and HF crystals with a typical value less than or equal to the specified MAX value are permitted.
- (8) Wait states only occur on actual FRAM accesses; that is, on FRAM cache misses. RAM and peripheral accesses are always executed without wait states.
- (9) DCO settings and HF crystals with a typical value less than or equal to the specified MAX value are permitted. If a clock sources with a larger typical value is used, the clock must be divided in the clock system.

## 5.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

over recommended operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                                                    | EXECUTION MEMORY             | V <sub>CC</sub> | FREQUENCY (f <sub>MCLK</sub> = f <sub>SMCLK</sub> ) |     |                                                     |     |                                                     |      |                                                     |      |                                                     |      | UNIT |
|--------------------------------------------------------------|------------------------------|-----------------|-----------------------------------------------------|-----|-----------------------------------------------------|-----|-----------------------------------------------------|------|-----------------------------------------------------|------|-----------------------------------------------------|------|------|
|                                                              |                              |                 | 1 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |     | 4 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |     | 8 MHz<br>0 WAIT STATES<br>(NWAITS <sub>x</sub> = 0) |      | 12 MHz<br>1 WAIT STATE<br>(NWAITS <sub>x</sub> = 1) |      | 16 MHz<br>1 WAIT STATE<br>(NWAITS <sub>x</sub> = 1) |      |      |
|                                                              |                              |                 | TYP                                                 | MAX | TYP                                                 | MAX | TYP                                                 | MAX  | TYP                                                 | MAX  | TYP                                                 | MAX  |      |
| I <sub>AM, FRAM_UNI</sub><br>(Unified memory) <sup>(3)</sup> | FRAM                         | 3.0 V           | 210                                                 |     | 640                                                 |     | 1220                                                |      | 1475                                                |      | 1845                                                |      | μA   |
| I <sub>AM, FRAM</sub> (0%) <sup>(4) (5)</sup>                | FRAM<br>0% cache hit ratio   | 3.0 V           | 375                                                 |     | 1290                                                |     | 2525                                                |      | 2100                                                |      | 2675                                                |      | μA   |
| I <sub>AM, FRAM</sub> (50%) <sup>(4) (5)</sup>               | FRAM<br>50% cache hit ratio  | 3.0 V           | 240                                                 |     | 745                                                 |     | 1440                                                |      | 1575                                                |      | 1990                                                |      | μA   |
| I <sub>AM, FRAM</sub> (66%) <sup>(4) (5)</sup>               | FRAM<br>66% cache hit ratio  | 3.0 V           | 200                                                 |     | 560                                                 |     | 1070                                                |      | 1300                                                |      | 1620                                                |      | μA   |
| I <sub>AM, FRAM</sub> (75%) <sup>(4) (5)</sup>               | FRAM<br>75% cache hit ratio  | 3.0 V           | 170                                                 | 255 | 480                                                 |     | 890                                                 | 1085 | 1155                                                | 1310 | 1420                                                | 1620 | μA   |
| I <sub>AM, FRAM</sub> (100%) <sup>(4) (5)</sup>              | FRAM<br>100% cache hit ratio | 3.0 V           | 110                                                 |     | 235                                                 |     | 420                                                 |      | 640                                                 |      | 730                                                 |      | μA   |
| I <sub>AM, RAM</sub> <sup>(6) (5)</sup>                      | RAM                          | 3.0 V           | 130                                                 |     | 320                                                 |     | 585                                                 |      | 890                                                 |      | 1070                                                |      | μA   |
| I <sub>AM, RAM only</sub> <sup>(7) (5)</sup>                 | RAM                          | 3.0 V           | 100                                                 | 180 | 290                                                 |     | 555                                                 |      | 860                                                 |      | 1040                                                | 1300 | μA   |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.

(2) Characterized with program executing typical data processing.

$f_{ACLK} = 32768$  Hz,  $f_{MCLK} = f_{SMCLK} = f_{DCO}$  at specified frequency, except for 12 MHz. For 12 MHz,  $f_{DCO} = 24$  MHz and  $f_{MCLK} = f_{SMCLK} = f_{DCO} / 2$ .

At MCLK frequencies above 8 MHz, the FRAM requires wait states. When wait states are required, the effective MCLK frequency ( $f_{MCLK,eff}$ ) decreases. The effective MCLK frequency also depends on the cache hit ratio. SMCLK is not affected by the number of wait states or the cache hit ratio.

The following equation can be used to compute  $f_{MCLK,eff}$ :

$$f_{MCLK,eff} = f_{MCLK} / [\text{wait states} \times (1 - \text{cache hit ratio}) + 1]$$

For example, with 1 wait state and 75% cache hit ratio  $f_{MCLK,eff} = f_{MCLK} / [1 \times (1 - 0.75) + 1] = f_{MCLK} / 1.25$ .

(3) Represents typical program execution. Program and data reside entirely in FRAM. All execution is from FRAM.

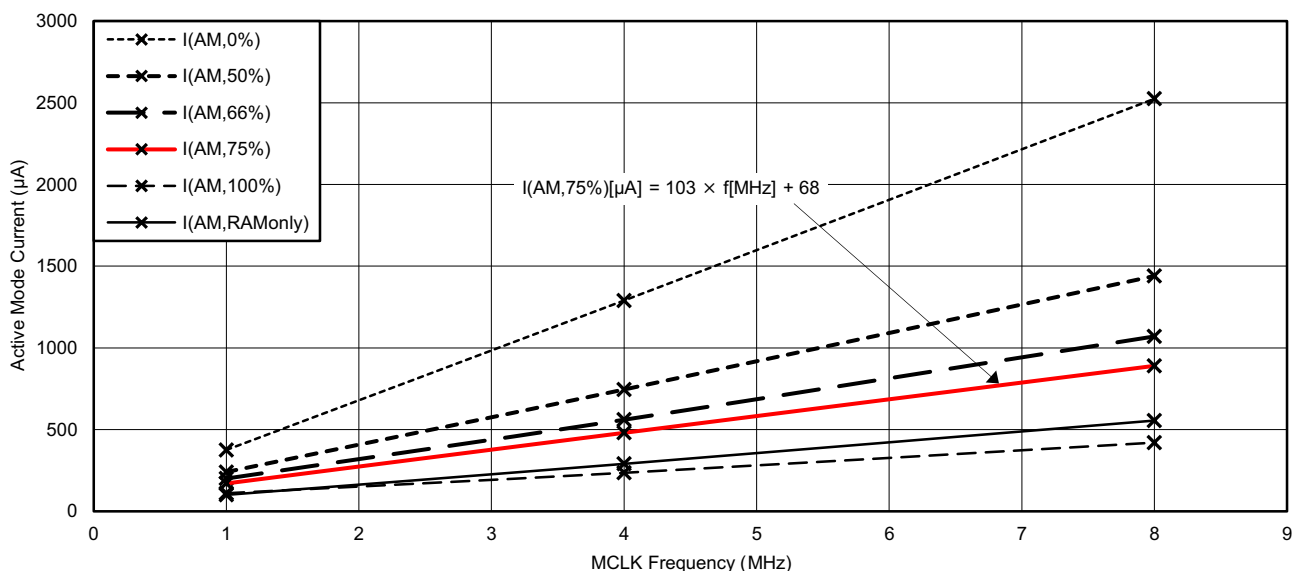
(4) Program resides in FRAM. Data resides in SRAM. Average current dissipation varies with cache hit-to-miss ratio as specified. Cache hit ratio represents number cache accesses divided by the total number of FRAM accesses. For example, a 75% ratio implies three of every four accesses is from cache, and the remaining are FRAM accesses.

(5) See Figure 5-1 for typical curves. Each characteristic equation shown in the graph is computed using the least squares method for best linear fit using the typical data shown in Section 5.4.

(6) Program and data reside entirely in RAM. All execution is from RAM.

(7) Program and data reside entirely in RAM. All execution is from RAM. FRAM is off.

## 5.5 Typical Characteristics, Active Mode Supply Currents



I(AM, cache hit ratio): Program resides in FRAM. Data resides in SRAM. Average current dissipation varies with cache hit-to-miss ratio as specified. Cache hit ratio represents number cache accesses divided by the total number of FRAM accesses. For example, a 75% ratio implies three of every four accesses is from cache, and the remaining are FRAM accesses.

I(AM, RAMOnly): Program and data reside entirely in RAM. All execution is from RAM. FRAM is off.

**Figure 5-1. Typical Active Mode Supply Currents, No Wait States**

## 5.6 Low-Power Mode (LPM0, LPM1) Supply Currents Into V<sub>CC</sub> Excluding External Current

over recommended operating free-air temperature (unless otherwise noted)<sup>(1)</sup> <sup>(2)</sup>

| PARAMETER         | V <sub>CC</sub> | FREQUENCY (f <sub>SMCLK</sub> ) |     |       |     |       |     |        |     |        |     | UNIT |
|-------------------|-----------------|---------------------------------|-----|-------|-----|-------|-----|--------|-----|--------|-----|------|
|                   |                 | 1 MHz                           |     | 4 MHz |     | 8 MHz |     | 12 MHz |     | 16 MHz |     |      |
|                   |                 | TYP                             | MAX | TYP   | MAX | TYP   | MAX | TYP    | MAX | TYP    | MAX |      |
| I <sub>LPM0</sub> | 2.2 V           | 75                              |     | 105   |     | 165   |     | 250    |     | 230    |     | μA   |
|                   | 3.0 V           | 85                              | 120 | 115   |     | 175   |     | 260    |     | 240    | 275 |      |
| I <sub>LPM1</sub> | 2.2 V           | 40                              |     | 65    |     | 130   |     | 215    |     | 195    |     | μA   |
|                   | 3.0 V           | 40                              | 65  | 65    |     | 130   |     | 215    |     | 195    | 220 |      |

(1) All inputs are tied to 0 V or to V<sub>CC</sub>. Outputs do not source or sink any current.

(2) Current for watchdog timer clocked by SMCLK included.

f<sub>ACLK</sub> = 32768 Hz, f<sub>MCLK</sub> = 0 MHz, f<sub>SMCLK</sub> = f<sub>DCO</sub> at specified frequency, except for 12 MHz: here f<sub>DCO</sub> = 24 MHz and f<sub>SMCLK</sub> = f<sub>DCO</sub> / 2.

## 5.7 Low-Power Mode (LPM2, LPM3, LPM4) Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) <sup>(1)</sup>

| PARAMETER                     |                                                                                                              | V <sub>CC</sub> | TEMPERATURE (T <sub>A</sub> ) |     |            |     |      |     |             |     | UNIT |
|-------------------------------|--------------------------------------------------------------------------------------------------------------|-----------------|-------------------------------|-----|------------|-----|------|-----|-------------|-----|------|
|                               |                                                                                                              |                 | −40°C                         |     | 25°C       |     | 60°C |     | 85°C        |     |      |
|                               |                                                                                                              |                 | TYP                           | MAX | TYP        | MAX | TYP  | MAX | TYP         | MAX |      |
| I <sub>LPM2,XT12</sub>        | Low-power mode 2, 12-pF crystal <sup>(2) (3) (4)</sup>                                                       | 2.2 V           | 0.6                           |     | 1.2        |     | 3.1  |     | 8.8         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.6                           |     | 1.2    2.2 |     | 3.1  |     | 8.8    20.8 |     |      |
| I <sub>LPM2,XT3.7</sub>       | Low-power mode 2, 3.7-pF crystal <sup>(2) (5) (4)</sup>                                                      | 2.2 V           | 0.5                           |     | 1.1        |     | 3.0  |     | 8.7         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.5                           |     | 1.1        |     | 3.0  |     | 8.7         |     |      |
| I <sub>LPM2,VLO</sub>         | Low-power mode 2, VLO, includes SVS <sup>(6)</sup>                                                           | 2.2 V           | 0.3                           |     | 0.9        |     | 2.8  |     | 8.5         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.3                           |     | 0.9    2.0 |     | 2.8  |     | 8.5    20.5 |     |      |
| I <sub>LPM3,XT12</sub>        | Low-power mode 3, 12-pF crystal, excludes SVS <sup>(2) (3) (7)</sup>                                         | 2.2 V           | 0.5                           |     | 0.7        |     | 1.2  |     | 2.5         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.5                           |     | 0.7    1.0 |     | 1.2  |     | 2.5    6.4  |     |      |
| I <sub>LPM3,XT3.7</sub>       | Low-power mode 3, 3.7-pF crystal, excludes SVS <sup>(2) (5) (8)</sup> (also see <a href="#">Figure 5-2</a> ) | 2.2 V           | 0.4                           |     | 0.6        |     | 1.1  |     | 2.4         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.4                           |     | 0.6        |     | 1.1  |     | 2.4         |     |      |
| I <sub>LPM3,VLO</sub>         | Low-power mode 3, VLO, excludes SVS <sup>(9)</sup>                                                           | 2.2 V           | 0.3                           |     | 0.4        |     | 0.9  |     | 2.2         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.3                           |     | 0.4    0.8 |     | 0.9  |     | 2.2    6.1  |     |      |
| I <sub>LPM3,VLO, RAMoff</sub> | Low-power mode 3, VLO, excludes SVS, RAM powered-down completely <sup>(10)</sup>                             | 2.2 V           | 0.3                           |     | 0.4        |     | 0.8  |     | 2.1         |     | μA   |
|                               |                                                                                                              | 3.0 V           | 0.3                           |     | 0.4    0.7 |     | 0.8  |     | 2.1    5.2  |     |      |

- (1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.
- (2) Not applicable for devices with HF crystal oscillator only.
- (3) Characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5 pF load.
- (4) Low-power mode 2, crystal oscillator test conditions:  
Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout and SVS included.  
CPUOFF = 1, SCG0 = 0 SCG1 = 1, OSCOFF = 0 (LPM2),  
 $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz
- (5) Characterized with a Seiko SSP-T7-FL (SMD) crystal with a load capacitance of 3.7 pF. The internal and external load capacitance are chosen to closely match the required 3.7-pF load.
- (6) Low-power mode 2, VLO test conditions:  
Current for watchdog timer clocked by ACLK included. RTC disabled (RTCHOLD = 1). Current for brownout and SVS included.  
CPUOFF = 1, SCG0 = 0 SCG1 = 1, OSCOFF = 0 (LPM2),  
 $f_{XT1} = 0$  Hz,  $f_{ACLK} = f_{VLO}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz
- (7) Low-power mode 3, 12-pF crystal excluding SVS test conditions:  
Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.
- (8) Low-power mode 3, 3.7-pF crystal excluding SVS test conditions:  
Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.
- (9) Low-power mode 3, VLO excluding SVS test conditions:  
Current for watchdog timer clocked by ACLK included. RTC disabled (RTCHOLD = 1). Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 0$  Hz,  $f_{ACLK} = f_{VLO}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.
- (10) Low-power mode 3, VLO excluding SVS test conditions:  
Current for watchdog timer clocked by ACLK included. RTC disabled (RTCHOLD = 1). RAM disabled (RCCTL0 = 5A55h). Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 0$  Hz,  $f_{ACLK} = f_{VLO}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.

## Low-Power Mode (LPM2, LPM3, LPM4) Supply Currents (Into $V_{CC}$ ) Excluding External Current (*continued*)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) <sup>(1)</sup>

| PARAMETER                |                                                                                                           | V <sub>CC</sub> | TEMPERATURE (T <sub>A</sub> ) |     |       |     |      |     |      |     | UNIT |
|--------------------------|-----------------------------------------------------------------------------------------------------------|-----------------|-------------------------------|-----|-------|-----|------|-----|------|-----|------|
|                          |                                                                                                           |                 | –40°C                         |     | 25°C  |     | 60°C |     | 85°C |     |      |
|                          |                                                                                                           |                 | TYP                           | MAX | TYP   | MAX | TYP  | MAX | TYP  | MAX |      |
| I <sub>LPM4,SVS</sub>    | Low-power mode 4, includes SVS <sup>(11)</sup>                                                            | 2.2 V           | 0.4                           |     | 0.5   |     | 0.9  |     | 2.3  |     | μA   |
|                          |                                                                                                           | 3.0 V           | 0.4                           |     | 0.5   | 0.8 | 0.9  |     | 2.3  | 6.2 |      |
| I <sub>LPM4</sub>        | Low-power mode 4, excludes SVS <sup>(12)</sup>                                                            | 2.2 V           | 0.2                           |     | 0.3   |     | 0.7  |     | 2.0  |     | μA   |
|                          |                                                                                                           | 3.0 V           | 0.2                           |     | 0.3   | 0.6 | 0.7  |     | 2.0  | 6.0 |      |
| I <sub>LPM4,RAMoff</sub> | Low-power mode 4, excludes SVS, RAM powered-down completely <sup>(13)</sup>                               | 2.2 V           | 0.2                           |     | 0.3   |     | 0.7  |     | 1.9  |     | μA   |
|                          |                                                                                                           | 3.0 V           | 0.2                           |     | 0.3   | 0.6 | 0.7  |     | 1.9  | 5.1 |      |
| I <sub>IDLE,GroupA</sub> | Additional idle current if one or more modules from Group A (see Table 6-3) are activated in LPM3 or LPM4 | 3.0V            |                               |     | 0.02  |     |      |     | 0.3  | 1.2 | μA   |
| I <sub>IDLE,GroupB</sub> | Additional idle current if one or more modules from Group B (see Table 6-3) are activated in LPM3 or LPM4 | 3.0V            |                               |     | 0.02  |     |      |     | 0.3  | 1.2 | μA   |
| I <sub>IDLE,GroupC</sub> | Additional idle current if one or more modules from Group C (see Table 6-3) are activated in LPM3 or LPM4 | 3.0V            |                               |     | 0.02  |     |      |     | 0.38 | 1.5 | μA   |
| I <sub>IDLE,GroupD</sub> | Additional idle current if one or more modules from Group D (see Table 6-3) are activated in LPM3 or LPM4 | 3.0V            |                               |     | 0.015 |     |      |     | 0.25 | 1.0 | μA   |

- (11) Low-power mode 4 including SVS test conditions:  
Current for brownout and SVS included (SVSHE = 1).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPM4),  
 $f_{XT1}$  = 0 Hz,  $f_{ACLK}$  = 0 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.
- (12) Low-power mode 4 excluding SVS test conditions:  
Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPM4),  
 $f_{XT1}$  = 0 Hz,  $f_{ACLK}$  = 0 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.
- (13) Low-power mode 4 excluding SVS test conditions:  
Current for brownout included. SVS disabled (SVSHE = 0). RAM disabled (RCCTL0 = 5A55h).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPM4),  
 $f_{XT1}$  = 0 Hz,  $f_{ACLK}$  = 0 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current. See the idle currents specified for the respective peripheral groups.

## 5.8 Low-Power Mode With LCD Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                             |                                                                                                                                                 | V <sub>CC</sub> | TEMPERATURE (T <sub>A</sub> ) |     |              |     |      |     |              |     | UNIT |
|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------------------------------|-----|--------------|-----|------|-----|--------------|-----|------|
|                                       |                                                                                                                                                 |                 | −40°C                         |     | 25°C         |     | 60°C |     | 85°C         |     |      |
|                                       |                                                                                                                                                 |                 | TYP                           | MAX | TYP          | MAX | TYP  | MAX | TYP          | MAX |      |
| I <sub>LPM3,XT12</sub> LCD, ext. bias | Low-power mode 3 (LPM3) current,12-pF crystal, LCD 4-mux mode, external biasing, excludes SVS <sup>(1) (2)</sup>                                | 3.0 V           | 0.7                           |     | 0.9          |     | 1.5  |     | 3.1          |     | μA   |
| I <sub>LPM3,XT12</sub> LCD, int. bias | Low-power mode 3 (LPM3) current, 12-pF crystal, LCD 4-mux mode, internal biasing, charge pump disabled, excludes SVS <sup>(1) (3)</sup>         | 3.0 V           | 2.0                           |     | 2.2      2.9 |     | 2.8  |     | 4.4      9.3 |     | μA   |
| I <sub>LPM3,XT12</sub> LCD,CP         | Low-power mode 3 (LPM3) current,12-pF crystal, LCD 4-mux mode, internal biasing, charge pump enabled, 1/3 bias, excludes SVS <sup>(1) (4)</sup> | 2.2 V           | 5.0                           |     | 5.2          |     | 5.8  |     | 7.4          |     | μA   |
|                                       |                                                                                                                                                 | 3.0 V           | 4.5                           |     | 4.7          |     | 5.3  |     | 6.9          |     |      |

- Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0).  
CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 0 (LPM3),  
 $f_{XT1} = 32768$  Hz,  $f_{ACLK} = f_{XT1}$ ,  $f_{MCLK} = f_{SMCLK} = 0$  MHz  
Activating additional peripherals increases the current consumption due to active supply current contribution as well as due to additional idle current - idle current of Group containing LCD module already included. See the idle currents specified for the respective peripheral groups.
- LCDMx = 11 (4-mux mode), LCDREXT = 1, LCDEXTBIAS = 1 (external biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 0 (charge pump disabled), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Current through external resistors not included (voltage levels are supplied by test equipment).  
Even segments S0, S2, ... = 0, odd segments S1, S3, ... = 1. No LCD panel load.
- LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 0 (charge pump disabled), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Even segments S0, S2, ...=0, odd segments S1, S3, ... = 1. No LCD panel load.
- LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 1 (charge pump enabled), VLCDx = 1000 ( $V_{LCD} = 3$  V typical), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD} = 32768$  Hz / 32 / 4 = 256 Hz)  
Even segments S0, S2, ...=0, odd segments S1, S3, ... = 1. No LCD panel load.  $C_{LDCAP} = 10$   $\mu F$

## 5.9 Low-Power Mode LPMx.5 Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                                                                  | $V_{CC}$ | –40°C |     | 25°C |     | 60°C |     | 85°C |     | UNIT    |
|--------------------------------------------------------------------------------------------|----------|-------|-----|------|-----|------|-----|------|-----|---------|
|                                                                                            |          | TYP   | MAX | TYP  | MAX | TYP  | MAX | TYP  | MAX |         |
| $I_{LPM3.5,XT12}$ Low-power mode 3.5, 12-pF crystal including SVS <sup>(2) (3) (4)</sup>   | 2.2 V    | 0.4   |     | 0.45 |     | 0.55 |     | 0.75 |     | $\mu A$ |
|                                                                                            | 3.0 V    | 0.4   |     | 0.45 | 0.7 | 0.55 |     | 0.75 | 1.6 |         |
| $I_{LPM3.5,XT3.7}$ Low-power mode 3.5, 3.7-pF crystal excluding SVS <sup>(2) (5) (6)</sup> | 2.2 V    | 0.3   |     | 0.35 |     | 0.4  |     | 0.65 |     | $\mu A$ |
|                                                                                            | 3.0 V    | 0.3   |     | 0.35 |     | 0.4  |     | 0.65 |     |         |
| $I_{LPM4.5,SVS}$ Low-power mode 4.5, including SVS <sup>(7)</sup>                          | 2.2 V    | 0.2   |     | 0.2  |     | 0.25 |     | 0.35 |     | $\mu A$ |
|                                                                                            | 3.0 V    | 0.2   |     | 0.2  | 0.4 | 0.25 |     | 0.35 | 0.7 |         |
| $I_{LPM4.5}$ Low-power mode 4.5, excluding SVS <sup>(8)</sup>                              | 2.2 V    | 0.02  |     | 0.02 |     | 0.03 |     | 0.14 |     | $\mu A$ |
|                                                                                            | 3.0 V    | 0.02  |     | 0.02 |     | 0.03 |     | 0.13 | 0.5 |         |

- (1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.
- (2) Not applicable for devices with HF crystal oscillator only.
- (3) Characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5 pF load.
- (4) Low-power mode 3.5, 1-pF crystal including SVS test conditions:  
Current for RTC clocked by XT1 included. Current for brownout and SVS included (SVSHE = 1). Core regulator disabled.  
PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1}$  = 32768 Hz,  $f_{ACLK}$  =  $f_{XT1}$ ,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz
- (5) Characterized with a Seiko SSP-T7-FL (SMD) crystal with a load capacitance of 3.7 pF. The internal and external load capacitance are chosen to closely match the required 3.7-pF load.
- (6) Low-power mode 3.5, 3.7-pF crystal excluding SVS test conditions:  
Current for RTC clocked by XT1 included. Current for brownout included. SVS disabled (SVSHE = 0). Core regulator disabled.  
PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1}$  = 32768 Hz,  $f_{ACLK}$  =  $f_{XT1}$ ,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz
- (7) Low-power mode 4.5 including SVS test conditions:  
Current for brownout and SVS included (SVSHE = 1). Core regulator disabled.  
PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1}$  = 0 Hz,  $f_{ACLK}$  = 0 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz
- (8) Low-power mode 4.5 excluding SVS test conditions:  
Current for brownout included. SVS disabled (SVSHE = 0). Core regulator disabled.  
PMMREGOFF = 1, CPUOFF = 1, SCG0 = 1 SCG1 = 1, OSCOFF = 1 (LPMx.5),  
 $f_{XT1}$  = 0 Hz,  $f_{ACLK}$  = 0 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz

## 5.10 Typical Characteristics, Low-Power Mode Supply Currents

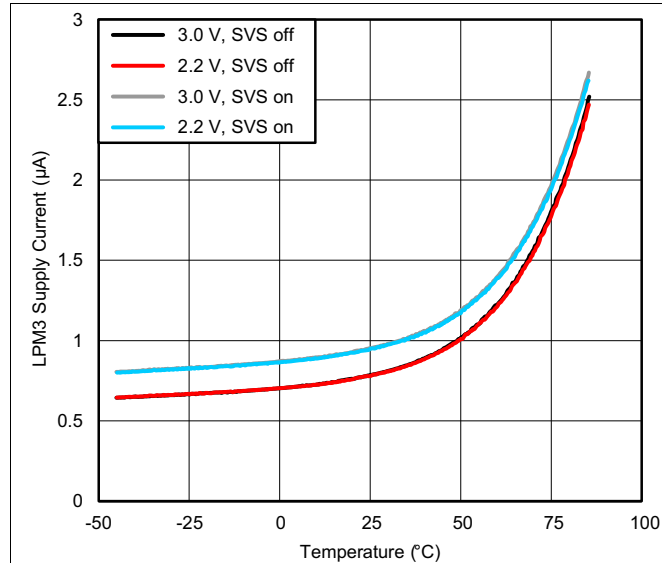


Figure 5-2. LPM3 Supply Current vs Temperature (LPM3, XT3.7)

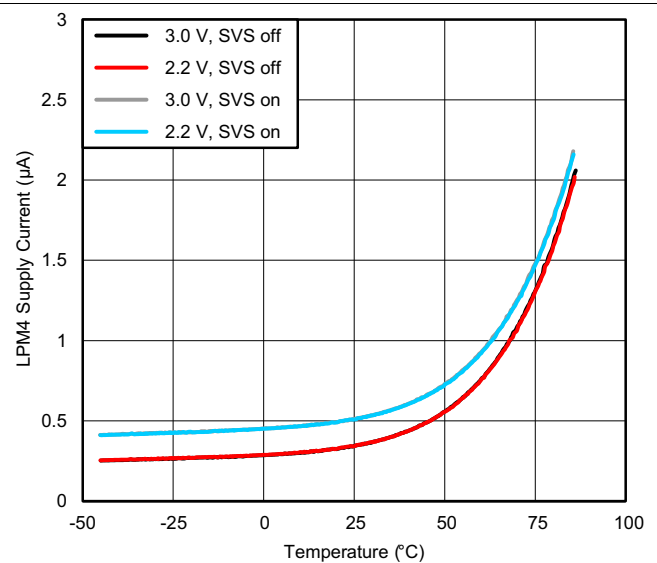


Figure 5-3. LPM4 Supply Current vs Temperature (LPM4, SVS)

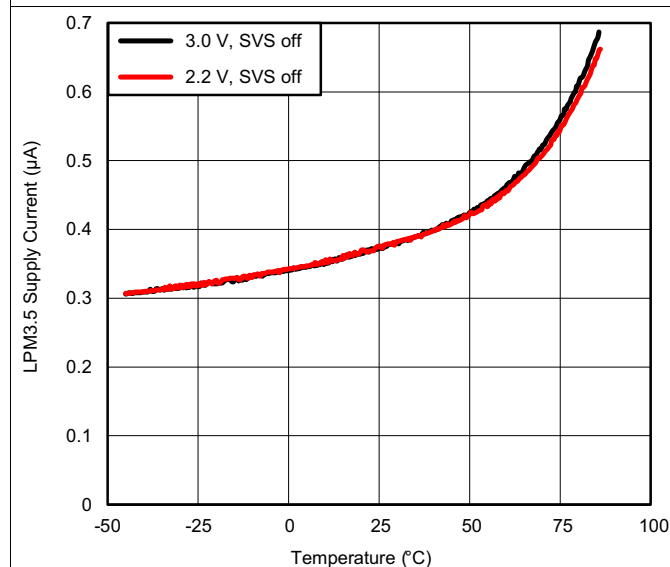


Figure 5-4. LPM3.5 Supply Current vs Temperature (LPM3.5, XT3.7)

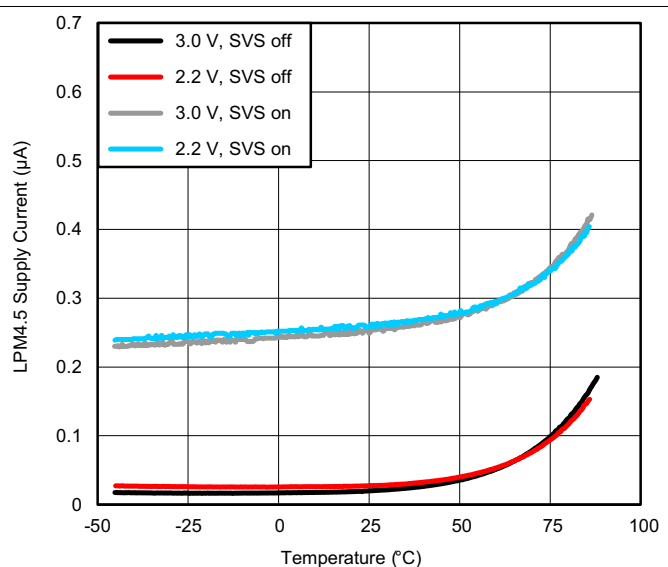


Figure 5-5. LPM4.5 Supply Current vs Temperature (LPM4.5)

## 5.11 Typical Characteristics, Current Consumption per Module<sup>(1)</sup>

| MODULE  | TEST CONDITIONS                     | REFERENCE CLOCK    | MIN | TYP | MAX | UNIT   |
|---------|-------------------------------------|--------------------|-----|-----|-----|--------|
| Timer_A |                                     | Module input clock |     | 3   |     | μA/MHz |
| Timer_B |                                     | Module input clock |     | 5   |     | μA/MHz |
| eUSCI_A | UART mode                           | Module input clock |     | 5.5 |     | μA/MHz |
| eUSCI_A | SPI mode                            | Module input clock |     | 3.5 |     | μA/MHz |
| eUSCI_B | SPI mode                            | Module input clock |     | 3.5 |     | μA/MHz |
| eUSCI_B | I <sup>2</sup> C mode, 100 kbaud    | Module input clock |     | 3.5 |     | μA/MHz |
| RTC_C   |                                     | 32 kHz             |     | 100 |     | nA     |
| MPY     | Only from start to end of operation | MCLK               |     | 25  |     | μA/MHz |
| CRC16   | Only from start to end of operation | MCLK               |     | 2.5 |     | μA/MHz |
| CRC32   | Only from start to end of operation | MCLK               |     | 2.5 |     | μA/MHz |

(1) LCD\_C: See [Section 5.8](#). For other module currents not listed here, see the module-specific parameter sections.

## 5.12 Thermal Resistance Characteristics

| THERMAL METRIC <sup>(1)</sup> |                                                                  | PACKAGE       | VALUE <sup>(2)</sup> | UNIT |
|-------------------------------|------------------------------------------------------------------|---------------|----------------------|------|
| $\theta_{JA}$                 | Junction-to-ambient thermal resistance, still air <sup>(3)</sup> | LQFP-100 (PZ) | 49.8                 | °C/W |
| $\theta_{JC(TOP)}$            | Junction-to-case (top) thermal resistance <sup>(4)</sup>         |               | 9.7                  | °C/W |
| $\theta_{JB}$                 | Junction-to-board thermal resistance <sup>(5)</sup>              |               | 26.0                 | °C/W |
| $\Psi_{JB}$                   | Junction-to-board thermal characterization parameter             |               | 25.7                 | °C/W |
| $\Psi_{JT}$                   | Junction-to-top thermal characterization parameter               |               | 0.2                  | °C/W |
| $\theta_{JC(BOTTOM)}$         | Junction-to-case (bottom) thermal resistance <sup>(6)</sup>      |               | N/A                  | °C/W |
| $\theta_{JA}$                 | Junction-to-ambient thermal resistance, still air <sup>(3)</sup> | LQFP-80 (PN)  | 49.5                 | °C/W |
| $\theta_{JC(TOP)}$            | Junction-to-case (top) thermal resistance <sup>(4)</sup>         |               | 14.7                 | °C/W |
| $\theta_{JB}$                 | Junction-to-board thermal resistance <sup>(5)</sup>              |               | 24.1                 | °C/W |
| $\Psi_{JB}$                   | Junction-to-board thermal characterization parameter             |               | 23.8                 | °C/W |
| $\Psi_{JT}$                   | Junction-to-top thermal characterization parameter               |               | 0.7                  | °C/W |
| $\theta_{JC(BOTTOM)}$         | Junction-to-case (bottom) thermal resistance <sup>(6)</sup>      |               | N/A                  | °C/W |
| $\theta_{JA}$                 | Junction-to-ambient thermal resistance, still air <sup>(3)</sup> | LQFP-64 (PM)  | 55.3                 | °C/W |
| $\theta_{JC(TOP)}$            | Junction-to-case (top) thermal resistance <sup>(4)</sup>         |               | 16.8                 | °C/W |
| $\theta_{JB}$                 | Junction-to-board thermal resistance <sup>(5)</sup>              |               | 26.8                 | °C/W |
| $\Psi_{JB}$                   | Junction-to-board thermal characterization parameter             |               | 26.5                 | °C/W |
| $\Psi_{JT}$                   | Junction-to-top thermal characterization parameter               |               | 0.8                  | °C/W |
| $\theta_{JC(BOTTOM)}$         | Junction-to-case (bottom) thermal resistance <sup>(6)</sup>      |               | N/A                  | °C/W |
| $\theta_{JA}$                 | Junction-to-ambient thermal resistance, still air <sup>(3)</sup> | VQFN-64 (RGC) | 29.2                 | °C/W |
| $\theta_{JC(TOP)}$            | Junction-to-case (top) thermal resistance <sup>(4)</sup>         |               | 13.9                 | °C/W |
| $\theta_{JB}$                 | Junction-to-board thermal resistance <sup>(5)</sup>              |               | 8.1                  | °C/W |
| $\Psi_{JB}$                   | Junction-to-board thermal characterization parameter             |               | 8.0                  | °C/W |
| $\Psi_{JT}$                   | Junction-to-top thermal characterization parameter               |               | 0.2                  | °C/W |
| $\theta_{JC(BOTTOM)}$         | Junction-to-case (bottom) thermal resistance <sup>(6)</sup>      |               | 1.0                  | °C/W |

- (1) For more information about traditional and new thermal metrics, see [Semiconductor and IC Package Thermal Metrics](#).
- (2) N/A = not applicable
- (3) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, High-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (4) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.
- (5) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.
- (6) The junction-to-case (bottom) thermal resistance is obtained by simulating a cold plate test on the exposed (power) pad. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

## 5.13 Timing and Switching Characteristics

### 5.13.1 Power Supply Sequencing

TI recommends powering the AVCC, DVCC, and ESIDVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference between AVCC, DVCC, and ESIDVCC must not exceed the limits specified in [Absolute Maximum Ratings](#). Exceeding the specified limits may cause malfunction of the device including erroneous writes to RAM and FRAM.

At power up, the device does not start executing code before the supply voltage reached  $V_{SVSH+}$  if the supply rises monotonically to this level.

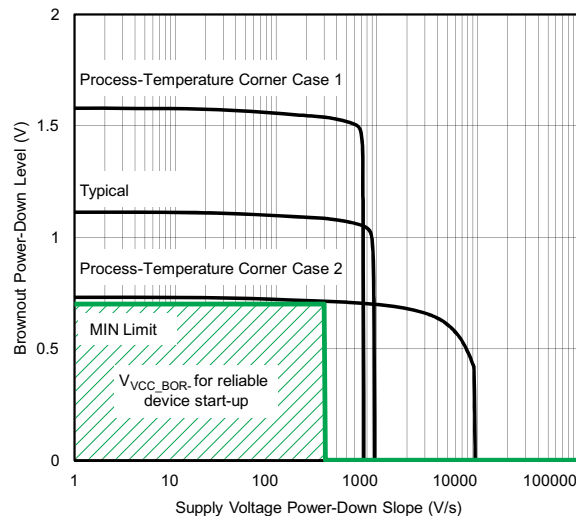
Table 5-1 lists the power ramp requirements.

**Table 5-1. Brownout and Device Reset Power Ramp Requirements**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                   | TEST CONDITIONS                        | MIN  | MAX  | UNIT |
|-------------------------------------------------------------|----------------------------------------|------|------|------|
| $V_{VCC\_BOR-}$ Brownout power-down level <sup>(1)(2)</sup> | $ dV_{CC}/dt  < 3 \text{ V/s}^{(3)}$   | 0.7  | 1.66 | V    |
|                                                             | $ dV_{CC}/dt  > 300 \text{ V/s}^{(3)}$ | 0    |      |      |
| $V_{VCC\_BOR+}$ Brownout power-up level <sup>(2)</sup>      | $ dV_{CC}/dt  < 3 \text{ V/s}^{(4)}$   | 0.79 | 1.68 | V    |

- (1) In case of a supply voltage brownout, the device supply voltages must ramp down to the specified brownout power-down level ( $V_{VCC\_BOR-}$ ) before the voltage is ramped up again to ensure a reliable device start-up and performance according to the data sheet including the correct operation of the on-chip SVS module.
- (2) Fast supply voltage changes can trigger a BOR reset even within the recommended supply voltage range. To avoid unwanted BOR resets, the supply voltage must change by less than 0.05 V per microsecond ( $\pm 0.05 \text{ V}/\mu\text{s}$ ). Following the data sheet recommendation for capacitor  $C_{DVCC}$  should limit the slopes accordingly.
- (3) The brownout levels are measured with a slowly changing supply. With faster slopes, the MIN level required to reset the device properly can decrease to 0 V. Use the graph in [Figure 5-6](#) to estimate the  $V_{VCC\_BOR-}$  level based on the down slope of the supply voltage. After removing  $V_{CC}$ , the down slope can be estimated based on the current consumption and the capacitance on DVCC:  $dV/dt = I/C$  where  $dV/dt = \text{slope}$ ,  $I = \text{current}$ ,  $C = \text{capacitance}$ .
- (4) The brownout levels are measured with a slowly changing supply.



**Figure 5-6. Brownout Power-Down Level vs Supply Voltage Down Slope**

Table 5-2 lists the characteristics of the SVS.

**Table 5-2. SVS**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER         |                                                       | TEST CONDITIONS                            | MIN  | TYP  | MAX  | UNIT          |
|-------------------|-------------------------------------------------------|--------------------------------------------|------|------|------|---------------|
| $I_{SVSH,LPM}$    | SVS <sub>H</sub> current consumption, low-power modes |                                            |      | 170  | 300  | nA            |
| $V_{SVSH-}$       | SVS <sub>H</sub> power-down level <sup>(1)</sup>      |                                            | 1.75 | 1.80 | 1.85 | V             |
| $V_{SVSH+}$       | SVS <sub>H</sub> power-up level <sup>(1)</sup>        |                                            | 1.77 | 1.88 | 1.99 | V             |
| $V_{SVSH\_hys}$   | SVS <sub>H</sub> hysteresis                           |                                            | 40   |      | 120  | mV            |
| $t_{PD,SVSH, AM}$ | SVS <sub>H</sub> propagation delay, active mode       | $dV_{VCC}/dt = -10 \text{ mV}/\mu\text{s}$ |      |      | 10   | $\mu\text{s}$ |

(1) For additional information, see the [Dynamic Voltage Scaling Power Solution for MSP430 Devices With Single-Channel LDO Reference Design](#).

### 5.13.2 Reset Timing

Table 5-11 lists the input requirements for the  $\overline{\text{RST}}$  signal.

**Table 5-3. Reset Input**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER   |                                                                         | $V_{CC}$     | MIN | MAX | UNIT          |
|-------------|-------------------------------------------------------------------------|--------------|-----|-----|---------------|
| $t_{(RST)}$ | External reset pulse duration on $\overline{\text{RST}}$ <sup>(1)</sup> | 2.2 V, 3.0 V | 2   |     | $\mu\text{s}$ |

(1) Not applicable if  $\overline{\text{RST}}$ /NMI pin configured as NMI.

### 5.13.3 Clock Specifications

Table 5-4 lists the characteristics of the LFXT.

**Table 5-4. Low-Frequency Crystal Oscillator, LFXT<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                   | TEST CONDITIONS                                                                                                                      | V <sub>CC</sub> | MIN   | TYP    | MAX | UNIT |
|------------------------|-------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|--------|-----|------|
| I <sub>VCC,LFXT</sub>  | Current consumption                                               | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {0},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 3.7 pF, ESR ≈ 44 kΩ  | 3.0 V           | 180   |        |     | nA   |
|                        |                                                                   | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {1},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 6 pF, ESR ≈ 40 kΩ    |                 | 185   |        |     |      |
|                        |                                                                   | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {2},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 9 pF, ESR ≈ 40 kΩ    |                 | 225   |        |     |      |
|                        |                                                                   | f <sub>OSC</sub> = 32768 Hz,<br>LFXTBYPASS = 0, LFXTDRIVE = {3},<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12.5 pF, ESR ≈ 40 kΩ |                 | 330   |        |     |      |
| f <sub>LFXT</sub>      | LFXT oscillator crystal frequency                                 | LFXTBYPASS = 0                                                                                                                       |                 | 32768 |        |     | Hz   |
| DC <sub>LFXT</sub>     | LFXT oscillator duty cycle                                        | Measured at ACLK,<br>f <sub>LFXT</sub> = 32768 Hz                                                                                    |                 | 30%   |        | 70% |      |
| f <sub>LFXT,SW</sub>   | LFXT oscillator logic-level square-wave input frequency           | LFXTBYPASS = 1 <sup>(2) (3)</sup>                                                                                                    |                 | 10.5  | 32.768 | 50  | kHz  |
| DC <sub>LFXT, SW</sub> | LFXT oscillator logic-level square-wave input duty cycle          | LFXTBYPASS = 1                                                                                                                       |                 | 30%   |        | 70% |      |
| OA <sub>LFXT</sub>     | Oscillation allowance for LF crystals <sup>(4)</sup>              | LFXTBYPASS = 0, LFXTDRIVE = {1},<br>f <sub>LFXT</sub> = 32768 Hz, C <sub>L,eff</sub> = 6 pF                                          |                 | 210   |        |     | kΩ   |
|                        |                                                                   | LFXTBYPASS = 0, LFXTDRIVE = {3},<br>f <sub>LFXT</sub> = 32768 Hz, C <sub>L,eff</sub> = 12.5 pF                                       |                 | 300   |        |     |      |
| C <sub>LFXIN</sub>     | Integrated load capacitance at LFXIN terminal <sup>(5) (6)</sup>  |                                                                                                                                      |                 | 2     |        |     | pF   |
| C <sub>LFXOUT</sub>    | Integrated load capacitance at LFXOUT terminal <sup>(5) (6)</sup> |                                                                                                                                      |                 | 2     |        |     | pF   |

- (1) To improve EMI on the LFXT oscillator, observe the following guidelines.
  - Keep the trace between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins LFXIN and LFXOUT.
  - Avoid running PCB traces underneath or adjacent to the LFXIN and LFXOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator LFXIN and LFXOUT pins.
  - If conformal coating is used, ensure that it does not induce capacitive or resistive leakage between the oscillator pins.
- (2) When LFXTBYPASS is set, LFXT circuits are automatically powered down. Input signal is a digital square wave with parametrics defined in the Schmitt-trigger Inputs section of this data sheet. Duty cycle requirements are defined by DC<sub>LFXT, SW</sub>.
- (3) Maximum frequency of operation of the entire device cannot be exceeded.
- (4) Oscillation allowance is based on a safety factor of 5 for recommended crystals. The oscillation allowance is a function of the LFXTDRIVE settings and the effective load. In general, comparable oscillator allowance can be achieved based on the following guidelines, but should be evaluated based on the actual crystal selected for the application:
  - For LFXTDRIVE = {0}, C<sub>L,eff</sub> = 3.7 pF.
  - For LFXTDRIVE = {1}, C<sub>L,eff</sub> = 6 pF
  - For LFXTDRIVE = {2}, 6 pF ≤ C<sub>L,eff</sub> ≤ 9 pF
  - For LFXTDRIVE = {3}, 9 pF ≤ C<sub>L,eff</sub> ≤ 12.5 pF
- (5) This represents all the parasitic capacitance present at the LFXIN and LFXOUT terminals, respectively, including parasitic bond and package capacitance. The effective load capacitance, C<sub>L,eff</sub> can be computed as C<sub>IN</sub> × C<sub>OUT</sub> / (C<sub>IN</sub> + C<sub>OUT</sub>), where C<sub>IN</sub> and C<sub>OUT</sub> are the total capacitance at the LFXIN and LFXOUT terminals, respectively.
- (6) Requires external capacitors at both terminals to meet the effective load capacitance specified by crystal manufacturers. Recommended effective load capacitance values supported are 3.7 pF, 6 pF, 9 pF, and 12.5 pF. Maximum shunt capacitance of 1.6 pF. The PCB adds additional capacitance, so it must also be considered in the overall capacitance. Verify that the recommended effective load capacitance of the selected crystal is met.

**Table 5-4. Low-Frequency Crystal Oscillator, LFXT<sup>(1)</sup> (continued)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                             | TEST CONDITIONS                                                                                                                              | V <sub>CC</sub> | MIN | TYP  | MAX  | UNIT |
|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|------|------|
| $t_{\text{START,LFXT}}$ Start-up time <sup>(7)</sup>                  | $f_{\text{OSC}} = 32768 \text{ Hz}$ ,<br>LFXTBYPASS = 0, LFXTDRIVE = {0},<br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 3.7 \text{ pF}$  | 3.0 V           |     | 800  |      | ms   |
|                                                                       | $f_{\text{OSC}} = 32768 \text{ Hz}$ ,<br>LFXTBYPASS = 0, LFXTDRIVE = {3},<br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 12.5 \text{ pF}$ | 3.0 V           |     | 1000 |      |      |
| $f_{\text{Fault,LFXT}}$ Oscillator fault frequency <sup>(8) (9)</sup> |                                                                                                                                              |                 | 0   |      | 3500 | Hz   |

(7) Includes start-up counter of 1024 clock cycles.

(8) Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX specification may set the flag. A static condition or stuck at fault condition sets the flag.

(9) Measured with logic-level input frequency but also applies to operation with crystals.

Table 5-5 lists the characteristics of the HFXT.

**Table 5-5. High-Frequency Crystal Oscillator, HFXT<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                 | TEST CONDITIONS                                                                                                                                                                                   | V <sub>CC</sub> | MIN   | TYP | MAX | UNIT          |
|-------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|-----|-----|---------------|
| $I_{\text{DVCC,HFXT}}$ HFXT oscillator crystal current HF mode at typical ESR             | $f_{\text{OSC}} = 4 \text{ MHz}$ ,<br>HFXTBYPASS = 0, HFXTDRIVE = 0, HFFREQ = 1 <sup>(2)</sup><br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 18 \text{ pF}$ , Typical ESR, $C_{\text{shunt}}$ | 3.0 V           |       | 75  |     | $\mu\text{A}$ |
|                                                                                           | $f_{\text{OSC}} = 8 \text{ MHz}$ ,<br>HFXTBYPASS = 0, HFXTDRIVE = 1, HFFREQ = 1,<br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 18 \text{ pF}$ , Typical ESR, $C_{\text{shunt}}$               |                 |       | 120 |     |               |
|                                                                                           | $f_{\text{OSC}} = 16 \text{ MHz}$ ,<br>HFXTBYPASS = 0, HFXTDRIVE = 2, HFFREQ = 2,<br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 18 \text{ pF}$ , Typical ESR, $C_{\text{shunt}}$              |                 |       | 190 |     |               |
|                                                                                           | $f_{\text{OSC}} = 24 \text{ MHz}$ ,<br>HFXTBYPASS = 0, HFXTDRIVE = 3, HFFREQ = 3,<br>$T_A = 25^\circ\text{C}$ , $C_{L,\text{eff}} = 18 \text{ pF}$ , Typical ESR, $C_{\text{shunt}}$              |                 |       | 250 |     |               |
| $f_{\text{HFXT}}$ HFXT oscillator crystal frequency, crystal mode                         | HFXTBYPASS = 0, HFFREQ = 1 <sup>(2)(3)</sup>                                                                                                                                                      |                 | 4     |     | 8   | MHz           |
|                                                                                           | HFXTBYPASS = 0, HFFREQ = 2 <sup>(3)</sup>                                                                                                                                                         |                 | 8.01  |     | 16  |               |
|                                                                                           | HFXTBYPASS = 0, HFFREQ = 3 <sup>(3)</sup>                                                                                                                                                         |                 | 16.01 |     | 24  |               |
| $\text{DC}_{\text{HFXT}}$ HFXT oscillator duty cycle                                      | Measured at SMCLK, $f_{\text{HFXT}} = 16 \text{ MHz}$                                                                                                                                             |                 | 40%   | 50% | 60% |               |
| $f_{\text{HFXT,SW}}$ HFXT oscillator logic-level square-wave input frequency, bypass mode | HFXTBYPASS = 1, HFFREQ = 0 <sup>(4)(3)</sup>                                                                                                                                                      |                 | 0.9   |     | 4   | MHz           |
|                                                                                           | HFXTBYPASS = 1, HFFREQ = 1 <sup>(4)(3)</sup>                                                                                                                                                      |                 | 4.01  |     | 8   |               |
|                                                                                           | HFXTBYPASS = 1, HFFREQ = 2 <sup>(4)(3)</sup>                                                                                                                                                      |                 | 8.01  |     | 16  |               |
|                                                                                           | HFXTBYPASS = 1, HFFREQ = 3 <sup>(4)(3)</sup>                                                                                                                                                      |                 | 16.01 |     | 24  |               |
| $\text{DC}_{\text{HFXT, SW}}$ HFXT oscillator logic-level square-wave input duty cycle    | HFXTBYPASS = 1                                                                                                                                                                                    |                 | 40%   |     | 60% |               |

(1) To improve EMI on the HFXT oscillator, observe the following guidelines.

- Keep the traces between the device and the crystal as short as possible.
- Design a good ground plane around the oscillator pins.
- Prevent crosstalk from other clock or data lines into oscillator pins HFXIN and HFXOUT.
- Avoid running PCB traces underneath or adjacent to the HFXIN and HFXOUT pins.
- Use assembly materials and processes that avoid any parasitic load on the oscillator HFXIN and HFXOUT pins.
- If conformal coating is used, ensure that it does not induce capacitive or resistive leakage between the oscillator pins.

(2) HFFREQ = {0} is not supported for HFXT crystal mode of operation.

(3) Maximum frequency of operation of the entire device cannot be exceeded.

(4) When HFXTBYPASS is set, HFXT circuits are automatically powered down. Input signal is a digital square wave with parametrics defined in the Schmitt-trigger Inputs section of this data sheet. Duty cycle requirements are defined by  $\text{DC}_{\text{HFXT, SW}}$ .

**Table 5-5. High-Frequency Crystal Oscillator, HFXT<sup>(1)</sup> (continued)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                              | TEST CONDITIONS                                                                                                               | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|----------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>START,HFXT</sub> Start-up time <sup>(5)</sup>                                   | f <sub>OSC</sub> = 4 MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 0, HFFREQ = 1,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 16 pF  | 3.0 V           |     | 1.6 |     | ms   |
|                                                                                        | f <sub>OSC</sub> = 24 MHz,<br>HFXTBYPASS = 0, HFXTDRIVE = 3, HFFREQ = 3,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 16 pF | 3.0 V           |     | 0.6 |     |      |
| C <sub>HFXIN</sub> Integrated load capacitance at HFXIN terminal <sup>(6)</sup><br>(7) |                                                                                                                               |                 |     | 2   |     | pF   |
| C <sub>HFXOUT</sub> Integrated load capacitance at HFXOUT terminal <sup>(6)</sup> (7)  |                                                                                                                               |                 |     | 2   |     | pF   |
| f <sub>Fault,HFXT</sub> Oscillator fault frequency <sup>(8)</sup> (9)                  |                                                                                                                               |                 | 0   |     | 800 | kHz  |

(5) Includes start-up counter of 1024 clock cycles.

(6) This represents all the parasitic capacitance present at the HFXIN and HFXOUT terminals, respectively, including parasitic bond and package capacitance. The effective load capacitance, C<sub>L,eff</sub> can be computed as C<sub>IN</sub> × C<sub>OUT</sub> / (C<sub>IN</sub> + C<sub>OUT</sub>), where C<sub>IN</sub> and C<sub>OUT</sub> are the total capacitance at the HFXIN and HFXOUT terminals, respectively.

(7) Requires external capacitors at both terminals to meet the effective load capacitance specified by crystal manufacturers. Recommended effective load capacitance values supported are 14 pF, 16 pF, and 18 pF. Maximum shunt capacitance of 7 pF. The PCB adds additional capacitance, so it must also be considered in the overall capacitance. Verify that the recommended effective load capacitance of the selected crystal is met.

(8) Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX might set the flag. A static condition or stuck at fault condition set the flag.

(9) Measured with logic-level input frequency but also applies to operation with crystals.

Table 5-6 lists the characteristics of the DCO.

**Table 5-6. DCO**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                         | TEST CONDITIONS                                                                                                                                                                        | V <sub>CC</sub> | MIN | TYP   | MAX                  | UNIT |
|--------------------------|-----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-------|----------------------|------|
| f <sub>DCO1</sub>        | DCO frequency range<br>1 MHz, trimmed   | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 0,<br>DCORSEL = 1, DCOFSEL = 0                                                                                               |                 |     | 1     | ±3.5%                | MHz  |
| f <sub>DCO2.7</sub>      | DCO frequency range<br>2.7 MHz, trimmed | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 1                                                                                                                            |                 |     | 2.667 | ±3.5%                | MHz  |
| f <sub>DCO3.5</sub>      | DCO frequency range<br>3.5 MHz, trimmed | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 2                                                                                                                            |                 |     | 3.5   | ±3.5%                | MHz  |
| f <sub>DCO4</sub>        | DCO frequency range<br>4 MHz, trimmed   | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 3                                                                                                                            |                 |     | 4     | ±3.5%                | MHz  |
| f <sub>DCO5.3</sub>      | DCO frequency range<br>5.3 MHz, trimmed | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 4,<br>DCORSEL = 1, DCOFSEL = 1                                                                                               |                 |     | 5.333 | ±3.5%                | MHz  |
| f <sub>DCO7</sub>        | DCO frequency range<br>7 MHz, trimmed   | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 5,<br>DCORSEL = 1, DCOFSEL = 2                                                                                               |                 |     | 7     | ±3.5%                | MHz  |
| f <sub>DCO8</sub>        | DCO frequency range<br>8 MHz, trimmed   | Measured at SMCLK, divide by 1,<br>DCORSEL = 0, DCOFSEL = 6,<br>DCORSEL = 1, DCOFSEL = 3                                                                                               |                 |     | 8     | ±3.5%                | MHz  |
| f <sub>DCO16</sub>       | DCO frequency range<br>16 MHz, trimmed  | Measured at SMCLK, divide by 1,<br>DCORSEL = 1, DCOFSEL = 4                                                                                                                            |                 |     | 16    | ±3.5% <sup>(1)</sup> | MHz  |
| f <sub>DCO21</sub>       | DCO frequency range<br>21 MHz, trimmed  | Measured at SMCLK, divide by 2,<br>DCORSEL = 1, DCOFSEL = 5                                                                                                                            |                 |     | 21    | ±3.5% <sup>(1)</sup> | MHz  |
| f <sub>DCO24</sub>       | DCO frequency range<br>24 MHz, trimmed  | Measured at SMCLK, divide by 2,<br>DCORSEL = 1, DCOFSEL = 6                                                                                                                            |                 |     | 24    | ±3.5% <sup>(1)</sup> | MHz  |
| f <sub>DCO,DC</sub>      | Duty cycle                              | Measured at SMCLK, divide by 1,<br>no external divide, all<br>DCORSEL/DCOFSEL settings except<br>DCORSEL = 1, DCOFSEL = 5 and<br>DCORSEL = 1, DCOFSEL = 6                              |                 | 48% | 50%   | 52%                  |      |
| t <sub>DCO, JITTER</sub> | DCO jitter                              | Based on f <sub>signal</sub> = 10 kHz and DCO used<br>for 12-bit SAR ADC sampling source.<br>This achieves >74 dB SNR due to jitter<br>(that is, it is limited by ADC<br>performance). |                 |     | 2     | 3                    | ns   |
| df <sub>DCO</sub> /dT    | DCO temperature drift <sup>(2)</sup>    |                                                                                                                                                                                        | 3.0 V           |     | 0.01  |                      | %/°C |

(1) After a wakeup from LPM1, LPM2, LPM3, or LPM4, the DCO frequency f<sub>DCO</sub> might exceed the specified frequency range for a few clock cycles by up to 5% before settling into the specified steady-state frequency range.

(2) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C))

Table 5-7 lists the characteristics of the VLO.

**Table 5-7. Internal Very-Low-Power Low-Frequency Oscillator (VLO)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                             | TEST CONDITIONS                 | MIN | TYP | MAX | UNIT |
|-------------------------------------------------------|---------------------------------|-----|-----|-----|------|
| $I_{VLO}$ Current consumption                         |                                 |     | 100 |     | nA   |
| $f_{VLO}$ VLO frequency                               | Measured at ACLK                | 6   | 9.4 | 14  | kHz  |
| $df_{VLO}/dT$ VLO frequency temperature drift         | Measured at ACLK <sup>(1)</sup> |     | 0.2 |     | %/°C |
| $df_{VLO}/dV_{CC}$ VLO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> |     | 0.7 |     | %/V  |
| $f_{VLO,DC}$ Duty cycle                               | Measured at ACLK                | 40% | 50% | 60% |      |

(1) Calculated using the box method:  $(MAX(-40^{\circ}C \text{ to } 85^{\circ}C) - MIN(-40^{\circ}C \text{ to } 85^{\circ}C)) / MIN(-40^{\circ}C \text{ to } 85^{\circ}C) / (85^{\circ}C - (-40^{\circ}C))$

(2) Calculated using the box method:  $(MAX(1.8 \text{ V to } 3.6 \text{ V}) - MIN(1.8 \text{ V to } 3.6 \text{ V})) / MIN(1.8 \text{ V to } 3.6 \text{ V}) / (3.6 \text{ V} - 1.8 \text{ V})$

Table 5-8 lists the characteristics of the MODOSC.

**Table 5-8. Module Oscillator (MODOSC)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                 | TEST CONDITIONS                | MIN | TYP  | MAX | UNIT |
|---------------------------------------------------------------------------|--------------------------------|-----|------|-----|------|
| $I_{MODOSC}$ Current consumption                                          | Enabled                        |     | 25   |     | μA   |
| $f_{MODOSC}$ MODOSC frequency                                             |                                | 4.0 | 4.8  | 5.4 | MHz  |
| $f_{MODOSC}/dT$ MODOSC frequency temperature drift <sup>(1)</sup>         |                                |     | 0.08 |     | %/°C |
| $f_{MODOSC}/dV_{CC}$ MODOSC frequency supply voltage drift <sup>(2)</sup> |                                |     | 1.4  |     | %/V  |
| $DC_{MODOSC}$ Duty cycle                                                  | Measured at SMCLK, divide by 1 | 40% | 50%  | 60% |      |

(1) Calculated using the box method:  $(MAX(-40^{\circ}C \text{ to } 85^{\circ}C) - MIN(-40^{\circ}C \text{ to } 85^{\circ}C)) / MIN(-40^{\circ}C \text{ to } 85^{\circ}C) / (85^{\circ}C - (-40^{\circ}C))$

(2) Calculated using the box method:  $(MAX(1.8 \text{ V to } 3.6 \text{ V}) - MIN(1.8 \text{ V to } 3.6 \text{ V})) / MIN(1.8 \text{ V to } 3.6 \text{ V}) / (3.6 \text{ V} - 1.8 \text{ V})$

### 5.13.4 Wake-up Characteristics

Table 5-9 lists the wake-up times.

**Table 5-9. Wake-up Times From Low-Power Modes and Reset**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                                                                                                                  | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP                             | MAX | UNIT |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----------------|-----|---------------------------------|-----|------|
| t <sub>WAKE-UP FRAM</sub> (Additional) wake-up time to activate the FRAM in AM if previously disabled by the FRAM controller or from an LPM if immediate activation is selected for wakeup |                 |                 |     | 6                               | 10  | μs   |
| t <sub>WAKE-UP LPM0</sub> Wake-up time from LPM0 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 400 +<br>1.5 / f <sub>DCO</sub> |     | ns   |
| t <sub>WAKE-UP LPM1</sub> Wake-up time from LPM1 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6                               |     | μs   |
| t <sub>WAKE-UP LPM2</sub> Wake-up time from LPM2 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 6                               |     | μs   |
| t <sub>WAKE-UP LPM3</sub> Wake-up time from LPM3 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 7                               | 10  | μs   |
| t <sub>WAKE-UP LPM4</sub> Wake-up time from LPM4 to active mode <sup>(1)</sup>                                                                                                             |                 | 2.2 V, 3.0 V    |     | 7                               | 10  | μs   |
| t <sub>WAKE-UP LPM3.5</sub> Wake-up time from LPM3.5 to active mode <sup>(2)</sup>                                                                                                         |                 | 2.2 V, 3.0 V    |     | 250                             | 375 | μs   |
| t <sub>WAKE-UP LPM4.5</sub> Wake-up time from LPM4.5 to active mode <sup>(2)</sup>                                                                                                         | SVSHE = 1       | 2.2 V, 3.0 V    |     | 250                             | 375 | μs   |
|                                                                                                                                                                                            | SVSHE = 0       | 2.2 V, 3.0 V    |     | 1                               | 1.5 | ms   |
| t <sub>WAKE-UP-RST</sub> Wake-up time from a $\overline{\text{RST}}$ pin triggered reset to active mode <sup>(2)</sup>                                                                     |                 | 2.2 V, 3.0 V    |     | 250                             | 375 | μs   |
| t <sub>WAKE-UP-BOR</sub> Wake-up time from power-up to active mode <sup>(2)</sup>                                                                                                          |                 | 2.2 V, 3.0 V    |     | 1                               | 1.5 | ms   |

- (1) The wake-up time is measured from the edge of an external wake-up signal (for example, port interrupt or wake-up event) to the first externally observable MCLK clock edge. MCLK is sourced by the DCO and the MCLK divider is set to divide-by-1 (DIVMx = 000b, f<sub>MCLK</sub> = f<sub>DCO</sub>). This time includes the activation of the FRAM during wakeup.
- (2) The wake-up time is measured from the edge of an external wake-up signal (for example, port interrupt or wake-up event) until the first instruction of the user program is executed.

Table 5-10 lists the typical charge consumed during wakeup from various low-power modes.

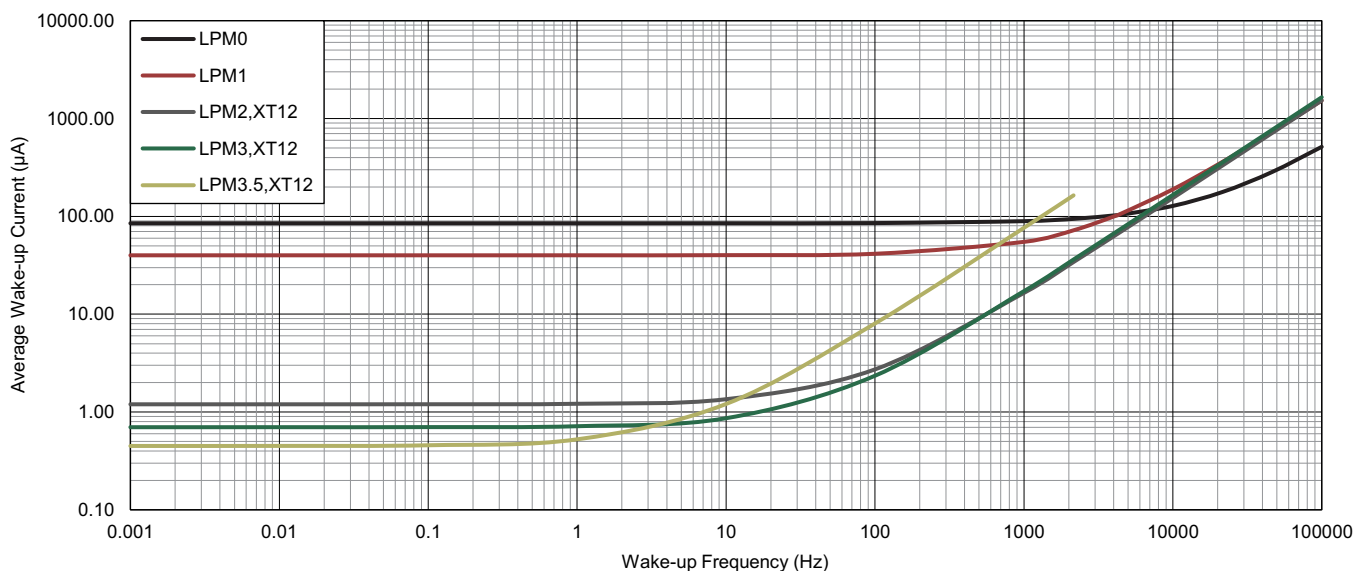
**Table 5-10. Typical Wake-up Charge<sup>(1)</sup>**

also see Figure 5-7 and Figure 5-8

| PARAMETER                                                                                                                                      | TEST CONDITIONS | MIN | TYP  | MAX | UNIT |
|------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|-----|------|
| Q <sub>WAKE-UP FRAM</sub> Charge used for activating the FRAM in AM or during wake-up from LPM0 if previously disabled by the FRAM controller. |                 |     | 15.1 |     | nAs  |
| Q <sub>WAKE-UP LPM0</sub> Charge used for wake-up from LPM0 to active mode (with FRAM active)                                                  |                 |     | 4.4  |     | nAs  |
| Q <sub>WAKE-UP LPM1</sub> Charge used for wake-up from LPM1 to active mode (with FRAM active)                                                  |                 |     | 15.1 |     | nAs  |
| Q <sub>WAKE-UP LPM2</sub> Charge used for wake-up from LPM2 to active mode (with FRAM active)                                                  |                 |     | 15.3 |     | nAs  |
| Q <sub>WAKE-UP LPM3</sub> Charge used for wake-up from LPM3 to active mode (with FRAM active)                                                  |                 |     | 16.5 |     | nAs  |
| Q <sub>WAKE-UP LPM4</sub> Charge used for wake-up from LPM4 to active mode (with FRAM active)                                                  |                 |     | 16.5 |     | nAs  |
| Q <sub>WAKE-UP LPM3.5</sub> Charge used for wake-up from LPM3.5 to active mode <sup>(2)</sup>                                                  |                 |     | 76   |     | nAs  |
| Q <sub>WAKE-UP LPM4.5</sub> Charge used for wake-up from LPM4.5 to active mode <sup>(2)</sup>                                                  | SVSHE = 1       |     | 77   |     | nAs  |
|                                                                                                                                                | SVSHE = 0       |     | 77.5 |     |      |
| Q <sub>WAKE-UP-RESET</sub> Charge used for reset from $\overline{\text{RST}}$ or BOR event to active mode <sup>(2)</sup>                       |                 |     | 75   |     | nAs  |

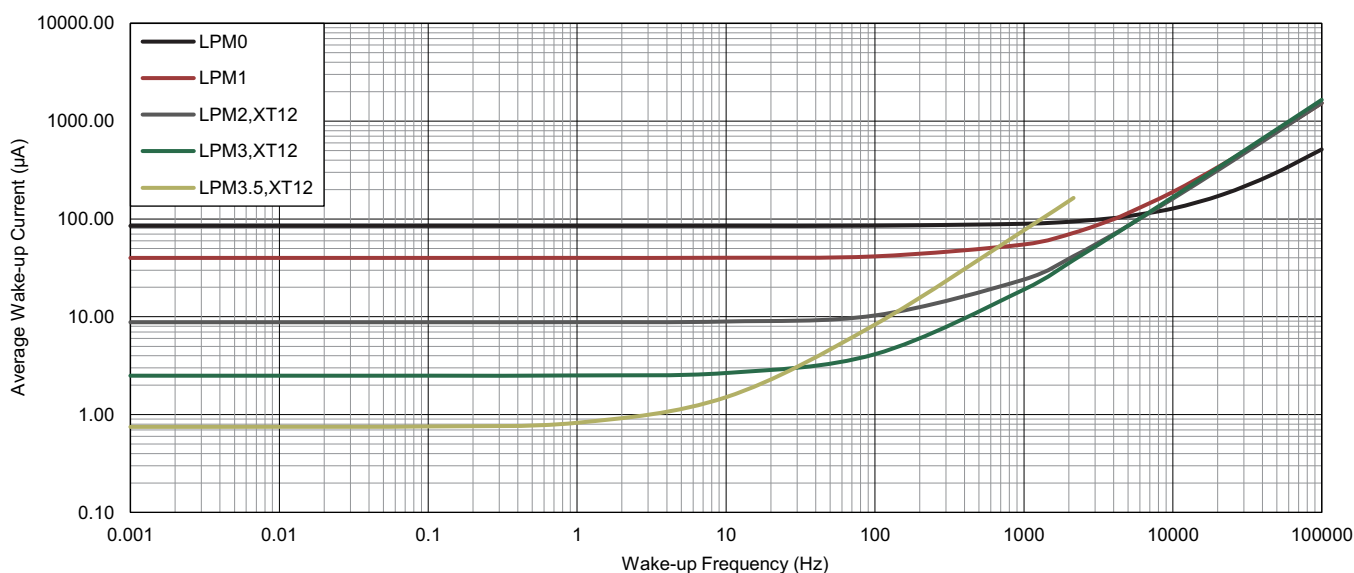
- (1) Charge used during the wake-up time from a given low-power mode to active mode. This does not include the energy required in active mode (for example, for an interrupt service routine).
- (2) Charge required until start of user code. This does not include the energy required to reconfigure the device.

#### 5.13.4.1 Typical Characteristics, Average LPM Currents vs Wake-up Frequency



NOTE: The average wake-up current does not include the energy required in active mode; for example, for an interrupt service routine or to reconfigure the device.

**Figure 5-7. Average LPM Currents vs Wake-up Frequency at 25°C**



NOTE: The average wake-up current does not include the energy required in active mode; for example, for an interrupt service routine or to reconfigure the device.

**Figure 5-8. Average LPM Currents vs Wake-up Frequency at 85°C**

## 5.13.5 Peripherals

### 5.13.5.1 Digital I/Os

Table 5-11 lists the characteristics of the digital inputs.

**Table 5-11. Digital Inputs**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                                           | TEST CONDITIONS                                                                                  | V <sub>CC</sub> | MIN  | TYP | MAX  | UNIT |
|---------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|-----------------|------|-----|------|------|
| V <sub>IT+</sub> Positive-going input threshold voltage                                                             |                                                                                                  | 2.2 V           | 1.2  |     | 1.65 | V    |
|                                                                                                                     |                                                                                                  | 3.0 V           | 1.65 |     | 2.25 |      |
| V <sub>IT–</sub> Negative-going input threshold voltage                                                             |                                                                                                  | 2.2 V           | 0.55 |     | 1.00 | V    |
|                                                                                                                     |                                                                                                  | 3.0 V           | 0.75 |     | 1.35 |      |
| V <sub>hys</sub> Input voltage hysteresis (V <sub>IT+</sub> – V <sub>IT–</sub> )                                    |                                                                                                  | 2.2 V           | 0.44 |     | 0.98 | V    |
|                                                                                                                     |                                                                                                  | 3.0 V           | 0.60 |     | 1.30 |      |
| R <sub>Pull</sub> Pullup or pulldown resistor                                                                       | For pullup: V <sub>IN</sub> = V <sub>SS</sub><br>For pulldown: V <sub>IN</sub> = V <sub>CC</sub> |                 | 20   | 35  | 50   | kΩ   |
| C <sub>I,dig</sub> Input capacitance, digital only port pins                                                        | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                             |                 |      | 3   |      | pF   |
| C <sub>I,ana</sub> Input capacitance, port pins with shared analog functions <sup>(1)</sup>                         | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                             |                 |      | 5   |      | pF   |
| I <sub>lkg(Px.y)</sub> High-impedance input leakage current                                                         | See <sup>(2)</sup> <sup>(3)</sup>                                                                | 2.2 V,<br>3.0 V | –20  |     | +20  | nA   |
| t <sub>(int)</sub> External interrupt timing (external trigger pulse duration to set interrupt flag) <sup>(4)</sup> | Ports with interrupt capability<br>(see Section 1.4 and Section 4.2)                             | 2.2 V,<br>3.0 V | 20   |     |      | ns   |
| t <sub>(RST)</sub> External reset pulse duration on $\overline{\text{RST}}$ <sup>(5)</sup>                          |                                                                                                  | 2.2 V,<br>3.0 V | 2    |     |      | μs   |

- (1) If the port pins PJ.4/LFXIN and PJ.5/LFXOUT are used as digital I/Os, they are connected by a 4-pF capacitor and a 35-MΩ resistor in series. At frequencies of approximately 1 kHz and lower, the 4-pF capacitor can add to the pin capacitance of PJ.4/LFXIN or PJ.5/LFXOUT.
- (2) The input leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.
- (3) The input leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup or pulldown resistor is disabled.
- (4) An external signal sets the interrupt flag every time the minimum interrupt pulse duration t<sub>(int)</sub> is met. It might be set by trigger signals shorter than t<sub>(int)</sub>.
- (5) Not applicable if  $\overline{\text{RST}}$ /NMI pin configured as NMI.

Table 5-12 lists the characteristics of the digital outputs.

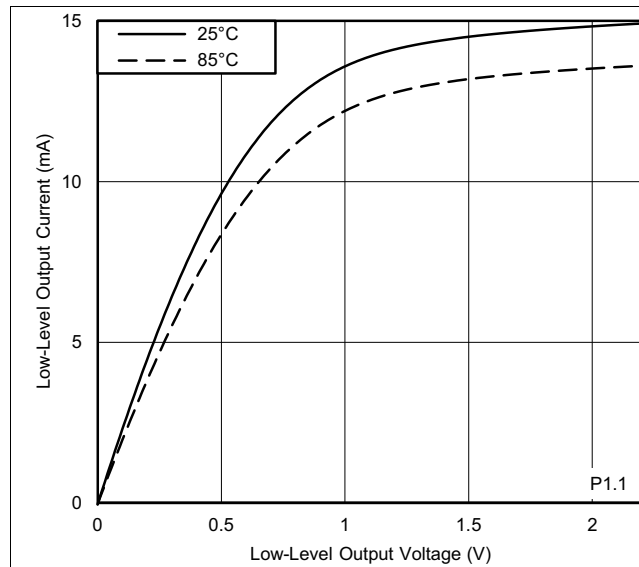
**Table 5-12. Digital Outputs**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5-9, Figure 5-10, Figure 5-11, and Figure 5-12)

| PARAMETER                                                                           | TEST CONDITIONS                                                                       | V <sub>CC</sub> | MIN                    | TYP | MAX                    | UNIT |
|-------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|-----------------|------------------------|-----|------------------------|------|
| V <sub>OH</sub> High-level output voltage                                           | I <sub>(OHmax)</sub> = –1 mA <sup>(1)</sup>                                           | 2.2 V           | V <sub>CC</sub> – 0.25 |     | V <sub>CC</sub>        | V    |
|                                                                                     | I <sub>(OHmax)</sub> = –3 mA <sup>(2)</sup>                                           |                 | V <sub>CC</sub> – 0.60 |     | V <sub>CC</sub>        |      |
|                                                                                     | I <sub>(OHmax)</sub> = –2 mA <sup>(1)</sup>                                           | 3.0 V           | V <sub>CC</sub> – 0.25 |     | V <sub>CC</sub>        |      |
|                                                                                     | I <sub>(OHmax)</sub> = –6 mA <sup>(2)</sup>                                           |                 | V <sub>CC</sub> – 0.60 |     | V <sub>CC</sub>        |      |
| V <sub>OL</sub> Low-level output voltage                                            | I <sub>(OLmax)</sub> = 1 mA <sup>(1)</sup>                                            | 2.2 V           | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.25 | V    |
|                                                                                     | I <sub>(OLmax)</sub> = 3 mA <sup>(2)</sup>                                            |                 | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.60 |      |
|                                                                                     | I <sub>(OLmax)</sub> = 2 mA <sup>(1)</sup>                                            | 3.0 V           | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.25 |      |
|                                                                                     | I <sub>(OLmax)</sub> = 6 mA <sup>(2)</sup>                                            |                 | V <sub>SS</sub>        |     | V <sub>SS</sub> + 0.60 |      |
| f <sub>Px,y</sub> Port output frequency (with load) <sup>(3)</sup>                  | C <sub>L</sub> = 20 pF, R <sub>L</sub> <sup>(4) (5)</sup>                             | 2.2 V           | 16                     |     |                        | MHz  |
|                                                                                     |                                                                                       | 3.0 V           | 16                     |     |                        |      |
| f <sub>Port_CLK</sub> Clock output frequency <sup>(3)</sup>                         | ACLK, MCLK, or SMCLK at configured output port, C <sub>L</sub> = 20 pF <sup>(5)</sup> | 2.2 V           | 16                     |     |                        | MHz  |
|                                                                                     |                                                                                       | 3.0 V           | 16                     |     |                        |      |
| t <sub>rise,dig</sub> Port output rise time, digital only port pins                 | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 4   | 15                     | ns   |
|                                                                                     |                                                                                       | 3.0 V           |                        | 3   | 15                     |      |
| t <sub>fall,dig</sub> Port output fall time, digital only port pins                 | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 4   | 15                     | ns   |
|                                                                                     |                                                                                       | 3.0 V           |                        | 3   | 15                     |      |
| t <sub>rise,ana</sub> Port output rise time, port pins with shared analog functions | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 6   | 15                     | ns   |
|                                                                                     |                                                                                       | 3.0 V           |                        | 4   | 15                     |      |
| t <sub>fall,ana</sub> Port output fall time, port pins with shared analog functions | C <sub>L</sub> = 20 pF                                                                | 2.2 V           |                        | 6   | 15                     | ns   |
|                                                                                     |                                                                                       | 3.0 V           |                        | 4   | 15                     |      |

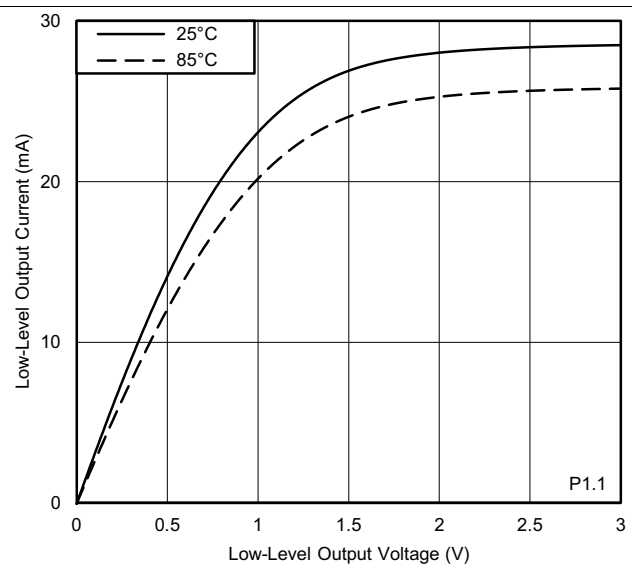
- (1) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.
- (2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±100 mA to hold the maximum voltage drop specified.
- (3) The port can output frequencies at least up to the specified limit - it might support higher frequencies.
- (4) A resistive divider with 2 × R1 and R1 = 1.6 kΩ between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider. C<sub>L</sub> = 20 pF is connected from the output to V<sub>SS</sub>.
- (5) The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.

### 5.13.5.1.1 Typical Characteristics, Digital Outputs at 3.0 V and 2.2 V



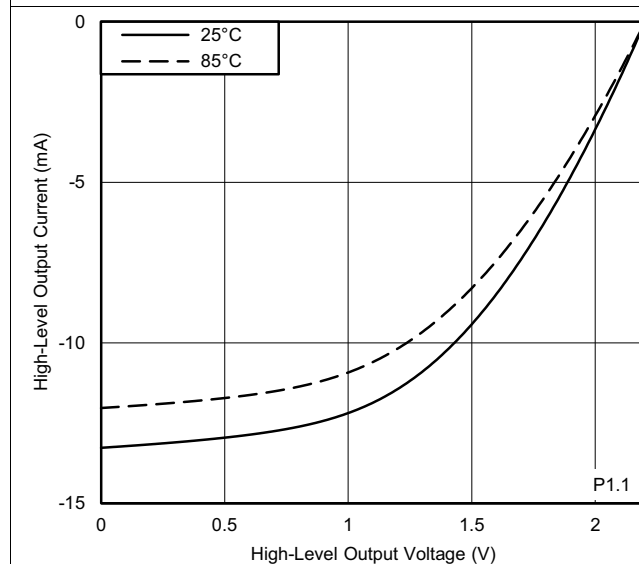
$V_{CC} = 2.2\text{ V}$

Figure 5-9. Typical Low-Level Output Current vs Low-Level Output Voltage



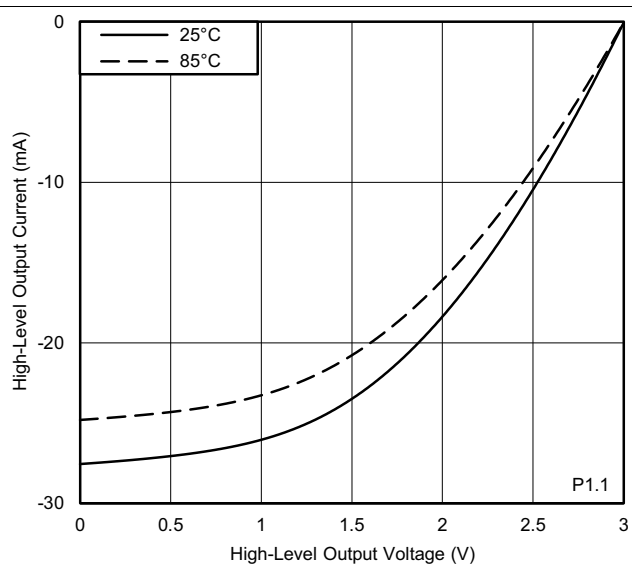
$V_{CC} = 3.0\text{ V}$

Figure 5-10. Typical Low-Level Output Current vs Low-Level Output Voltage



$V_{CC} = 2.2\text{ V}$

Figure 5-11. Typical High-Level Output Current vs High-Level Output Voltage



$V_{CC} = 3.0\text{ V}$

Figure 5-12. Typical High-Level Output Current vs High-Level Output Voltage

Table 5-13 lists the frequencies of the pin oscillator.

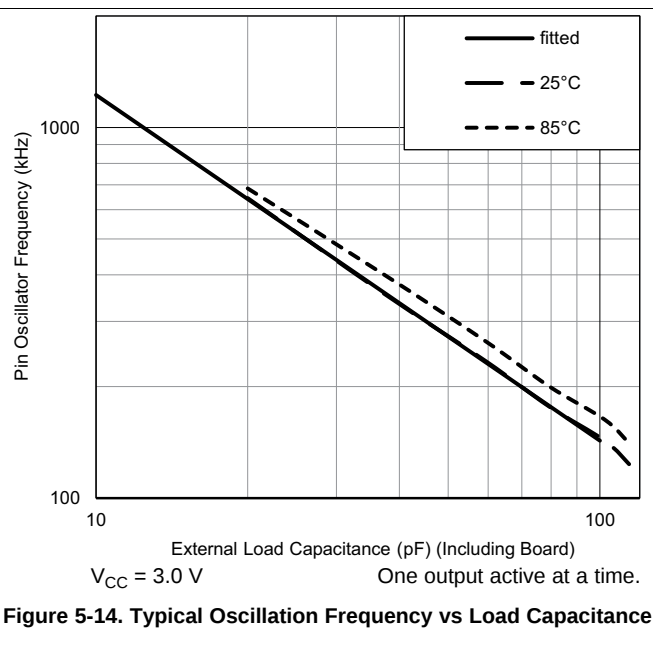
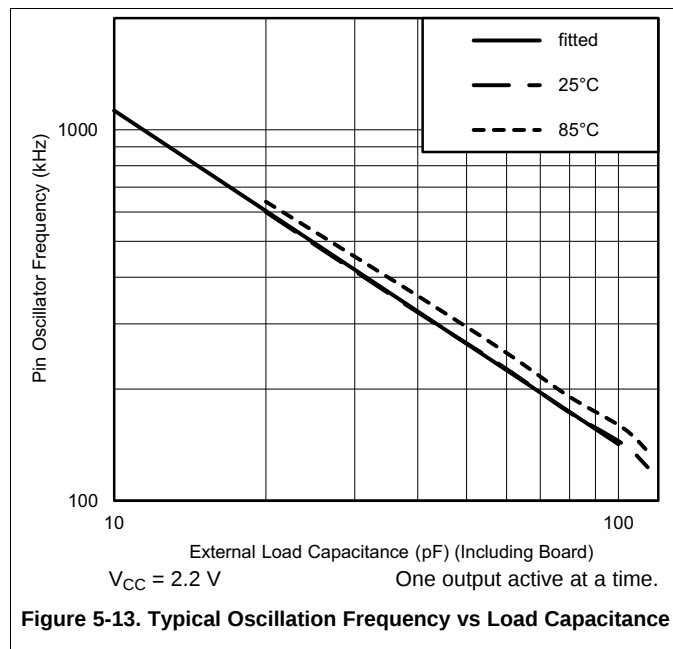
**Table 5-13. Pin-Oscillator Frequency, Ports Px**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5-13 and Figure 5-14)

| PARAMETER                                   | TEST CONDITIONS                             | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|---------------------------------------------|---------------------------------------------|-----------------|-----|------|-----|------|
| f <sub>OPx,y</sub> Pin-oscillator frequency | Px,y, C <sub>L</sub> = 10 pF <sup>(1)</sup> | 3.0 V           |     | 1200 |     | kHz  |
|                                             | Px,y, C <sub>L</sub> = 20 pF <sup>(1)</sup> |                 |     | 650  |     |      |

(1) C<sub>L</sub> is the external load capacitance connected from the output to V<sub>SS</sub> and includes all parasitic effects such as PCB traces.

#### 5.13.5.1.2 Typical Characteristics, Pin-Oscillator Frequency



### 5.13.5.2 Timer\_A and Timer\_B

[Table 5-14](#) lists the characteristics of the Timer\_A.

**Table 5-14. Timer\_A**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                     | TEST CONDITIONS                                                       | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------|-----------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TA</sub> Timer_A input clock frequency | Internal: SMCLK or ACLK,<br>External: TACLK,<br>Duty cycle = 50% ±10% | 2.2 V,<br>3.0 V |     |     | 16  | MHz  |
| t <sub>TA,cap</sub> Timer_A capture timing    | All capture inputs, minimum pulse<br>duration required for capture    | 2.2 V,<br>3.0 V | 20  |     |     | ns   |

[Table 5-15](#) lists the characteristics of the Timer\_B.

**Table 5-15. Timer\_B**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                     | TEST CONDITIONS                                                       | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------|-----------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TB</sub> Timer_B input clock frequency | Internal: SMCLK or ACLK,<br>External: TBCLK,<br>Duty cycle = 50% ±10% | 2.2 V,<br>3.0 V |     |     | 16  | MHz  |
| t <sub>TB,cap</sub> Timer_B capture timing    | All capture inputs, minimum pulse<br>duration required for capture    | 2.2 V,<br>3.0 V | 20  |     |     | ns   |

### 5.13.5.3 eUSCI

Table 5-16 lists the supported clock frequencies of the eUSCI in UART mode.

**Table 5-16. eUSCI (UART Mode) Clock Frequency**

| PARAMETER    |                                                       | TEST CONDITIONS                                                           | MIN | MAX | UNIT |
|--------------|-------------------------------------------------------|---------------------------------------------------------------------------|-----|-----|------|
| $f_{eUSCI}$  | eUSCI input clock frequency                           | Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% $\pm$ 10% |     | 16  | MHz  |
| $f_{BITCLK}$ | BITCLK clock frequency<br>(equals baud rate in MBaud) |                                                                           |     | 4   | MHz  |

Table 5-17 lists the characteristics of the eUSCI in UART mode.

**Table 5-17. eUSCI (UART Mode)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                           | TEST CONDITIONS | $V_{CC}$     | MIN | TYP | MAX | UNIT |
|-----------|-------------------------------------------|-----------------|--------------|-----|-----|-----|------|
| $t_t$     | UART receive deglitch time <sup>(1)</sup> | UCGLITx = 0     | 2.2 V, 3.0 V | 5   |     | 30  | ns   |
|           |                                           | UCGLITx = 1     |              | 20  |     | 90  |      |
|           |                                           | UCGLITx = 2     |              | 35  |     | 160 |      |
|           |                                           | UCGLITx = 3     |              | 50  |     | 220 |      |

- (1) Pulses on the UART receive input (UCxRX) shorter than the UART receive deglitch time are suppressed. Thus the selected deglitch time can limit the maximum useable baud rate. To ensure that pulses are correctly recognized, their duration should exceed the maximum specification of the deglitch time.

Table 5-18 lists the supported clock frequencies of the eUSCI in SPI master mode.

**Table 5-18. eUSCI (SPI Master Mode) Clock Frequency**

| PARAMETER   |                             | TEST CONDITIONS                                        | MIN | MAX | UNIT |
|-------------|-----------------------------|--------------------------------------------------------|-----|-----|------|
| $f_{eUSCI}$ | eUSCI input clock frequency | Internal: SMCLK or ACLK,<br>Duty cycle = 50% $\pm$ 10% |     | 16  | MHz  |

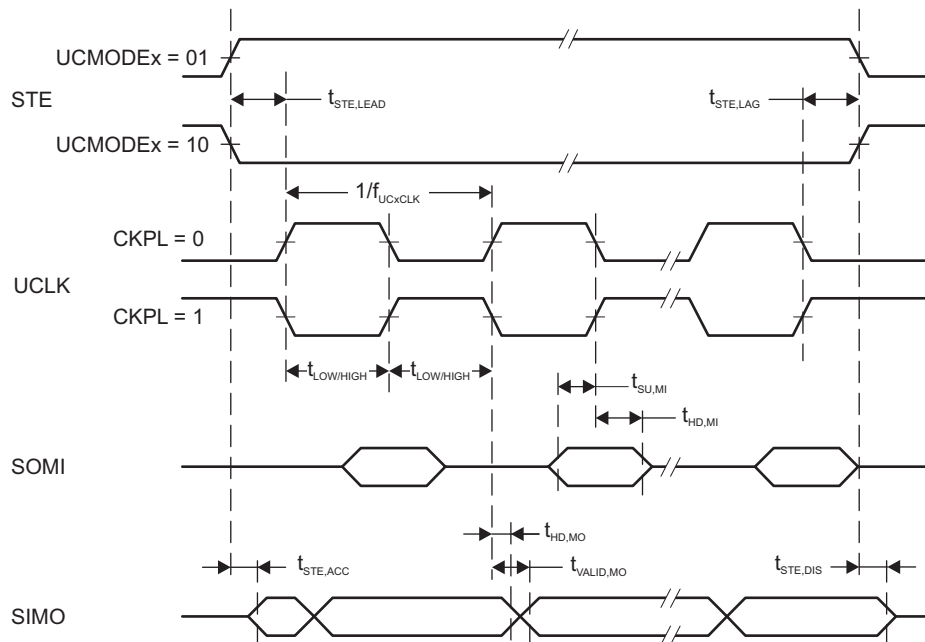
Table 5-19 lists the characteristics of the eUSCI in SPI master mode.

**Table 5-19. eUSCI (SPI Master Mode)**

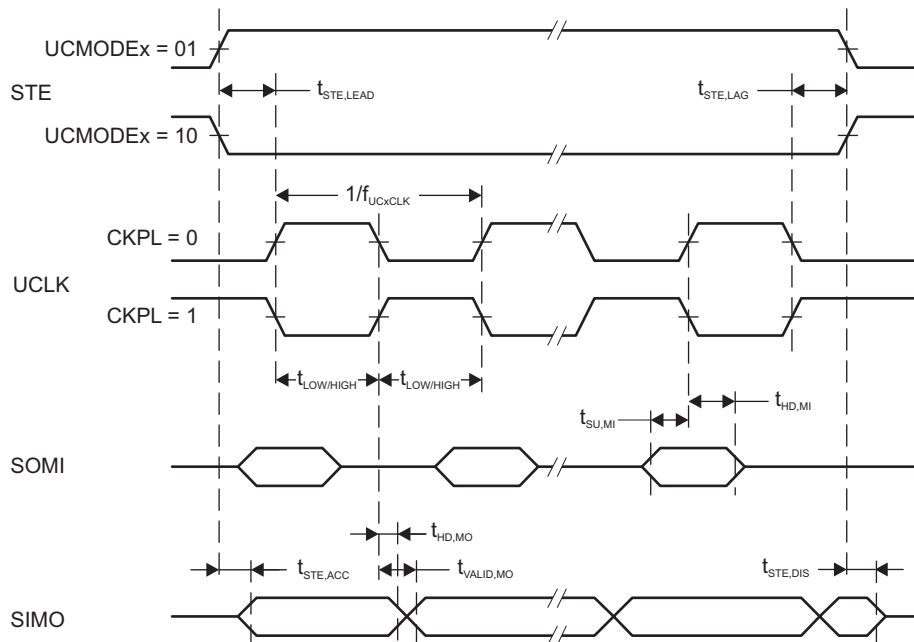
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER             |                                                       | TEST CONDITIONS                                    | V <sub>CC</sub> | MIN | TYP | MAX | UNIT             |
|-----------------------|-------------------------------------------------------|----------------------------------------------------|-----------------|-----|-----|-----|------------------|
| t <sub>STE,LEAD</sub> | STE lead time, STE active to clock                    | UCSTEM = 1,<br>UCMODEx = 01 or 10                  |                 | 1   |     |     | UCxCLK<br>cycles |
| t <sub>STE,LAG</sub>  | STE lag time, last clock to STE inactive              | UCSTEM = 1,<br>UCMODEx = 01 or 10                  |                 | 1   |     |     | UCxCLK<br>cycles |
| t <sub>STE,ACC</sub>  | STE access time, STE active to SIMO data out          | UCSTEM = 0,<br>UCMODEx = 01 or 10                  | 2.2 V, 3.0 V    |     |     | 60  | ns               |
| t <sub>STE,DIS</sub>  | STE disable time, STE inactive to SOMI high impedance | UCSTEM = 0,<br>UCMODEx = 01 or 10                  | 2.2 V, 3.0 V    |     |     | 80  | ns               |
| t <sub>SU,MI</sub>    | SOMI input data setup time                            |                                                    | 2.2 V           | 40  |     |     | ns               |
|                       |                                                       |                                                    | 3.0 V           | 40  |     |     |                  |
| t <sub>HD,MI</sub>    | SOMI input data hold time                             |                                                    | 2.2 V           | 0   |     |     | ns               |
|                       |                                                       |                                                    | 3.0 V           | 0   |     |     |                  |
| t <sub>VALID,MO</sub> | SIMO output data valid time <sup>(2)</sup>            | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF | 2.2 V           |     |     | 10  | ns               |
|                       |                                                       |                                                    | 3.0 V           |     |     | 10  |                  |
| t <sub>HD,MO</sub>    | SIMO output data hold time <sup>(3)</sup>             | C <sub>L</sub> = 20 pF                             | 2.2 V           |     | 0   |     | ns               |
|                       |                                                       |                                                    | 3.0 V           |     | 0   |     |                  |

- (1)  $f_{UCxCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} = \max(t_{VALID,MO}(eUSCI) + t_{SU,SI}(Slave), t_{SU,MI}(eUSCI) + t_{VALID,SO}(Slave))$   
For the slave parameters  $t_{SU,SI}(Slave)$  and  $t_{VALID,SO}(Slave)$ , see the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SIMO output after the output changing UCLK clock edge. See the timing diagrams in Figure 5-15 and Figure 5-16.
- (3) Specifies how long data on the SIMO output is valid after the output changing UCLK clock edge. Negative values indicate that the data on the SIMO output can become invalid before the output changing clock edge observed on UCLK. See the timing diagrams in Figure 5-15 and Figure 5-16.



**Figure 5-15. SPI Master Mode, CKPH = 0**



**Figure 5-16. SPI Master Mode, CKPH = 1**

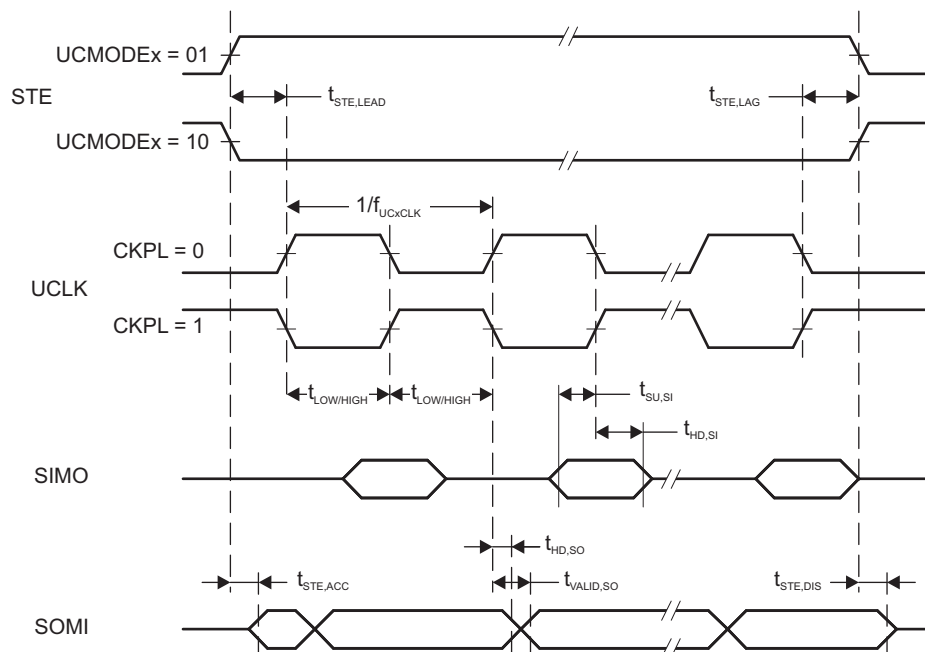
Table 5-20 lists the characteristics of the eUSCI in SPI slave mode.

**Table 5-20. eUSCI (SPI Slave Mode)**

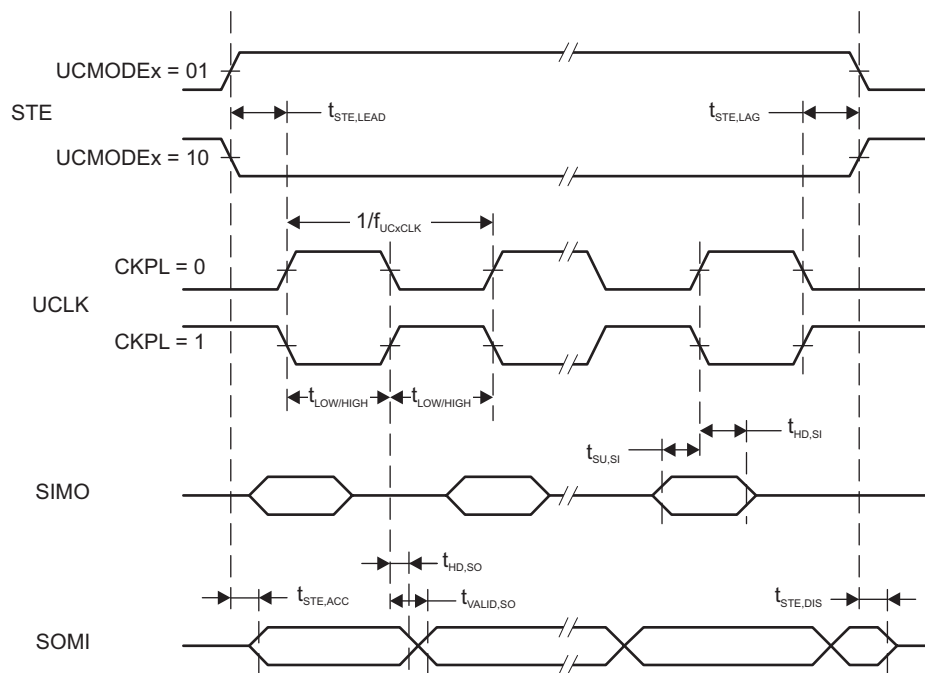
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                                                  | TEST CONDITIONS                                    | V <sub>CC</sub> | MIN | MAX | UNIT |
|----------------------------------------------------------------------------|----------------------------------------------------|-----------------|-----|-----|------|
| t <sub>STE,LEAD</sub> STE lead time, STE active to clock                   |                                                    | 2.2 V           | 45  |     | ns   |
|                                                                            |                                                    | 3.0 V           | 40  |     |      |
| t <sub>STE,LAG</sub> STE lag time, Last clock to STE inactive              |                                                    | 2.2 V           | 2   |     | ns   |
|                                                                            |                                                    | 3.0 V           | 3   |     |      |
| t <sub>STE,ACC</sub> STE access time, STE active to SOMI data out          |                                                    | 2.2 V           |     | 45  | ns   |
|                                                                            |                                                    | 3.0 V           |     | 40  |      |
| t <sub>STE,DIS</sub> STE disable time, STE inactive to SOMI high impedance |                                                    | 2.2 V           |     | 50  | ns   |
|                                                                            |                                                    | 3.0 V           |     | 45  |      |
| t <sub>SU,SI</sub> SIMO input data setup time                              |                                                    | 2.2 V           | 4   |     | ns   |
|                                                                            |                                                    | 3.0 V           | 4   |     |      |
| t <sub>HD,SI</sub> SIMO input data hold time                               |                                                    | 2.2 V           | 7   |     | ns   |
|                                                                            |                                                    | 3.0 V           | 7   |     |      |
| t <sub>VALID,SO</sub> SOMI output data valid time <sup>(2)</sup>           | UCLK edge to SOMI valid,<br>C <sub>L</sub> = 20 pF | 2.2 V           |     | 35  | ns   |
|                                                                            |                                                    | 3.0 V           |     | 35  |      |
| t <sub>HD,SO</sub> SOMI output data hold time <sup>(3)</sup>               | C <sub>L</sub> = 20 pF                             | 2.2 V           | 0   |     | ns   |
|                                                                            |                                                    | 3.0 V           | 0   |     |      |

- (1)  $f_{UCXCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} \geq \max(t_{VALID,MO(Master)} + t_{SU,SI(eUSCI)}, t_{SU,MI(Master)} + t_{VALID,SO(eUSCI)})$   
For the master parameters  $t_{SU,MI(Master)}$  and  $t_{VALID,MO(Master)}$ , see the SPI parameters of the attached master.
- (2) Specifies the time to drive the next valid data to the SOMI output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-17](#) and [Figure 5-18](#).
- (3) Specifies how long data on the SOMI output is valid after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-17](#) and [Figure 5-18](#).



**Figure 5-17. SPI Slave Mode, CKPH = 0**



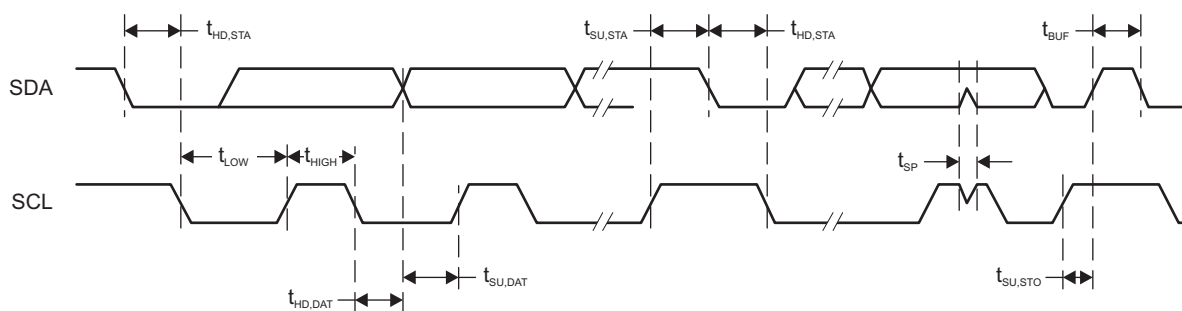
**Figure 5-18. SPI Slave Mode, CKPH = 1**

Table 5-21 lists the characteristics of the eUSCI in I<sup>2</sup>C mode.

### Table 5-21. eUSCI (I<sup>2</sup>C Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-19](#))

| PARAMETER            |                                                     | TEST CONDITIONS                                                      | V <sub>CC</sub> | MIN  | TYP | MAX  | UNIT |
|----------------------|-----------------------------------------------------|----------------------------------------------------------------------|-----------------|------|-----|------|------|
| f <sub>eUSCI</sub>   | eUSCI input clock frequency                         | Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% ±10% |                 |      |     | 16   | MHz  |
| f <sub>SCL</sub>     | SCL clock frequency                                 |                                                                      | 2.2 V, 3.0 V    | 0    |     | 400  | kHz  |
| t <sub>HD,STA</sub>  | Hold time (repeated) START                          | f <sub>SCL</sub> = 100 kHz                                           | 2.2 V, 3.0 V    | 4.0  |     |      | μs   |
|                      |                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6  |     |      |      |
| t <sub>SU,STA</sub>  | Setup time for a repeated START                     | f <sub>SCL</sub> = 100 kHz                                           | 2.2 V, 3.0 V    | 4.7  |     |      | μs   |
|                      |                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6  |     |      |      |
| t <sub>HD,DAT</sub>  | Data hold time                                      |                                                                      | 2.2 V, 3.0 V    | 0    |     |      | ns   |
| t <sub>SU,DAT</sub>  | Data setup time                                     |                                                                      | 2.2 V, 3.0 V    | 100  |     |      | ns   |
| t <sub>SU,STO</sub>  | Setup time for STOP                                 | f <sub>SCL</sub> = 100 kHz                                           | 2.2 V, 3.0 V    | 4.0  |     |      | μs   |
|                      |                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6  |     |      |      |
| t <sub>BUF</sub>     | Bus free time between STOP and START conditions     | f <sub>SCL</sub> = 100 kHz                                           |                 | 4.7  |     |      | μs   |
|                      |                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 1.3  |     |      |      |
| t <sub>SP</sub>      | Pulse duration of spikes suppressed by input filter | UCGLITx = 0                                                          | 2.2 V, 3.0 V    | 50   |     | 250  | ns   |
|                      |                                                     | UCGLITx = 1                                                          |                 | 25   |     | 125  |      |
|                      |                                                     | UCGLITx = 2                                                          |                 | 12.5 |     | 62.5 |      |
|                      |                                                     | UCGLITx = 3                                                          |                 | 6.3  |     | 31.5 |      |
| t <sub>TIMEOUT</sub> | Clock low time-out                                  | UCCLTOx = 1                                                          | 2.2 V, 3.0 V    | 27   |     |      | ms   |
|                      |                                                     | UCCLTOx = 2                                                          |                 | 30   |     |      |      |
|                      |                                                     | UCCLTOx = 3                                                          |                 | 33   |     |      |      |



### Figure 5-19. I<sup>2</sup>C Mode Timing

### 5.13.5.4 LCD Controller

Table 5-22 lists the operating conditions of the LCD\_C.

**Table 5-22. LCD\_C, Recommended Operating Conditions**

|                            |                                                                                                |                                                                                                   | MIN                                                        | NOM    | MAX                | UNIT |
|----------------------------|------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|------------------------------------------------------------|--------|--------------------|------|
| $V_{CC,LCD\_C,CP\ en,3.6}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.6\text{ V}$                         | LCDCPEN = 1, 0000b < VLCDx ≤ 1111b (charge pump enabled, $V_{LCD} \leq 3.6\text{ V}$ )            | 2.2                                                        |        | 3.6                | V    |
| $V_{CC,LCD\_C,CP\ en,3.3}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.3\text{ V}$                         | LCDCPEN = 1, 0000b < VLCDx ≤ 1100b (charge pump enabled, $V_{LCD} \leq 3.3\text{ V}$ )            | 2.0                                                        |        | 3.6                | V    |
| $V_{CC,LCD\_C,int.\ bias}$ | Supply voltage range, internal biasing, charge pump disabled                                   | LCDCPEN = 0, VLCDEXT = 0                                                                          | 2.4                                                        |        | 3.6                | V    |
| $V_{CC,LCD\_C,ext.\ bias}$ | Supply voltage range, external biasing, charge pump disabled                                   | LCDCPEN = 0, VLCDEXT = 0                                                                          | 2.4                                                        |        | 3.6                | V    |
| $V_{CC,LCD\_C,VLCDEXT}$    | Supply voltage range, external LCD voltage, internal or external biasing, charge pump disabled | LCDCPEN = 0, VLCDEXT = 1                                                                          | 2.0                                                        |        | 3.6                | V    |
| $V_{LCDCAP}$               | External LCD voltage at LCDCAP, internal or external biasing, charge pump disabled             | LCDCPEN = 0, VLCDEXT = 1                                                                          | 2.4                                                        |        | 3.6                | V    |
| $C_{LCDCAP}$               | Capacitor value on LCDCAP when charge pump enabled                                             | LCDCPEN = 1, VLCDx > 0000b (charge pump enabled)                                                  | 4.7 <sub>-20%</sub>                                        | 4.7    | 10 <sub>+20%</sub> | μF   |
| $f_{ACLK,in}$              | ACLK input frequency range                                                                     |                                                                                                   | 30                                                         | 32.768 | 40                 | kHz  |
| $f_{LCD}$                  | LCD frequency range                                                                            | $f_{FRAME} = 1/(2 \times \text{mux}) \times f_{LCD}$ with mux = 1 (static) to 8                   | 0                                                          |        | 1024               | Hz   |
| $f_{FRAME,4mux}$           | LCD frame frequency range                                                                      | $f_{FRAME,4mux}(MAX) = 1/(2 \times 4) \times f_{LCD}(MAX) = 1/(2 \times 4) \times 1024\text{ Hz}$ |                                                            |        | 128                | Hz   |
| $f_{FRAME,8mux}$           | LCD frame frequency range                                                                      | $f_{FRAME,8mux}(MAX) = 1/(2 \times 4) \times f_{LCD}(MAX) = 1/(2 \times 8) \times 1024\text{ Hz}$ |                                                            |        | 64                 | Hz   |
| $C_{Panel}$                | Panel capacitance                                                                              | $f_{LCD} = 1024\text{ Hz}$ , all common lines equally loaded                                      |                                                            |        | 10000              | pF   |
| $V_{R33}$                  | Analog input voltage at R33                                                                    | LCDCPEN = 0, VLCDEXT = 1                                                                          | 2.4                                                        |        | $V_{CC}+0.2$       | V    |
| $V_{R23,1/3bias}$          | Analog input voltage at R23                                                                    | LCDREXT = 1, LCDEXTBIAS = 1, LCD2B = 0                                                            | $V_{R13} \times \frac{V_{R03} + 2/3}{(V_{R33} - V_{R03})}$ |        | $V_{R33}$          | V    |
| $V_{R13,1/3bias}$          | Analog input voltage at R13 with 1/3 biasing                                                   | LCDREXT = 1, LCDEXTBIAS = 1, LCD2B = 0                                                            | $V_{R03} \times \frac{V_{R03} + 1/3}{(V_{R33} - V_{R03})}$ |        | $V_{R23}$          | V    |
| $V_{R13,1/2bias}$          | Analog input voltage at R13 with 1/2 biasing                                                   | LCDREXT = 1, LCDEXTBIAS = 1, LCD2B = 1                                                            | $V_{R03} \times \frac{V_{R03} + 1/2}{(V_{R33} - V_{R03})}$ |        | $V_{R33}$          | V    |
| $V_{R03}$                  | Analog input voltage at R03                                                                    | R0EXT = 1                                                                                         | $V_{SS}$                                                   |        |                    | V    |
| $V_{LCD}-V_{R03}$          | Voltage difference between $V_{LCD}$ and R03                                                   | LCDCPEN = 0, R0EXT = 1                                                                            | 2.4                                                        |        | $V_{CC}+0.2$       | V    |
| $V_{LCDREF}$               | External LCD reference voltage applied at LCDREF                                               | VLCDREFx = 01                                                                                     | 0.8                                                        | 1.0    | 1.2                | V    |

Table 5-23 lists the characteristics of the LCD\_C.

**Table 5-23. LCD\_C Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER               |                                                       | TEST CONDITIONS                                                                       | V <sub>CC</sub> | MIN             | TYP  | MAX  | UNIT |
|-------------------------|-------------------------------------------------------|---------------------------------------------------------------------------------------|-----------------|-----------------|------|------|------|
| V <sub>LCD,0</sub>      | LCD voltage                                           | VLCDx = 0000, VLCDxEXT = 0                                                            | 2.4 V to 3.6 V  | V <sub>CC</sub> |      |      | V    |
| V <sub>LCD,1</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0001b                                                            | 2 V to 3.6 V    | 2.49            | 2.60 | 2.72 |      |
| V <sub>LCD,2</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0010b                                                            | 2 V to 3.6 V    | 2.66            |      |      |      |
| V <sub>LCD,3</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0011b                                                            | 2 V to 3.6 V    | 2.72            |      |      |      |
| V <sub>LCD,4</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0100b                                                            | 2 V to 3.6 V    | 2.78            |      |      |      |
| V <sub>LCD,5</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0101b                                                            | 2 V to 3.6 V    | 2.84            |      |      |      |
| V <sub>LCD,6</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0110b                                                            | 2 V to 3.6 V    | 2.90            |      |      |      |
| V <sub>LCD,7</sub>      |                                                       | LCDCPEN = 1, VLCDx = 0111b                                                            | 2 V to 3.6 V    | 2.96            |      |      |      |
| V <sub>LCD,8</sub>      |                                                       | LCDCPEN = 1, VLCDx = 1000b                                                            | 2 V to 3.6 V    | 3.02            |      |      |      |
| V <sub>LCD,9</sub>      |                                                       | LCDCPEN = 1, VLCDx = 1001b                                                            | 2 V to 3.6 V    | 3.08            |      |      |      |
| V <sub>LCD,10</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1010b                                                            | 2 V to 3.6 V    | 3.14            |      |      |      |
| V <sub>LCD,11</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1011b                                                            | 2 V to 3.6 V    | 3.20            |      |      |      |
| V <sub>LCD,12</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1100b                                                            | 2 V to 3.6 V    | 3.26            |      |      |      |
| V <sub>LCD,13</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1101b                                                            | 2.2 V to 3.6 V  | 3.32            |      |      |      |
| V <sub>LCD,14</sub>     |                                                       | LCDCPEN = 1, VLCDx = 1110b                                                            | 2.2 V to 3.6 V  | 3.38            |      |      |      |
| V <sub>LCD,15</sub>     | LCDCPEN = 1, VLCDx = 1111b                            | 2.2 V to 3.6 V                                                                        | 3.32            | 3.44            | 3.6  |      |      |
| V <sub>LCD,7,0.8</sub>  | LCD voltage with external reference of 0.8 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 0.8 V               | 2 V to 3.6 V    | 2.96 × 0.8 V    |      |      | V    |
| V <sub>LCD,7,1.0</sub>  | LCD voltage with external reference of 1.0 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 1.0 V               | 2 V to 3.6 V    | 2.96 × 1.0 V    |      |      | V    |
| V <sub>LCD,7,1.2</sub>  | LCD voltage with external reference of 1.2 V          | LCDCPEN = 1, VLCDx = 0111b, VLCDREFx = 01b, V <sub>LCDREF</sub> = 1.2 V               | 2.2 V to 3.6 V  | 2.96 × 1.2 V    |      |      | V    |
| ΔV <sub>LCD</sub>       | Voltage difference between consecutive VLCDx settings | ΔV <sub>LCD</sub> = V <sub>LCD,x</sub> - V <sub>LCD,x-1</sub> with x = 0010b to 1111b |                 | 40              | 60   | 80   | mV   |
| I <sub>CC,Peak,CP</sub> | Peak supply currents due to charge pump activities    | LCDCPEN = 1, VLCDx = 1111b external, with decoupling capacitor on DVCC supply ≥ 1 μF  | 2.2 V           | 600             |      |      | μA   |
| t <sub>LCD,CP,on</sub>  | Time to charge C <sub>LCD</sub> when discharged       | C <sub>LCD</sub> = 4.7 μF, LCDCPEN = 0→1, VLCDx = 1111b                               | 2.2 V           | 100 500         |      |      | ms   |
| I <sub>CP,Load</sub>    | Maximum charge pump load current                      | LCDCPEN = 1, VLCDx = 1111b                                                            | 2.2 V           | 50              |      |      | μA   |
| R <sub>LCD,Seg</sub>    | LCD driver output impedance, segment lines            | LCDCPEN = 0, I <sub>LOAD</sub> = ±10 μA                                               | 2.2 V           | 10              |      |      | kΩ   |
| R <sub>LCD,COM</sub>    | LCD driver output impedance, common lines             | LCDCPEN = 0, I <sub>LOAD</sub> = ±10 μA                                               | 2.2 V           | 10              |      |      | kΩ   |

### 5.13.5.5 ADC

Table 5-24 lists the input requirements of the ADC.

**Table 5-24. 12-Bit ADC, Power Supply and Input Range Conditions**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                      |                                                                                        | TEST CONDITIONS                                                                                                            | V <sub>CC</sub> | MIN | NOM | MAX  | UNIT |
|------------------------------------------------|----------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|------|------|
| V <sub>(Ax)</sub>                              | Analog input voltage range <sup>(1)</sup>                                              | All ADC12 analog input pins Ax                                                                                             |                 | 0   |     | AVCC | V    |
| I <sub>(ADC12_B)</sub><br>single-ended<br>mode | Operating supply current into<br>AVCC and DVCC terminals <sup>(2)</sup> <sup>(3)</sup> | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1,<br>ADC12PWRMD = 0, ADC12DIF = 0,<br>REFON = 0, ADC12SHTx = 0,<br>ADC12DIV = 0 | 3.0 V           |     | 145 | 199  | μA   |
|                                                |                                                                                        |                                                                                                                            | 2.2 V           |     | 140 | 190  |      |
| I <sub>(ADC12_B)</sub><br>differential<br>mode | Operating supply current into<br>AVCC and DVCC terminals <sup>(2)</sup> <sup>(3)</sup> | f <sub>ADC12CLK</sub> = MODCLK, ADC12ON = 1,<br>ADC12PWRMD = 0, ADC12DIF = 1,<br>REFON = 0, ADC12SHTx = 0,<br>ADC12DIV = 0 | 3.0 V           |     | 175 | 245  | μA   |
|                                                |                                                                                        |                                                                                                                            | 2.2 V           |     | 170 | 230  |      |
| C <sub>I</sub>                                 | Input capacitance                                                                      | Only one terminal Ax can be selected<br>at one time                                                                        | 2.2 V           |     | 10  | 15   | pF   |
| R <sub>I</sub>                                 | Input MUX ON resistance                                                                | 0 V ≤ V <sub>(Ax)</sub> ≤ AVCC                                                                                             | >2 V            |     | 0.5 | 4    | kΩ   |
|                                                |                                                                                        |                                                                                                                            | <2 V            |     | 1   | 10   |      |

(1) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results.

(2) The internal reference supply current is not included in current consumption parameter I<sub>(ADC12\_B)</sub>.

(3) Approximately 60% (typical) of the total current into the AVCC and DVCC terminals is from AVCC.

Table 5-25 lists the timing parameters of the ADC.

**Table 5-25. 12-Bit ADC, Timing Parameters**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                   | TEST CONDITIONS                                                                                                                             | MIN  | TYP                | MAX | UNIT          |
|-----------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------|------|--------------------|-----|---------------|
| $f_{\text{ADC12CLK}}$ Frequency for specified performance                   | For specified performance of ADC12 linearity parameters with ADC12PWRMD = 0. If ADC12PWRMD = 1, the maximum is 1/4 of the value shown here. | 0.45 |                    | 5.4 | MHz           |
| $f_{\text{ADC12CLK}}$ Frequency for reduced performance                     | Linearity parameters have reduced performance                                                                                               |      | 32.768             |     | kHz           |
| $f_{\text{ADC12OSC}}$ Internal oscillator <sup>(1)</sup>                    | ADC12DIV = 0, $f_{\text{ADC12CLK}} = f_{\text{ADC12OSC}}$ from MODCLK                                                                       | 4    | 4.8                | 5.4 | MHz           |
| $t_{\text{CONVERT}}$ Conversion time                                        | REFON = 0, Internal oscillator, $f_{\text{ADC12CLK}} = f_{\text{ADC12OSC}}$ from MODCLK, ADC12WINC = 0                                      | 2.6  |                    | 3.5 | $\mu\text{s}$ |
|                                                                             | External $f_{\text{ADC12CLK}}$ from ACLK, MCLK, or SMCLK, ADC12SSEL $\neq$ 0                                                                |      | See <sup>(2)</sup> |     |               |
| $t_{\text{ADC12ON}}$ Turnon settling time of the ADC                        | See <sup>(3)</sup>                                                                                                                          |      |                    | 100 | ns            |
| $t_{\text{ADC12OFF}}$ Time ADC must be off before it can be turned on again | $t_{\text{ADC12OFF}}$ must be met to make sure that $t_{\text{ADC12ON}}$ time holds.                                                        | 100  |                    |     | ns            |
| $t_{\text{Sample}}$ Sampling time                                           | $R_S = 400\ \Omega$ , $R_I = 4\ \text{k}\Omega$ , $C_I = 15\ \text{pF}$ , $C_{\text{pext}} = 8\ \text{pF}$ <sup>(4)</sup>                   |      | 1                  |     | $\mu\text{s}$ |
|                                                                             | Extended sample mode (ADC12SHP = 0) with unbuffered reference (ADC12VRSEL = 0x0, 0x2, 0x4, 0x6, 0xC, 0xE)                                   |      | See <sup>(5)</sup> |     | $\mu\text{s}$ |

(1) The ADC12OSC is sourced directly from MODOSC inside the UCS.

(2)  $14 \times 1 / f_{\text{ADC12CLK}}$ . If ADC12WINC = 1, then  $15 \times 1 / f_{\text{ADC12CLK}}$

(3) The condition is that the error in a conversion started after  $t_{\text{ADC12ON}}$  is less than  $\pm 0.5$  LSB. The reference and input signal are already settled.

(4) Approximately 10 Tau ( $\tau$ ) are needed to get an error of less than  $\pm 0.5$  LSB:  $t_{\text{sample}} = \ln(2^{n+2}) \times (R_S + R_I) \times (C_I + C_{\text{pext}})$ ,  $R_S < 10\ \text{k}\Omega$ , where  $n$  = ADC resolution = 12,  $R_S$  = external source resistance,  $C_{\text{pext}}$  = external parasitic capacitance.

(5)  $6 \times 1 / f_{\text{ADC12CLK}}$

Table 5-26 lists the linearity parameters of the ADC when using an external reference.

**Table 5-26. 12-Bit ADC, Linearity Parameters With External Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER          |                                                        | TEST CONDITIONS                                                                                                                                                                                                                 | MIN   | TYP  | MAX   | UNIT |
|--------------------|--------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|-------|------|
| Resolution         | Number of no missing code output-code bits             |                                                                                                                                                                                                                                 | 12    |      |       | bits |
| E <sub>I</sub>     | Integral linearity error (INL) for differential input  | $1.2\text{ V} \leq V_{R+} - V_{R-} \leq AV_{CC}$                                                                                                                                                                                |       |      | ±1.8  | LSB  |
| E <sub>I</sub>     | Integral linearity error (INL) for single ended inputs | $1.2\text{ V} \leq V_{R+} - V_{R-} \leq AV_{CC}$                                                                                                                                                                                |       |      | ±2.2  | LSB  |
| E <sub>D</sub>     | Differential linearity error (DNL)                     |                                                                                                                                                                                                                                 | –0.99 |      | +1.0  | LSB  |
| E <sub>O</sub>     | Offset error <sup>(2) (3)</sup>                        | ADC12VRSEL = 0x2 or 0x4 without TLV calibration, TLV calibration data can be used to improve the parameter <sup>(4)</sup>                                                                                                       |       | ±0.5 | ±1.5  | mV   |
| E <sub>G,ext</sub> | Gain error                                             | With external voltage reference without internal buffer (ADC12VRSEL = 0x2 or 0x4) without TLV calibration, TLV calibration data can be used to improve the parameter <sup>(4)</sup> , $V_{R+} = 2.5\text{ V}$ , $V_{R-} = AVSS$ |       | ±0.8 | ±2.5  | LSB  |
|                    |                                                        | With external voltage reference with internal buffer (ADC12VRSEL = 0x3), $V_{R+} = 2.5\text{ V}$ , $V_{R-} = AVSS$                                                                                                              |       | ±1   | ±20   |      |
| E <sub>T,ext</sub> | Total unadjusted error                                 | With external voltage reference without internal buffer (ADC12VRSEL = 0x2 or 0x4) without TLV calibration, TLV calibration data can be used to improve the parameter <sup>(4)</sup> , $V_{R+} = 2.5\text{ V}$ , $V_{R-} = AVSS$ |       | ±1.4 | ±3.5  | LSB  |
|                    |                                                        | With external voltage reference with internal buffer (ADC12VRSEL = 0x3), $V_{R+} = 2.5\text{ V}$ , $V_{R-} = AVSS$                                                                                                              |       | ±1.4 | ±21.0 |      |

(1) See Table 5-28 and Table 5-34 for more information on internal reference performance, and see [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.

(2) Offset is measured as the input voltage (at which ADC output transitions from 0 to 1) minus 0.5 LSB.

(3) Offset increases as I<sub>R</sub> drop increases when V<sub>R-</sub> is AVSS.

(4) For details, see the device descriptor in the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide](#).

Table 5-27 lists the dynamic performance characteristics of the ADC with differential inputs and an external reference.

**Table 5-27. 12-Bit ADC, Dynamic Performance for Differential Inputs With External Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                         | TEST CONDITIONS                                  | MIN  | TYP  | MAX | UNIT |
|-----------|-----------------------------------------|--------------------------------------------------|------|------|-----|------|
| SNR       | Signal-to-noise                         | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 68   | 71   |     | dB   |
| ENOB      | Effective number of bits <sup>(2)</sup> | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 10.7 | 11.2 |     | bits |

(1) See Table 5-28 and Table 5-34 for more information on internal reference performance, and see [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.

(2)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

Table 5-28 lists the dynamic performance characteristics of the ADC with differential inputs and an internal reference.

**Table 5-28. 12-Bit ADC, Dynamic Performance for Differential Inputs With Internal Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                         | TEST CONDITIONS                                  | MIN  | TYP  | MAX | UNIT |
|-----------|-----------------------------------------|--------------------------------------------------|------|------|-----|------|
| ENOB      | Effective number of bits <sup>(2)</sup> | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 10.3 | 10.7 |     | Bits |

(1) See Table 5-34 for more information on internal reference performance, and see [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.

(2)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

Table 5-29 lists the dynamic performance characteristics of the ADC with single-ended inputs and an external reference.

**Table 5-29. 12-Bit ADC, Dynamic Performance for Single-Ended Inputs With External Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                         | TEST CONDITIONS                                  | MIN  | TYP  | MAX | UNIT |
|-----------|-----------------------------------------|--------------------------------------------------|------|------|-----|------|
| SNR       | Signal-to-noise                         | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 64   | 68   |     | dB   |
| ENOB      | Effective number of bits <sup>(2)</sup> | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 10.2 | 10.7 |     | bits |

(1) See Table 5-30 and Table 5-34 for more information on internal reference performance, and see [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.

(2)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

Table 5-30 lists the dynamic performance characteristics of the ADC with single-ended inputs and an internal reference.

**Table 5-30. 12-Bit ADC, Dynamic Performance for Single-Ended Inputs With Internal Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                         | TEST CONDITIONS                                  | MIN | TYP  | MAX | UNIT |
|-----------|-----------------------------------------|--------------------------------------------------|-----|------|-----|------|
| ENOB      | Effective number of bits <sup>(2)</sup> | $V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 9.4 | 10.4 |     | bits |

(1) See Table 5-34 for more information on internal reference performance, and see [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal or external reference.

(2)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

Table 5-31 lists the dynamic performance characteristics of the ADC using a 32.678-kHz clock.

**Table 5-31. 12-Bit ADC, Dynamic Performance With 32.768-kHz Clock**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER |                                         | TEST CONDITIONS                                                                                                                                        | TYP | UNIT |
|-----------|-----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|
| ENOB      | Effective number of bits <sup>(1)</sup> | Reduced performance with $f_{\text{ADC12CLK}}$ from $\text{ACLK}_{\text{LFX}} 32.768\text{ kHz}$ ,<br>$V_{R+} = 2.5\text{ V}$ , $V_{R-} = \text{AVSS}$ | 10  | bits |

(1)  $\text{ENOB} = (\text{SINAD} - 1.76) / 6.02$

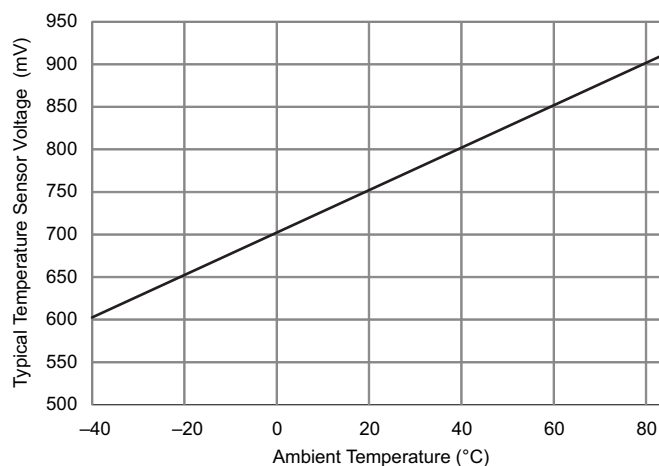
Table 5-32 lists the characteristics of the temperature sensor and built-in  $V_{1/2}$  of the ADC.

**Table 5-32. 12-Bit ADC, Temperature Sensor and Built-In  $V_{1/2}$**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                     |                                                                                          | TEST CONDITIONS                                                         | MIN   | TYP | MAX   | UNIT                 |
|-------------------------------|------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|-------|-----|-------|----------------------|
| $V_{\text{SENSOR}}$           | See <sup>(1)</sup> <sup>(2)</sup> (also see Figure 5-20)                                 | ADC12ON = 1, ADC12TCMAP = 1,<br>$T_A = 0^\circ\text{C}$                 |       | 700 |       | mV                   |
| $TC_{\text{SENSOR}}$          | See <sup>(2)</sup>                                                                       | ADC12ON = 1, ADC12TCMAP = 1                                             |       | 2.5 |       | mV/ $^\circ\text{C}$ |
| $t_{\text{SENSOR(sample)}}$   | Sample time required if ADCTCMAP = 1 and<br>channel (MAX – 1) is selected <sup>(3)</sup> | ADC12ON = 1, ADC12TCMAP = 1,<br>Error of conversion result $\leq 1$ LSB | 30    |     |       | $\mu\text{s}$        |
| $V_{1/2}$                     | AVCC voltage divider for ADC12BATMAP = 1<br>on MAX input channel                         | ADC12ON = 1, ADC12BATMAP = 1                                            | 47.5% | 50% | 52.5% |                      |
| $I_{V\ 1/2}$                  | Current for battery monitor during sample time                                           | ADC12ON = 1, ADC12BATMAP = 1                                            |       | 38  | 63    | $\mu\text{A}$        |
| $t_{V\ 1/2\ (\text{sample})}$ | Sample time required if ADC12BATMAP = 1<br>and channel MAX is selected <sup>(4)</sup>    | ADC12ON = 1, ADC12BATMAP = 1                                            | 1.7   |     |       | $\mu\text{s}$        |

- (1) The temperature sensor offset can be as much as  $\pm 30^\circ\text{C}$ . TI recommends a single-point calibration to minimize the offset error of the built-in temperature sensor.
- (2) The device descriptor structure contains calibration values for  $30^\circ\text{C} \pm 3^\circ\text{C}$  and  $85^\circ\text{C} \pm 3^\circ\text{C}$  for each available reference voltage level. The sensor voltage can be computed as  $V_{\text{SENSE}} = TC_{\text{SENSOR}} \times (\text{Temperature, } ^\circ\text{C}) + V_{\text{SENSOR}}$ , where  $TC_{\text{SENSOR}}$  and  $V_{\text{SENSOR}}$  can be computed from the calibration values for higher accuracy.
- (3) The typical equivalent impedance of the sensor is 250 k $\Omega$ . The sample time required includes the sensor-on time  $t_{\text{SENSOR(on)}}$ .
- (4) The on-time  $t_{V1/2(\text{on})}$  is included in the sampling time  $t_{V1/2(\text{sample})}$ ; no additional on time is needed.



**Figure 5-20. Typical Temperature Sensor Voltage**

Table 5-33 lists the external reference requirements for the ADC.

**Table 5-33. 12-Bit ADC, External Reference<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                      |                                                                                       | TEST CONDITIONS                                                                                                                                                    | MIN | TYP | MAX       | UNIT          |
|--------------------------------|---------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----------|---------------|
| $V_{R+}$                       | Positive external reference voltage input<br>VeREF+ or VeREF- based on ADC12VRSEL bit | $V_{R+} > V_{R-}$                                                                                                                                                  | 1.2 |     | $AV_{CC}$ | V             |
| $V_{R-}$                       | Negative external reference voltage input<br>VeREF+ or VeREF- based on ADC12VRSEL bit | $V_{R+} > V_{R-}$                                                                                                                                                  | 0   |     | 1.2       | V             |
| $V_{R+} - V_{R-}$              | Differential external reference voltage input                                         | $V_{R+} > V_{R-}$                                                                                                                                                  | 1.2 |     | $AV_{CC}$ | V             |
| $I_{VeREF+}$ ,<br>$I_{VeREF-}$ | Static input current, singled-ended input mode                                        | $1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTX = 1h$ ,<br>$ADC12DIF = 0$ , $ADC12PWRMD = 0$  |     |     | $\pm 10$  | $\mu\text{A}$ |
|                                |                                                                                       | $1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTX = 8h$ ,<br>$ADC12DIF = 0$ , $ADC12PWRMD = 01$ |     |     | $\pm 2.5$ |               |
| $I_{VeREF+}$ ,<br>$I_{VeREF-}$ | Static input current, differential input mode                                         | $1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTX = 1h$ ,<br>$ADC12DIF = 1$ , $ADC12PWRMD = 0$  |     |     | $\pm 20$  | $\mu\text{A}$ |
|                                |                                                                                       | $1.2\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $V_{eREF-} = 0\text{ V}$<br>$f_{ADC12CLK} = 5\text{ MHz}$ , $ADC12SHTX = 8h$ ,<br>$ADC12DIF = 1$ , $ADC12PWRMD = 1$  |     |     | $\pm 5$   |               |
| $I_{VeREF+}$                   | Peak input current with single-ended input                                            | $0\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $ADC12DIF = 0$                                                                                                         |     |     | 1.5       | mA            |
| $I_{VeREF+}$                   | Peak input current with differential input                                            | $0\text{ V} \leq V_{eREF+} \leq V_{AVCC}$ , $ADC12DIF = 1$                                                                                                         |     |     | 3         | mA            |
| $C_{VeREF+/-}$                 | Capacitance at VeREF+ or VeREF- terminal                                              | See <sup>(2)</sup>                                                                                                                                                 | 10  |     |           | $\mu\text{F}$ |

- (1) The external reference is used during ADC conversion to charge and discharge the capacitance array. The input capacitance,  $C_i$ , is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 12-bit accuracy.
- (2) Connect two decoupling capacitors, 10  $\mu\text{F}$  and 470 nF, to VeREF to decouple the dynamic current required for an external reference source if it is used for the ADC12\_B. Also see the [MSP430FR58xx](#), [MSP430FR59xx](#), [MSP430FR68xx](#), and [MSP430FR69xx Family User's Guide](#).

### 5.13.5.6 Reference

Table 5-34 lists the characteristics of the built-in voltage reference.

**Table 5-34. REF, Built-In Reference**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                  | TEST CONDITIONS                                            | V <sub>CC</sub>                                                                                                                                        | MIN   | TYP   | MAX   | UNIT  |
|--------------------------------------------|------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|-------|-------|
| V <sub>REF+</sub>                          | Positive built-in reference voltage output                 | REFVSEL = {2} for 2.5 V, REFON = 1                                                                                                                     | 2.7 V | 2.5   | ±1.5% | V     |
|                                            |                                                            | REFVSEL = {1} for 2.0 V, REFON = 1                                                                                                                     | 2.2 V | 2.0   | ±1.5% |       |
|                                            |                                                            | REFVSEL = {0} for 1.2 V, REFON = 1                                                                                                                     | 1.8 V | 1.2   | ±1.8% |       |
| Noise                                      | RMS noise at VREF <sup>(1)</sup>                           | From 0.1 Hz to 10 Hz, REFVSEL = {0}                                                                                                                    |       | 110   | 600   | μV    |
| V <sub>OS_BUF_INT</sub>                    | VREF ADC BUF_INT buffer offset <sup>(2)</sup>              | T <sub>A</sub> = 25°C, ADC ON, REFVSEL = {0}, REFON = 1, REFOUT = 0                                                                                    |       | –12   | +12   | mV    |
| V <sub>OS_BUF_EXT</sub>                    | VREF ADC BUF_EXT buffer offset <sup>(2)</sup>              | T <sub>A</sub> = 25°C, REFVSEL = {0}, REFOUT = 1, REFON = 1 or ADC ON                                                                                  |       | –12   | +12   | mV    |
| AV <sub>CC(min)</sub>                      | AVCC minimum voltage, Positive built-in reference active   | REFVSEL = {0} for 1.2 V                                                                                                                                |       | 1.8   |       | V     |
|                                            |                                                            | REFVSEL = {1} for 2.0 V                                                                                                                                |       | 2.2   |       |       |
|                                            |                                                            | REFVSEL = {2} for 2.5 V                                                                                                                                |       | 2.7   |       |       |
| I <sub>REF+</sub>                          | Operating supply current into AVCC terminal <sup>(3)</sup> | REFON = 1                                                                                                                                              | 3 V   | 8     | 15    | μA    |
| I <sub>REF+_ADC_BUF</sub>                  | Operating supply current into AVCC terminal <sup>(3)</sup> | ADC ON, REFOUT = 0, REFVSEL = {0, 1, 2}, ADC12PWRMD = 0,                                                                                               | 3 V   | 225   | 355   | μA    |
|                                            |                                                            | ADC ON, REFOUT = 1, REFVSEL = {0, 1, 2}, ADC12PWRMD = 0                                                                                                |       | 1030  | 1660  |       |
|                                            |                                                            | ADC ON, REFOUT = 0, REFVSEL = {0, 1, 2}, ADC12PWRMD = 1                                                                                                |       | 120   | 185   |       |
|                                            |                                                            | ADC ON, REFOUT = 1, REFVSEL = {0, 1, 2}, ADC12PWRMD = 1                                                                                                |       | 545   | 895   |       |
|                                            |                                                            | ADC OFF, REFON = 1, REFOUT = 1, REFVSEL = {0, 1, 2}                                                                                                    |       | 1085  | 1780  |       |
| I <sub>O(VREF+)</sub>                      | VREF maximum load current, VREF+ terminal                  | REFVSEL = {0, 1, 2}, AVCC = AVCC(min) for each reference level, REFON = REFOUT = 1                                                                     |       | –1000 | +10   | μA    |
| ΔV <sub>out</sub> /ΔI <sub>O</sub> (VREF+) | Load-current regulation, VREF+ terminal                    | REFVSEL = {0, 1, 2}, I <sub>O(VREF+)</sub> = +10 μA or –1000 μA, AV <sub>CC</sub> = AV <sub>CC(min)</sub> for each reference level, REFON = REFOUT = 1 |       |       | 2500  | μV/mA |
| C <sub>VREF+/-</sub>                       | Capacitance at VREF+ and VREF- terminals                   | REFON = REFOUT = 1                                                                                                                                     |       | 0     | 100   | pF    |
| TC <sub>REF+</sub>                         | Temperature coefficient of built-in reference              | REFVSEL = {0, 1, 2}, REFON = REFOUT = 1, T <sub>A</sub> = –40°C to 85°C <sup>(4)</sup>                                                                 |       | 18    | 50    | ppm/K |
| PSRR <sub>DC</sub>                         | Power supply rejection ratio (DC)                          | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> , T <sub>A</sub> = 25°C, REFVSEL = {0, 1, 2}, REFON = REFOUT = 1                     |       | 120   | 400   | μV/V  |
| PSRR <sub>AC</sub>                         | Power supply rejection ratio (AC)                          | dAV <sub>CC</sub> = 0.1 V at 1 kHz                                                                                                                     |       | 3.0   |       | mV/V  |
| t <sub>SETTLE</sub>                        | Settling time of reference voltage <sup>(5)</sup>          | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> , REFVSEL = {0, 1, 2}, REFON = 0 → 1                                                 |       | 75    | 80    | μs    |

(1) Internal reference noise affects ADC performance when ADC uses internal reference. See [Designing With the MSP430FR59xx and MSP430FR58xx ADC](#) for details on optimizing ADC performance for your application with the choice of internal versus external reference.

(2) Buffer offset affects ADC gain error and thus total unadjusted error.

(3) The internal reference current is supplied through the AVCC terminal.

(4) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C)).

(5) The condition is that the error in a conversion started after t<sub>REFON</sub> is less than ±0.5 LSB.

### 5.13.5.7 Comparator

Table 5-35 lists the characteristics of the comparator.

**Table 5-35. Comparator\_E**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                                                   | TEST CONDITIONS                                                                         | V <sub>CC</sub> | MIN                  | TYP                | MAX                  | UNIT |    |
|--------------------------|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-----------------|----------------------|--------------------|----------------------|------|----|
| I <sub>AVCC_COMP</sub>   | Comparator operating supply current into AVCC, excludes reference resistor ladder | CEPWRMD = 00, CEON = 1, CERSx = 00 (fast)                                               | 2.2 V, 3.0 V    | 11                   |                    | 20                   | μA   |    |
|                          |                                                                                   | CEPWRMD = 01, CEON = 1, CERSx = 00 (medium)                                             |                 | 9                    | 17                 |                      |      |    |
|                          |                                                                                   | CEPWRMD = 10, CEON = 1, CERSx = 00 (slow), T <sub>A</sub> = 30°C                        |                 |                      | 0.5                |                      |      |    |
|                          |                                                                                   | CEPWRMD = 10, CEON = 1, CERSx = 00 (slow), T <sub>A</sub> = 85°C                        |                 |                      | 1.3                |                      |      |    |
| I <sub>AVCC_REF</sub>    | Quiescent current of resistor ladder into AVCC, including REF module current      | CEREFLx = 01, CERSx = 10, REFON = 0, CEON = 0, CEREFAcc = 0                             | 2.2 V, 3.0 V    | 12                   |                    | 15                   | μA   |    |
|                          |                                                                                   | CEREFLx = 01, CERSx = 10, REFON = 0, CEON = 0, CEREFAcc = 1                             |                 | 5                    | 7                  |                      |      |    |
| V <sub>REF</sub>         | Reference voltage level                                                           | CERSx = 11, CEREFLx = 01, CEREFAcc = 0                                                  | 1.8 V           | 1.17                 | 1.2                | 1.23                 | V    |    |
|                          |                                                                                   | CERSx = 11, CEREFLx = 10, CEREFAcc = 0                                                  | 2.2 V           | 1.92                 | 2.0                | 2.08                 |      |    |
|                          |                                                                                   | CERSx = 11, CEREFLx = 11, CEREFAcc = 0                                                  | 2.7 V           | 2.40                 | 2.5                | 2.60                 |      |    |
|                          |                                                                                   | CERSx = 11, CEREFLx = 01, CEREFAcc = 1                                                  | 1.8 V           | 1.10                 | 1.2                | 1.245                |      |    |
|                          |                                                                                   | CERSx = 11, CEREFLx = 10, CEREFAcc = 1                                                  | 2.2 V           | 1.90                 | 2.0                | 2.08                 |      |    |
|                          |                                                                                   | CERSx = 11, CEREFLx = 11, CEREFAcc = 1                                                  | 2.7 V           | 2.35                 | 2.5                | 2.60                 |      |    |
| V <sub>IC</sub>          | Common-mode input range                                                           |                                                                                         |                 | 0                    |                    | V <sub>CC</sub> – 1  | V    |    |
| V <sub>OFFSET</sub>      | Input offset voltage                                                              | CEPWRMD = 00                                                                            |                 | –32                  |                    | 32                   | mV   |    |
|                          |                                                                                   | CEPWRMD = 01                                                                            |                 | –32                  |                    | 32                   |      |    |
|                          |                                                                                   | CEPWRMD = 10                                                                            |                 | –30                  |                    | 30                   |      |    |
| C <sub>IN</sub>          | Input capacitance                                                                 | CEPWRMD = 00 or CEPWRMD = 01                                                            |                 | 9                    |                    |                      | pF   |    |
|                          |                                                                                   | CEPWRMD = 10                                                                            |                 | 9                    |                    |                      |      |    |
| R <sub>SIN</sub>         | Series input resistance                                                           | On (switch closed)                                                                      |                 | 1                    |                    | 3                    | kΩ   |    |
|                          |                                                                                   | Off (switch open)                                                                       |                 | 50                   |                    |                      | MΩ   |    |
| t <sub>PD</sub>          | Propagation delay, response time                                                  | CEPWRMD = 00, CEF = 0, Overdrive ≥ 20 mV                                                |                 | 260                  |                    | 330                  | ns   |    |
|                          |                                                                                   | CEPWRMD = 01, CEF = 0, Overdrive ≥ 20 mV                                                |                 | 350                  |                    | 460                  |      |    |
|                          |                                                                                   | CEPWRMD = 10, CEF = 0, Overdrive ≥ 20 mV                                                |                 |                      |                    | 15                   | μs   |    |
| t <sub>PD,filter</sub>   | Propagation delay with filter active                                              | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLY = 00                             |                 | 700                  |                    | 1000                 | ns   |    |
|                          |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLY = 01                             |                 | 1.0                  |                    | 1.8                  |      | μs |
|                          |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLY = 10                             |                 | 2.0                  |                    | 3.5                  |      |    |
|                          |                                                                                   | CEPWRMD = 00 or 01, CEF = 1, Overdrive ≥ 20 mV, CEFDLY = 11                             |                 | 4.0                  |                    | 7.0                  |      |    |
| t <sub>EN_CMP</sub>      | Comparator enable time                                                            | CEON = 0 → 1, VIN+, VIN- from pins, Overdrive ≥ 20 mV, CEPWRMD = 00                     |                 | 0.9                  |                    | 1.5                  | μs   |    |
|                          |                                                                                   | CEON = 0 → 1, VIN+, VIN- from pins, Overdrive ≥ 20 mV, CEPWRMD = 01                     |                 | 0.9                  |                    | 1.5                  |      |    |
|                          |                                                                                   | CEON = 0 → 1, VIN+, VIN- from pins, Overdrive ≥ 20 mV, CEPWRMD = 10                     |                 | 15                   |                    | 100                  |      |    |
| t <sub>EN_CMP_VREF</sub> | Comparator and reference ladder and reference voltage enable time                 | CEON = 0 → 1, CEREFLx = 10, CERSx = 10 or 11, CEREFO = CEREFL = 0x0F, Overdrive ≥ 20 mV |                 | 350                  |                    | 1500                 | μs   |    |
| V <sub>CE_REF</sub>      | Reference voltage for a given tap                                                 | VIN = reference into resistor ladder, n = 0 to 31                                       |                 | VIN × (n + 0.5) / 32 | VIN × (n + 1) / 32 | VIN × (n + 1.5) / 32 | V    |    |

### 5.13.5.8 Scan Interface

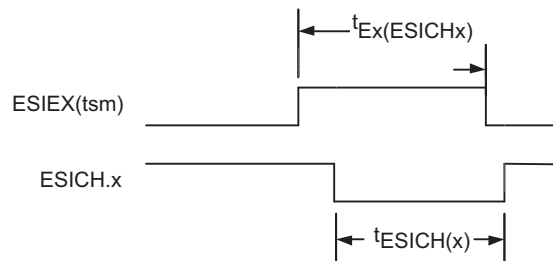
Table 5-36 lists the port timing characteristics of the ESI.

**Table 5-36. Extended Scan Interface, Port Drive, Port Timing**

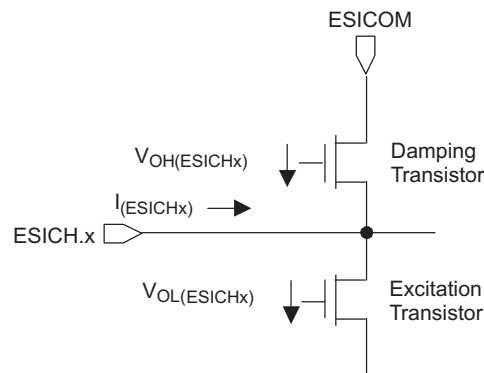
over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                       | TEST CONDITIONS                                                                          | V <sub>CC</sub>                 | MIN | TYP | MAX | UNIT |
|---------------------------------|------------------------------------------------------------------------------------------|---------------------------------|-----|-----|-----|------|
| V <sub>OL</sub> (ESICHx)        | Voltage drop due to ON-resistance of excitation transistor (see Figure 5-21)             | I(ESICHx) = 2 mA, ESITEN = 1    |     |     | 0.3 | V    |
| V <sub>OH</sub> (ESICHx)        | Voltage drop due to ON-resistance of damping transistor <sup>(1)</sup> (see Figure 5-21) | I(ESICHx) = –200 μA, ESITEN = 1 |     |     | 0.1 | V    |
| V <sub>OL</sub> (ESICOM)        |                                                                                          | I(ESICOM) = 3 mA, ESISH = 1     | 0   |     | 0.1 | V    |
| I <sub>ESICHx</sub> (tri-state) | V(ESICHx) = 0 V to AV <sub>CC</sub> , port function disabled, ESISH = 1                  | 3 V                             | –50 |     | 50  | nA   |

(1) ESICOM = 1.5 V, supplied externally (see Figure 5-22)



**Figure 5-21. P6.x/ESICHx Timing, ESICHx Function Selected**



**Figure 5-22. Voltage Drop Due to ON-Resistance**

Table 5-37 lists the sample timing of the ESI.

**Table 5-37. Extended Scan Interface, Sample Capacitor/Ri Timing <sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                             | TEST CONDITIONS                                                                                                | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| C <sub>SHC(ESICHx)</sub><br>Sample capacitance on selected ESICHx pin | ESIEx(tsm) = 1, ESISH = 1                                                                                      | 2.2 V, 3 V      |     | 7   | 9   | pF   |
| R <sub>i(ESICHx)</sub><br>Serial input resistance at the ESICHx pin   | ESIEx(tsm) = 1, ESISH = 1                                                                                      | 2.2 V, 3 V      |     | 1.5 |     | kΩ   |
| t <sub>Hold</sub><br>Maximum hold time <sup>(2)</sup>                 | ESISHTSM <sup>(3)</sup> = 1, measurement sequence uses at least two ESICHx inputs, ΔV <sub>sample</sub> < 3 mV |                 | 62  |     |     | μs   |

- (1) The minimum sampling time (7.6 tau for 1/2 LSB accuracy) with maximum C<sub>SHC(ESICHx)</sub> and R<sub>i(ESICHx)</sub> and R<sub>i(source)</sub> is t<sub>sample(min)</sub> ≈ 7.6 × C<sub>SHC(ESICHx)</sub> × (R<sub>i(ESICHx)</sub> + R<sub>i(source)</sub>) with R<sub>i(source)</sub> estimated at 3 kΩ, t<sub>sample(min)</sub> = 319 ns.  
(2) The sampled voltage at the sample capacitance varies less than 3 mV (ΔV<sub>sample</sub>) during the hold time t<sub>Hold</sub>. If the voltage is sampled after t<sub>Hold</sub>, the sampled voltage may be any other value.  
(3) The control bit ESIVSS was renamed to ESISHTSM to avoid confusion with supply pin naming.

Table 5-38 lists the characteristics of the ESI V<sub>CC</sub>/2 generator.

**Table 5-38. Extended Scan Interface, V<sub>CC</sub>/2 Generator**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                                                                                | TEST CONDITIONS                                                                                                                                                  | V <sub>CC</sub> | MIN                         | TYP                  | MAX                         | UNIT |
|--------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----------------------------|----------------------|-----------------------------|------|
| V <sub>CC</sub><br>ESI V <sub>CC</sub> /2 generator supply voltage                                                       | AVCC = DVCC = ESIDVCC (connected together), AVSS = DVSS = ESIDVSS (connected together)                                                                           |                 | 2.2                         |                      | 3.6                         | V    |
| I <sub>VMID</sub><br>ESI V <sub>CC</sub> /2 generator quiescent current                                                  | C <sub>L</sub> at ESICOM pin = 470 nF ±20%,<br>f <sub>refresh(ESICOM)</sub> = 32768 Hz,<br>T = 0°C to 85°C,<br>R <sub>ext</sub> = 1k in series to C <sub>L</sub> | 2.2 V, 3 V      |                             | 370                  | 500                         | nA   |
|                                                                                                                          | C <sub>L</sub> at ESICOM pin = 470 nF ±20%,<br>f <sub>refresh(ESICOM)</sub> = 32768 Hz,<br>T = -40°C to 85°C                                                     |                 |                             | 370                  | 1600                        |      |
| f <sub>refresh(ESICOM)</sub><br>V <sub>CC</sub> /2 refresh frequency                                                     | Source clock = ACLK                                                                                                                                              | 2.2 V, 3 V      |                             | 32.768               |                             | kHz  |
| V <sub>(ESICOM)</sub><br>Output voltage at pin ESICOM                                                                    | C <sub>L</sub> at ESICOM pin = 470 nF ±20%,<br>I <sub>Load</sub> = 1 μA                                                                                          |                 | AV <sub>CC</sub> / 2 - 0.07 | AV <sub>CC</sub> / 2 | AV <sub>CC</sub> / 2 + 0.07 | V    |
| t <sub>on(ESICOM)</sub><br>Time to reach 98% after V <sub>CC</sub> / 2 is switched on                                    | C <sub>L</sub> at ESICOM pin = 470 nF ±20%,<br>f <sub>refresh(ESICOM)</sub> = 32768 Hz                                                                           | 2.2 V, 3 V      |                             | 1.7                  | 6                           | ms   |
| t <sub>VCCSettle(ESICOM)</sub><br>Settling time to ±V <sub>CC</sub> / 2560 (2 LSB) after AV <sub>CC</sub> voltage change | ESIEN = 1, ESIVMIDEN <sup>(1)</sup> = 1,<br>ESISH = 0, AV <sub>CC</sub> = AV <sub>CC</sub> -100 mV,<br>f <sub>refresh(ESICOM)</sub> = 32768 Hz                   | 2.2 V, 3 V      |                             | 3                    |                             | ms   |
|                                                                                                                          | AV <sub>CC</sub> = AV <sub>CC</sub> + 100 mV,<br>f <sub>refresh(ESICOM)</sub> = 32768 Hz                                                                         | 2.2 V, 3 V      |                             | 3                    |                             |      |

- (1) The control bit ESIVCC2 was renamed to ESIVMIDEN to avoid confusion with supply pin naming.

Table 5-39 lists the characteristics of the ESI DAC.

**Table 5-39. Extended Scan Interface, 12-Bit DAC**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                    | TEST CONDITIONS                                                           | V <sub>CC</sub>                                                                           | MIN | TYP | MAX  | UNIT |
|------------------------------|---------------------------------------------------------------------------|-------------------------------------------------------------------------------------------|-----|-----|------|------|
| V <sub>CC</sub>              | ESI DAC supply voltage                                                    | ESIDVCC = AVCC = DVCC (connected together),<br>ESIDVSS = AVSS = DVSS (connected together) | 2.2 |     | 3.6  | V    |
| I <sub>CC</sub>              | ESI 12-bit DAC operating supply current into AVCC terminal <sup>(1)</sup> | 2.2 V                                                                                     | 10  |     | 27   | μA   |
|                              |                                                                           | 3 V                                                                                       | 14  |     | 35   |      |
|                              | Resolution                                                                |                                                                                           | 12  |     |      | bit  |
| INL                          | Integral nonlinearity                                                     | R <sub>L</sub> = 1000 MΩ, C <sub>L</sub> = 20 pF<br>With autozeroing                      | –10 | ±2  | +10  | LSB  |
| DNL                          | Differential nonlinearity                                                 | R <sub>L</sub> = 1000 MΩ, C <sub>L</sub> = 20 pF,<br>Without autozeroing                  | –10 |     | +10  | LSB  |
|                              |                                                                           | R <sub>L</sub> = 1000 MΩ, C <sub>L</sub> = 20 pF,<br>With autozeroing                     | –10 |     | +10  | LSB  |
| E <sub>OS</sub>              | Offset error                                                              | With autozeroing                                                                          |     | 0   |      | V    |
| E <sub>G</sub>               | Gain error                                                                | With autozeroing                                                                          |     |     | 0.6% |      |
| t <sub>on</sub> (ESIDAC)     | On time after AV <sub>CC</sub> of ESIDAC is switched on                   | V <sub>+ESICA</sub> – V <sub>ESIDAC</sub> = ±6 mV                                         |     |     | 2    | μs   |
| t <sub>Settle</sub> (ESIDAC) | Settling time                                                             | ESIDAC code = 0h → A0h                                                                    |     |     | 2    | μs   |
|                              |                                                                           | ESIDAC code = A0h → 0h                                                                    |     |     | 2    | μs   |

(1) This parameter covers one ESI 12-bit DAC, either ESI AFE1 12-bit DAC or ESI AFE2 12-bit DAC.

Table 5-40 lists the characteristics of the ESI comparator.

**Table 5-40. Extended Scan Interface, Comparator**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                              | TEST CONDITIONS                                                                  | V <sub>CC</sub>                                                                                            | MIN  | TYP | MAX                 | UNIT  |
|----------------------------------------|----------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------|------|-----|---------------------|-------|
| V <sub>CC</sub>                        | ESI comparator supply voltage                                                    | ESIDVCC = AVCC = DVCC (connected together),<br>ESIDVSS = AVSS = DVSS (connected together)                  | 2.2  |     | 3.6                 | V     |
| I <sub>CC</sub>                        | ESI comparator operating supply current into AVCC terminal <sup>(1)</sup>        | 2.2 V, 3 V                                                                                                 |      | 25  | 42                  | μA    |
| V <sub>IC</sub>                        | Common-mode input voltage range <sup>(2)</sup>                                   | 2.2 V, 3 V                                                                                                 | 0    |     | V <sub>CC</sub> – 1 | V     |
| V <sub>Offset</sub>                    | Input offset voltage                                                             | After autozeroing                                                                                          | –1.5 |     | 1.5                 | mV    |
| dV <sub>Offset</sub> /dT               | Temperature coefficient of V <sub>Offset</sub> <sup>(3)</sup>                    | Without autozeroing                                                                                        |      | 40  |                     | μV/°C |
|                                        |                                                                                  | After autozeroing                                                                                          |      | 2   |                     |       |
| dV <sub>Offset</sub> /dV <sub>CC</sub> | V <sub>Offset</sub> supply voltage (V <sub>CC</sub> ) sensitivity <sup>(4)</sup> | Without autozeroing                                                                                        |      | 0.3 |                     | mV/V  |
|                                        |                                                                                  | After autozeroing                                                                                          |      | 0.2 |                     |       |
| V <sub>hys</sub>                       | Input voltage hysteresis                                                         | V <sub>+</sub> terminal = V <sub>–</sub> terminal = 0.5 × V <sub>CC</sub>                                  |      | 0.5 |                     | LSB   |
| t <sub>on</sub> (ESICA)                | On time after ESICA is switched on                                               | V <sub>+ESICA</sub> – V <sub>ESIDAC</sub> = +6 mV,<br>V <sub>+ESICA</sub> = 0.5 × AV <sub>CC</sub>         |      |     | 2.0                 | μs    |
| t <sub>Settle</sub> (ESICA)            | Settle time                                                                      | V <sub>+ESICA</sub> – V <sub>ESIDAC</sub> = –12 mV → 6 mV,<br>V <sub>+ESICA</sub> = 0.5 × AV <sub>CC</sub> |      |     | 3.0                 | μs    |
| t <sub>autozero</sub>                  | Autozeroing time of comparator                                                   | V <sub>input</sub> = V <sub>CC</sub> / 2,<br> V <sub>offset</sub>   < 1 mV                                 |      |     | 3.0                 | μs    |

(1) This parameter covers one single ESI comparator; either ESI AFE1 comparator or ESI AFE2 comparator.

(2) The comparator output is reliable when at least one of the input signals is within the common-mode input voltage range.

(3) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C))

(4) Calculated using the box method: ABS((V<sub>offset\_Vcc\_max</sub> – V<sub>offset\_Vcc\_min</sub>)/(V<sub>cc\_max</sub> – V<sub>cc\_min</sub>))

Table 5-41 lists the characteristics of the ESI oscillator and clock.

**Table 5-41. Extended Scan Interface, ESICLK Oscillator and TSM Clock Signals**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                             | TEST CONDITIONS                                      | V <sub>CC</sub>                                                                                 | MIN        | TYP    | MAX | UNIT |
|---------------------------------------|------------------------------------------------------|-------------------------------------------------------------------------------------------------|------------|--------|-----|------|
| V <sub>CC</sub>                       | ESI oscillator supply voltage                        | ESIDVCC = AVCC = DVCC (connected together), ESIDVSS = AVSS = DVSS (connected together)          | 2.2        |        | 3.6 | V    |
| I <sub>CC</sub>                       | ESI oscillator operating supply current              | f <sub>ESIOSC</sub> = 4.8 MHz, ESIDIV1x = 00b, ESICLKON = 1, ESIEN = 1, no TSM sequence running | 2.2 V      | 45     |     | μA   |
|                                       |                                                      | 3 V                                                                                             |            | 50     |     |      |
| f <sub>ESIOSC_min</sub>               | ESI oscillator at minimum setting                    | T <sub>A</sub> = 30°C, ESICLK FQ = 000000                                                       |            | 2.3    |     | MHz  |
| f <sub>ESIOSC_max</sub>               | ESI oscillator at maximum setting                    | T <sub>A</sub> = 30°C, ESICLK FQ = 111111                                                       |            | 7.9    |     | MHz  |
| t <sub>on</sub> (ESIOSC)              | Start-up time including synchronization cycles       | f <sub>ESIOSC</sub> = 4.8 MHz                                                                   | 2.2 V, 3 V | 400    | 700 | ns   |
| f <sub>ESIOSC</sub> /dT               | ESIOSC frequency temperature drift <sup>(1)</sup>    | f <sub>ESIOSC</sub> = 4.8 MHz                                                                   | 2.2 V, 3 V | 0.15   |     | %/°C |
| f <sub>ESIOSC</sub> /dV <sub>CC</sub> | ESIOSC frequency supply voltage drift <sup>(2)</sup> | f <sub>ESIOSC</sub> = 4.8 MHz                                                                   | 2.2 V, 3 V | 2      |     | %/V  |
| f <sub>ESILCLK</sub>                  | TSM low-frequency state clock                        |                                                                                                 |            | 32.768 | 50  | kHz  |
| f <sub>ESIHCLK</sub>                  | TSM high-frequency state clock                       |                                                                                                 | 0.25       |        | 8   | MHz  |

(1) Calculated using the box method: (MAX(–40 to 85°C) – MIN(–40 to 85°C)) / MIN(–40 to 85°C) / (85°C – (–40°C))

(2) Calculated using the box method: (MAX(2.2 V to 3.6 V) – MIN(2.2 V to 3.6 V)) / MIN(2.2 V to 3.6 V) / (3.6 V – 2.2 V)

### 5.13.5.9 FRAM Controller

Table 5-42 lists the characteristics of the FRAM.

**Table 5-42. FRAM**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                            | TEST CONDITIONS       | MIN              | TYP                                    | MAX | UNIT   |
|--------------------------|----------------------------|-----------------------|------------------|----------------------------------------|-----|--------|
| Read and write endurance |                            |                       | 10 <sup>15</sup> |                                        |     | cycles |
| t <sub>Retention</sub>   | Data retention duration    | T <sub>J</sub> = 25°C | 100              |                                        |     | years  |
|                          |                            | T <sub>J</sub> = 70°C | 40               |                                        |     |        |
|                          |                            | T <sub>J</sub> = 85°C | 10               |                                        |     |        |
| I <sub>WRITE</sub>       | Current to write into FRAM |                       |                  | I <sub>READ</sub> <sup>(1)</sup>       |     | nA     |
| I <sub>ERASE</sub>       | Erase current              |                       |                  | n/a <sup>(2)</sup>                     |     | nA     |
| t <sub>WRITE</sub>       | Write time                 |                       |                  | t <sub>READ</sub> <sup>(3)</sup>       |     | ns     |
| t <sub>READ</sub>        | Read time                  | NWAITSx = 0           |                  | 1 / f <sub>SYSTEM</sub> <sup>(4)</sup> |     | ns     |
|                          |                            | NWAITSx = 1           |                  | 2 / f <sub>SYSTEM</sub> <sup>(4)</sup> |     |        |

- (1) Writing to FRAM does not require a setup sequence or additional power when compared to reading from FRAM. The FRAM read current I<sub>READ</sub> is included in the active mode current consumption numbers I<sub>AM,FRAM</sub>.
- (2) FRAM does not require a special erase sequence.
- (3) Writing into FRAM is as fast as reading.
- (4) The maximum read (and write) speed is specified by f<sub>SYSTEM</sub> using the appropriate wait state settings (NWAITSx).

### 5.13.6 Emulation and Debug

Table 5-43 lists the characteristics of the JTAG and Spy-Bi-Wire interface.

**Table 5-43. JTAG and Spy-Bi-Wire Interface**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                       |                                                                                                                         | TEST CONDITIONS | MIN  | TYP | MAX | UNIT |
|---------------------------------|-------------------------------------------------------------------------------------------------------------------------|-----------------|------|-----|-----|------|
| I <sub>JTAG</sub>               | Supply current adder when JTAG active (but not clocked)                                                                 | 2.2 V, 3.0 V    |      | 40  | 100 | μA   |
| f <sub>SBW</sub>                | Spy-Bi-Wire input frequency                                                                                             | 2.2 V, 3.0 V    | 0    |     | 10  | MHz  |
| t <sub>SBW,Low</sub>            | Spy-Bi-Wire low clock pulse duration                                                                                    | 2.2 V, 3.0 V    | 0.04 |     | 15  | μs   |
| t <sub>SBW,En</sub>             | Spy-Bi-Wire enable time (TEST high to acceptance of first clock edge) <sup>(1)</sup>                                    | 2.2 V, 3.0 V    |      |     | 110 | μs   |
| t <sub>SBW,Rst</sub>            | Spy-Bi-Wire return to normal operation time                                                                             |                 | 15   |     | 100 | μs   |
| f <sub>TCK</sub>                | TCK input frequency, 4-wire JTAG <sup>(2)</sup>                                                                         | 2.2 V           | 0    |     | 16  | MHz  |
|                                 |                                                                                                                         | 3.0 V           | 0    |     | 16  | MHz  |
| R <sub>internal</sub>           | Internal pulldown resistance on TEST                                                                                    | 2.2 V, 3.0 V    | 20   | 35  | 50  | kΩ   |
| f <sub>TCLK</sub>               | TCLK/MCLK frequency during JTAG access, no FRAM access (limited by f <sub>SYSTEM</sub> )                                |                 |      |     | 16  | MHz  |
| t <sub>TCLK,Low/High</sub>      | TCLK low or high clock pulse duration, no FRAM access                                                                   |                 |      |     | 25  | ns   |
| f <sub>TCLK,FRAM</sub>          | TCLK/MCLK frequency during JTAG access, including FRAM access (limited by f <sub>SYSTEM</sub> with no FRAM wait states) |                 |      |     | 4   | MHz  |
| t <sub>TCLK,FRAM,Low/High</sub> | TCLK low or high clock pulse duration, including FRAM accesses                                                          |                 |      |     | 100 | ns   |

- (1) Tools that access the Spy-Bi-Wire and BSL interfaces must wait for the t<sub>SBW,En</sub> time after the first transition of the TEST/SBW<sub>TCK</sub> pin (low to high), before the second transition of the pin (high to low) during the entry sequence.
- (2) f<sub>TCK</sub> may be restricted to meet the timing requirements of the module selected.

## 6 Detailed Description

### 6.1 Overview

The TI MSP430FR688x and MSP430FR588x families of ultra-low-power microcontrollers consists of several devices featuring different sets of peripherals. The architecture, combined with seven low-power modes, is optimized to achieve extended battery life for example in flow metering applications. The devices features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency.

The MSP430FR688x and MSP430FR588x devices are microcontroller configurations with an extended scan interface (ESI) for background water, heat and gas volume metering together with up to five 16-bit timers, a comparator, eUSCs that support UART, SPI, and I<sup>2</sup>C, a hardware multiplier, DMA, an RTC module with alarm capabilities, up to 83 I/O pins, and a high-performance 12-bit ADC. The MSP430FR698x devices also include an LCD module with contrast control for displays with up to 320 segments.

### 6.2 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers.

Peripherals are connected to the CPU using data, address, and control buses. Peripherals can be managed with all instructions.

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data.

### 6.3 Operating Modes

The MSP430FR688x(1) and MSP430FR588x(1) MCUs have one active mode and seven software selectable low-power modes of operation (see [Table 6-1](#)). An interrupt event can wake up the device from a low-power mode (LPM0 to LPM4), service the request, and restore back to the low-power mode on return from the interrupt program. Low-power modes LPM3.5 and LPM4.5 disable the core supply to minimize power consumption.

**Table 6-1. Operating Modes**

| MODE                                                  | AM                                             |                                    | LPM0                                           | LPM1                                           | LPM2                                 | LPM3                                 | LPM4                                 | LPM3.5              | LPM4.5               |                         |
|-------------------------------------------------------|------------------------------------------------|------------------------------------|------------------------------------------------|------------------------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|---------------------|----------------------|-------------------------|
|                                                       | ACTIVE                                         | ACTIVE,<br>FRAM OFF <sup>(1)</sup> | CPU OFF <sup>(2)</sup>                         | CPU OFF                                        | STANDBY                              | STANDBY                              | OFF                                  | RTC ONLY            | SHUTDOWN<br>WITH SVS | SHUTDOWN<br>WITHOUT SVS |
| Maximum system clock                                  | 16 MHz                                         |                                    | 16 MHz                                         | 16 MHz                                         | 50 kHz                               | 50 kHz                               | 0 <sup>(3)</sup>                     | 50 kHz              | 0 <sup>(3)</sup>     |                         |
| Typical current consumption,<br>T <sub>A</sub> = 25°C | 103 µA/MHz                                     | 65 µA/MHz                          | 75 µA at 1 MHz                                 | 40 µA at 1 MHz                                 | 0.9 µA                               | 0.4 µA                               | 0.3 µA                               | 0.35 µA             | 0.2 µA               | 0.02 µA                 |
| Typical wake-up time                                  | N/A                                            |                                    | instant.                                       | 6 µs                                           | 6 µs                                 | 7 µs                                 | 7 µs                                 | 250 µs              | 250 µs               | 1000 µs                 |
| Wake-up events                                        | N/A                                            |                                    | all                                            | all                                            | LF<br>I/O<br>Comp                    | LF<br>I/O<br>Comp                    | I/O<br>Comp                          | RTC<br>I/O          | I/O                  |                         |
| CPU                                                   | on                                             |                                    | off                                            | off                                            | off                                  | off                                  | off                                  | reset               | reset                |                         |
| FRAM                                                  | on                                             | off <sup>(1)</sup>                 | standby (or off <sup>(1)</sup> )               | off                                            | off                                  | off                                  | off                                  | off                 | off                  |                         |
| High-frequency peripherals <sup>(4)</sup>             | available                                      |                                    | available                                      | available                                      | off                                  | off                                  | off                                  | reset               | reset                |                         |
| Low-frequency peripherals <sup>(4)</sup>              | available                                      |                                    | available                                      | available                                      | available                            | available <sup>(5)</sup>             | off                                  | RTC                 | reset                |                         |
| Unclocked peripherals <sup>(4)</sup>                  | available                                      |                                    | available                                      | available                                      | available                            | available <sup>(5)</sup>             | available <sup>(5)</sup>             | reset               | reset                |                         |
| MCLK                                                  | on<br>(16MHz <sub>MAX</sub> )                  |                                    | off                                            | off                                            | off                                  | off                                  | off                                  | off                 | off                  |                         |
| SMCLK                                                 | opt. <sup>(6)</sup><br>(16MHz <sub>MAX</sub> ) |                                    | opt. <sup>(6)</sup><br>(16MHz <sub>MAX</sub> ) | opt. <sup>(6)</sup><br>(16MHz <sub>MAX</sub> ) | off                                  | off                                  | off                                  | off                 | off                  |                         |
| ACLK                                                  | on<br>(50 kHz <sub>MAX</sub> )                 |                                    | on<br>(50 kHz <sub>MAX</sub> )                 | on<br>(50 kHz <sub>MAX</sub> )                 | on<br>(50 kHz <sub>MAX</sub> )       | on<br>(50 kHz <sub>MAX</sub> )       | off                                  | off                 | off                  |                         |
| External clock                                        | optional<br>(16MHz <sub>MAX</sub> )            |                                    | optional<br>(16MHz <sub>MAX</sub> )            | optional<br>(16MHz <sub>MAX</sub> )            | optional<br>(50 kHz <sub>MAX</sub> ) | optional<br>(50 kHz <sub>MAX</sub> ) | optional<br>(50 kHz <sub>MAX</sub> ) | off                 | off                  |                         |
| Full retention                                        | yes                                            |                                    | yes                                            | yes                                            | yes                                  | yes <sup>(7)</sup>                   | yes <sup>(7)</sup>                   | no                  | no                   |                         |
| SVS                                                   | always                                         |                                    | always                                         | always                                         | opt. <sup>(8)</sup>                  | opt. <sup>(8)</sup>                  | opt. <sup>(8)</sup>                  | opt. <sup>(8)</sup> | on <sup>(9)</sup>    | off <sup>(10)</sup>     |
| Brownout                                              | always                                         |                                    | always                                         | always                                         | always                               | always                               | always                               | always              | always               |                         |

(1) FRAM disabled in FRAM controller

(2) Disabling the FRAM through the FRAM controller decreases the LPM current consumption, but the wake-up time can increase. If the wake-up is for FRAM access (for example, to fetch an interrupt vector), wake-up time is increased. If the wake-up is for an operation other than FRAM access (for example, DMA transfer to RAM), wake-up time is not increased.

(3) All clocks disabled

(4) See [Table 6-2](#) for a detailed description of peripherals in high-frequency, low-frequency, or unlocked state.

(5) See [Section 6.3.1](#), which describes the use of peripherals in LPM3 and LPM4.

(6) Controlled by SMCLKOFF

(7) Using the RAM controller, the RAM can be completely powered down to save leakage; however, all data are lost.

(8) Activated SVS (SVSHE = 1) results in higher current consumption. SVS is not included in typical current consumption.

(9) SVSHE = 1

(10) SVSHE = 0

### 6.3.1 Peripherals in Low-Power Modes

Peripherals can be in different states that impact the achievable power modes of the device. The states depend on the operational modes of the peripherals (see [Table 6-2](#)). The states are:

- A peripheral is in a *high-frequency state* if it requires or uses a clock with a "high" frequency of more than 50 kHz.
- A peripheral is in a *low-frequency state* if it requires or uses a clock with a "low" frequency of 50 kHz or less.
- A peripheral is in an *unclocked state* if it does not require or use an internal clock.

If the CPU requests a power mode that does not support the current state of all active peripherals, the device does not enter the requested power mode and instead enters a power mode that still supports the current state of the peripherals, unless an external clock is used. If an external clock is used, the application must ensure that the correct frequency range for the requested power mode is selected.

**Table 6-2. Peripheral States**

| PERIPHERAL                                           | IN HIGH-FREQUENCY STATE <sup>(1)</sup>                | IN LOW-FREQUENCY STATE <sup>(2)</sup>                 | IN UNLOCKED STATE <sup>(3)</sup>                                 |
|------------------------------------------------------|-------------------------------------------------------|-------------------------------------------------------|------------------------------------------------------------------|
| WDT                                                  | Clocked by SMCLK                                      | Clocked by ACLK                                       | Not applicable                                                   |
| DMA <sup>(4)</sup>                                   | Not applicable                                        | Not applicable                                        | Waiting for a trigger                                            |
| RTC_C                                                | Not applicable                                        | Clocked by LFXT                                       | Not applicable                                                   |
| LCD_C                                                | Not applicable                                        | Clocked by ACLK or VLOCLK                             | Not applicable                                                   |
| Timer_A, TA <sub>x</sub>                             | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz. | Clocked by external clock ≤50 kHz.                               |
| Timer_B, TB <sub>x</sub>                             | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz  | Clocked by external clock ≤50 kHz                                |
| eUSCI_A <sub>x</sub> in UART mode                    | Clocked by SMCLK                                      | Clocked by ACLK                                       | Waiting for first edge of START bit                              |
| eUSCI_A <sub>x</sub> in SPI master mode              | Clocked by SMCLK                                      | Clocked by ACLK                                       | Not applicable                                                   |
| eUSCI_A <sub>x</sub> in SPI slave mode               | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                     | Clocked by external clock ≤50 kHz                                |
| eUSCI_B <sub>x</sub> in I <sup>2</sup> C master mode | Clocked by SMCLK or clocked by external clock >50 kHz | Clocked by ACLK or clocked by external clock ≤50 kHz  | Not applicable                                                   |
| eUSCI_B <sub>x</sub> in I <sup>2</sup> C slave mode  | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                     | Waiting for START condition or clocked by external clock ≤50 kHz |
| eUSCI_B <sub>x</sub> in SPI master mode              | Clocked by SMCLK                                      | Clocked by ACLK                                       | Not applicable                                                   |
| eUSCI_B <sub>x</sub> in SPI slave mode               | Clocked by external clock >50 kHz                     | Clocked by external clock ≤50 kHz                     | Clocked by external clock ≤50 kHz                                |
| ESI                                                  | Clocked by SMCLK                                      | Clocked by ACLK or ESIOSC                             | Not applicable                                                   |
| ADC12_B                                              | Clocked by SMCLK or by MODOSC                         | Clocked by ACLK                                       | Waiting for a trigger                                            |
| REF_A                                                | Not applicable                                        | Not applicable                                        | Always                                                           |
| COMP_E                                               | Not applicable                                        | Not applicable                                        | Always                                                           |
| CRC <sup>(5)</sup>                                   | Not applicable                                        | Not applicable                                        | Not applicable                                                   |
| MPY <sup>(5)</sup>                                   | Not applicable                                        | Not applicable                                        | Not applicable                                                   |

(1) Peripherals are in a state that requires or uses a clock with a "high" frequency of more than 50 kHz.

(2) Peripherals are in a state that requires or uses a clock with a "low" frequency of 50 kHz or less.

(3) Peripherals are in a state that does not require or does not use an internal clock.

(4) The DMA always transfers data in active mode but can wait for a trigger in any low-power mode. A DMA trigger during a low-power mode will cause a temporary transition into active mode for the time of the transfer.

(5) Operates only during active mode and will delay the transition into a low-power mode until its operation is completed.

### 6.3.1.1 Idle Currents of Peripherals in LPM3 and LPM4

Most peripherals can be activated to be operational in LPM3 if clocked by ACLK. Some modules are even operational in LPM4 because they do not require a clock to operate (for example, the comparator). Activating a peripheral in LPM3 or LPM4 increases the current consumption due to its active supply current contribution but also due to an additional idle current. To limit the idle current adder certain peripherals are group together. To achieve optimal current consumption try to use modules within one group and to limit the number of groups with active modules. [Table 6-3](#) lists the group for each peripheral. Modules not listed in this table are either already included in the standard LPM3 current consumption specifications or cannot be used in LPM3 or LPM4.

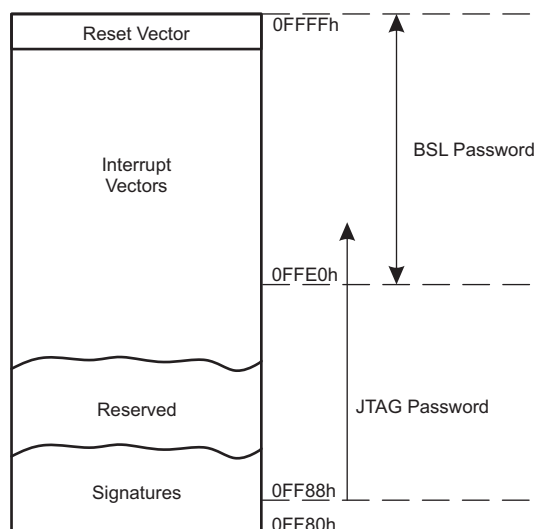
The idle current adder is very small at room temperature (25°C) but increases at high temperatures (85°C). See the  $I_{IDLE}$  parameters in [Section 5.7](#) for details.

**Table 6-3. Peripheral Groups**

| GROUP A    | GROUP B                       | GROUP C   | GROUP D   |
|------------|-------------------------------|-----------|-----------|
| Timer TA0  | Timer TA1                     | Timer TA2 | Timer TA3 |
| Comparator | Extended Scan Interface (ESI) | Timer B0  | LCD_C     |
| ADC12_B    |                               | eUSCI_A0  | eUSCI_A1  |
| REF_A      |                               | eUSCI_B0  |           |
|            |                               | eUSCI_B1  |           |

## 6.4 Interrupt Vector Table and Signatures

The interrupt vectors, the power-up start address and signatures are in the address range 0FFFFh to 0FF80h. [Figure 6-1](#) summarizes the content of this address range.



**Figure 6-1. Interrupt Vectors, Signatures, and Passwords**

The power-up start address or reset vector is located at 0FFFFh to 0FFFEh. It contains the 16-bit address pointing to the start address of the application program.

The interrupt vectors start at 0FFFDh and extend to lower addresses. Each vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence. [Table 6-4](#) shows the device-specific interrupt vector locations.

The vectors programmed into the address range from 0FFFFh to 0FFE0h are used as the BSL password (if enabled by the corresponding signature).

The signatures are located at 0FF80h and extend to higher addresses. Signatures are evaluated during device start-up. [Table 6-5](#) shows the device-specific signature locations.

A JTAG password can be programmed starting at address 0FF88h and extending to higher addresses. The password can extend into the interrupt vector locations using the interrupt vector addresses as additional bits for the password. The length of the JTAG password depends on the JTAG signature.

See the *System Resets, Interrupts, and Operating Modes, System Control Module (SYS)* chapter in the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, MSP430FR69xx Family User's Guide](#) for details.

**Table 6-4. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE                                                                                                                                                                                                                                                                                            | INTERRUPT FLAG                                                                                                                                                                                                                                  | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------------|----------|
| <b>System Reset</b><br>Power up, Brownout, Supply Supervisor<br>External Reset $\overline{\text{RST}}$<br>Watchdog time-out (watchdog mode)<br>WDT, FRCTL MPU, CS, PMM password violation<br>FRAM uncorrectable bit error detection<br>MPU segment violation<br>FRAM access time error<br>Software POR, BOR | SVSHIFG<br>PMMRSTIFG<br>WDTIFG<br>WDTPW, FRCTLPW, MPUW, CSPW, PMMPW<br>UBDIFG<br>MPUSEG1IFG, MPUSEG2IFG, MPUSEG3IFG<br>ACCTEIFG<br>PMMPORIFG, PMMBORIFG<br>(SYSRSTIV) <sup>(1) (2)</sup>                                                        | Reset            | 0FFFEh       | Highest  |
| <b>System NMI</b><br>Vacant memory access<br>JTAG mailbox<br>FRAM bit error detection<br>MPU segment violation                                                                                                                                                                                              | VMAIFG<br>JMBINIFG, JMBOUTIFG<br>CBDIFG, UBDIFG<br>MPUSEG1IFG, MPUSEG2IFG, MPUSEG3IFG<br>(SYSSNIV) <sup>(1) (3)</sup>                                                                                                                           | (Non)maskable    | 0FFFCh       |          |
| <b>User NMI</b><br>External NMI<br>Oscillator fault                                                                                                                                                                                                                                                         | NMIFG, OFIFG<br>(SYSUNIV) <sup>(1) (3)</sup>                                                                                                                                                                                                    | (Non)maskable    | 0FFFAh       |          |
| Comparator_E                                                                                                                                                                                                                                                                                                | Comparator_E interrupt flags (CEIV) <sup>(1)</sup>                                                                                                                                                                                              | Maskable         | 0FFF8h       |          |
| Timer_B TB0                                                                                                                                                                                                                                                                                                 | TB0CCR0.CCIFG                                                                                                                                                                                                                                   | Maskable         | 0FFF6h       |          |
| Timer_B TB0                                                                                                                                                                                                                                                                                                 | TB0CCR1.CCIFG to TB0CCR6.CCIFG, TB0CTL.TBIFG (TB0IV) <sup>(1)</sup>                                                                                                                                                                             | Maskable         | 0FFF4h       |          |
| Watchdog timer (interval timer mode)                                                                                                                                                                                                                                                                        | WDTIFG                                                                                                                                                                                                                                          | Maskable         | 0FFF2h       |          |
| Extended Scan IF                                                                                                                                                                                                                                                                                            | ESIIFG0 to ESIIFG8 (ESIIV) <sup>(1)</sup>                                                                                                                                                                                                       | Maskable         | 0FFF0h       |          |
| eUSCI_A0 receive or transmit                                                                                                                                                                                                                                                                                | UCA0IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA0IFG: UCSTTIFG, UCTXPTIFG, UCRXIFG, UCTXIFG (UART mode)<br>(UCA0IV) <sup>(1)</sup>                                                                                                                   | Maskable         | 0FFEEh       |          |
| eUSCI_B0 receive or transmit                                                                                                                                                                                                                                                                                | UCB0IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCB0IFG: UCALIFG, UCNACKIFG, UCSTTIFG, UCSTPIFG, UCRXIFG0, UCTXIFG0, UCRXIFG1, UCTXIFG1, UCRXIFG2, UCTXIFG2, UCRXIFG3, UCTXIFG3, UCCNTIFG, UCBIT9IFG (I <sup>2</sup> C mode)<br>(UCB0IV) <sup>(1)</sup> | Maskable         | 0FFEC h      |          |
| ADC12_B                                                                                                                                                                                                                                                                                                     | ADC12IFG0 to ADC12IFG31<br>ADC12LOIFG, ADC12INIFG, ADC12HIIFG, ADC12RDYIFG, ADC12OVIFG, ADC12TOVIFG (ADC12IV) <sup>(1)</sup>                                                                                                                    | Maskable         | 0FFEAh       |          |
| Timer_A TA0                                                                                                                                                                                                                                                                                                 | TA0CCR0.CCIFG                                                                                                                                                                                                                                   | Maskable         | 0FFE8h       |          |
| Timer_A TA0                                                                                                                                                                                                                                                                                                 | TA0CCR1.CCIFG to TA0CCR2.CCIFG, TA0CTL.TAIFG (TA0IV) <sup>(1)</sup>                                                                                                                                                                             | Maskable         | 0FFE6h       |          |
| eUSCI_A1 receive or transmit                                                                                                                                                                                                                                                                                | UCA1IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCA1IFG: UCSTTIFG, UCTXPTIFG, UCRXIFG, UCTXIFG (UART mode)<br>(UCA1IV) <sup>(1)</sup>                                                                                                                   | Maskable         | 0FFE4h       |          |

(1) Multiple source flags

(2) A reset is generated if the CPU tries to fetch instructions from within peripheral space

(3) (Non)maskable: the individual interrupt-enable bit can disable an interrupt event, but the general-interrupt enable cannot disable it.

**Table 6-4. Interrupt Sources, Flags, and Vectors (continued)**

| INTERRUPT SOURCE                    | INTERRUPT FLAG                                                                                                                                                                                                                                           | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY |
|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------------|----------|
| eUSCI_B1 receive or transmit)       | UCB1IFG: UCRXIFG, UCTXIFG (SPI mode)<br>UCB1IFG: UCALIFG, UCNACKIFG, UCSTTIFG,<br>UCSTPIFG, UCRXIFG0, UCTXIFG0, UCRXIFG1,<br>UCTXIFG1, UCRXIFG2, UCTXIFG2, UCRXIFG3,<br>UCTXIFG3, UCCNTIFG, UCBIT9IFG (I <sup>2</sup> C mode)<br>(UCB1IV) <sup>(1)</sup> | Maskable         | 0FFE2h       |          |
| DMA                                 | DMA0CTL.DMAIFG, DMA1CTL.DMAIFG,<br>DMA2CTL.DMAIFG<br>(DMAIV) <sup>(1)</sup>                                                                                                                                                                              | Maskable         | 0FFE0h       |          |
| Timer_A TA1                         | TA1CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFDEh       |          |
| Timer_A TA1                         | TA1CCR1.CCIFG to TA1CCR2.CCIFG,<br>TA1CTL.TAIFG<br>(TA1IV) <sup>(1)</sup>                                                                                                                                                                                | Maskable         | 0FFDCh       |          |
| I/O Port P1                         | P1IFG.0 to P1IFG.7<br>(P1IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFDAh       |          |
| Timer_A TA2                         | TA2CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFD8h       |          |
| Timer_A TA2                         | TA2CCR1.CCIFG<br>TA2CTL.TAIFG<br>(TA2IV) <sup>(1)</sup>                                                                                                                                                                                                  | Maskable         | 0FFD6h       |          |
| I/O Port P2                         | P2IFG.0 to P2IFG.7<br>(P2IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFD4h       |          |
| Timer_A TA3                         | TA3CCR0.CCIFG                                                                                                                                                                                                                                            | Maskable         | 0FFD2h       |          |
| Timer_A TA3                         | TA3CCR1.CCIFG<br>TA3CTL.TAIFG<br>(TA3IV) <sup>(1)</sup>                                                                                                                                                                                                  | Maskable         | 0FFD0h       |          |
| I/O Port P3                         | P3IFG.0 to P3IFG.7<br>(P3IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFCEh       |          |
| I/O Port P4                         | P4IFG.0 to P4IFG.7<br>(P4IV) <sup>(1)</sup>                                                                                                                                                                                                              | Maskable         | 0FFCCh       |          |
| LCD_C<br>(Reserved on MSP430FR5xxx) | LCD_C interrupt flags (LCDIV) <sup>(1)</sup>                                                                                                                                                                                                             | Maskable         | 0FFCAh       |          |
| RTC_C                               | RTCRDYIFG, RTCTEVIFG, RTCAIFG,<br>RT0PSIFG, RT1PSIFG, RTCOFIFG<br>(RTCIV) <sup>(1)</sup>                                                                                                                                                                 | Maskable         | 0FFC8h       | Lowest   |

**Table 6-5. Signatures**

| SIGNATURE                                  | WORD ADDRESS |
|--------------------------------------------|--------------|
| IP Encapsulation Signature2                | 0FF8Ah       |
| IP Encapsulation Signature1 <sup>(1)</sup> | 0FF88h       |
| BSL Signature2                             | 0FF86h       |
| BSL Signature1                             | 0FF84h       |
| JTAG Signature2                            | 0FF82h       |
| JTAG Signature1                            | 0FF80h       |

(1) Must not contain 0AAAAh if used as JTAG password and IP encapsulation functionality is not desired.

## 6.5 Bootloader (BSL)

The BSL enables programming of the FRAM or RAM using a UART serial interface (FRxxxx devices) or an I<sup>2</sup>C interface (FRxxxx1 devices). Access to the device memory through the BSL is protected by a user-defined password. [Table 6-6](#) lists the BSL pin requirements. BSL entry requires a specific entry sequence on the  $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$  and TEST/SBWTCCK pins. For complete description of the features of the BSL and its implementation, see [MSP430 Programming With the Bootloader \(BSL\)](#).

**Table 6-6. BSL Pin Requirements and Functions**

| DEVICE SIGNAL                                     | BSL FUNCTION                                       |
|---------------------------------------------------|----------------------------------------------------|
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | Entry sequence signal                              |
| TEST/SBWTCCK                                      | Entry sequence signal                              |
| P2.0                                              | Devices with UART BSL (FRxxxx): Data transmit      |
| P2.1                                              | Devices with UART BSL (FRxxxx): Data receive       |
| P1.6                                              | Devices with I <sup>2</sup> C BSL (FRxxxx1): Data  |
| P1.7                                              | Devices with I <sup>2</sup> C BSL (FRxxxx1): Clock |
| VCC                                               | Power supply                                       |
| VSS                                               | Ground supply                                      |

## 6.6 JTAG Operation

### 6.6.1 JTAG Standard Interface

The MSP430 family supports the standard JTAG interface, which requires four signals for sending and receiving data. The JTAG signals are shared with general-purpose I/Os. The TEST/SBWTCCK pin is used to enable the JTAG signals. In addition to these signals, the  $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$  signal is required to interface with MSP430 development tools and device programmers. [Table 6-7](#) lists the JTAG pin requirements. For details on interfacing to development tools and device programmers, see the [MSP430 Hardware Tools User's Guide](#). For details on the JTAG implementation in MSP MCUs, see [MSP430 Programming With the JTAG Interface](#).

**Table 6-7. JTAG Pin Requirements and Functions**

| DEVICE SIGNAL                                     | DIRECTION | FUNCTION                    |
|---------------------------------------------------|-----------|-----------------------------|
| PJ.3/TCK                                          | IN        | JTAG clock input            |
| PJ.2/TMS                                          | IN        | JTAG state control          |
| PJ.1/TDI/TCLK                                     | IN        | JTAG data input, TCLK input |
| PJ.0/TDO                                          | OUT       | JTAG data output            |
| TEST/SBWTCCK                                      | IN        | Enable JTAG pins            |
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | IN        | External reset              |
| VCC                                               |           | Power supply                |
| VSS                                               |           | Ground supply               |

### 6.6.2 Spy-Bi-Wire Interface

In addition to the standard JTAG interface, the MSP430 family supports the 2-wire Spy-Bi-Wire interface. Spy-Bi-Wire can be used to interface with MSP430 development tools and device programmers. [Table 6-8](#) lists the Spy-Bi-Wire interface pin requirements. For details on interfacing to development tools and device programmers, see the [MSP430 Hardware Tools User's Guide](#). For details on the SBW implementation in MSP MCUs, see [MSP430 Programming With the JTAG Interface](#).

**Table 6-8. Spy-Bi-Wire Pin Requirements and Functions**

| DEVICE SIGNAL                                     | DIRECTION | FUNCTION                      |
|---------------------------------------------------|-----------|-------------------------------|
| TEST/SBWTCK                                       | IN        | Spy-Bi-Wire clock input       |
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | IN, OUT   | Spy-Bi-Wire data input/output |
| VCC                                               |           | Power supply                  |
| VSS                                               |           | Ground supply                 |

## 6.7 FRAM

The FRAM can be programmed through the JTAG port, Spy-Bi-Wire (SBW), the BSL, or in system by the CPU. Features of the FRAM include:

- Ultra-low-power ultra-fast-write nonvolatile memory
- Byte and word access capability
- Programmable wait state generation
- Error correction coding (ECC)

### NOTE

#### Wait States

For MCLK frequencies > 8 MHz, wait states must be configured following the flow described in the "FRAM Controller (FRCTRL)" chapter, section "Wait State Control" of the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, MSP430FR69xx Family User's Guide](#).

For important software design information regarding FRAM including but not limited to partitioning the memory layout according to application-specific code, constant, and data space requirements, the use of FRAM to optimize application energy consumption, and the use of the memory protection unit (MPU) to maximize application robustness by protecting the program code against unintended write accesses, see [MSP430 FRAM Technology – How To and Best Practices](#).

## 6.8 RAM

The RAM is made up of one sector. The sector can be completely powered down in LPM3 and LPM4 to save leakage; however, all data is lost during shutdown.

## 6.9 Tiny RAM

The Tiny RAM can be used to hold data or a very small stack if the complete RAM is powered down in LPM3 and LPM4.

## 6.10 Memory Protection Unit Including IP Encapsulation

The FRAM can be protected from inadvertent CPU execution, read or write access by the MPU. Features of the MPU include:

- IP Encapsulation with programmable boundaries (prevents reads from "outside" like JTAG or non-IP software) in steps of 1KB.
- Main memory partitioning programmable up to three segments in steps of 1KB.
- The access rights of each segment (main and information memory) can be individually selected.
- Access violation flags with interrupt capability for easy servicing of access violations.

## 6.11 Peripherals

Peripherals are connected to the CPU through data, address, and control buses. Peripherals can be managed using all instructions. For complete module descriptions, see the [MSP430FR58xx](#), [MSP430FR59xx](#), [MSP430FR68xx](#), [MSP430FR69xx Family User's Guide](#).

### 6.11.1 Digital I/O

Up to eleven 8-bit I/O ports are implemented:

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt conditions is possible.
- Programmable pullup or pulldown on all ports.
- Edge-selectable interrupt and LPM3.5 and LPM4.5 wake-up input capability is available for all pins of ports P1, P2, P3, and P4.
- Read and write access to port-control registers is supported by all instructions.
- Ports can be accessed byte-wise or word-wise in pairs.
- Capacitive touch functionality is supported on all pins of ports P1 to P10 and PJ.
- No cross-currents during start-up

#### NOTE

##### Configuration of Digital I/Os After BOR Reset

To prevent any cross-currents during start-up of the device all port pins are high-impedance with Schmitt triggers and their module functions disabled. To enable the I/O functionality after a BOR reset the ports must be configured first and then the LOCKLPM5 bit must be cleared. For details, see the *Configuration After Reset* section of the *Digital I/O* chapter in the [MSP430FR58xx](#), [MSP430FR59xx](#), [MSP430FR68xx](#), [MSP430FR69xx Family User's Guide](#).

### 6.11.2 Oscillator and Clock System (CS)

The clock system includes support for a 32-kHz watch crystal oscillator XT1 (LF), an internal very-low-power low-frequency oscillator (VLO), an integrated internal digitally controlled oscillator (DCO), and a high-frequency crystal oscillator XT2 (HF). The clock system module is designed to meet the requirements of both low system cost and low power consumption. A fail-safe mechanism exists for all crystal sources. The clock system module provides the following clock signals:

- Auxiliary clock (ACLK), sourced from a 32-kHz watch crystal (LFXT1), the internal low-frequency oscillator (VLO), or a digital external low frequency (<50 kHz) clock source.
- Main clock (MCLK), the system clock used by the CPU. MCLK can be sourced from a high-frequency crystal (HFXT2), the internal digitally controlled oscillator DCO, a 32-kHz watch crystal (LFXT1), the internal low-frequency oscillator (VLO), or a digital external clock source.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules. SMCLK can be sourced by same sources made available to MCLK.

### 6.11.3 Power-Management Module (PMM)

The primary functions of the PMM are:

- Supply regulated voltages to the core logic
- Supervise voltages that are connected to the device (at DVCC pins)
- Give reset signals to the device during power on and power off

#### 6.11.4 Hardware Multiplier (MPY)

The multiplication operation is supported by a dedicated peripheral module. The module performs operations with 32-, 24-, 16-, and 8-bit operands. The module supports signed and unsigned multiplication as well as signed and unsigned multiply-and-accumulate operations.

#### 6.11.5 Real-Time Clock (RTC\_C)

The RTC\_C module contains an integrated real-time clock (RTC) with the following features implemented:

- Calendar mode with leap year correction
- General-purpose counter mode

The internal calendar compensates months with less than 31 days and includes leap year correction. The RTC\_C also supports flexible alarm functions and offset-calibration hardware. RTC operation is available in LPM3.5 modes to minimize power consumption.

#### 6.11.6 Watchdog Timer (WDT\_A)

The primary function of the WDT\_A module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be configured as an interval timer and can generate interrupts at selected time intervals. [Table 6-9](#) lists the clocks that can be used by the WDT.

#### NOTE

In watchdog mode, the watchdog timer prevents entry into LPM3.5 or LPM4.5 because this would deactivate the watchdog.

**Table 6-9. WDT\_A Clocks**

| WDTSEL | NORMAL OPERATION<br>(WATCHDOG AND INTERVAL TIMER MODE) |
|--------|--------------------------------------------------------|
| 00     | SMCLK                                                  |
| 01     | ACLK                                                   |
| 10     | VLOCLK                                                 |
| 11     | LFMODCLK                                               |

#### 6.11.7 System Module (SYS)

The SYS module handles many of the system functions within the device. These system functions include power-on reset and power-up clear handling, NMI source selection and management, reset interrupt vector generators, bootloader entry mechanisms, and configuration management (device descriptors). The SYS module also includes a data exchange mechanism through JTAG called a JTAG mailbox that can be used in the application. [Table 6-10](#) lists the interrupt vector registers of the SYS module.

**Table 6-10. System Module Interrupt Vector Registers**

| INTERRUPT VECTOR REGISTER | ADDRESS | INTERRUPT EVENT                                           | VALUE      | PRIORITY |
|---------------------------|---------|-----------------------------------------------------------|------------|----------|
| SYSRSTIV,<br>System Reset | 019Eh   | No interrupt pending                                      | 00h        |          |
|                           |         | Brownout (BOR)                                            | 02h        | Highest  |
|                           |         | RSTIFG $\overline{\text{RST}}$ /NMI (BOR)                 | 04h        |          |
|                           |         | PMMSWBOR software BOR (BOR)                               | 06h        |          |
|                           |         | LPMx.5 wakeup (BOR)                                       | 08h        |          |
|                           |         | Security violation (BOR)                                  | 0Ah        |          |
|                           |         | Reserved                                                  | 0Ch        |          |
|                           |         | SVSHIFG SVSH event (BOR)                                  | 0Eh        |          |
|                           |         | Reserved                                                  | 10h        |          |
|                           |         | Reserved                                                  | 12h        |          |
|                           |         | PMMSWPOR software POR (POR)                               | 14h        |          |
|                           |         | WDTIFG watchdog time-out (PUC)                            | 16h        |          |
|                           |         | WDTPW password violation (PUC)                            | 18h        |          |
|                           |         | FRCTLPW password violation (PUC)                          | 1Ah        |          |
|                           |         | Uncorrectable FRAM bit error detection (PUC)              | 1Ch        |          |
|                           |         | Peripheral area fetch (PUC)                               | 1Eh        |          |
|                           |         | PMMPW PMM password violation (PUC)                        | 20h        |          |
|                           |         | MPUPW MPU password violation (PUC)                        | 22h        |          |
|                           |         | CSPW CS password violation (PUC)                          | 24h        |          |
|                           |         | MPUSEGPIFG encapsulated IP memory segment violation (PUC) | 26h        |          |
|                           |         | MPUSEGIIFG information memory segment violation (PUC)     | 28h        |          |
|                           |         | MPUSEG1IFG segment 1 memory violation (PUC)               | 2Ah        |          |
|                           |         | MPUSEG2IFG segment 2 memory violation (PUC)               | 2Ch        |          |
|                           |         | MPUSEG3IFG segment 3 memory violation (PUC)               | 2Eh        |          |
|                           |         | ACCTEIFG access time error (PUC) <sup>(1)</sup>           | 30h        |          |
|                           |         | Reserved                                                  | 32h to 3Eh | Lowest   |
| SYSSNIV,<br>System NMI    | 019Ch   | No interrupt pending                                      | 00h        |          |
|                           |         | Reserved                                                  | 02h        | Highest  |
|                           |         | Uncorrectable FRAM bit error detection                    | 04h        |          |
|                           |         | Reserved                                                  | 06h        |          |
|                           |         | MPUSEGPIFG encapsulated IP memory segment violation       | 08h        |          |
|                           |         | MPUSEGIIFG information memory segment violation           | 0Ah        |          |
|                           |         | MPUSEG1IFG segment 1 memory violation                     | 0Ch        |          |
|                           |         | MPUSEG2IFG segment 2 memory violation                     | 0Eh        |          |
|                           |         | MPUSEG3IFG segment 3 memory violation                     | 10h        |          |
|                           |         | VMAIFG Vacant memory access                               | 12h        |          |
|                           |         | JMBINIFG JTAG mailbox input                               | 14h        |          |
|                           |         | JMBOUTIFG JTAG mailbox output                             | 16h        |          |
|                           |         | Correctable FRAM bit error detection                      | 18h        |          |
|                           |         | Reserved                                                  | 1Ah to 1Eh | Lowest   |
| SYSUNIV,<br>User NMI      | 019Ah   | No interrupt pending                                      | 00h        |          |
|                           |         | NMIIFG NMI pin                                            | 02h        | Highest  |
|                           |         | OFIFG oscillator fault                                    | 04h        |          |
|                           |         | Reserved                                                  | 06h        |          |
|                           |         | Reserved                                                  | 08h        |          |
|                           |         | Reserved                                                  | 0Ah to 1Eh | Lowest   |

(1) Indicates incorrect wait state settings.

### 6.11.8 DMA Controller

The DMA controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA controller can be used to move data from the ADC10\_B conversion memory to RAM. Using the DMA controller can increase the throughput of peripheral modules. The DMA controller reduces system power consumption by allowing the CPU to remain in sleep mode, without having to awaken to move data to or from a peripheral. [Table 6-11](#) lists the triggers that can be used to start DMA operation.

**Table 6-11. DMA Trigger Assignments<sup>(1)</sup>**

| TRIGGER | CHANNEL 0                                        | CHANNEL 1                                        | CHANNEL 2                                        |
|---------|--------------------------------------------------|--------------------------------------------------|--------------------------------------------------|
| 0       | DMAREQ                                           | DMAREQ                                           | DMAREQ                                           |
| 1       | TA0CCR0 CCIFG                                    | TA0CCR0 CCIFG                                    | TA0CCR0 CCIFG                                    |
| 2       | TA0CCR2 CCIFG                                    | TA0CCR2 CCIFG                                    | TA0CCR2 CCIFG                                    |
| 3       | TA1CCR0 CCIFG                                    | TA1CCR0 CCIFG                                    | TA1CCR0 CCIFG                                    |
| 4       | TA1CCR2 CCIFG                                    | TA1CCR2 CCIFG                                    | TA1CCR2 CCIFG                                    |
| 5       | TA2 CCR0 CCIFG                                   | TA2 CCR0 CCIFG                                   | TA2 CCR0 CCIFG                                   |
| 6       | TA3 CCR0 CCIFG                                   | TA3 CCR0 CCIFG                                   | TA3 CCR0 CCIFG                                   |
| 7       | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    | TB0CCR0 CCIFG                                    |
| 8       | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    | TB0CCR2 CCIFG                                    |
| 9       | Reserved                                         | Reserved                                         | Reserved                                         |
| 10      | Reserved                                         | Reserved                                         | Reserved                                         |
| 11      | Reserved                                         | Reserved                                         | Reserved                                         |
| 12      | Reserved                                         | Reserved                                         | Reserved                                         |
| 13      | Reserved                                         | Reserved                                         | Reserved                                         |
| 14      | UCA0RXIFG                                        | UCA0RXIFG                                        | UCA0RXIFG                                        |
| 15      | UCA0TXIFG                                        | UCA0TXIFG                                        | UCA0TXIFG                                        |
| 16      | UCA1RXIFG                                        | UCA1RXIFG                                        | UCA1RXIFG                                        |
| 17      | UCA1TXIFG                                        | UCA1TXIFG                                        | UCA1TXIFG                                        |
| 18      | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) | UCB0RXIFG (SPI)<br>UCB0RXIFG0 (I <sup>2</sup> C) |
| 19      | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) | UCB0TXIFG (SPI)<br>UCB0TXIFG0 (I <sup>2</sup> C) |
| 20      | UCB0RXIFG1 (I <sup>2</sup> C)                    | UCB0RXIFG1 (I <sup>2</sup> C)                    | UCB0RXIFG1 (I <sup>2</sup> C)                    |
| 21      | UCB0TXIFG1 (I <sup>2</sup> C)                    | UCB0TXIFG1 (I <sup>2</sup> C)                    | UCB0TXIFG1 (I <sup>2</sup> C)                    |
| 22      | UCB0RXIFG2 (I <sup>2</sup> C)                    | UCB0RXIFG2 (I <sup>2</sup> C)                    | UCB0RXIFG2 (I <sup>2</sup> C)                    |
| 23      | UCB0TXIFG2 (I <sup>2</sup> C)                    | UCB0TXIFG2 (I <sup>2</sup> C)                    | UCB0TXIFG2 (I <sup>2</sup> C)                    |
| 24      | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) | UCB1RXIFG (SPI)<br>UCB1RXIFG0 (I <sup>2</sup> C) |
| 25      | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) | UCB1TXIFG (SPI)<br>UCB1TXIFG0 (I <sup>2</sup> C) |
| 26      | ADC12 end of conversion                          | ADC12 end of conversion                          | ADC12 end of conversion                          |
| 27      | Reserved                                         | Reserved                                         | Reserved                                         |
| 28      | ESI                                              | ESI                                              | ESI                                              |
| 29      | MPY ready                                        | MPY ready                                        | MPY ready                                        |
| 30      | DMA2IFG                                          | DMA0IFG                                          | DMA1IFG                                          |
| 31      | DMAE0                                            | DMAE0                                            | DMAE0                                            |

(1) If a reserved trigger source is selected, no trigger is generated.

### 6.11.9 Enhanced Universal Serial Communication Interface (eUSCI)

The eUSCI modules are used for serial data communication. The eUSCI module supports synchronous communication protocols such as SPI (3 or 4 pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baud-rate detection, and IrDA.

The eUSCI\_An module provides support for SPI (3 pin or 4 pin), UART, enhanced UART, and IrDA.

The eUSCI\_Bn module provides support for SPI (3 pin or 4 pin) and I<sup>2</sup>C.

Two eUSCI\_A modules and one or two eUSCI\_B module are implemented.

### 6.11.10 Extended Scan Interface (ESI)

The ESI peripheral automatically scans sensors and measures linear or rotational motion with the lowest possible power consumption. The ESI incorporates a V<sub>CC</sub>/2 generator, a comparator, and a 12-bit DAC and supports up to four sensors.

### 6.11.11 Timer\_A TA0, Timer\_A TA1

TA0 and TA1 are 16-bit timers/counters (Timer\_A type) with three capture/compare registers each. TA0 and TA1 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-12](#) and [Table 6-13](#)). TA0 and TA1 have extensive interrupt capabilities. Interrupts can be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-12. Timer\_A TA0 Signal Connections**

| INPUT PORT PIN               | DEVICE INPUT SIGNAL        | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                     |
|------------------------------|----------------------------|---------------------|--------------|----------------------|----------------------|-------------------------------------|
| P1.2 or P6.7 or P7.0         | TA0CLK                     | TACLK               | Timer        | N/A                  | N/A                  |                                     |
|                              | ACLK (internal)            | ACLK                |              |                      |                      |                                     |
|                              | SMCLK (internal)           | SMCLK               |              |                      |                      |                                     |
| P1.2 or P6.7 or P7.0         | $\overline{\text{TA0CLK}}$ | INCLK               |              |                      |                      |                                     |
| P1.5                         | TA0.0                      | CCI0A               | CCR0         | TA0                  | TA0.0                | P1.5                                |
| P7.1 or P10.1                | TA0.0                      | CCI0B               |              |                      |                      | P7.1                                |
|                              | DV <sub>SS</sub>           | GND                 |              |                      |                      | P10.1                               |
|                              | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P1.0 or P1.6 or P7.2 or P7.6 | TA0.1                      | CCI1A               | CCR1         | TA1                  | TA0.1                | P1.0                                |
|                              | COUT (internal)            | CCI1B               |              |                      |                      | P1.6                                |
|                              | DV <sub>SS</sub>           | GND                 |              |                      |                      | P7.2                                |
|                              | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      | P7.6                                |
|                              |                            |                     |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {1} |
| P1.1 or P1.7 or P7.3 or P7.5 | TA0.2                      | CCI2A               | CCR2         | TA2                  | TA0.2                | P1.1                                |
|                              | ACLK (internal)            | CCI2B               |              |                      |                      | P1.7                                |
|                              | DV <sub>SS</sub>           | GND                 |              |                      |                      | P7.3                                |
|                              | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      | P7.5                                |

**Table 6-13. Timer\_A TA1 Signal Connections**

| INPUT PORT PIN               | DEVICE INPUT SIGNAL         | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                     |
|------------------------------|-----------------------------|---------------------|--------------|----------------------|----------------------|-------------------------------------|
| P1.1 or P4.4 or P5.2         | TA1CLK                      | TACLK               | Timer        | N/A                  | N/A                  |                                     |
|                              | ACLK (internal)             | ACLK                |              |                      |                      |                                     |
|                              | SMCLK (internal)            | SMCLK               |              |                      |                      |                                     |
| P1.1 or P4.4 or P5.2         | $\overline{\text{TA1CLK}}$  | INCLK               |              |                      |                      |                                     |
| P1.4 or P4.5                 | TA1.0                       | CCI0A               | CCR0         | TA0                  | TA1.0                | P1.4                                |
| P5.2 or P10.2                | TA1.0                       | CCI0B               |              |                      |                      | P4.5                                |
|                              | DV <sub>SS</sub>            | GND                 |              |                      |                      | P5.2                                |
|                              | DV <sub>CC</sub>            | V <sub>CC</sub>     |              |                      |                      | P10.2                               |
| P1.2 or P3.3 or P4.6 or P5.0 | TA1.1                       | CCI1A               | CCR1         | TA1                  | TA1.1                | P1.2                                |
|                              | COU <sub>T</sub> (internal) | CCI1B               |              |                      |                      | P4.6                                |
|                              | DV <sub>SS</sub>            | GND                 |              |                      |                      | P3.3                                |
|                              | DV <sub>CC</sub>            | V <sub>CC</sub>     |              |                      |                      | P5.0                                |
|                              |                             |                     |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {4} |
| P1.3 or P4.7 or P5.1 or P7.7 | TA1.2                       | CCI2A               | CCR2         | TA2                  | TA1.2                | P1.3                                |
|                              | ACLK (internal)             | CCI2B               |              |                      |                      | P4.7                                |
|                              | DV <sub>SS</sub>            | GND                 |              |                      |                      | P5.1                                |
|                              | DV <sub>CC</sub>            | V <sub>CC</sub>     |              |                      |                      | P7.7                                |

### 6.11.12 Timer\_A TA2

TA2 is a 16-bit timer/counter (Timer\_A type) with two capture/compare registers each and with internal connections only. TA2 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-14](#)). TA2 has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-14. Timer\_A TA2 Signal Connections**

| DEVICE INPUT SIGNAL                    | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                |
|----------------------------------------|-------------------|--------------|----------------------|-------------------------------------|
| COU <sub>T</sub> (internal)            | TACLK             | Timer        | N/A                  |                                     |
| ACLK (internal)                        | ACLK              |              |                      |                                     |
| SMCLK (internal)                       | SMCLK             |              |                      |                                     |
| From Capacitive Touch I/O 0 (internal) | INCLK             |              |                      |                                     |
| TA3 CCR0 output (internal)             | CCI0A             | CCR0         | TA0                  | TA3 CCI0A input                     |
| ACLK (internal)                        | CCI0B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |
| From Capacitive Touch I/O 0 (internal) | CCI1A             | CCR1         | TA1                  | ADC12 (internal)<br>ADC12SHSx = {5} |
| COU <sub>T</sub> (internal)            | CCI1B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |

### 6.11.13 Timer\_A TA3

TA3 is a 16-bit timer/counter (Timer\_A type) with five capture/compare registers each and with internal connections only. TA3 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-15](#)). TA3 has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-15. Timer\_A TA3 Signal Connections**

| DEVICE INPUT SIGNAL                    | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                |
|----------------------------------------|-------------------|--------------|----------------------|-------------------------------------|
| COUT (internal)                        | TACLK             | Timer        | N/A                  |                                     |
| ACLK (internal)                        | ACLK              |              |                      |                                     |
| SMCLK (internal)                       | SMCLK             |              |                      |                                     |
| From Capacitive Touch I/O 1 (internal) | INCLK             |              |                      |                                     |
| TA2 CCR0 output (internal)             | CCI0A             | CCR0         | TA0                  | TA2 CCI0A input                     |
| ACLK (internal)                        | CCI0B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |
| From Capacitive Touch I/O 1 (internal) | CCI1A             | CCR1         | TA1                  | ADC12 (internal)<br>ADC12SHSx = {6} |
| COUT (internal)                        | CCI1B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |
| DV <sub>SS</sub>                       | CCI2A             | CCR2         | TA2                  |                                     |
| ESIO0 (internal)                       | CCI2B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |
| DV <sub>SS</sub>                       | CCI3A             | CCR3         | TA3                  |                                     |
| ESIO1 (internal)                       | CCI3B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |
| DV <sub>SS</sub>                       | CCI4A             | CCR4         | TA4                  |                                     |
| ESIO2 (internal)                       | CCI4B             |              |                      |                                     |
| DV <sub>SS</sub>                       | GND               |              |                      |                                     |
| DV <sub>CC</sub>                       | V <sub>CC</sub>   |              |                      |                                     |

### 6.11.14 Timer\_B TB0

TB0 is a 16-bit timer/counter (Timer\_B type) with seven capture/compare registers each. TB0 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-16](#)). TB0 has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-16. Timer\_B TB0 Signal Connections**

| INPUT PORT PIN       | DEVICE INPUT SIGNAL        | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PORT PIN                     |
|----------------------|----------------------------|---------------------|--------------|----------------------|----------------------|-------------------------------------|
| P2.0 or P3.3 or P5.7 | TB0CLK                     | TBCLK               | Timer        | N/A                  | N/A                  |                                     |
|                      | ACLK (internal)            | ACLK                |              |                      |                      |                                     |
|                      | SMCLK (internal)           | SMCLK               |              |                      |                      |                                     |
| P2.0 or P3.3 or P5.7 | $\overline{\text{TB0CLK}}$ | INCLK               |              |                      |                      |                                     |
| P3.4                 | TB0.0                      | CCI0A               | CCR0         | TB0                  | TB0.0                | P3.4                                |
| P6.4                 | TB0.0                      | CCI0B               |              |                      |                      | P6.4                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {2} |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P3.5 or P6.5         | TB0.1                      | CCI1A               | CCR1         | TB1                  | TB0.1                | P3.5                                |
|                      | COUT (internal)            | CCI1B               |              |                      |                      | P6.5                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      | ADC12 (internal)<br>ADC12SHSx = {3} |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P3.6 or P6.6         | TB0.2                      | CCI2A               | CCR2         | TB2                  | TB0.2                | P3.6                                |
|                      | ACLK (internal)            | CCI2B               |              |                      |                      | P6.6                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      |                                     |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P2.4                 | TB0.3                      | CCI3A               | CCR3         | TB3                  | TB0.3                | P2.4                                |
| P3.7                 | TB0.3                      | CCI3B               |              |                      |                      | P3.7                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      |                                     |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P2.5                 | TB0.4                      | CCI4A               | CCR4         | TB4                  | TB0.4                | P2.5                                |
| P2.2                 | TB0.4                      | CCI4B               |              |                      |                      | P2.2                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      |                                     |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P2.6                 | TB0.5                      | CCI5A               | CCR5         | TB5                  | TB0.5                | P2.6                                |
| P2.1                 | TB0.5                      | CCI5B               |              |                      |                      | P2.1                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      |                                     |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |
| P2.7                 | TB0.6                      | CCI6A               | CCR6         | TB6                  | TB0.6                | P2.7                                |
| P2.0                 | TB0.6                      | CCI6B               |              |                      |                      | P2.0                                |
|                      | DV <sub>SS</sub>           | GND                 |              |                      |                      |                                     |
|                      | DV <sub>CC</sub>           | V <sub>CC</sub>     |              |                      |                      |                                     |

### 6.11.15 ADC12\_B

The ADC12\_B module supports fast 12-bit analog-to-digital conversions with differential and single-ended inputs. The module implements a 12-bit SAR core, sample select control, a reference generator, and a conversion result buffer. A window comparator with lower and upper limits allows CPU-independent result monitoring with three window comparator interrupt flags.

Table 6-17 lists the external trigger sources. Table 6-18 lists the available multiplexing between internal and external analog inputs.

**Table 6-17. ADC12\_B Trigger Signal Connections**

| ADC12SHSx |         | CONNECTED TRIGGER SOURCE |
|-----------|---------|--------------------------|
| BINARY    | DECIMAL |                          |
| 000       | 0       | Software (ADC12SC)       |
| 001       | 1       | Timer_A TA0 CCR1 output  |
| 010       | 2       | Timer_B TB0 CCR0 output  |
| 011       | 3       | Timer_B TB0 CCR1 output  |
| 100       | 4       | Timer_A TA1 CCR1 output  |
| 101       | 5       | Timer_A TA2 CCR1 output  |
| 110       | 6       | Timer_A TA3 CCR1 output  |
| 111       | 7       | Reserved (DVSS)          |

**Table 6-18. ADC12\_B External and Internal Signal Mapping**

| CONTROL BIT | EXTERNAL<br>(CONTROL BIT = 0) | INTERNAL<br>(CONTROL BIT = 1) |
|-------------|-------------------------------|-------------------------------|
| ADC12BATMAP | A31                           | Battery Monitor               |
| ADC12TCMAP  | A30                           | Temperature Sensor            |
| ADC12CH0MAP | A29                           | N/A <sup>(1)</sup>            |
| ADC12CH1MAP | A28                           | N/A <sup>(1)</sup>            |
| ADC12CH2MAP | A27                           | N/A <sup>(1)</sup>            |
| ADC12CH3MAP | A26                           | N/A <sup>(1)</sup>            |

(1) N/A = No internal signal available on this device.

### 6.11.16 Comparator\_E

The primary function of the Comparator\_E module is to support precision slope analog-to-digital conversions, battery voltage supervision, and monitoring of external analog signals.

### 6.11.17 CRC16

The CRC16 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC16 signature is based on the CRC-CCITT standard.

### 6.11.18 CRC32

The CRC32 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC32 signature is based on the ISO 3309 standard.

### 6.11.19 True Random Seed

The Device Descriptor Information (TLV) section contains a 128-bit true random seed that can be used to implement a deterministic random number generator.

## 6.11.20 Shared Reference (REF\_A)

The reference module (REF\_A) generates all critical reference voltages that can be used by the various analog peripherals in the device.

## 6.11.21 LCD\_C

The LCD\_C driver generates the segment and common signals required to drive a liquid crystal display (LCD). The LCD\_C controller has dedicated data memories to hold segment drive information. Common and segment signals are generated as defined by the mode. Static and 2-mux to 8-mux LCDs are supported. The module can provide a LCD voltage independent of the supply voltage with its integrated charge pump. It is possible to control the level of the LCD voltage and thus contrast by software. The module also provides an automatic blinking capability for individual segments in static, 2-mux, 3-mux, and 4-mux modes.

To reduce system noise, the charge pump can be temporarily disabled. [Table 6-19](#) lists the available automatic charge pump disable options.

**Table 6-19. LCD Automatic Charge Pump Disable Bits (LCDCPDISx)**

| CONTROL BIT          | DESCRIPTION                                                                                                                                                                           |
|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDCPDIS0             | LCD charge pump disable during ADC12 conversion<br>0b = LCD charge pump not automatically disabled during conversion<br>1b = LCD charge pump automatically disabled during conversion |
| LDCPDIS1 to LDCPDIS7 | No functionality                                                                                                                                                                      |

## 6.11.22 Embedded Emulation

### 6.11.22.1 Embedded Emulation Module (EEM)

The EEM supports real-time in-system debugging. The S version of the EEM has the following features:

- Three hardware triggers or breakpoints on memory access
- One hardware trigger or breakpoint on CPU register write access
- Up to four hardware triggers that can be combined to form complex triggers or breakpoints
- One cycle counter
- Clock control on module level

### 6.11.22.2 EnergyTrace++™ Technology

These MCUs implement circuitry to support EnergyTrace++ technology. The EnergyTrace++ technology allows you to observe information about the internal states of the microcontroller. These states include the CPU Program Counter (PC), the ON or OFF status of the peripherals and the system clocks (regardless of the clock source), and the low-power mode currently in use. These states can always be read by a debug tool, even when the microcontroller sleeps in LPMx.5 modes.

The activity of the following modules can be observed:

- MPY is calculating.
- WDT is counting.
- RTC is counting.
- ADC: a sequence, sample, or conversion is active.
- REF: REFBG or REFGEN active and BG in static mode.
- COMP is on.
- eUSCI\_A0 is transferring (receiving or transmitting) data.
- eUSCI\_A1 is transferring (receiving or transmitting) data.

- eUSCI\_B0 is transferring (receiving or transmitting) data.
- eUSCI\_B1 is transferring (receiving or transmitting) data.
- TB0 is counting.
- TA0 is counting.
- TA1 is counting.
- TA2 is counting.
- TA3 is counting.
- LCD: timing generator is active.
- ESI:
  - ESI is active using LF clock source
  - ESI is active using HF clock source

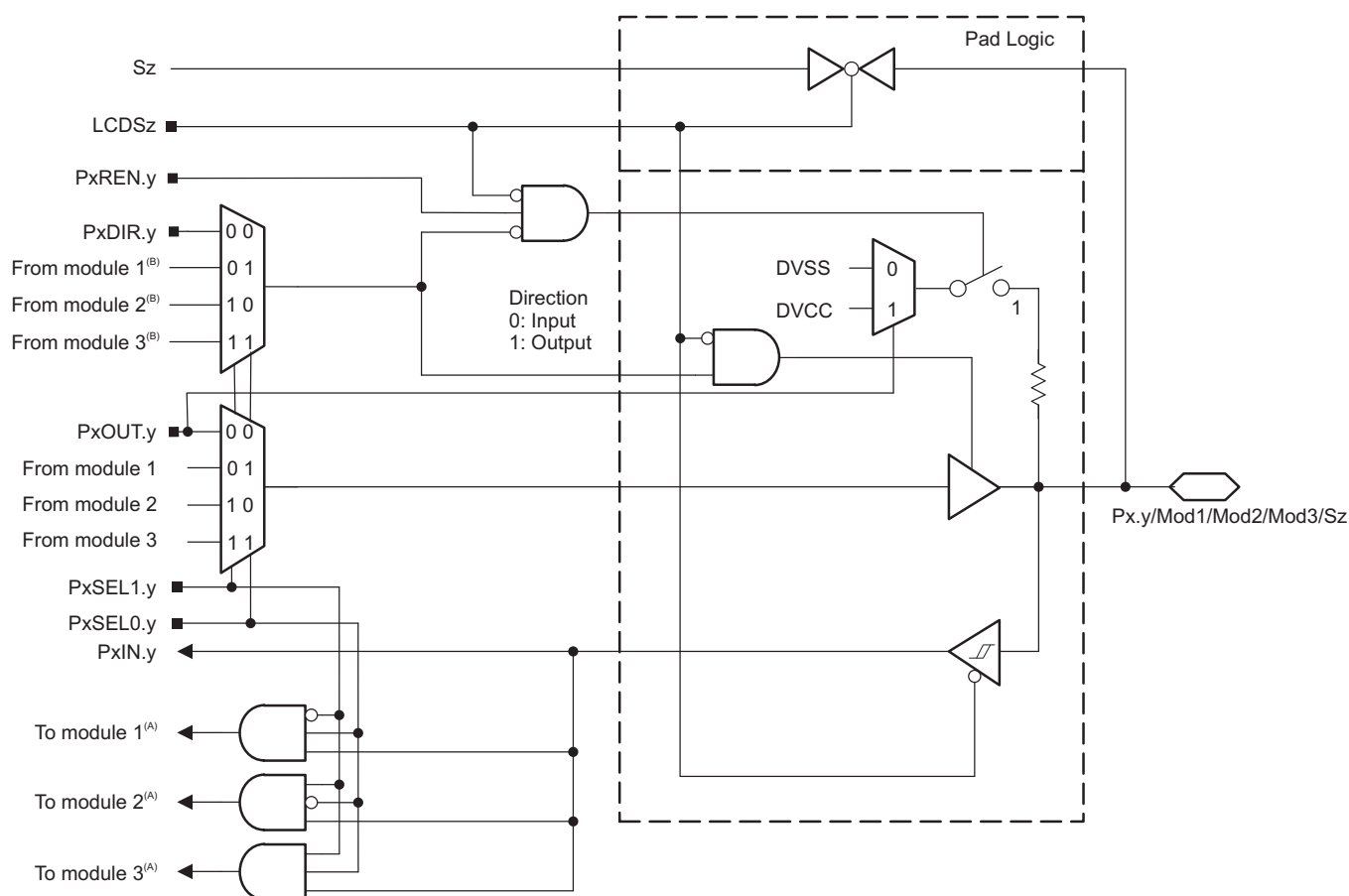
## 6.11.23 Input/Output Diagrams

### 6.11.23.1 Digital I/O Functionality – Ports P1 to P10

The port pins provide the following features:

- Interrupt and wakeup from LPMx.5 capability for ports P1, P2, P3, and P4
- Capacitive touch functionality (see [Section 6.11.23.2](#))
- Up to three digital module input or output functions
- LCD segment functionality (not all pins, package dependent)

Figure 6-2 shows the features and the corresponding control logic (not including the capacitive touch logic). It is applicable for all port pins P1.0 to P10.2 unless a dedicated diagram is available in the following sections. The module functions provided per pin and whether the direction is controlled by the module or by the port direction register for the selected secondary function are described in the pin function tables.



A. The inputs from several pins toward a module are ORed together.

B. The direction is controlled either by the connected module or by the corresponding PxDIR.y bit. See the pin function tables.

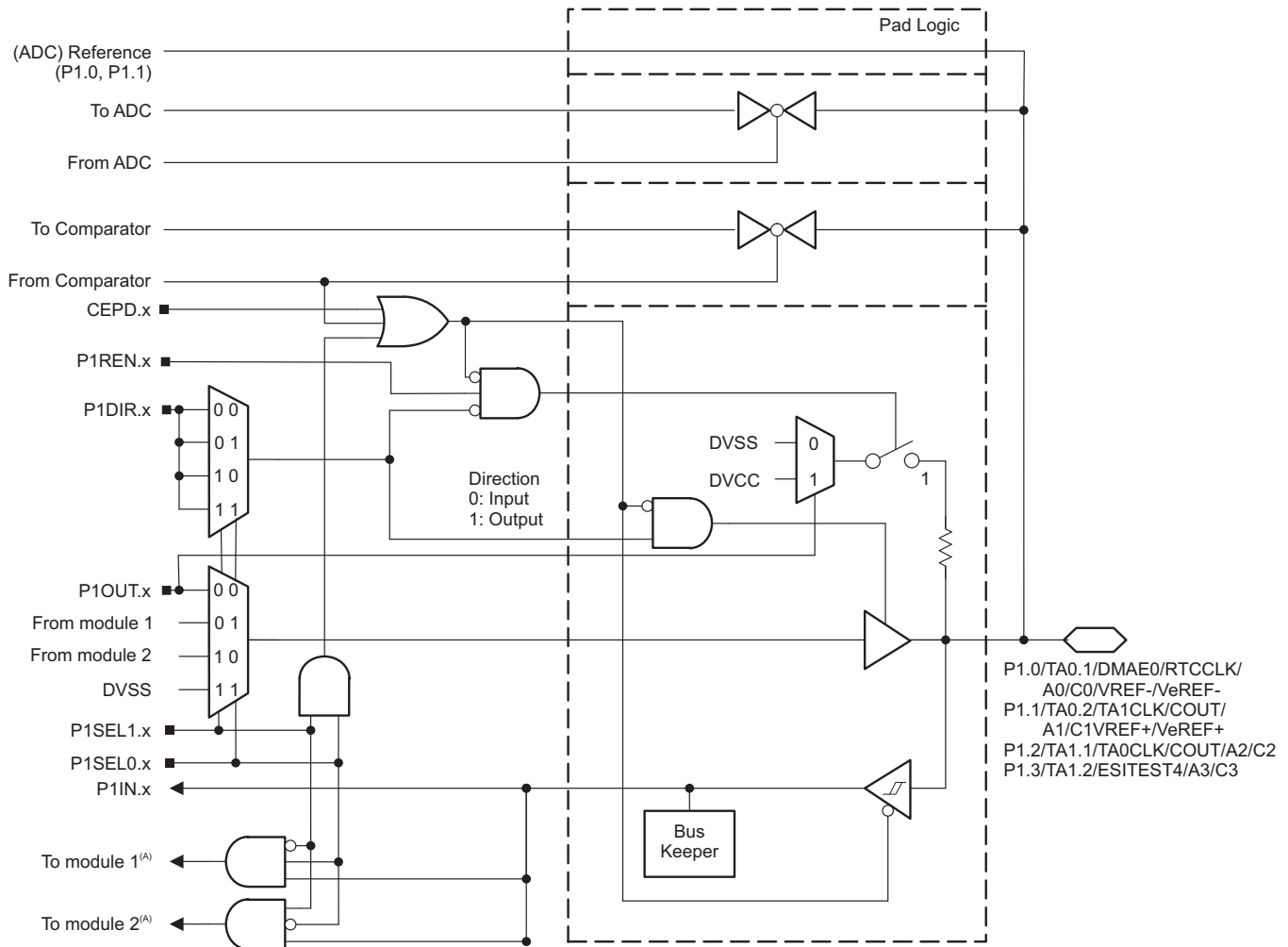
NOTE: Functional representation only.

**Figure 6-2. General Port Pin Diagram**



### 6.11.23.3 Port P1 (P1.0 to P1.3) Input/Output With Schmitt Trigger

Figure 6-4 shows the port diagram. Table 6-20 summarizes the selection of the pin function.



A. The inputs from several pins toward a module are ORed together.

NOTE: Functional representation only.

**Figure 6-4. Port P1 (P1.0 to P1.3) Diagram**

**Table 6-20. Port P1 (P1.0 to P1.3) Pin Functions**

| PIN NAME (P1.x)                                | x | FUNCTION                                 | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|------------------------------------------------|---|------------------------------------------|-----------------------------------------|----------|----------|
|                                                |   |                                          | P1DIR.x                                 | P1SEL1.x | P1SEL0.x |
| P1.0/TA0.1/DMAE0/RTCCLK/A0/C0/<br>VREF-/VeREF- | 0 | P1.0 (I/O)                               | I: 0; O: 1                              | 0        | 0        |
|                                                |   | TA0.CCI1A                                | 0                                       | 0        | 1        |
|                                                |   | TA0.1                                    | 1                                       |          |          |
|                                                |   | DMAE0                                    | 0                                       | 1        | 0        |
|                                                |   | RTCCLK <sup>(2)</sup>                    | 1                                       |          |          |
|                                                |   | A0, C0, VREF-, VeREF- <sup>(3) (4)</sup> | X                                       | 1        | 1        |
| P1.1/TA0.2/TA1CLK/COUT/A1/C1/<br>VREF+/VeREF+  | 1 | P1.1 (I/O)                               | I: 0; O: 1                              | 0        | 0        |
|                                                |   | TA0.CCI2A                                | 0                                       | 0        | 1        |
|                                                |   | TA0.2                                    | 1                                       |          |          |
|                                                |   | TA1CLK                                   | 0                                       | 1        | 0        |
|                                                |   | COUT <sup>(5)</sup>                      | 1                                       |          |          |
|                                                |   | A1, C1, VREF+, VeREF+ <sup>(3) (4)</sup> | X                                       | 1        | 1        |
| P1.2/TA1.1/TA0CLK/COUT/A2/C2                   | 2 | P1.2 (I/O)                               | I: 0; O: 1                              | 0        | 0        |
|                                                |   | TA1.CCI1A                                | 0                                       | 0        | 1        |
|                                                |   | TA1.1                                    | 1                                       |          |          |
|                                                |   | TA0CLK                                   | 0                                       | 1        | 0        |
|                                                |   | COUT <sup>(6)</sup>                      | 1                                       |          |          |
|                                                |   | A2, C2 <sup>(3) (4)</sup>                | X                                       | 1        | 1        |
| P1.3/TA1.2/ESITEST4/A3/C3                      | 3 | P1.3 (I/O)                               | I: 0; O: 1                              | 0        | 0        |
|                                                |   | TA1.CCI2A                                | 0                                       | 0        | 1        |
|                                                |   | TA1.2                                    | 1                                       |          |          |
|                                                |   | N/A                                      | 0                                       | 1        | 0        |
|                                                |   | ESITEST4                                 | 1                                       |          |          |
|                                                |   | A3, C3 <sup>(3) (4)</sup>                | X                                       | 1        | 1        |

(1) X = Don't care

(2) Do not use this pin as RTCCLK output if the DMAE0 functionality is used on any other pin. Select an alternative RTCCLK output pin.

(3) Setting P1SEL1.x and P1SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(4) Setting the CEPD.x bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPD.x bit.

(5) Do not use this pin as COUT output if the TA1CLK functionality is used on any other pin. Select an alternative COUT output pin.

(6) Do not use this pin as COUT output if the TA0CLK functionality is used on any other pin. Select an alternative COUT output pin.

#### 6.11.23.4 Port P1 (P1.4 to P1.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-21](#) summarizes the selection of the pin function.

**Table 6-21. Port P1 (P1.4 to P1.7) Pin Functions**

| PIN NAME (P1.x)                | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                                |   |                         | P1DIR.x                                 | P1SEL1.x | P1SEL0.x | LCDSz |
| P1.4/UCB0CLK/UCA0STE/TA1.0/Sz  | 4 | P1.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | UCB0CLK                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                |   | UCA0STE                 | X <sup>(3)</sup>                        | 1        | 0        | 0     |
|                                |   | TA1.CCI0A               | 0                                       | 1        | 1        | 0     |
|                                |   | TA1.0                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(4)</sup>       | X                                       | X        | X        | 1     |
| P1.5/UCB0STE/UCA0CLK/TA0.0/Sz  | 5 | P1.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | UCB0STE                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                |   | UCA0CLK                 | X <sup>(3)</sup>                        | 1        | 0        | 0     |
|                                |   | TA0.CCI0A               | 0                                       | 1        | 1        | 0     |
|                                |   | TA0.0                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(4)</sup>       | X                                       | X        | X        | 1     |
| P1.6/UCB0SIMO/UCB0SDA/TA0.1/Sz | 6 | P1.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | UCB0SIMO/UCB0SDA        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | TA0.CCI1A               | 0                                       | 1        | 1        | 0     |
|                                |   | TA0.1                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(4)</sup>       | X                                       | X        | X        | 1     |
| P1.7/UCB0SOMI/UCB0SCL/TA0.2/Sz | 7 | P1.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | UCB0SOMI/UCB0SCL        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | TA0.CCI2A               | 0                                       | 1        | 1        | 0     |
|                                |   | TA0.2                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(4)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) Direction controlled by eUSCI\_B0 module.

(3) Direction controlled by eUSCI\_A0 module.

(4) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.5 Port P2 (P2.0 to P2.3) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-22](#) summarizes the selection of the pin function.

**Table 6-22. Port P2 (P2.0 to P2.3) Pin Functions**

| PIN NAME (P2.x)                           | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-------------------------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                                           |   |                         | P2DIR.x                                 | P2SEL1.x | P2SEL0.x | LCDSz |
| P2.0/UCA0SIMO/UCA0TXD/TB0.6/<br>TB0CLK/Sz | 0 | P2.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                           |   | UCA0SIMO/UCA0TXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                           |   | TB0.CCI6B               | 0                                       | 1        | 0        | 0     |
|                                           |   | TB0.6                   | 1                                       |          |          |       |
|                                           |   | TB0CLK                  | 0                                       | 1        | 1        | 0     |
|                                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                           |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P2.1/UCA0SOMI/UCA0RXD/TB0.5/<br>DMAE0/Sz  | 1 | P2.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                           |   | UCA0SOMI/UCA0RXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                           |   | TB0.CCI5B               | 0                                       | 1        | 0        | 0     |
|                                           |   | TB0.5                   | 1                                       |          |          |       |
|                                           |   | DMA0E                   | 0                                       | 1        | 1        | 0     |
|                                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                           |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P2.2/UCA0CLK/TB0.4/RTCCLK/Sz              | 2 | P2.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                           |   | UCA0CLK                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                           |   | TB0.CCI4B               | 0                                       | 1        | 0        | 0     |
|                                           |   | TB0.4                   | 1                                       |          |          |       |
|                                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                           |   | RTCCLK                  | 1                                       |          |          |       |
|                                           |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P2.3/UCA0STE/TB0OUTH/Sz                   | 3 | P2.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                           |   | UCA0STE                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                           |   | TB0OUTH                 | 0                                       | 1        | 0        | 0     |
|                                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                           |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

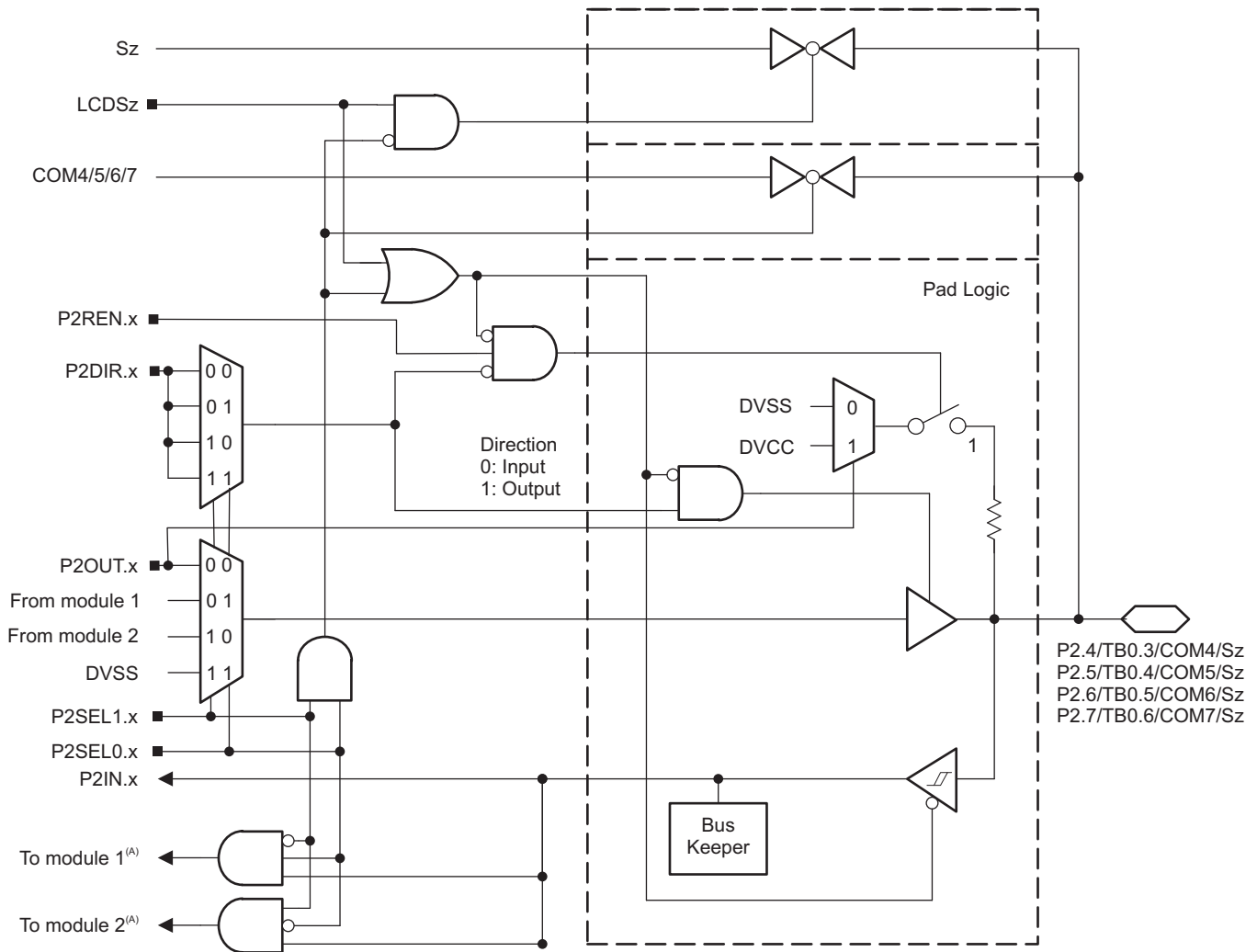
(1) X = Don't care

(2) Direction controlled by eUSCI\_A0 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.6 Port P2 (P2.4 to P2.7) Input/Output With Schmitt Trigger

Figure 6-5 shows the port diagram. Table 6-23 summarizes the selection of the pin function.



A. The inputs from several pins toward a module are ORed together.

NOTE: Functional representation only.

**Figure 6-5. Port P2 (P2.4 to P2.7) Diagram**

**Table 6-23. Port P2 (P2.4 to P2.7) Pin Functions**

| PIN NAME (P2.x)             | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                             |   |                         | P2DIR.x                                 | P2SEL1.x | P2SEL0.x | LCDSz |
| P2.4/TB0.3/COM4/Sz          | 4 | P2.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                             |   | TB0.CCI3A               | 0                                       | 0        | 1        | 0     |
|                             |   | TB0.3                   | 1                                       |          |          |       |
|                             |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                             |   | Internally tied to DVSS | 1                                       |          |          |       |
|                             |   | COM4                    | X                                       |          |          |       |
|                             |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P2.5/TB0.4/COM5/Sz          | 5 | P2.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                             |   | TB0.CCI4A               | 0                                       | 0        | 1        | 0     |
|                             |   | TB0.4                   | 1                                       |          |          |       |
|                             |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                             |   | Internally tied to DVSS | 1                                       |          |          |       |
|                             |   | COM5                    | X                                       |          |          |       |
|                             |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P2.6/TB0.5/ESIC1OUT/COM6/Sx | 6 | P2.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                             |   | TB0.CCI5A               | 0                                       | 0        | 1        | 0     |
|                             |   | TB0.5                   | 1                                       |          |          |       |
|                             |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                             |   | ESIC1OUT                | 1                                       |          |          |       |
|                             |   | COM6                    | X                                       |          |          |       |
|                             |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P2.7/TB0.6/ESIC2OUT/COM7/Sx | 7 | P2.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                             |   | TB0.CCI6A               | 0                                       | 0        | 1        | 0     |
|                             |   | TB0.6                   | 1                                       |          |          |       |
|                             |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                             |   | ESIC2OUT                | 1                                       |          |          |       |
|                             |   | COM7                    | X                                       |          |          |       |
|                             |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.7 Port P3 (P3.0 to P3.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-24](#) and [Table 6-25](#) summarize the selection of the pin function.

**Table 6-24. Port P3 (P3.0 to P3.3) Pin Functions**

| PIN NAME (P3.x)          | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                          |   |                         | P3DIR.x                                 | P3SEL1.x | P3SEL0.x | LCDSz |
| P3.0/UCB1CLK/Sz          | 0 | P3.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCB1CLK                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.1/UCB1SIMO/UCB1SDA/Sz | 1 | P3.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCB1SIMO/UCB1SDA        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.2/UCB1SOMI/UCB1SCL/Sz | 2 | P3.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCB1SOMI/UCB1SCL        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   |                         | 0                                       | 1        | 1        | 0     |
|                          |   |                         | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.3/TA1.1/TB0CLK/Sz     | 3 | P3.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | TA1.CCI1A               | 0                                       | 1        | 0        | 0     |
|                          |   | TA1.1                   | 1                                       |          |          |       |
|                          |   | TB0CLK                  | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) Direction controlled by eUSCI\_B1 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

**Table 6-25. Port P3 (P3.4 to P3.7) Pin Functions**

| PIN NAME (P3.x)                    | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|------------------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                                    |   |                         | P3DIR.x                                 | P3SEL1.x | P3SEL0.x | LCDSz |
| P3.4/UCA1SIMO/UCA1TXD/TB0.0/<br>Sz | 4 | P3.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                    |   | UCA1SIMO/UCA1TXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                    |   | TB0CCI0A                | 0                                       | 1        | 0        | 0     |
|                                    |   | TB0.0                   | 1                                       |          |          |       |
|                                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                    |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.5/UCA1SOMI/UCA1RXD/TB0.1/<br>Sz | 5 | P3.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                    |   | UCA1SOMI/UCA1RXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                    |   | TB0CCI1A                | 0                                       | 1        | 0        | 0     |
|                                    |   | TB0.1                   | 1                                       |          |          |       |
|                                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                    |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.6/UCA1CLK/TB0.2/Sz              | 6 | P3.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                    |   | UCA1CLK                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                    |   | TB0CCI2A                | 0                                       | 1        | 0        | 0     |
|                                    |   | TB0.2                   | 1                                       |          |          |       |
|                                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                    |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P3.7/UCA1STE/TB0.3/Sz              | 7 | P3.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                    |   | UCA1STE                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                                    |   | TB0CCI3B                | 0                                       | 1        | 0        | 0     |
|                                    |   | TB0.3                   | 1                                       |          |          |       |
|                                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                    |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) Direction controlled by eUSCI\_A1 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.8 Port P4 (P4.0 to P4.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-26](#) and [Table 6-27](#) summarize the selection of the pin function.

**Table 6-26. Port P4 (P4.0 to P4.3) Pin Functions**

| PIN NAME (P4.x)                  | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|----------------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                                  |   |                         | P4DIR.x                                 | P4SEL1.x | P4SEL0.x | LCDSz |
| P4.0/UCB1SIMO/UCB1SDA/MCLK/Sz    | 0 | P4.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                  |   | UCB1SIMO/UCB1SDA        | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                  |   | MCLK                    | 1                                       |          |          |       |
|                                  |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.1/UCB1SOMI/UCB1SCL/ACLK/Sz    | 1 | P4.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                  |   | UCB1SOMI/UCB1SCL        | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                  |   | ACLK                    | 1                                       |          |          |       |
|                                  |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.2/UCA0SIMO/UCA0TXD/UCB1CLK/Sz | 2 | P4.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                  |   | UCA0SIMO/UCA0TXD        | X <sup>(4)</sup>                        | 0        | 1        | 0     |
|                                  |   | UCB1CLK                 | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                  |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.3/UCA0SOMI/UCA0RXD/UCB1STE/Sz | 3 | P4.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                  |   | UCA0SOMI/UCA0RXD        | X <sup>(4)</sup>                        | 0        | 1        | 0     |
|                                  |   | UCB1STE                 | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                  |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                                  |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                  |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) Direction controlled by eUSCI\_B1 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

(4) Direction controlled by eUSCI\_A0 module.

**Table 6-27. Port P4 (P4.4 to P4.7) Pin Functions**

| PIN NAME (P4.x)                | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                                |   |                         | P4DIR.x                                 | P4SEL1.x | P4SEL0.x | LCDSz |
| P4.4/UCB1STE/TA1CLK/Sz         | 4 | P4.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | UCB1STE                 | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                |   | TA1CLK                  | 0                                       | 1        | 1        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.5/UCB1CLK/TA1.0/Sz          | 5 | P4.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | UCB1CLK                 | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                |   | TA1CCI0A                | 0                                       | 1        | 1        | 0     |
|                                |   | TA1.0                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.6/UCB1SIMO/UCB1SDA/TA1.1/Sz | 6 | P4.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | UCB1SIMO/UCB1SDA        | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                |   | TA1CCI1A                | 0                                       | 1        | 1        | 0     |
|                                |   | TA1.1                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P4.7/UCB1SOMI/UCB1SCL/TA1.2/Sz | 7 | P4.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                                |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                                |   | Internally tied to DVSS | 1                                       |          |          |       |
|                                |   | UCB1SOMI/UCB1SCL        | X <sup>(2)</sup>                        | 1        | 0        | 0     |
|                                |   | TA1CCI2A                | 0                                       | 1        | 1        | 0     |
|                                |   | TA1.2                   | 1                                       |          |          |       |
|                                |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) Direction controlled by eUSCI\_B1 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.9 Port P5 (P5.0 to P5.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-28](#) and [Table 6-29](#) summarize the selection of the pin function.

**Table 6-28. Port P5 (P5.0 to P5.3) Pin Functions**

| PIN NAME (P5.x)           | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|---------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                           |   |                         | P5DIR.x                                 | P5SEL1.x | P5SEL0.x | LCDSz |
| P5.0/TA1.1/MCLK/Sz        | 0 | P5.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                           |   | TA1CCI1A                | 0                                       | 0        | 1        | 0     |
|                           |   | TA1.1                   | 1                                       |          |          |       |
|                           |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                           |   | MCLK                    | 1                                       |          |          |       |
|                           |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P5.1/TA1.2/Sz             | 1 | P5.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                           |   | TA1CCI2A                | 0                                       | 0        | 1        | 0     |
|                           |   | TA1.2                   | 1                                       |          |          |       |
|                           |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                           |   | N/A                     | 1                                       |          |          |       |
|                           |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P5.2/TA1.0/TA1CLK/ACLK/Sz | 2 | P5.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                           |   | TA1CCI0B                | 0                                       | 0        | 1        | 0     |
|                           |   | TA1.0                   | 1                                       |          |          |       |
|                           |   | TA1CLK                  | 0                                       | 1        | 0        | 0     |
|                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                           |   | ACLK                    | 1                                       |          |          |       |
|                           |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P5.3/UCB1STE/Sz           | 3 | P5.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                           |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                           |   | UCB1STE                 | X <sup>(3)</sup>                        | 1        | 0        | 0     |
|                           |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                           |   | Internally tied to DVSS | 1                                       |          |          |       |
|                           |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

(3) Direction controlled by eUSCI\_B1 module.

**Table 6-29. Port P5 (P5.4 to P5.7) Pin Functions**

| PIN NAME (P5.x)          | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                          |   |                         | P5DIR.x                                 | P5SEL1.x | P5SEL0.x | LCDSz |
| P5.4/UCA1SIMO/UCA1TXD/Sz | 4 | P5.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCA1SIMO/UCA1TXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P5.5/UCA1SOMI/UCA1RXD/Sz | 5 | P5.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCA1SOMI/UCA1RXD        | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P5.6/UCA1CLK/Sz          | 6 | P5.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCA1CLK                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |
| P5.7/UCA1STE/TB0CLK/Sz   | 7 | P5.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                          |   | UCA1STE                 | X <sup>(2)</sup>                        | 0        | 1        | 0     |
|                          |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | TB0CLK                  | 0                                       | 1        | 1        | 0     |
|                          |   | Internally tied to DVSS | 1                                       |          |          |       |
|                          |   | Sz <sup>(3)</sup>       | X                                       | X        | X        | 1     |

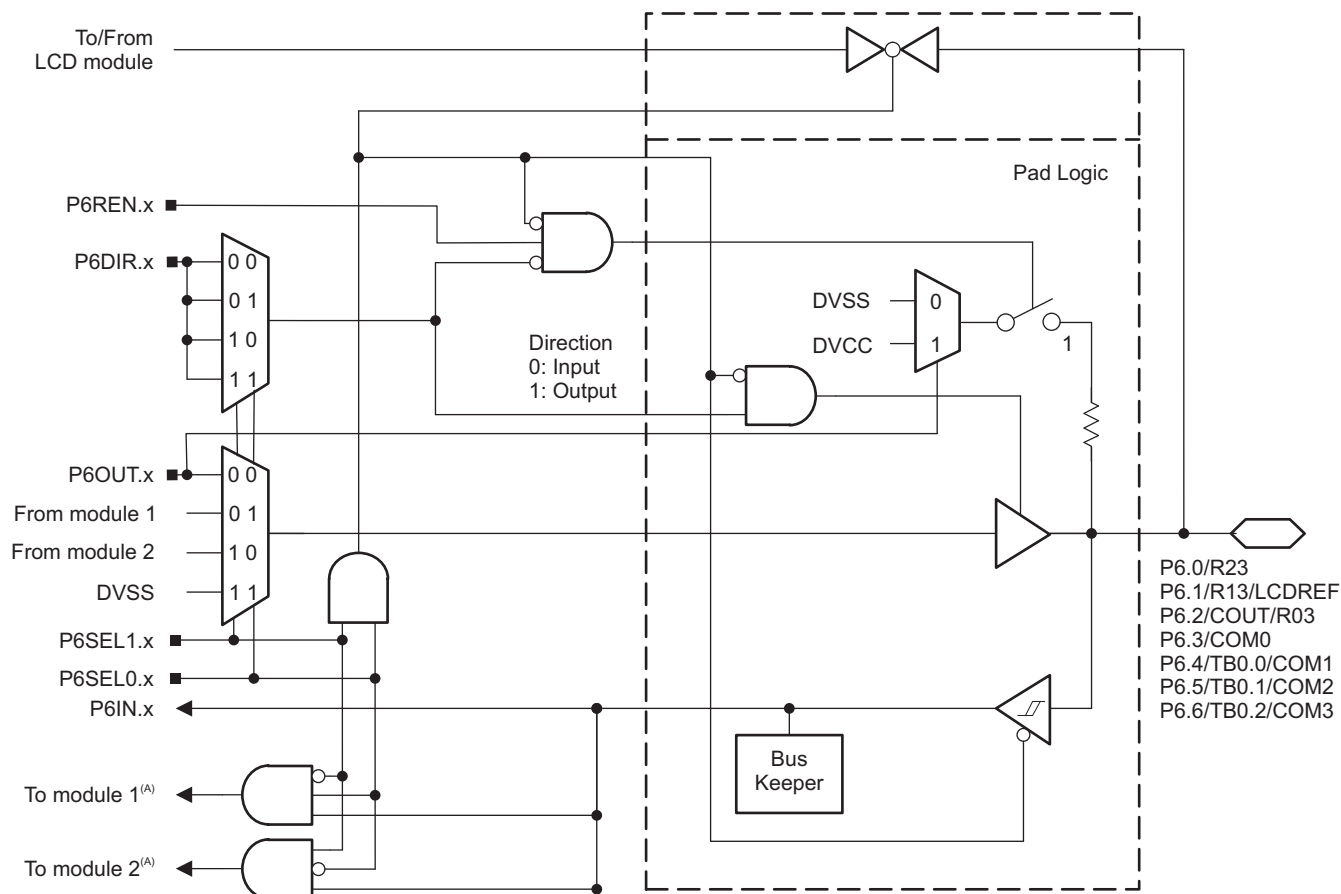
(1) X = Don't care

(2) Direction controlled by eUSCI\_A1 module.

(3) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.10 Port P6 (P6.0 to P6.6) Input/Output With Schmitt Trigger

Figure 6-6 shows the port diagram. Table 6-30 and Table 6-31 summarize the selection of the pin function.



A. The inputs from several pins toward a module are ORed together.

NOTE: Functional representation only.

**Figure 6-6. Port P6 (P6.0 to P6.6) Diagram**

**Table 6-30. Port P6 (P6.0 to P6.2) Pin Functions**

| PIN NAME (P6.x) | x | FUNCTION                  | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|---------------------------|-----------------------------------------|----------|----------|-------|
|                 |   |                           | P6DIR.x                                 | P6SEL1.x | P6SEL0.x | LCDSz |
| P6.0/R23        | 0 | P6.0 (I/O)                | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | N/A                       | 0                                       | 0        | 1        | –     |
|                 |   | Internally tied to DVSS   | 1                                       |          |          |       |
|                 |   | N/A                       | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS   | 1                                       |          |          |       |
|                 |   | R23 <sup>(2)</sup>        | X                                       | 1        | 1        | –     |
| P6.1/R13/LCDREF | 1 | P6.1 (I/O)                | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | N/A                       | 0                                       | 0        | 1        | –     |
|                 |   | Internally tied to DVSS   | 1                                       |          |          |       |
|                 |   | N/A                       | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS   | 1                                       |          |          |       |
|                 |   | R13/LCDREF <sup>(2)</sup> | X                                       | 1        | 1        | –     |
| P6.2/COUT/R03   | 2 | P6.2 (I/O)                | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | N/A                       | 0                                       | 0        | 1        | –     |
|                 |   | COUT                      | 1                                       |          |          |       |
|                 |   | N/A                       | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS   | 1                                       |          |          |       |
|                 |   | R03 <sup>(2)</sup>        | X                                       | 1        | 1        | –     |

(1) X = Don't care

(2) Setting P6SEL1.x and P6SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

**Table 6-31. Port P6 (P6.3 to P6.6) Pin Functions**

| PIN NAME (P6.x) | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                 |   |                         | P6DIR.x                                 | P6SEL1.x | P6SEL0.x | LCDSz |
| P6.3/COM0       | 3 | P6.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | N/A                     | 0                                       | 0        | 1        | –     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | COM0 <sup>(2)</sup>     | X                                       | 1        | 1        | –     |
| P6.4/TB0.0/COM1 | 4 | P6.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | TB0CCI0B                | 0                                       | 0        | 1        | –     |
|                 |   | TB0.0                   | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | COM1 <sup>(2)</sup>     | X                                       | 1        | 1        | –     |
| P6.5/TB0.1/COM2 | 5 | P6.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | TB0CCI1A                | 0                                       | 0        | 1        | –     |
|                 |   | TB0.1                   | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | COM2 <sup>(2)</sup>     | X                                       | 1        | 1        | –     |
| P6.6/TB0.2/COM3 | 6 | P6.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | –     |
|                 |   | TB0CCI2A                | 0                                       | 0        | 1        | –     |
|                 |   | TB0.2                   | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | –     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | COM3 <sup>(2)</sup>     | X                                       | 1        | 1        | –     |

(1) X = Don't care

(2) Setting P6SEL1.x and P6SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

### 6.11.23.11 Port P6 (P6.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-32](#) summarizes the selection of the pin function.

**Table 6-32. Port P6 (P6.7) Pin Functions**

| PIN NAME (P6.x) | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                 |   |                         | P6DIR.x                                 | P6SEL1.x | P6SEL0.x | LCDSz |
| P6.7/TA0CLK/Sz  | 7 | P6.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                 |   | TA0CLK                  | 0                                       | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.12 Port P7 (P7.0 to P7.7) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-33](#) and [Table 6-34](#) summarize the selection of the pin function.

**Table 6-33. Port P7 (P7.0 to P7.3) Pin Functions**

| PIN NAME (P7.x)    | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|--------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                    |   |                         | P7DIR.x                                 | P7SEL1.x | P7SEL0.x | LCDSz |
| P7.0/TA0CLK/Sz     | 0 | P7.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                    |   | TA0CLK                  | 0                                       | 0        | 1        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P7.1/TA0.0/ACLK/Sz | 1 | P7.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                    |   | TA0CCI0B                | 0                                       | 0        | 1        | 0     |
|                    |   | TA0.0                   | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                    |   | ACLK                    | 1                                       |          |          |       |
|                    |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P7.2/TA0.1/Sz      | 2 | P7.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                    |   | TA0CCI1A                | 0                                       | 0        | 1        | 0     |
|                    |   | TA0.1                   | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                    |   | N/A                     | 1                                       |          |          |       |
|                    |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P7.3/TA0.2/Sz      | 3 | P7.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                    |   | TA0CCI2A                | 0                                       | 0        | 1        | 0     |
|                    |   | TA0.2                   | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                    |   | Internally tied to DVSS | 1                                       |          |          |       |
|                    |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

**Table 6-34. Port P7 (P7.4 to P7.7) Pin Functions**

| PIN NAME (P7.x)       | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                       |   |                         | P7DIR.x                                 | P7SEL1.x | P7SEL0.x | LCDSz |
| P7.4/SMCLK/Sz         | 4 | P7.4 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                       |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                       |   | SMCLK                   | 1                                       |          |          |       |
|                       |   | Sz <sup>(2)</sup>       | X                                       |          |          |       |
| P7.5/TA0.2/Sz         | 5 | P7.5 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                       |   | TA0CCI2A                | 0                                       | 0        | 1        | 0     |
|                       |   | TA0.2                   | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | Sz <sup>(2)</sup>       | X                                       |          |          |       |
| P7.6/TA0.1/Sz         | 6 | P7.6 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                       |   | TA0CCI1A                | 0                                       | 0        | 1        | 0     |
|                       |   | TA0.1                   | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | Sz <sup>(2)</sup>       | X                                       |          |          |       |
| P7.7/TA1.2/TB0OUTH/Sz | 7 | P7.7 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                       |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | TA1.CCI2A               | 0                                       | 1        | 0        | 0     |
|                       |   | TA1.2                   | 1                                       |          |          |       |
|                       |   | TB0OUTH                 | 0                                       | 1        | 1        | 0     |
|                       |   | Internally tied to DVSS | 1                                       |          |          |       |
|                       |   | Sz <sup>(2)</sup>       | X                                       |          |          |       |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

### 6.11.23.13 Port P8 (P8.0 to P8.3) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-35](#) summarizes the selection of the pin function.

**Table 6-35. Port P8 (P8.0 to P8.3) Pin Functions**

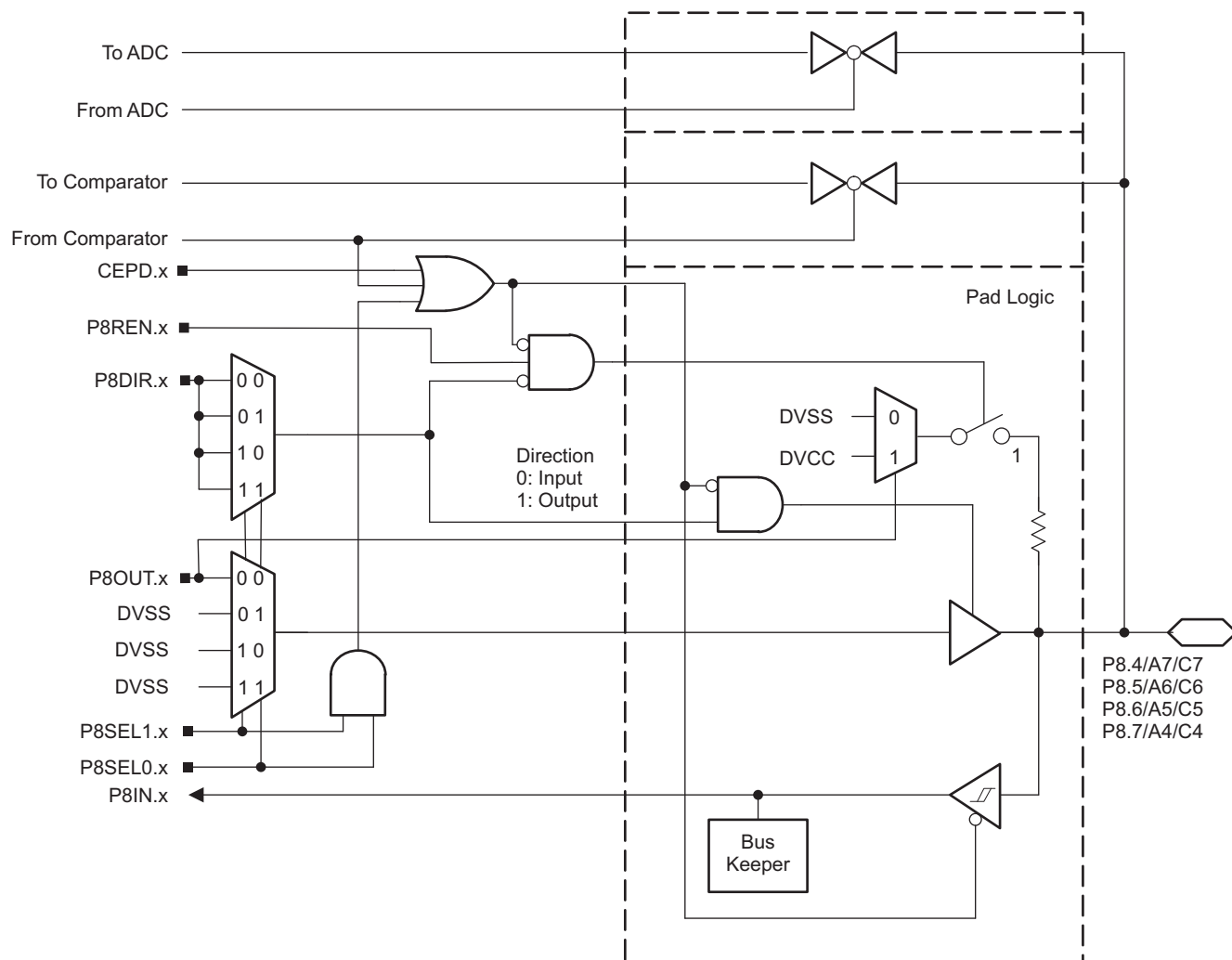
| PIN NAME (P8.x) | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |       |
|-----------------|---|-------------------------|-----------------------------------------|----------|----------|-------|
|                 |   |                         | P8DIR.x                                 | P8SEL1.x | P8SEL0.x | LCDSz |
| P8.0/RTCCLK/Sz  | 0 | P8.0 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                 |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                 |   | RTCCLK                  | 1                                       |          |          |       |
|                 |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P8.1/DMAE0/Sz   | 1 | P8.1 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                 |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | DMA0E                   | 0                                       | 1        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P8.2/Sz         | 2 | P8.2 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                 |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |
| P8.3/MCLK/Sz    | 3 | P8.3 (I/O)              | I: 0; O: 1                              | 0        | 0        | 0     |
|                 |   | N/A                     | 0                                       | 0        | 1        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 0        | 0     |
|                 |   | Internally tied to DVSS | 1                                       |          |          |       |
|                 |   | N/A                     | 0                                       | 1        | 1        | 0     |
|                 |   | MCLK                    | 1                                       |          |          |       |
|                 |   | Sz <sup>(2)</sup>       | X                                       | X        | X        | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

#### 6.11.23.14 Port P8 (P8.4 to P8.7) Input/Output With Schmitt Trigger

Figure 6-7 shows the port diagram. Table 6-36 summarizes the selection of the pin function.



NOTE: Functional representation only.

Figure 6-7. Port P8 (P8.4 to P8.7) Diagram

**Table 6-36. Port P8 (P8.4 to P8.7) Pin Functions**

| PIN NAME (P8.x) | x | FUNCTION                 | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|-----------------|---|--------------------------|-----------------------------------------|----------|----------|
|                 |   |                          | P8DIR.x                                 | P8SEL1.x | P8SEL0.x |
| P8.4/A7/C7      | 4 | P8.4 (I/O)               | I: 0; O: 1                              | 0        | 0        |
|                 |   | N/A                      | 0                                       | 0        | 1        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | N/A                      | 0                                       | 1        | 0        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | A7/C7 <sup>(2) (3)</sup> | X                                       | 1        | 1        |
| P8.5/A6/C6      | 5 | P8.5 (I/O)               | I: 0; O: 1                              | 0        | 0        |
|                 |   | N/A                      | 0                                       | 0        | 1        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | N/A                      | 0                                       | 1        | 0        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | A6/C6 <sup>(2) (3)</sup> | X                                       | 1        | 1        |
| P8.6/A5/C5      | 6 | P8.6 (I/O)               | I: 0; O: 1                              | 0        | 0        |
|                 |   | N/A                      | 0                                       | 0        | 1        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | N/A                      | 0                                       | 1        | 0        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | A5/C5 <sup>(2) (3)</sup> | X                                       | 1        | 1        |
| P8.7/A4/C4      | 7 | P8.7 (I/O)               | I: 0; O: 1                              | 0        | 0        |
|                 |   | N/A                      | 0                                       | 0        | 1        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | N/A                      | 0                                       | 1        | 0        |
|                 |   | Internally tied to DVSS  | 1                                       |          |          |
|                 |   | A4/C4 <sup>(2) (3)</sup> | X                                       | 1        | 1        |

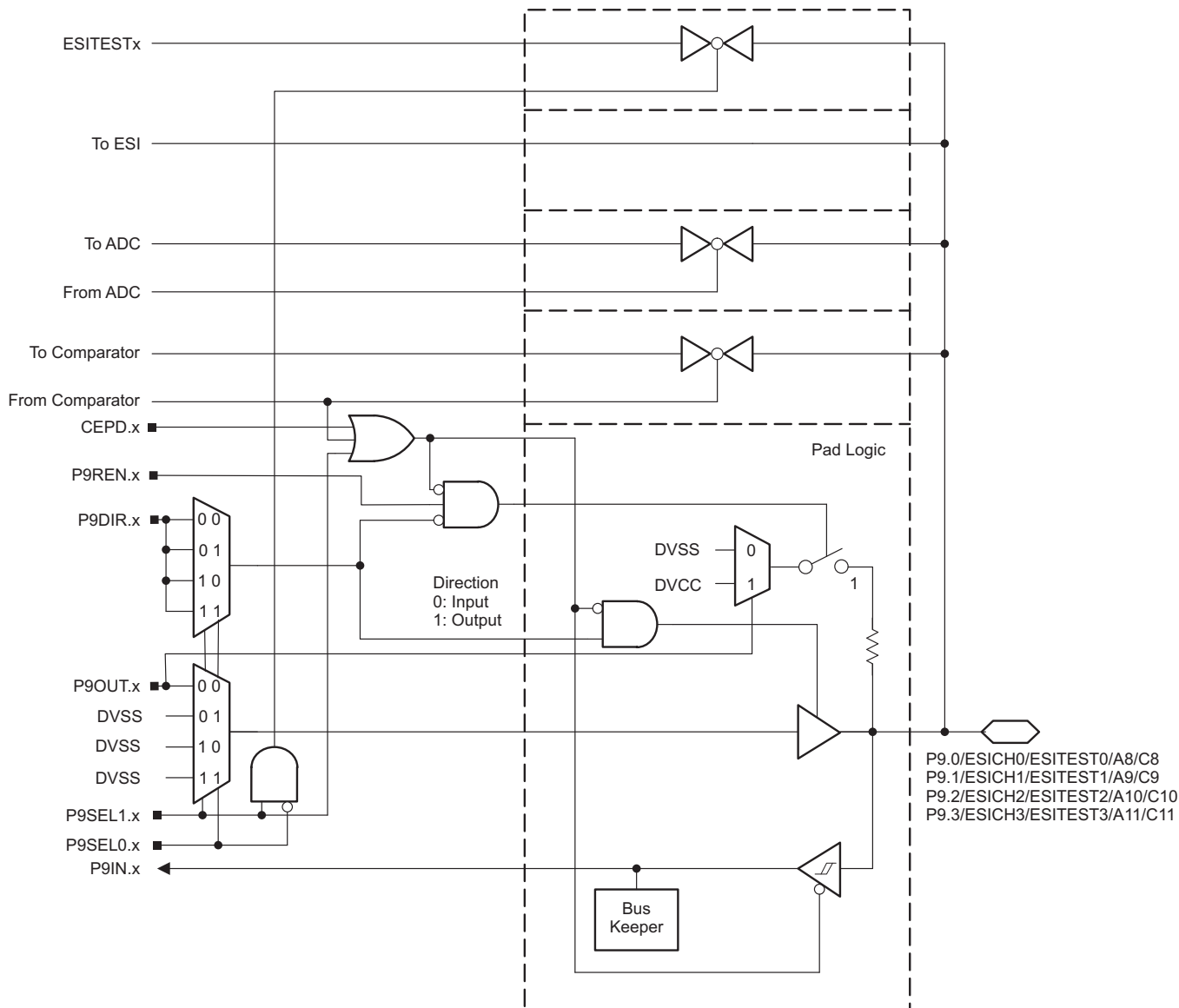
(1) X = Don't care

(2) Setting P8SEL1.x and P8SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(3) Setting the CEPD.x bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPD.x bit.

### 6.11.23.15 Port P9 (P9.0 to P9.3) Input/Output With Schmitt Trigger

Figure 6-8 shows the port diagram. Table 6-37 summarizes the selection of the pin function.



NOTE: Functional representation only.

Figure 6-8. Port P9 (P9.0 to P9.3) Diagram

**Table 6-37. Port P9 (P9.0 to P9.3) Pin Functions**

| PIN NAME (P9.x)              | x | FUNCTION                            | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|------------------------------|---|-------------------------------------|-----------------------------------------|----------|----------|
|                              |   |                                     | P9DIR.x                                 | P9SEL1.x | P9SEL0.x |
| P9.0/ESICH0/ESITEST0/A8/C8   | 0 | P9.0 (I/O)                          | I: 0; O: 1                              | 0        | 0        |
|                              |   | N/A                                 | 0                                       | 0        | 1        |
|                              |   | Internally tied to DVSS             | 1                                       |          |          |
|                              |   | ESITEST0 <sup>(2)</sup>             | X                                       |          |          |
|                              |   | ESICH0/A8/C8 <sup>(2)(3)(4)</sup>   | X                                       | 1        | 1        |
| P9.1/ESICH1/ESITEST1/A9/C9   | 1 | P9.1 (I/O)                          | I: 0; O: 1                              | 0        | 0        |
|                              |   | N/A                                 | 0                                       | 0        | 1        |
|                              |   | Internally tied to DVSS             | 1                                       |          |          |
|                              |   | ESITEST1 <sup>(2)</sup>             | X                                       |          |          |
|                              |   | ESICH1/A9/C9 <sup>(2)(3)(4)</sup>   | X                                       | 1        | 1        |
| P9.2/ESICH2/ESITEST2/A10/C10 | 2 | P9.2 (I/O)                          | I: 0; O: 1                              | 0        | 0        |
|                              |   | N/A                                 | 0                                       | 0        | 1        |
|                              |   | Internally tied to DVSS             | 1                                       |          |          |
|                              |   | ESITEST2 <sup>(2)</sup>             | X                                       |          |          |
|                              |   | ESICH2/A10/C10 <sup>(2)(3)(4)</sup> | X                                       | 1        | 1        |
| P9.3/ESICH3/ESITEST3/A11/C11 | 3 | P9.3 (I/O)                          | I: 0; O: 1                              | 0        | 0        |
|                              |   | N/A                                 | 0                                       | 0        | 1        |
|                              |   | Internally tied to DVSS             | 1                                       |          |          |
|                              |   | ESITEST3 <sup>(2)</sup>             | X                                       |          |          |
|                              |   | ESICH3/A11/C11 <sup>(2)(3)(4)</sup> | X                                       | 1        | 1        |

(1) X = Don't care

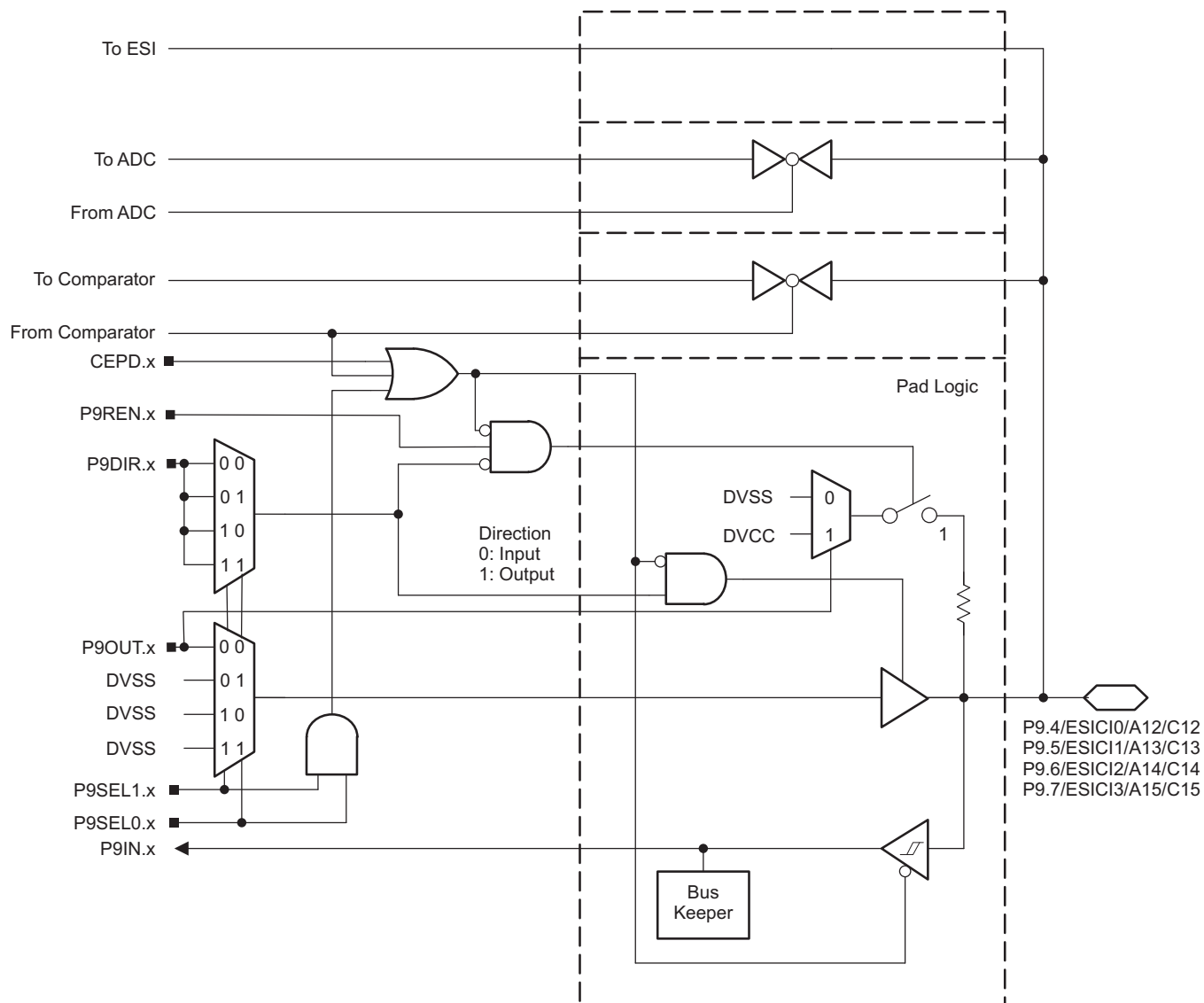
(2) Setting P9SEL1.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.

(3) Setting the CEPD.x bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPD.x bit.

(4) Depending on the configuration of the ESI module other ESICHx pins are stimulated as well and thus should have the input Schmitt triggers disabled (with P9SEL1.x = 1) and cannot be used as digital I/O, ADC or comparator inputs.

### 6.11.23.16 Port P9 (P9.4 to P9.7) Input/Output With Schmitt Trigger

Figure 6-9 shows the port diagram. Table 6-38 summarizes the selection of the pin function.



NOTE: Functional representation only.

Figure 6-9. Port P9 (P9.4 to P9.7) Diagram

**Table 6-38. Port P9 (P9.4 to P9.7) Pin Functions**

| PIN NAME (P9.x)     | x | FUNCTION                             | CONTROL BITS AND SIGNALS <sup>(1)</sup> |          |          |
|---------------------|---|--------------------------------------|-----------------------------------------|----------|----------|
|                     |   |                                      | P9DIR.x                                 | P9SEL1.x | P9SEL0.x |
| P9.4/ESIC10/A12/C12 | 4 | P9.4 (I/O)                           | I: 0; O: 1                              | 0        | 0        |
|                     |   | N/A                                  | 0                                       | 0        | 1        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | N/A                                  | 0                                       | 1        | 0        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | ESIC10/A12/C12 <sup>(2) (3)(4)</sup> | X                                       | 1        | 1        |
| P9.5/ESIC11/A13/C13 | 5 | P9.5 (I/O)                           | I: 0; O: 1                              | 0        | 0        |
|                     |   | N/A                                  | 0                                       | 0        | 1        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | N/A                                  | 0                                       | 1        | 0        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | ESIC11/A13/C13 <sup>(2) (3)(4)</sup> | X                                       | 1        | 1        |
| P9.6/ESIC12/A14/C14 | 6 | P9.6 (I/O)                           | I: 0; O: 1                              | 0        | 0        |
|                     |   | N/A                                  | 0                                       | 0        | 1        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | N/A                                  | 0                                       | 1        | 0        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | ESIC12/A14/C14 <sup>(2) (3)(4)</sup> | X                                       | 1        | 1        |
| P9.7/ESIC13/A15/C15 | 7 | P9.7 (I/O)                           | I: 0; O: 1                              | 0        | 0        |
|                     |   | N/A                                  | 0                                       | 0        | 1        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | N/A                                  | 0                                       | 1        | 0        |
|                     |   | Internally tied to DVSS              | 1                                       |          |          |
|                     |   | ESIC13/A15/C15 <sup>(2) (3)(4)</sup> | X                                       | 1        | 1        |

- (1) X = Don't care
- (2) Setting P9SEL1.x and P9SEL0.x disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals.
- (3) Setting the CEPD.x bit of the comparator disables the output driver and the input Schmitt trigger to prevent parasitic cross currents when applying analog signals. Selecting the Cx input pin to the comparator multiplexer with the input select bits in the comparator module automatically disables output driver and input buffer for that pin, regardless of the state of the associated CEPD.x bit.
- (4) Depending on the configuration of the ESI module, other ESIC12/ pins are used, and thus should have the input Schmitt triggers disabled (with P9SEL1.x = 1 and P9SEL0.x = 1) and cannot be used as digital I/O, ADC, or comparator inputs.

### 6.11.23.17 Port P10 (P10.0 to P10.2) Input/Output With Schmitt Trigger

For the pin diagram, see [Figure 6-2](#). [Table 6-39](#) summarizes the selection of the pin function.

**Table 6-39. Port P10 (P10.0 to P10.2) Pin Functions**

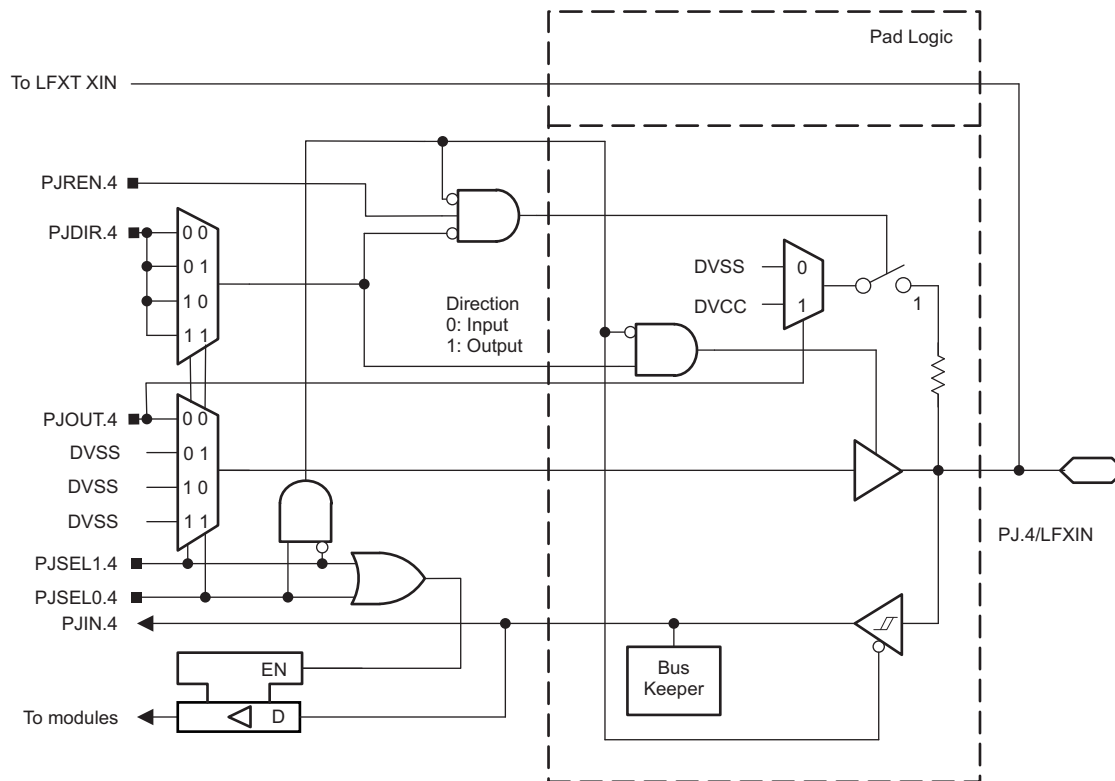
| PIN NAME (P10.x)     | x | FUNCTION                | CONTROL BITS AND SIGNALS <sup>(1)</sup> |           |           |       |
|----------------------|---|-------------------------|-----------------------------------------|-----------|-----------|-------|
|                      |   |                         | P10DIR.x                                | P10SEL1.x | P10SEL0.x | LCDSz |
| P10.0/SMCLK/Sz       | 0 | P10.0 (I/O)             | I: 0; O: 1                              | 0         | 0         | 0     |
|                      |   | N/A                     | 0                                       | 0         | 1         | 0     |
|                      |   | Internally tied to DVSS | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 0         | 0     |
|                      |   | Internally tied to DVSS | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 1         | 0     |
|                      |   | SMCLK                   | 1                                       |           |           |       |
|                      |   | Sz <sup>(2)</sup>       | X                                       | X         | X         | 1     |
| P10.1/TA0.0/Sz       | 1 | P10.1 (I/O)             | I: 0; O: 1                              | 0         | 0         | 0     |
|                      |   | TA0.CCI0B               | 0                                       | 0         | 1         | 0     |
|                      |   | TA0.0                   | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 0         | 0     |
|                      |   | Internally tied to DVSS | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 1         | 0     |
|                      |   | Internally tied to DVSS | 1                                       |           |           |       |
|                      |   | Sz <sup>(2)</sup>       | X                                       | X         | X         | 1     |
| P10.2/TA1.0/SMCLK/Sz | 2 | P10.2 (I/O)             | I: 0; O: 1                              | 0         | 0         | 0     |
|                      |   | TA1.CCI0B               | 0                                       | 0         | 1         | 0     |
|                      |   | TA1.0                   | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 0         | 0     |
|                      |   | Internally tied to DVSS | 1                                       |           |           |       |
|                      |   | N/A                     | 0                                       | 1         | 1         | 0     |
|                      |   | SMCLK                   | 1                                       |           |           |       |
|                      |   | Sz <sup>(2)</sup>       | X                                       | X         | X         | 1     |

(1) X = Don't care

(2) The associated LCD segment is package dependent. See the Signal Descriptions tables and Pin Diagrams figures.

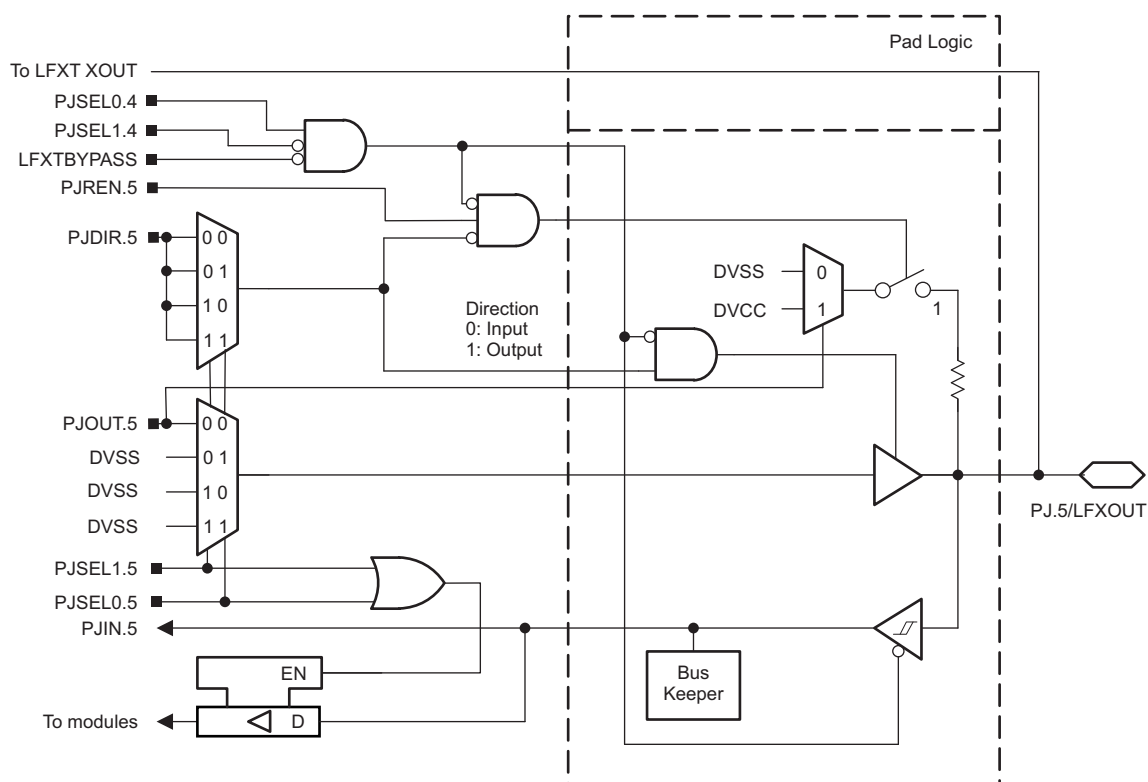
### 6.11.23.18 Port PJ (PJ.4 and PJ.5) Input/Output With Schmitt Trigger

Figure 6-10 and Figure 6-11 show the port diagrams. Table 6-40 summarizes the selection of the pin function.



NOTE: Functional representation only.

**Figure 6-10. Port PJ (PJ.4) Diagram**



NOTE: Functional representation only.

Figure 6-11. Port PJ (PJ.5) Diagram

**Table 6-40. Port PJ (PJ.4 and PJ.5) Pin Functions**

| PIN NAME (PJ.x) | x | FUNCTION                           | CONTROL BITS AND SIGNALS <sup>(1)</sup> |                    |                    |          |          |                  |
|-----------------|---|------------------------------------|-----------------------------------------|--------------------|--------------------|----------|----------|------------------|
|                 |   |                                    | PJDIR.x                                 | PJSEL1.5           | PJSEL0.5           | PJSEL1.4 | PJSEL0.4 | LFXT BYPASS      |
| PJ.4/LFXIN      | 4 | PJ.4 (I/O)                         | I: 0; O: 1                              | X                  | X                  | 0        | 0        | X                |
|                 |   | N/A                                | 0                                       | X                  | X                  | 1        | X        | X                |
|                 |   | Internally tied to DVSS            | 1                                       |                    |                    |          |          |                  |
|                 |   | LFXIN crystal mode <sup>(2)</sup>  | X                                       | X                  | X                  | 0        | 1        | 0                |
|                 |   | LFXIN bypass mode <sup>(2)</sup>   | X                                       | X                  | X                  | 0        | 1        | 1                |
| PJ.5/LFXOUT     | 5 | PJ.5 (I/O)                         | I: 0; O: 1                              | 0                  | 0                  | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | N/A                                | 0                                       | see <sup>(4)</sup> | see <sup>(4)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | Internally tied to DVSS            | 1                                       | see <sup>(4)</sup> | see <sup>(4)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | LFXOUT crystal mode <sup>(2)</sup> | X                                       | X                  | X                  | 0        | 1        | 0                |

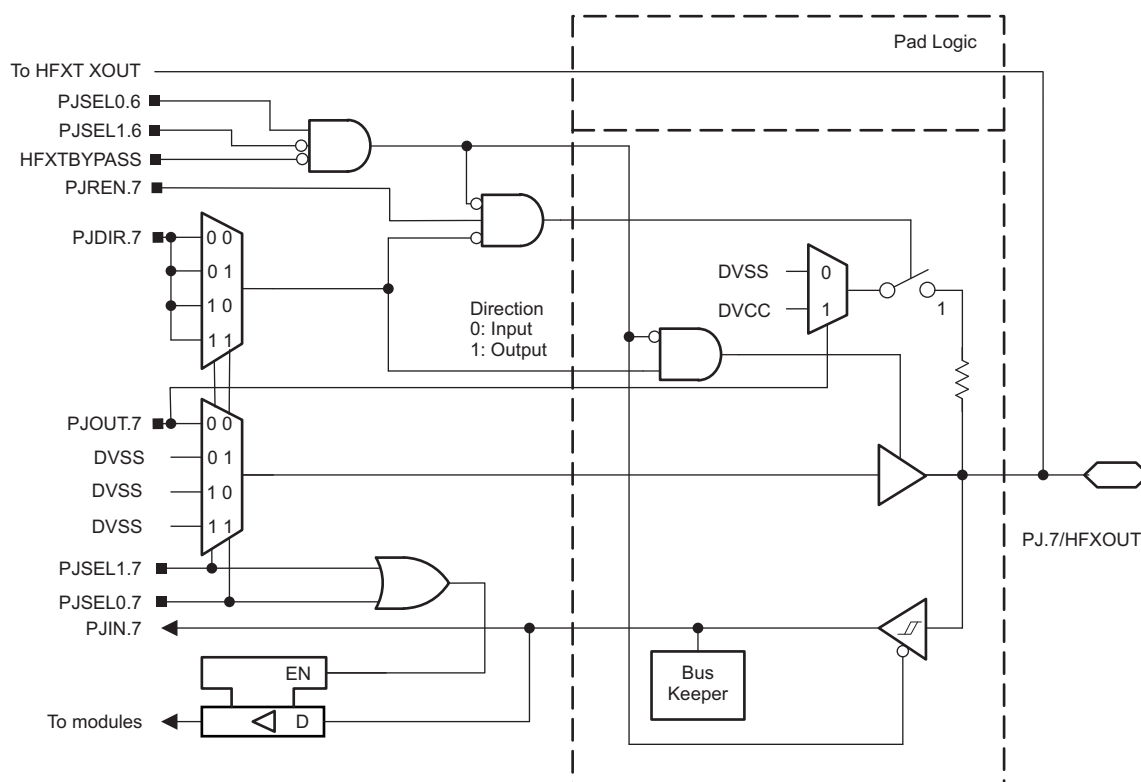
(1) X = Don't care

(2) Setting PJSEL1.4 = 0 and PJSEL0.4 = 1 causes the general-purpose I/O to be disabled. When LFXTBYPASS = 0, PJ.4 and PJ.5 are configured for crystal operation and PJSEL1.5 and PJSEL0.5 are don't care. When LFXTBYPASS = 1, PJ.4 is configured for bypass operation and PJ.5 is configured as general-purpose I/O.

(3) When PJ.4 is configured in bypass mode, PJ.5 is configured as general-purpose I/O.

(4) With PJSEL0.5 = 1 or PJSEL1.5 = 1 the general-purpose I/O functionality is disabled. No input function is available. When configured as output, the pin is actively pulled to zero.





NOTE: Functional representation only.

**Figure 6-13. Port PJ (PJ.7) Diagram**

**Table 6-41. Port PJ (PJ.6 and PJ.7) Pin Functions**

| PIN NAME (PJ.x) | x | FUNCTION                           | CONTROL BITS AND SIGNALS <sup>(1)</sup> |                    |                    |          |          |                  |
|-----------------|---|------------------------------------|-----------------------------------------|--------------------|--------------------|----------|----------|------------------|
|                 |   |                                    | PJDIR.x                                 | PJSEL1.7           | PJSEL0.7           | PJSEL1.6 | PJSEL0.6 | HFXT BYPASS      |
| PJ.6/HFXIN      | 6 | PJ.6 (I/O)                         | I: 0; O: 1                              | X                  | X                  | 0        | 0        | X                |
|                 |   | N/A                                | 0                                       | X                  | X                  | 1        | X        | X                |
|                 |   | Internally tied to DVSS            | 1                                       |                    |                    |          |          |                  |
|                 |   | HFXIN crystal mode <sup>(2)</sup>  | X                                       | X                  | X                  | 0        | 1        | 0                |
|                 |   | HFXIN bypass mode <sup>(2)</sup>   | X                                       | X                  | X                  | 0        | 1        | 1                |
| PJ.7/HFXOUT     | 7 | PJ.7 (I/O)                         | I: 0; O: 1                              | 0                  | 0                  | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | N/A                                | 0                                       | see <sup>(4)</sup> | see <sup>(4)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | Internally tied to DVSS            | 1                                       | see <sup>(4)</sup> | see <sup>(4)</sup> | 0        | 0        | 0                |
|                 |   |                                    |                                         |                    |                    | 1        | X        |                  |
|                 |   |                                    |                                         |                    |                    | X        | X        | 1 <sup>(3)</sup> |
|                 |   | HFXOUT crystal mode <sup>(2)</sup> | X                                       | X                  | X                  | 0        | 1        | 0                |

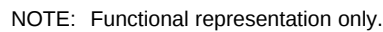
(1) X = Don't care

(2) Setting PJSEL1.6 = 0 and PJSEL0.6 = 1 causes the general-purpose I/O to be disabled. When HFXTBYPASS = 0, PJ.6 and PJ.7 are configured for crystal operation and PJSEL1.6 and PJSEL0.7 are don't care. When HFXTBYPASS = 1, PJ.6 is configured for bypass operation and PJ.7 is configured as general-purpose I/O.

(3) When PJ.6 is configured in bypass mode, PJ.7 is configured as general-purpose I/O.

(4) With PJSEL0.7 = 1 or PJSEL1.7 = 1 the general-purpose I/O functionality is disabled. No input function is available. When configured as output, the pin is actively pulled to zero.

Figure 6-14 shows the port diagram. Table 6-42 summarizes the selection of the pin function.



### Figure 6-14. Port PJ (PJ.0 to PJ.3) Diagram

**Table 6-42. Port PJ (PJ.0 to PJ.3) Pin Functions**

| PIN NAME (PJ.x)                   | x | FUNCTION                       | CONTROL BITS OR SIGNALS <sup>(1)</sup> |          |          |
|-----------------------------------|---|--------------------------------|----------------------------------------|----------|----------|
|                                   |   |                                | PJDIR.x                                | PJSEL1.x | PJSEL0.x |
| PJ.0/TDO/TB0OUTH/<br>SMCLK/SRSCG1 | 0 | PJ.0 (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0        | 0        |
|                                   |   | TDO <sup>(3)</sup>             | X                                      | X        | X        |
|                                   |   | TB0OUTH                        | 0                                      | 0        | 1        |
|                                   |   | SMCLK <sup>(4)</sup>           | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 0        |
|                                   |   | CPU Status Register Bit SCG1   | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 1        |
|                                   |   | Internally tied to DVSS        | 1                                      |          |          |
| PJ.1/TDI/TCLK/<br>MCLK/SRSCG0     | 1 | PJ.1 (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0        | 0        |
|                                   |   | TDI/TCLK <sup>(3) (5)</sup>    | X                                      | X        | X        |
|                                   |   | N/A                            | 0                                      | 0        | 1        |
|                                   |   | MCLK                           | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 0        |
|                                   |   | CPU Status Register Bit SCG0   | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 1        |
|                                   |   | Internally tied to DVSS        | 1                                      |          |          |
| PJ.2/TMS/ACLK/<br>SROSCOFF        | 2 | PJ.2 (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0        | 0        |
|                                   |   | TMS <sup>(3) (5)</sup>         | X                                      | X        | X        |
|                                   |   | N/A                            | 0                                      | 0        | 1        |
|                                   |   | ACLK                           | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 0        |
|                                   |   | CPU Status Register Bit OSCOFF | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 1        |
|                                   |   | Internally tied to DVSS        | 1                                      |          |          |
| PJ.3/TCK/COUT/<br>SRCPUOFF        | 3 | PJ.3 (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0        | 0        |
|                                   |   | TCK <sup>(3) (5)</sup>         | X                                      | X        | X        |
|                                   |   | N/A                            | 0                                      | 0        | 1        |
|                                   |   | COUT                           | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 0        |
|                                   |   | CPU Status Register Bit CPUOFF | 1                                      |          |          |
|                                   |   | N/A                            | 0                                      | 1        | 1        |
|                                   |   | Internally tied to DVSS        | 1                                      |          |          |

(1) X = Don't care

(2) Default condition

(3) The pin direction is controlled by the JTAG module. JTAG mode selection is made through the SYS module or by the Spy-Bi-Wire 4-wire entry sequence. Neither PJSEL1.x and PJSEL0.x nor CEPD.x bits have an effect in these cases.

(4) Do not use this pin as SMCLK output if the TB0OUTH functionality is used on any other pin. Select an alternative SMCLK output pin.

(5) In JTAG mode, pullups are activated automatically on TMS, TCK, and TDI/TCLK. PJREN.x are don't care.

## 6.12 Device Descriptors (TLV)

[Table 6-43](#) summarizes the Device IDs. [Table 6-44](#) lists the contents of the device descriptor tag-length-value (TLV) structure for each device type.

**Table 6-43. Device ID**

| DEVICE        | DEVICE ID |        |
|---------------|-----------|--------|
|               | 01A05h    | 01A04h |
| MSP430FR6889  | 081h      | 0C0h   |
| MSP430FR6888  | 081h      | 0BFh   |
| MSP430FR6887  | 081h      | 0BEh   |
| MSP430FR5889  | 081h      | 0C3h   |
| MSP430FR5888  | 081h      | 0C2h   |
| MSP430FR5887  | 081h      | 0C1h   |
| MSP430FR68891 | 081h      | 0C0h   |
| MSP430FR58891 | 081h      | 0C3h   |

**Table 6-44. Device Descriptor Table <sup>(1)</sup>**

| DESCRIPTION        |                                                | MSP430FRxxxx (UART BSL) |                                  | MSP430FRxxxx1 (I <sup>2</sup> C BSL) |                                  |
|--------------------|------------------------------------------------|-------------------------|----------------------------------|--------------------------------------|----------------------------------|
|                    |                                                | ADDRESS                 | VALUE                            | ADDRESS                              | VALUE                            |
| Info Block         | Info length                                    | 01A00h                  | 06h                              | 01A00h                               | 06h                              |
|                    | CRC length                                     | 01A01h                  | 06h                              | 01A01h                               | 06h                              |
|                    | CRC value                                      | 01A02h                  | Per unit                         | 01A02h                               | Per unit                         |
|                    |                                                | 01A03h                  | Per unit                         | 01A03h                               | Per unit                         |
|                    | Device ID                                      | 01A04h                  | See <a href="#">Table 6-43</a> . | 01A04h                               | See <a href="#">Table 6-43</a> . |
|                    |                                                | 01A05h                  |                                  | 01A05h                               |                                  |
|                    | Hardware revision                              | 01A06h                  | Per unit                         | 01A06h                               | Per unit                         |
| Die Record         | Firmware revision                              | 01A07h                  | Per unit                         | 01A07h                               | Per unit                         |
|                    | Die record tag                                 | 01A08h                  | 08h                              | 01A08h                               | 08h                              |
|                    | Die record length                              | 01A09h                  | 0Ah                              | 01A09h                               | 0Ah                              |
|                    | Lot/wafer ID                                   | 01A0Ah                  | Per unit                         | 01A0Ah                               | Per unit                         |
|                    |                                                | 01A0Bh                  | Per unit                         | 01A0Bh                               | Per unit                         |
|                    |                                                | 01A0Ch                  | Per unit                         | 01A0Ch                               | Per unit                         |
|                    |                                                | 01A0Dh                  | Per unit                         | 01A0Dh                               | Per unit                         |
|                    | Die X position                                 | 01A0Eh                  | Per unit                         | 01A0Eh                               | Per unit                         |
|                    |                                                | 01A0Fh                  | Per unit                         | 01A0Fh                               | Per unit                         |
|                    | Die Y position                                 | 01A10h                  | Per unit                         | 01A10h                               | Per unit                         |
|                    |                                                | 01A11h                  | Per unit                         | 01A11h                               | Per unit                         |
|                    | Test results                                   | 01A12h                  | Per unit                         | 01A12h                               | Per unit                         |
|                    |                                                | 01A13h                  | Per unit                         | 01A13h                               | Per unit                         |
| ADC12B Calibration | ADC12B calibration tag                         | 01A14h                  | 11h                              | 01A14h                               | 11h                              |
|                    | ADC12B calibration length                      | 01A15h                  | 10h                              | 01A15h                               | 10h                              |
|                    | ADC gain factor <sup>(2)</sup>                 | 01A16h                  | Per unit                         | 01A16h                               | Per unit                         |
|                    |                                                | 01A17h                  | Per unit                         | 01A17h                               | Per unit                         |
|                    | ADC offset <sup>(3)</sup>                      | 01A18h                  | Per unit                         | 01A18h                               | Per unit                         |
|                    |                                                | 01A19h                  | Per unit                         | 01A19h                               | Per unit                         |
|                    | ADC 1.2-V reference<br>Temperature sensor 30°C | 01A1Ah                  | Per unit                         | 01A1Ah                               | Per unit                         |
|                    |                                                | 01A1Bh                  | Per unit                         | 01A1Bh                               | Per unit                         |
|                    | ADC 1.2-V reference<br>Temperature sensor 85°C | 01A1Ch                  | Per unit                         | 01A1Ch                               | Per unit                         |
|                    |                                                | 01A1Dh                  | Per unit                         | 01A1Dh                               | Per unit                         |
|                    | ADC 2.0-V reference<br>Temperature sensor 30°C | 01A1Eh                  | Per unit                         | 01A1Eh                               | Per unit                         |
|                    |                                                | 01A1Fh                  | Per unit                         | 01A1Fh                               | Per unit                         |
|                    | ADC 2.0-V reference<br>Temperature sensor 85°C | 01A20h                  | Per unit                         | 01A20h                               | Per unit                         |
|                    |                                                | 01A21h                  | Per unit                         | 01A21h                               | Per unit                         |
|                    | ADC 2.5-V reference<br>Temperature sensor 30°C | 01A22h                  | Per unit                         | 01A22h                               | Per unit                         |
|                    |                                                | 01A23h                  | Per unit                         | 01A23h                               | Per unit                         |
|                    | ADC 2.5-V reference<br>Temperature sensor 85°C | 01A24h                  | Per unit                         | 01A24h                               | Per unit                         |
|                    |                                                | 01A25h                  | Per unit                         | 01A25h                               | Per unit                         |

(1) NA = Not applicable, Per unit = Content can differ from device to device

(2) ADC gain: The gain correction factor is measured using the internal voltage reference with REFOUT = 0. Other settings (for example, with REFOUT = 1) can result in different correction factors.

(3) ADC offset: The offset correction factor is measured using the internal 2.5-V reference.

**Table 6-44. Device Descriptor Table <sup>(1)</sup> (continued)**

| DESCRIPTION       |                                      | MSP430FRxxxx (UART BSL) |          | MSP430FRxxxx1 (I <sup>2</sup> C BSL) |          |
|-------------------|--------------------------------------|-------------------------|----------|--------------------------------------|----------|
|                   |                                      | ADDRESS                 | VALUE    | ADDRESS                              | VALUE    |
| REF Calibration   | REF calibration tag                  | 01A26h                  | 12h      | 01A26h                               | 12h      |
|                   | REF calibration length               | 01A27h                  | 06h      | 01A27h                               | 06h      |
|                   | REF 1.2-V reference                  | 01A28h                  | Per unit | 01A28h                               | Per unit |
|                   |                                      | 01A29h                  | Per unit | 01A29h                               | Per unit |
|                   | REF 2.0-V reference                  | 01A2Ah                  | Per unit | 01A2Ah                               | Per unit |
|                   |                                      | 01A2Bh                  | Per unit | 01A2Bh                               | Per unit |
|                   | REF 2.5-V reference                  | 01A2Ch                  | Per unit | 01A2Ch                               | Per unit |
|                   |                                      | 01A2Dh                  | Per unit | 01A2Dh                               | Per unit |
| Random Number     | 128-bit random number tag            | 01A2Eh                  | 15h      | 01A2Eh                               | 15h      |
|                   | Random number length                 | 01A2Fh                  | 10h      | 01A2Fh                               | 10h      |
|                   | 128-bit random number <sup>(4)</sup> | 01A30h                  | Per unit | 01A30h                               | Per unit |
|                   |                                      | 01A31h                  | Per unit | 01A31h                               | Per unit |
|                   |                                      | 01A32h                  | Per unit | 01A32h                               | Per unit |
|                   |                                      | 01A33h                  | Per unit | 01A33h                               | Per unit |
|                   |                                      | 01A34h                  | Per unit | 01A34h                               | Per unit |
|                   |                                      | 01A35h                  | Per unit | 01A35h                               | Per unit |
|                   |                                      | 01A36h                  | Per unit | 01A36h                               | Per unit |
|                   |                                      | 01A37h                  | Per unit | 01A37h                               | Per unit |
|                   |                                      | 01A38h                  | Per unit | 01A38h                               | Per unit |
|                   |                                      | 01A39h                  | Per unit | 01A39h                               | Per unit |
|                   |                                      | 01A3Ah                  | Per unit | 01A3Ah                               | Per unit |
|                   |                                      | 01A3Bh                  | Per unit | 01A3Bh                               | Per unit |
|                   |                                      | 01A3Ch                  | Per unit | 01A3Ch                               | Per unit |
|                   |                                      | 01A3Dh                  | Per unit | 01A3Dh                               | Per unit |
|                   |                                      | 01A3Eh                  | Per unit | 01A3Eh                               | Per unit |
|                   |                                      | 01A3Fh                  | Per unit | 01A3Fh                               | Per unit |
| BSL Configuration | BSL tag                              | 01A40h                  | 1Ch      | 01A40h                               | 1Ch      |
|                   | BSL length                           | 01A41h                  | 02h      | 01A41h                               | 02h      |
|                   | BSL interface                        | 01A42h                  | 00h      | 01A42h                               | 01h      |
|                   | BSL interface configuration          | 01A43h                  | 00h      | 01A43h                               | 48h      |

(4) 128-bit random number: The random number is generated during production test using the CryptGenRandom() function from Microsoft®.

## 6.13 Memory

Table 6-45 summarizes the memory map.

**Table 6-45. Memory Organization<sup>(1)</sup>**

|                                                                                 |            | MSP430FRxxx9(1)                             | MSP430FRxxx8(1)                            | MSP430FRxxx7(1)                            |
|---------------------------------------------------------------------------------|------------|---------------------------------------------|--------------------------------------------|--------------------------------------------|
| Memory (FRAM)<br>Main: interrupt vectors<br>and signatures<br>Main: code memory | Total Size | 127KB<br>00FFFFh–00FF80h<br>023FFFh–004400h | 95KB<br>00FFFFh–00FF80h<br>01BFFFh–004400h | 63KB<br>00FFFFh–00FF80h<br>013FFFh–004400h |
| RAM                                                                             | Sect 1     | 2KB<br>0023FFh–001C00h                      | 2KB<br>0023FFh–001C00h                     | 2KB<br>0023FFh–001C00h                     |
| Boot memory (ROM)                                                               |            | 256 B<br>001BFFh–001B00h                    | 256 B<br>001BFFh–001B00h                   | 256 B<br>001BFFh–001B00h                   |
| Device Descriptor Info<br>(TLV)                                                 |            | 256 B<br>001AFFh–001A00h                    | 256 B<br>001AFFh–001A00h                   | 256 B<br>001AFFh–001A00h                   |
| Information memory<br>(FRAM)                                                    | Info A     | 128 B<br>0019FFh–001980h                    | 128 B<br>0019FFh–001980h                   | 128 B<br>0019FFh–001980h                   |
|                                                                                 | Info B     | 128 B<br>00197Fh–001900h                    | 128 B<br>00197Fh–001900h                   | 128 B<br>00197Fh–001900h                   |
|                                                                                 | Info C     | 128 B<br>0018FFh–001880h                    | 128 B<br>0018FFh–001880h                   | 128 B<br>0018FFh–001880h                   |
|                                                                                 | Info D     | 128 B<br>00187Fh–001800h                    | 128 B<br>00187Fh–001800h                   | 128 B<br>00187Fh–001800h                   |
| Bootloader (BSL)<br>memory (ROM)                                                | BSL 3      | 512 B<br>0017FFh–001600h                    | 512 B<br>0017FFh–001600h                   | 512 B<br>0017FFh–001600h                   |
|                                                                                 | BSL 2      | 512 B<br>0015FFh–001400h                    | 512 B<br>0015FFh–001400h                   | 512 B<br>0015FFh–001400h                   |
|                                                                                 | BSL 1      | 512 B<br>0013FFh–001200h                    | 512 B<br>0013FFh–001200h                   | 512 B<br>0013FFh–001200h                   |
|                                                                                 | BSL 0      | 512 B<br>0011FFh–001000h                    | 512 B<br>0011FFh–001000h                   | 512 B<br>0011FFh–001000h                   |
| Peripherals                                                                     | Size       | 4KB<br>000FFFh–000020h                      | 4KB<br>000FFFh–000020h                     | 4KB<br>000FFFh–000020h                     |
| Tiny RAM                                                                        | Size       | 26 B<br>000001Fh–000006h                    | 26 B<br>000001Fh–000006h                   | 26 B<br>000001Fh–000006h                   |
| Reserved<br>(Read Only)                                                         | Size       | 6 B<br>000005h–000000h                      | 6 B<br>000005h–000000h                     | 6 B<br>000005h–000000h                     |

(1) All address space not listed is considered vacant memory.

### 6.13.1 Peripheral File Map

Table 6-46 lists the base address for each available peripheral. Table 6-47 through Table 6-81 list the registers and their offsets for each peripheral.

**Table 6-46. Peripherals**

| MODULE NAME                                 | BASE ADDRESS | OFFSET ADDRESS RANGE |
|---------------------------------------------|--------------|----------------------|
| Special Functions (see Table 6-47)          | 0100h        | 000h–01Fh            |
| PMM (see Table 6-48)                        | 0120h        | 000h–01Fh            |
| FRAM Control (see Table 6-49)               | 0140h        | 000h–00Fh            |
| CRC16 (see Table 6-50)                      | 0150h        | 000h–007h            |
| RAM Controller (see Table 6-51)             | 0158h        | 000h–001h            |
| Watchdog Timer (see Table 6-52)             | 015Ch        | 000h–001h            |
| CS (see Table 6-53)                         | 0160h        | 000h–00Fh            |
| SYS (see Table 6-54)                        | 0180h        | 000h–01Fh            |
| Shared Reference (see Table 6-55)           | 01B0h        | 000h–001h            |
| Port P1, P2 (see Table 6-56)                | 0200h        | 000h–01Fh            |
| Port P3, P4 (see Table 6-57)                | 0220h        | 000h–01Fh            |
| Port P5, P6 (see Table 6-58)                | 0240h        | 000h–01Fh            |
| Port P7, P8 (see Table 6-59)                | 0260h        | 000h–01Fh            |
| Port P9, P10 (see Table 6-60)               | 0280h        | 000h–01Fh            |
| Port PJ (see Table 6-61)                    | 0320h        | 000h–01Fh            |
| Timer_A TA0 (see Table 6-62)                | 0340h        | 000h–02Fh            |
| Timer_A TA1 (see Table 6-63)                | 0380h        | 000h–02Fh            |
| Timer_B TB0 (see Table 6-64)                | 03C0h        | 000h–02Fh            |
| Timer_A TA2 (see Table 6-65)                | 0400h        | 000h–02Fh            |
| Capacitive Touch I/O 0 (see Table 6-66)     | 0430h        | 000h–00Fh            |
| Timer_A TA3 (see Table 6-67)                | 0440h        | 000h–02Fh            |
| Capacitive Touch I/O 1 (see Table 6-68)     | 0470h        | 000h–00Fh            |
| Real-Time Clock (RTC_C) (see Table 6-69)    | 04A0h        | 000h–01Fh            |
| 32-Bit Hardware Multiplier (see Table 6-70) | 04C0h        | 000h–02Fh            |
| DMA General Control (see Table 6-71)        | 0500h        | 000h–00Fh            |
| DMA Channel 0 (see Table 6-71)              | 0510h        | 000h–00Fh            |
| DMA Channel 1 (see Table 6-71)              | 0520h        | 000h–00Fh            |
| DMA Channel 2 (see Table 6-71)              | 0530h        | 000h–00Fh            |
| MPU (see Table 6-72)                        | 05A0h        | 000h–00Fh            |
| eUSCI_A0 (see Table 6-73)                   | 05C0h        | 000h–01Fh            |
| eUSCI_A1 (see Table 6-74)                   | 05E0h        | 000h–01Fh            |
| eUSCI_B0 (see Table 6-75)                   | 0640h        | 000h–02Fh            |
| eUSCI_B1 (see Table 6-76)                   | 0680h        | 000h–02Fh            |
| ADC12_B (see Table 6-77)                    | 0800h        | 000h–09Fh            |
| Comparator_E (see Table 6-78)               | 08C0h        | 000h–00Fh            |
| CRC32 (see Table 6-79)                      | 0980h        | 000h–02Fh            |
| LCD_C (see Table 6-80)                      | 0A00h        | 000h–05Fh            |
| ESI (see Table 6-81)                        | 0D00h        | 000h–09Fh            |
| ESI RAM (128 bytes)                         | 0E00h        | 00h–07Fh             |

**Table 6-47. Special Function Registers (Base Address: 0100h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| SFR interrupt enable  | SFRIE1   | 00h    |
| SFR interrupt flag    | SFRIFG1  | 02h    |
| SFR reset pin control | SFRRPCR  | 04h    |

**Table 6-48. PMM Registers (Base Address: 0120h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| PMM control 0        | PMMCTL0  | 00h    |
| PMM interrupt flags  | PMMIFG   | 0Ah    |
| PM5 control 0        | PM5CTL0  | 10h    |

**Table 6-49. FRAM Control Registers (Base Address: 0140h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| FRAM control 0       | FRCTL0   | 00h    |
| General control 0    | GCCTL0   | 04h    |
| General control 1    | GCCTL1   | 06h    |

**Table 6-50. CRC16 Registers (Base Address: 0150h)**

| REGISTER DESCRIPTION          | REGISTER  | OFFSET |
|-------------------------------|-----------|--------|
| CRC data input                | CRC16DI   | 00h    |
| CRC data input reverse byte   | CRCDIRB   | 02h    |
| CRC initialization and result | CRCINIRES | 04h    |
| CRC result reverse byte       | CRCRESR   | 06h    |

**Table 6-51. RAM Controller Registers (Base Address: 0158h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| RAM controller control 0 | RCCTL0   | 00h    |

**Table 6-52. Watchdog Registers (Base Address: 015Ch)**

| REGISTER DESCRIPTION   | REGISTER | OFFSET |
|------------------------|----------|--------|
| Watchdog timer control | WDTCTL   | 00h    |

**Table 6-53. CS Registers (Base Address: 0160h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| CS control 0         | CSCTL0   | 00h    |
| CS control 1         | CSCTL1   | 02h    |
| CS control 2         | CSCTL2   | 04h    |
| CS control 3         | CSCTL3   | 06h    |
| CS control 4         | CSCTL4   | 08h    |
| CS control 5         | CSCTL5   | 0Ah    |
| CS control 6         | CSCTL6   | 0Ch    |

**Table 6-54. SYS Registers (Base Address: 0180h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| System control       | SYSCTL   | 00h    |
| JTAG mailbox control | SYSJMBC  | 06h    |

**Table 6-54. SYS Registers (Base Address: 0180h) (continued)**

| REGISTER DESCRIPTION        | REGISTER | OFFSET |
|-----------------------------|----------|--------|
| JTAG mailbox input 0        | SYSJMBIO | 08h    |
| JTAG mailbox input 1        | SYSJMBI1 | 0Ah    |
| JTAG mailbox output 0       | SYSJMBO0 | 0Ch    |
| JTAG mailbox output 1       | SYSJMBO1 | 0Eh    |
| User NMI vector generator   | SYSUNIV  | 1Ah    |
| System NMI vector generator | SYSSNIV  | 1Ch    |
| Reset vector generator      | SYSRSTIV | 1Eh    |

**Table 6-55. Shared Reference Registers (Base Address: 01B0h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| Shared reference control | REFCTL   | 00h    |

**Table 6-56. Port P1, P2 Registers (Base Address: 0200h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| Port P1 input                 | P1IN     | 00h    |
| Port P1 output                | P1OUT    | 02h    |
| Port P1 direction             | P1DIR    | 04h    |
| Port P1 resistor enable       | P1REN    | 06h    |
| Port P1 selection 0           | P1SEL0   | 0Ah    |
| Port P1 selection 1           | P1SEL1   | 0Ch    |
| Port P1 interrupt vector word | P1IV     | 0Eh    |
| Port P1 complement selection  | P1SELC   | 16h    |
| Port P1 interrupt edge select | P1IES    | 18h    |
| Port P1 interrupt enable      | P1IE     | 1Ah    |
| Port P1 interrupt flag        | P1IFG    | 1Ch    |
| Port P2 input                 | P2IN     | 01h    |
| Port P2 output                | P2OUT    | 03h    |
| Port P2 direction             | P2DIR    | 05h    |
| Port P2 resistor enable       | P2REN    | 07h    |
| Port P2 selection 0           | P2SEL0   | 0Bh    |
| Port P2 selection 1           | P2SEL1   | 0Dh    |
| Port P2 complement selection  | P2SELC   | 17h    |
| Port P2 interrupt vector word | P2IV     | 1Eh    |
| Port P2 interrupt edge select | P2IES    | 19h    |
| Port P2 interrupt enable      | P2IE     | 1Bh    |
| Port P2 interrupt flag        | P2IFG    | 1Dh    |

**Table 6-57. Port P3, P4 Registers (Base Address: 0220h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| Port P3 input                 | P3IN     | 00h    |
| Port P3 output                | P3OUT    | 02h    |
| Port P3 direction             | P3DIR    | 04h    |
| Port P3 resistor enable       | P3REN    | 06h    |
| Port P3 selection 0           | P3SEL0   | 0Ah    |
| Port P3 selection 1           | P3SEL1   | 0Ch    |
| Port P3 interrupt vector word | P3IV     | 0Eh    |

**Table 6-57. Port P3, P4 Registers (Base Address: 0220h) (continued)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| Port P3 complement selection  | P3SELC   | 16h    |
| Port P3 interrupt edge select | P3IES    | 18h    |
| Port P3 interrupt enable      | P3IE     | 1Ah    |
| Port P3 interrupt flag        | P3IFG    | 1Ch    |
| Port P4 input                 | P4IN     | 01h    |
| Port P4 output                | P4OUT    | 03h    |
| Port P4 direction             | P4DIR    | 05h    |
| Port P4 resistor enable       | P4REN    | 07h    |
| Port P4 selection 0           | P4SEL0   | 0Bh    |
| Port P4 selection 1           | P4SEL1   | 0Dh    |
| Port P4 complement selection  | P4SELC   | 17h    |
| Port P4 interrupt vector word | P4IV     | 1Eh    |
| Port P4 interrupt edge select | P4IES    | 19h    |
| Port P4 interrupt enable      | P4IE     | 1Bh    |
| Port P4 interrupt flag        | P4IFG    | 1Dh    |

**Table 6-58. Port P5, P6 Registers (Base Address: 0240h)**

| REGISTER DESCRIPTION         | REGISTER | OFFSET |
|------------------------------|----------|--------|
| Port P5 input                | P5IN     | 00h    |
| Port P5 output               | P5OUT    | 02h    |
| Port P5 direction            | P5DIR    | 04h    |
| Port P5 resistor enable      | P5REN    | 06h    |
| Port P5 selection 0          | P5SEL0   | 0Ah    |
| Port P5 selection 1          | P5SEL1   | 0Ch    |
| Reserved                     |          | 0Eh    |
| Port P5 complement selection | P5SELC   | 16h    |
| Reserved                     |          | 18h    |
| Reserved                     |          | 1Ah    |
| Reserved                     |          | 1Ch    |
| Port P6 input                | P6IN     | 01h    |
| Port P6 output               | P6OUT    | 03h    |
| Port P6 direction            | P6DIR    | 05h    |
| Port P6 resistor enable      | P6REN    | 07h    |
| Port P6 selection 0          | P6SEL0   | 0Bh    |
| Port P6 selection 1          | P6SEL1   | 0Dh    |
| Port P6 complement selection | P6SELC   | 17h    |
| Reserved                     |          | 1Eh    |
| Reserved                     |          | 19h    |
| Reserved                     |          | 1Bh    |
| Reserved                     |          | 1Dh    |

**Table 6-59. Port P7, P8 Registers (Base Address: 0260h)**

| REGISTER DESCRIPTION    | REGISTER | OFFSET |
|-------------------------|----------|--------|
| Port P7 input           | P7IN     | 00h    |
| Port P7 output          | P7OUT    | 02h    |
| Port P7 direction       | P7DIR    | 04h    |
| Port P7 resistor enable | P7REN    | 06h    |

**Table 6-59. Port P7, P8 Registers (Base Address: 0260h) (continued)**

| REGISTER DESCRIPTION         | REGISTER | OFFSET |
|------------------------------|----------|--------|
| Port P7 selection 0          | P7SEL0   | 0Ah    |
| Port P7 selection 1          | P7SEL1   | 0Ch    |
| Reserved                     |          | 0Eh    |
| Port P7 complement selection | P7SELC   | 16h    |
| Reserved                     |          | 18h    |
| Reserved                     |          | 1Ah    |
| Reserved                     |          | 1Ch    |
| Port P8 input                | P8IN     | 01h    |
| Port P8 output               | P8OUT    | 03h    |
| Port P8 direction            | P8DIR    | 05h    |
| Port P8 resistor enable      | P8REN    | 07h    |
| Port P8 selection 0          | P8SEL0   | 0Bh    |
| Port P8 selection 1          | P8SEL1   | 0Dh    |
| Port P8 complement selection | P8SELC   | 17h    |
| Reserved                     |          | 1Eh    |
| Reserved                     |          | 19h    |
| Reserved                     |          | 1Bh    |
| Reserved                     |          | 1Dh    |

**Table 6-60. Port P9, P10 Registers (Base Address: 0280h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| Port P9 input                 | P9IN     | 00h    |
| Port P9 output                | P9OUT    | 02h    |
| Port P9 direction             | P9DIR    | 04h    |
| Port P9 resistor enable       | P9REN    | 06h    |
| Port P9 selection 0           | P9SEL0   | 0Ah    |
| Port P9 selection 1           | P9SEL1   | 0Ch    |
| Reserved                      |          | 0Eh    |
| Port P9 complement selection  | P9SELC   | 16h    |
| Reserved                      |          | 18h    |
| Reserved                      |          | 1Ah    |
| Reserved                      |          | 1Ch    |
| Port P10 input                | P10IN    | 01h    |
| Port P10 output               | P10OUT   | 03h    |
| Port P10 direction            | P10DIR   | 05h    |
| Port P10 resistor enable      | P10REN   | 07h    |
| Port P10 selection 0          | P10SEL0  | 0Bh    |
| Port P10 selection 1          | P10SEL1  | 0Dh    |
| Port P10 complement selection | P10SELC  | 17h    |
| Reserved                      |          | 1Eh    |
| Reserved                      |          | 19h    |
| Reserved                      |          | 1Bh    |
| Reserved                      |          | 1Dh    |

**Table 6-61. Port J Registers (Base Address: 0320h)**

| REGISTER DESCRIPTION         | REGISTER | OFFSET |
|------------------------------|----------|--------|
| Port PJ input                | PJIN     | 00h    |
| Port PJ output               | PJOUT    | 02h    |
| Port PJ direction            | PJDIR    | 04h    |
| Port PJ resistor enable      | PJREN    | 06h    |
| Port PJ selection 0          | PJSEL0   | 0Ah    |
| Port PJ selection 1          | PJSEL1   | 0Ch    |
| Port PJ complement selection | PJSELC   | 16h    |

**Table 6-62. Timer\_A TA0 Registers (Base Address: 0340h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA0 control               | TA0CTL   | 00h    |
| Capture/compare control 0 | TA0CCTL0 | 02h    |
| Capture/compare control 1 | TA0CCTL1 | 04h    |
| Capture/compare control 2 | TA0CCTL2 | 06h    |
| Capture/compare control 3 | TA0CCTL3 | 08h    |
| Capture/compare control 4 | TA0CCTL4 | 0Ah    |
| TA0 counter               | TA0R     | 10h    |
| Capture/compare 0         | TA0CCR0  | 12h    |
| Capture/compare 1         | TA0CCR1  | 14h    |
| Capture/compare 2         | TA0CCR2  | 16h    |
| Capture/compare 3         | TA0CCR3  | 18h    |
| Capture/compare 4         | TA0CCR4  | 1Ah    |
| TA0 expansion 0           | TA0EX0   | 20h    |
| TA0 interrupt vector      | TA0IV    | 2Eh    |

**Table 6-63. Timer\_A TA1 Registers (Base Address: 0380h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA1 control               | TA1CTL   | 00h    |
| Capture/compare control 0 | TA1CCTL0 | 02h    |
| Capture/compare control 1 | TA1CCTL1 | 04h    |
| Capture/compare control 2 | TA1CCTL2 | 06h    |
| TA1 counter               | TA1R     | 10h    |
| Capture/compare 0         | TA1CCR0  | 12h    |
| Capture/compare 1         | TA1CCR1  | 14h    |
| Capture/compare 2         | TA1CCR2  | 16h    |
| TA1 expansion 0           | TA1EX0   | 20h    |
| TA1 interrupt vector      | TA1IV    | 2Eh    |

**Table 6-64. Timer\_B TB0 Registers (Base Address: 03C0h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TB0 control               | TB0CTL   | 00h    |
| Capture/compare control 0 | TB0CCTL0 | 02h    |
| Capture/compare control 1 | TB0CCTL1 | 04h    |
| Capture/compare control 2 | TB0CCTL2 | 06h    |
| Capture/compare control 3 | TB0CCTL3 | 08h    |
| Capture/compare control 4 | TB0CCTL4 | 0Ah    |

**Table 6-64. Timer\_B TB0 Registers (Base Address: 03C0h) (continued)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| Capture/compare control 5 | TB0CCTL5 | 0Ch    |
| Capture/compare control 6 | TB0CCTL6 | 0Eh    |
| TB0 counter               | TB0R     | 10h    |
| Capture/compare 0         | TB0CCR0  | 12h    |
| Capture/compare 1         | TB0CCR1  | 14h    |
| Capture/compare 2         | TB0CCR2  | 16h    |
| Capture/compare 3         | TB0CCR3  | 18h    |
| Capture/compare 4         | TB0CCR4  | 1Ah    |
| Capture/compare 5         | TB0CCR5  | 1Ch    |
| Capture/compare 6         | TB0CCR6  | 1Eh    |
| TB0 expansion 0           | TB0EX0   | 20h    |
| TB0 interrupt vector      | TB0IV    | 2Eh    |

**Table 6-65. Timer\_A TA2 Registers (Base Address: 0400h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA2 control               | TA2CTL   | 00h    |
| Capture/compare control 0 | TA2CCTL0 | 02h    |
| Capture/compare control 1 | TA2CCTL1 | 04h    |
| TA2 counter               | TA2R     | 10h    |
| Capture/compare 0         | TA2CCR0  | 12h    |
| Capture/compare 1         | TA2CCR1  | 14h    |
| TA2 expansion 0           | TA2EX0   | 20h    |
| TA2 interrupt vector      | TA2IV    | 2Eh    |

**Table 6-66. Capacitive Touch I/O 0 Registers (Base Address: 0430h)**

| REGISTER DESCRIPTION           | REGISTER   | OFFSET |
|--------------------------------|------------|--------|
| Capacitive Touch I/O 0 control | CAPTIO0CTL | 0Eh    |

**Table 6-67. Timer\_A TA3 Registers (Base Address: 0440h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA3 control               | TA3CTL   | 00h    |
| Capture/compare control 0 | TA3CCTL0 | 02h    |
| Capture/compare control 1 | TA3CCTL1 | 04h    |
| Capture/compare control 2 | TA3CCTL2 | 06h    |
| Capture/compare control 3 | TA3CCTL3 | 08h    |
| Capture/compare control 4 | TA3CCTL4 | 0Ah    |
| TA3 counter               | TA3R     | 10h    |
| Capture/compare 0         | TA3CCR0  | 12h    |
| Capture/compare 1         | TA3CCR1  | 14h    |
| Capture/compare 2         | TA3CCR2  | 16h    |
| Capture/compare 3         | TA3CCR3  | 18h    |
| Capture/compare 4         | TA3CCR4  | 1Ah    |
| TA3 expansion 0           | TA3EX0   | 20h    |
| TA3 interrupt vector      | TA3IV    | 2Eh    |

**Table 6-68. Capacitive Touch I/O 1 Registers (Base Address: 0470h)**

| REGISTER DESCRIPTION           | REGISTER   | OFFSET |
|--------------------------------|------------|--------|
| Capacitive Touch I/O 1 control | CAPTIO1CTL | 0Eh    |

**Table 6-69. RTC\_C Registers (Base Address: 04A0h)**

| REGISTER DESCRIPTION         | REGISTER       | OFFSET |
|------------------------------|----------------|--------|
| RTC control 0                | RTCCTL0        | 00h    |
| RTC password                 | RTCPWD         | 01h    |
| RTC control 1                | RTCCTL1        | 02h    |
| RTC control 3                | RTCCTL3        | 03h    |
| RTC offset calibration       | RTCOCAL        | 04h    |
| RTC temperature compensation | RTCTCMP        | 06h    |
| RTC prescaler 0 control      | RTCP0CTL       | 08h    |
| RTC prescaler 1 control      | RTCP1CTL       | 0Ah    |
| RTC prescaler 0              | RTCP0          | 0Ch    |
| RTC prescaler 1              | RTCP1          | 0Dh    |
| RTC interrupt vector word    | RTCIV          | 0Eh    |
| RTC seconds/counter 1        | RTCSEC/RTCNT1  | 10h    |
| RTC minutes/counter 2        | RTCMIN/RTCNT2  | 11h    |
| RTC hours/counter 3          | RTCHOUR/RTCNT3 | 12h    |
| RTC day of week/counter 4    | RTCDOW/RTCNT4  | 13h    |
| RTC days                     | RTCDAY         | 14h    |
| RTC month                    | RTCMON         | 15h    |
| RTC year                     | RTCYEAR        | 16h    |
| RTC alarm minutes            | RTCAMIN        | 18h    |
| RTC alarm hours              | RTCAHOUR       | 19h    |
| RTC alarm day of week        | RTCADOW        | 1Ah    |
| RTC alarm days               | RTCADAY        | 1Bh    |
| Binary-to-BCD conversion     | BIN2BCD        | 1Ch    |
| BCD-to-Binary conversion     | BCD2BIN        | 1Eh    |

**Table 6-70. 32-Bit Hardware Multiplier Registers (Base Address: 04C0h)**

| REGISTER DESCRIPTION                                    | REGISTER | OFFSET |
|---------------------------------------------------------|----------|--------|
| 16-bit operand 1 – multiply                             | MPY      | 00h    |
| 16-bit operand 1 – signed multiply                      | MPYS     | 02h    |
| 16-bit operand 1 – multiply accumulate                  | MAC      | 04h    |
| 16-bit operand 1 – signed multiply accumulate           | MACS     | 06h    |
| 16-bit operand 2                                        | OP2      | 08h    |
| 16 × 16 result low word                                 | RESLO    | 0Ah    |
| 16 × 16 result high word                                | RESHI    | 0Ch    |
| 16 × 16 sum extension                                   | SUMEXT   | 0Eh    |
| 32-bit operand 1 – multiply low word                    | MPY32L   | 10h    |
| 32-bit operand 1 – multiply high word                   | MPY32H   | 12h    |
| 32-bit operand 1 – signed multiply low word             | MPYS32L  | 14h    |
| 32-bit operand 1 – signed multiply high word            | MPYS32H  | 16h    |
| 32-bit operand 1 – multiply accumulate low word         | MAC32L   | 18h    |
| 32-bit operand 1 – multiply accumulate high word        | MAC32H   | 1Ah    |
| 32-bit operand 1 – signed multiply accumulate low word  | MACS32L  | 1Ch    |
| 32-bit operand 1 – signed multiply accumulate high word | MACS32H  | 1Eh    |

**Table 6-70. 32-Bit Hardware Multiplier Registers (Base Address: 04C0h) (continued)**

| REGISTER DESCRIPTION                      | REGISTER  | OFFSET |
|-------------------------------------------|-----------|--------|
| 32-bit operand 2 – low word               | OP2L      | 20h    |
| 32-bit operand 2 – high word              | OP2H      | 22h    |
| 32 × 32 result 0 – least significant word | RES0      | 24h    |
| 32 × 32 result 1                          | RES1      | 26h    |
| 32 × 32 result 2                          | RES2      | 28h    |
| 32 × 32 result 3 – most significant word  | RES3      | 2Ah    |
| MPY32 control 0                           | MPY32CTL0 | 2Ch    |

**Table 6-71. DMA Registers (Base Address DMA General Control: 0500h, DMA Channel 0: 0510h, DMA Channel 1: 0520h, DMA Channel 2: 0530h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 0 control                  | DMA0CTL  | 00h    |
| DMA channel 0 source address low       | DMA0SAL  | 02h    |
| DMA channel 0 source address high      | DMA0SAH  | 04h    |
| DMA channel 0 destination address low  | DMA0DAL  | 06h    |
| DMA channel 0 destination address high | DMA0DAH  | 08h    |
| DMA channel 0 transfer size            | DMA0SZ   | 0Ah    |
| DMA channel 1 control                  | DMA1CTL  | 00h    |
| DMA channel 1 source address low       | DMA1SAL  | 02h    |
| DMA channel 1 source address high      | DMA1SAH  | 04h    |
| DMA channel 1 destination address low  | DMA1DAL  | 06h    |
| DMA channel 1 destination address high | DMA1DAH  | 08h    |
| DMA channel 1 transfer size            | DMA1SZ   | 0Ah    |
| DMA channel 2 control                  | DMA2CTL  | 00h    |
| DMA channel 2 source address low       | DMA2SAL  | 02h    |
| DMA channel 2 source address high      | DMA2SAH  | 04h    |
| DMA channel 2 destination address low  | DMA2DAL  | 06h    |
| DMA channel 2 destination address high | DMA2DAH  | 08h    |
| DMA channel 2 transfer size            | DMA2SZ   | 0Ah    |
| DMA module control 0                   | DMACTL0  | 00h    |
| DMA module control 1                   | DMACTL1  | 02h    |
| DMA module control 2                   | DMACTL2  | 04h    |
| DMA module control 3                   | DMACTL3  | 06h    |
| DMA module control 4                   | DMACTL4  | 08h    |
| DMA interrupt vector                   | DMAIV    | 0Eh    |

**Table 6-72. MPU Control Registers (Base Address: 05A0h)**

| REGISTER DESCRIPTION                  | REGISTER   | OFFSET |
|---------------------------------------|------------|--------|
| MPU control 0                         | MPUCTL0    | 00h    |
| MPU control 1                         | MPUCTL1    | 02h    |
| MPU segmentation border 2             | MPUSEGB2   | 04h    |
| MPU segmentation border 1             | MPUSEGB1   | 06h    |
| MPU access management                 | MPUSAM     | 08h    |
| MPU IP control 0                      | MPUIPC0    | 0Ah    |
| MPU IP encapsulation segment border 2 | MPUIPSEGB2 | 0Ch    |
| MPU IP encapsulation segment border 1 | MPUIPSEGB1 | 0Eh    |

**Table 6-73. eUSCI\_A0 Registers (Base Address: 05C0h)**

| REGISTER DESCRIPTION          | REGISTER   | OFFSET |
|-------------------------------|------------|--------|
| eUSCI_A control word 0        | UCA0CTLW0  | 00h    |
| eUSCI_A control word 1        | UCA0CTLW1  | 02h    |
| eUSCI_A baud rate 0           | UCA0BR0    | 06h    |
| eUSCI_A baud rate 1           | UCA0BR1    | 07h    |
| eUSCI_A modulation control    | UCA0MCTLW  | 08h    |
| eUSCI_A status word           | UCA0STATW  | 0Ah    |
| eUSCI_A receive buffer        | UCA0RXBUF  | 0Ch    |
| eUSCI_A transmit buffer       | UCA0TXBUF  | 0Eh    |
| eUSCI_A LIN control           | UCA0ABCTL  | 10h    |
| eUSCI_A IrDA transmit control | UCA0IRTCTL | 12h    |
| eUSCI_A IrDA receive control  | UCA0IRRCTL | 13h    |
| eUSCI_A interrupt enable      | UCA0IE     | 1Ah    |
| eUSCI_A interrupt flags       | UCA0IFG    | 1Ch    |
| eUSCI_A interrupt vector word | UCA0IV     | 1Eh    |

**Table 6-74. eUSCI\_A1 Registers (Base Address:05E0h)**

| REGISTER DESCRIPTION          | REGISTER   | OFFSET |
|-------------------------------|------------|--------|
| eUSCI_A control word 0        | UCA1CTLW0  | 00h    |
| eUSCI_A control word 1        | UCA1CTLW1  | 02h    |
| eUSCI_A baud rate 0           | UCA1BR0    | 06h    |
| eUSCI_A baud rate 1           | UCA1BR1    | 07h    |
| eUSCI_A modulation control    | UCA1MCTLW  | 08h    |
| eUSCI_A status word           | UCA1STATW  | 0Ah    |
| eUSCI_A receive buffer        | UCA1RXBUF  | 0Ch    |
| eUSCI_A transmit buffer       | UCA1TXBUF  | 0Eh    |
| eUSCI_A LIN control           | UCA1ABCTL  | 10h    |
| eUSCI_A IrDA transmit control | UCA1IRTCTL | 12h    |
| eUSCI_A IrDA receive control  | UCA1IRRCTL | 13h    |
| eUSCI_A interrupt enable      | UCA1IE     | 1Ah    |
| eUSCI_A interrupt flags       | UCA1IFG    | 1Ch    |
| eUSCI_A interrupt vector word | UCA1IV     | 1Eh    |

**Table 6-75. eUSCI\_B0 Registers (Base Address: 0640h)**

| REGISTER DESCRIPTION           | REGISTER   | OFFSET |
|--------------------------------|------------|--------|
| eUSCI_B control word 0         | UCB0CTLW0  | 00h    |
| eUSCI_B control word 1         | UCB0CTLW1  | 02h    |
| eUSCI_B bit rate 0             | UCB0BR0    | 06h    |
| eUSCI_B bit rate 1             | UCB0BR1    | 07h    |
| eUSCI_B status word            | UCB0STATW  | 08h    |
| eUSCI_B byte counter threshold | UCB0TBCNT  | 0Ah    |
| eUSCI_B receive buffer         | UCB0RXBUF  | 0Ch    |
| eUSCI_B transmit buffer        | UCB0TXBUF  | 0Eh    |
| eUSCI_B I2C own address 0      | UCB0I2COA0 | 14h    |
| eUSCI_B I2C own address 1      | UCB0I2COA1 | 16h    |
| eUSCI_B I2C own address 2      | UCB0I2COA2 | 18h    |
| eUSCI_B I2C own address 3      | UCB0I2COA3 | 1Ah    |
| eUSCI_B received address       | UCB0ADDRX  | 1Ch    |

**Table 6-75. eUSCI\_B0 Registers (Base Address: 0640h) (continued)**

| REGISTER DESCRIPTION          | REGISTER    | OFFSET |
|-------------------------------|-------------|--------|
| eUSCI_B address mask          | UCB0ADDMASK | 1Eh    |
| eUSCI_B I2C slave address     | UCB0I2CSA   | 20h    |
| eUSCI_B interrupt enable      | UCB0IE      | 2Ah    |
| eUSCI_B interrupt flags       | UCB0IFG     | 2Ch    |
| eUSCI_B interrupt vector word | UCB0IV      | 2Eh    |

**Table 6-76. eUSCI\_B1 Registers (Base Address: 0680h)**

| REGISTER DESCRIPTION           | REGISTER    | OFFSET |
|--------------------------------|-------------|--------|
| eUSCI_B control word 0         | UCB1CTLW0   | 00h    |
| eUSCI_B control word 1         | UCB1CTLW1   | 02h    |
| eUSCI_B bit rate 0             | UCB1BR0     | 06h    |
| eUSCI_B bit rate 1             | UCB1BR1     | 07h    |
| eUSCI_B status word            | UCB1STATW   | 08h    |
| eUSCI_B byte counter threshold | UCB1TBCNT   | 0Ah    |
| eUSCI_B receive buffer         | UCB1RXBUF   | 0Ch    |
| eUSCI_B transmit buffer        | UCB1TXBUF   | 0Eh    |
| eUSCI_B I2C own address 0      | UCB1I2COA0  | 14h    |
| eUSCI_B I2C own address 1      | UCB1I2COA1  | 16h    |
| eUSCI_B I2C own address 2      | UCB1I2COA2  | 18h    |
| eUSCI_B I2C own address 3      | UCB1I2COA3  | 1Ah    |
| eUSCI_B received address       | UCB1ADDRX   | 1Ch    |
| eUSCI_B address mask           | UCB1ADDMASK | 1Eh    |
| eUSCI_B I2C slave address      | UCB1I2CSA   | 20h    |
| eUSCI_B interrupt enable       | UCB1IE      | 2Ah    |
| eUSCI_B interrupt flags        | UCB1IFG     | 2Ch    |
| eUSCI_B interrupt vector word  | UCB1IV      | 2Eh    |

**Table 6-77. ADC12\_B Registers (Base Address: 0800h)**

| REGISTER DESCRIPTION                     | REGISTER   | OFFSET |
|------------------------------------------|------------|--------|
| ADC12_B control 0                        | ADC12CTL0  | 00h    |
| ADC12_B control 1                        | ADC12CTL1  | 02h    |
| ADC12_B control 2                        | ADC12CTL2  | 04h    |
| ADC12_B control 3                        | ADC12CTL3  | 06h    |
| ADC12_B window comparator low threshold  | ADC12LO    | 08h    |
| ADC12_B window comparator high threshold | ADC12HI    | 0Ah    |
| ADC12_B interrupt flag 0                 | ADC12IFGR0 | 0Ch    |
| ADC12_B Interrupt flag 1                 | ADC12IFGR1 | 0Eh    |
| ADC12_B interrupt flag 2                 | ADC12IFGR2 | 10h    |
| ADC12_B interrupt enable 0               | ADC12IER0  | 12h    |
| ADC12_B interrupt enable 1               | ADC12IER1  | 14h    |
| ADC12_B interrupt enable 2               | ADC12IER2  | 16h    |
| ADC12_B interrupt vector                 | ADC12IV    | 18h    |
| ADC12_B memory control 0                 | ADC12MCTL0 | 20h    |
| ADC12_B memory control 1                 | ADC12MCTL1 | 22h    |
| ADC12_B memory control 2                 | ADC12MCTL2 | 24h    |
| ADC12_B memory control 3                 | ADC12MCTL3 | 26h    |
| ADC12_B memory control 4                 | ADC12MCTL4 | 28h    |

**Table 6-77. ADC12\_B Registers (Base Address: 0800h) (continued)**

| REGISTER DESCRIPTION      | REGISTER    | OFFSET |
|---------------------------|-------------|--------|
| ADC12_B memory control 5  | ADC12MCTL5  | 2Ah    |
| ADC12_B memory control 6  | ADC12MCTL6  | 2Ch    |
| ADC12_B memory control 7  | ADC12MCTL7  | 2Eh    |
| ADC12_B memory control 8  | ADC12MCTL8  | 30h    |
| ADC12_B memory control 9  | ADC12MCTL9  | 32h    |
| ADC12_B memory control 10 | ADC12MCTL10 | 34h    |
| ADC12_B memory control 11 | ADC12MCTL11 | 36h    |
| ADC12_B memory control 12 | ADC12MCTL12 | 38h    |
| ADC12_B memory control 13 | ADC12MCTL13 | 3Ah    |
| ADC12_B memory control 14 | ADC12MCTL14 | 3Ch    |
| ADC12_B memory control 15 | ADC12MCTL15 | 3Eh    |
| ADC12_B memory control 16 | ADC12MCTL16 | 40h    |
| ADC12_B memory control 17 | ADC12MCTL17 | 42h    |
| ADC12_B memory control 18 | ADC12MCTL18 | 44h    |
| ADC12_B memory control 19 | ADC12MCTL19 | 46h    |
| ADC12_B memory control 20 | ADC12MCTL20 | 48h    |
| ADC12_B memory control 21 | ADC12MCTL21 | 4Ah    |
| ADC12_B memory control 22 | ADC12MCTL22 | 4Ch    |
| ADC12_B memory control 23 | ADC12MCTL23 | 4Eh    |
| ADC12_B memory control 24 | ADC12MCTL24 | 50h    |
| ADC12_B memory control 25 | ADC12MCTL25 | 52h    |
| ADC12_B memory control 26 | ADC12MCTL26 | 54h    |
| ADC12_B memory control 27 | ADC12MCTL27 | 56h    |
| ADC12_B memory control 28 | ADC12MCTL28 | 58h    |
| ADC12_B memory control 29 | ADC12MCTL29 | 5Ah    |
| ADC12_B memory control 30 | ADC12MCTL30 | 5Ch    |
| ADC12_B memory control 31 | ADC12MCTL31 | 5Eh    |
| ADC12_B memory 0          | ADC12MEM0   | 60h    |
| ADC12_B memory 1          | ADC12MEM1   | 62h    |
| ADC12_B memory 2          | ADC12MEM2   | 64h    |
| ADC12_B memory 3          | ADC12MEM3   | 66h    |
| ADC12_B memory 4          | ADC12MEM4   | 68h    |
| ADC12_B memory 5          | ADC12MEM5   | 6Ah    |
| ADC12_B memory 6          | ADC12MEM6   | 6Ch    |
| ADC12_B memory 7          | ADC12MEM7   | 6Eh    |
| ADC12_B memory 8          | ADC12MEM8   | 70h    |
| ADC12_B memory 9          | ADC12MEM9   | 72h    |
| ADC12_B memory 10         | ADC12MEM10  | 74h    |
| ADC12_B memory 11         | ADC12MEM11  | 76h    |
| ADC12_B memory 12         | ADC12MEM12  | 78h    |
| ADC12_B memory 13         | ADC12MEM13  | 7Ah    |
| ADC12_B memory 14         | ADC12MEM14  | 7Ch    |
| ADC12_B memory 15         | ADC12MEM15  | 7Eh    |
| ADC12_B memory 16         | ADC12MEM16  | 80h    |
| ADC12_B memory 17         | ADC12MEM17  | 82h    |
| ADC12_B memory 18         | ADC12MEM18  | 84h    |
| ADC12_B memory 19         | ADC12MEM19  | 86h    |

**Table 6-77. ADC12\_B Registers (Base Address: 0800h) (continued)**

| REGISTER DESCRIPTION | REGISTER   | OFFSET |
|----------------------|------------|--------|
| ADC12_B memory 20    | ADC12MEM20 | 88h    |
| ADC12_B memory 21    | ADC12MEM21 | 8Ah    |
| ADC12_B memory 22    | ADC12MEM22 | 8Ch    |
| ADC12_B memory 23    | ADC12MEM23 | 8Eh    |
| ADC12_B memory 24    | ADC12MEM24 | 90h    |
| ADC12_B memory 25    | ADC12MEM25 | 92h    |
| ADC12_B memory 26    | ADC12MEM26 | 94h    |
| ADC12_B memory 27    | ADC12MEM27 | 96h    |
| ADC12_B memory 28    | ADC12MEM28 | 98h    |
| ADC12_B memory 29    | ADC12MEM29 | 9Ah    |
| ADC12_B memory 30    | ADC12MEM30 | 9Ch    |
| ADC12_B memory 31    | ADC12MEM31 | 9Eh    |

**Table 6-78. Comparator\_E Registers (Base Address: 08C0h)**

| REGISTER DESCRIPTION             | REGISTER | OFFSET |
|----------------------------------|----------|--------|
| Comparator control 0             | CECTL0   | 00h    |
| Comparator control 1             | CECTL1   | 02h    |
| Comparator control 2             | CECTL2   | 04h    |
| Comparator control 3             | CECTL3   | 06h    |
| Comparator interrupt             | CEINT    | 0Ch    |
| Comparator interrupt vector word | CEIV     | 0Eh    |

**Table 6-79. CRC32 Registers (Base Address: 0980h)**

| REGISTER DESCRIPTION                   | REGISTER      | OFFSET |
|----------------------------------------|---------------|--------|
| CRC32 data input                       | CRC32DIW0     | 00h    |
| Reserved                               |               | 02h    |
| Reserved                               |               | 04h    |
| CRC32 data input reverse               | CRC32DIRBW0   | 06h    |
| CRC32 initialization and result word 0 | CRC32INIRESW0 | 08h    |
| CRC32 initialization and result word 1 | CRC32INIRESW1 | 0Ah    |
| CRC32 result reverse word 1            | CRC32RESRW1   | 0Ch    |
| CRC32 result reverse word 0            | CRC32RESRW1   | 0Eh    |
| CRC16 data input                       | CRC16DIW0     | 10h    |
| Reserved                               |               | 12h    |
| Reserved                               |               | 14h    |
| CRC16 data input reverse               | CRC16DIRBW0   | 16h    |
| CRC16 initialization and result word 0 | CRC16INIRESW0 | 18h    |
| Reserved                               |               | 1Ah    |
| Reserved                               |               | 1Ch    |
| CRC16 result reverse word 0            | CRC16RESRW1   | 1Eh    |
| Reserved                               |               | 20h    |
| Reserved                               |               | 22h    |
| Reserved                               |               | 24h    |
| Reserved                               |               | 26h    |
| Reserved                               |               | 28h    |
| Reserved                               |               | 2Ah    |
| Reserved                               |               | 2Ch    |

**Table 6-79. CRC32 Registers (Base Address: 0980h) (continued)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Reserved             |          | 2Eh    |

**Table 6-80. LCD\_C Registers (Base Address: 0A00h)**

| REGISTER DESCRIPTION               | REGISTER   | OFFSET |
|------------------------------------|------------|--------|
| LCD_C control 0                    | LCDCCTL0   | 000h   |
| LCD_C control 1                    | LCDCCTL1   | 002h   |
| LCD_C blinking control             | LCDCBLKCTL | 004h   |
| LCD_C memory control               | LCDCMEMCTL | 006h   |
| LCD_C voltage control              | LCDCVCTL   | 008h   |
| LCD_C port control 0               | LCDCPCTL0  | 00Ah   |
| LCD_C port control 1               | LCDCPCTL1  | 00Ch   |
| LCD_C port control 2               | LCDCPCTL2  | 00Eh   |
| LCD_C charge pump control          | LCDCCPCTL  | 012h   |
| LCD_C interrupt vector             | LCDCIV     | 01Eh   |
| <b>Static and 2 to 4 mux modes</b> |            |        |
| LCD_C memory 1                     | LCDM1      | 020h   |
| LCD_C memory 2                     | LCDM2      | 021h   |
| LCD_C memory 3                     | LCDM3      | 022h   |
| LCD_C memory 4                     | LCDM4      | 023h   |
| LCD_C memory 5                     | LCDM5      | 024h   |
| LCD_C memory 6                     | LCDM6      | 025h   |
| LCD_C memory 7                     | LCDM7      | 026h   |
| LCD_C memory 8                     | LCDM8      | 027h   |
| LCD_C memory 9                     | LCDM9      | 028h   |
| LCD_C memory 10                    | LCDM10     | 029h   |
| LCD_C memory 11                    | LCDM11     | 02Ah   |
| LCD_C memory 12                    | LCDM12     | 02Bh   |
| LCD_C memory 13                    | LCDM13     | 02Ch   |
| LCD_C memory 14                    | LCDM14     | 02Dh   |
| LCD_C memory 15                    | LCDM15     | 02Eh   |
| LCD_C memory 16                    | LCDM16     | 02Fh   |
| LCD_C memory 17                    | LCDM17     | 030h   |
| LCD_C memory 18                    | LCDM18     | 031h   |
| LCD_C memory 19                    | LCDM19     | 032h   |
| LCD_C memory 20                    | LCDM20     | 033h   |
| LCD_C memory 21                    | LCDM21     | 034h   |
| LCD_C memory 22                    | LCDM22     | 035h   |
| Reserved                           |            | 036h   |
| Reserved                           |            | 037h   |
| LCD_C blinking memory 1            | LCDBM1     | 040h   |
| LCD_C blinking memory 2            | LCDBM2     | 041h   |
| LCD_C blinking memory 3            | LCDBM3     | 042h   |
| LCD_C blinking memory 4            | LCDBM4     | 043h   |
| LCD_C blinking memory 5            | LCDBM5     | 044h   |
| LCD_C blinking memory 6            | LCDBM6     | 045h   |
| LCD_C blinking memory 7            | LCDBM7     | 046h   |
| LCD_C blinking memory 8            | LCDBM8     | 047h   |

**Table 6-80. LCD\_C Registers (Base Address: 0A00h) (continued)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| LCD_C blinking memory 9  | LCDBM9   | 048h   |
| LCD_C blinking memory 10 | LCDBM10  | 049h   |
| LCD_C blinking memory 11 | LCDBM11  | 04Ah   |
| LCD_C blinking memory 12 | LCDBM12  | 04Bh   |
| LCD_C blinking memory 13 | LCDBM13  | 04Ch   |
| LCD_C blinking memory 14 | LCDBM14  | 04Dh   |
| LCD_C blinking memory 15 | LCDBM15  | 04Eh   |
| LCD_C blinking memory 16 | LCDBM16  | 04Fh   |
| LCD_C blinking memory 17 | LCDBM17  | 050h   |
| LCD_C blinking memory 18 | LCDBM18  | 051h   |
| LCD_C blinking memory 19 | LCDBM19  | 052h   |
| LCD_C blinking memory 20 | LCDBM20  | 053h   |
| LCD_C blinking memory 21 | LCDBM21  | 054h   |
| LCD_C blinking memory 22 | LCDBM22  | 055h   |
| Reserved                 |          | 056h   |
| Reserved                 |          | 057h   |
| <b>5 to 8 mux modes</b>  |          |        |
| LCD_C memory 1           | LCDM1    | 020h   |
| LCD_C memory 2           | LCDM2    | 021h   |
| LCD_C memory 3           | LCDM3    | 022h   |
| LCD_C memory 4           | LCDM4    | 023h   |
| LCD_C memory 5           | LCDM5    | 024h   |
| LCD_C memory 6           | LCDM6    | 025h   |
| LCD_C memory 7           | LCDM7    | 026h   |
| LCD_C memory 8           | LCDM8    | 027h   |
| LCD_C memory 9           | LCDM9    | 028h   |
| LCD_C memory 10          | LCDM10   | 029h   |
| LCD_C memory 11          | LCDM11   | 02Ah   |
| LCD_C memory 12          | LCDM12   | 02Bh   |
| LCD_C memory 13          | LCDM13   | 02Ch   |
| LCD_C memory 14          | LCDM14   | 02Dh   |
| LCD_C memory 15          | LCDM15   | 02Eh   |
| LCD_C memory 16          | LCDM16   | 02Fh   |
| LCD_C memory 17          | LCDM17   | 030h   |
| LCD_C memory 18          | LCDM18   | 031h   |
| LCD_C memory 19          | LCDM19   | 032h   |
| LCD_C memory 20          | LCDM20   | 033h   |
| LCD_C memory 21          | LCDM21   | 034h   |
| LCD_C memory 22          | LCDM22   | 035h   |
| LCD_C memory 23          | LCDM23   | 036h   |
| LCD_C memory 24          | LCDM24   | 037h   |
| LCD_C memory 25          | LCDM25   | 038h   |
| LCD_C memory 26          | LCDM26   | 039h   |
| LCD_C memory 27          | LCDM27   | 03Ah   |
| LCD_C memory 28          | LCDM28   | 03Bh   |
| LCD_C memory 29          | LCDM29   | 03Ch   |
| LCD_C memory 30          | LCDM30   | 03Dh   |

**Table 6-80. LCD\_C Registers (Base Address: 0A00h) (continued)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| LCD_C memory 31      | LCDM31   | 03Eh   |
| LCD_C memory 32      | LCDM32   | 03Fh   |
| LCD_C memory 33      | LCDM33   | 040h   |
| LCD_C memory 34      | LCDM34   | 041h   |
| LCD_C memory 35      | LCDM35   | 042h   |
| LCD_C memory 36      | LCDM36   | 043h   |
| LCD_C memory 37      | LCDM37   | 044h   |
| LCD_C memory 38      | LCDM38   | 045h   |
| LCD_C memory 39      | LCDM39   | 046h   |
| LCD_C memory 40      | LCDM40   | 047h   |
| LCD_C memory 41      | LCDM41   | 048h   |
| LCD_C memory 42      | LCDM42   | 049h   |
| LCD_C memory 43      | LCDM43   | 04Ah   |

**Table 6-81. Extended Scan Interface (ESI) Registers (Base Address: 0D00h)**

| REGISTER DESCRIPTION        | REGISTER  | OFFSET |
|-----------------------------|-----------|--------|
| ESI debug 1                 | ESIDEBUG1 | 000h   |
| ESI debug 2                 | ESIDEBUG2 | 002h   |
| ESI debug 3                 | ESIDEBUG3 | 004h   |
| ESI debug 4                 | ESIDEBUG4 | 006h   |
| ESI debug 5                 | ESIDEBUG5 | 008h   |
| Reserved                    |           | 00Ah   |
| Reserved                    |           | 00Ch   |
| Reserved                    |           | 00Eh   |
| ESI PSM counter 0           | ESICNT0   | 010h   |
| ESI PSM counter 1           | ESICNT1   | 012h   |
| ESI PSM counter 2           | ESICNT2   | 014h   |
| ESI oscillator counter      | ESICNT3   | 016h   |
| Reserved                    |           | 018h   |
| ESI interrupt vector        | ESIIV     | 01Ah   |
| ESI interrupt 1             | ESIINT1   | 01Ch   |
| ESI interrupt 2             | ESIINT2   | 01Eh   |
| ESI AFE control             | ESIAFE    | 020h   |
| ESI PPU control             | ESIPPU    | 022h   |
| ESI TSM control             | ESITSM    | 024h   |
| ESI PSM control             | ESIPSM    | 026h   |
| ESI oscillator control      | ESIOSC    | 028h   |
| ESI control                 | ESICTL    | 02Ah   |
| ESI PSM counter threshold 1 | ESITHR1   | 02Ch   |
| ESI PSM counter threshold 2 | ESITHR2   | 02Eh   |
| ESI A/D conversion memory 1 | ESIADMEM1 | 030h   |
| ESI A/D conversion memory 2 | ESIADMEM2 | 032h   |
| ESI A/D conversion memory 3 | ESIADMEM3 | 034h   |
| ESI A/D conversion memory 4 | ESIADMEM4 | 036h   |
| Reserved                    |           | 038h   |
| Reserved                    |           | 03Ah   |
| Reserved                    |           | 03Ch   |

**Table 6-81. Extended Scan Interface (ESI) Registers (Base Address: 0D00h) (continued)**

| REGISTER DESCRIPTION | REGISTER  | OFFSET |
|----------------------|-----------|--------|
| Reserved             |           | 03Eh   |
| ESI DAC1 0           | ESIDAC1R0 | 040h   |
| ESI DAC1 1           | ESIDAC1R1 | 042h   |
| ESI DAC1 2           | ESIDAC1R2 | 044h   |
| ESI DAC1 3           | ESIDAC1R3 | 046h   |
| ESI DAC1 4           | ESIDAC1R4 | 048h   |
| ESI DAC1 5           | ESIDAC1R5 | 04Ah   |
| ESI DAC1 6           | ESIDAC1R6 | 04Ch   |
| ESI DAC1 7           | ESIDAC1R7 | 04Eh   |
| ESI DAC2 0           | ESIDAC2R0 | 050h   |
| ESI DAC2 1           | ESIDAC2R1 | 052h   |
| ESI DAC2 2           | ESIDAC2R2 | 054h   |
| ESI DAC2 3           | ESIDAC2R3 | 056h   |
| ESI DAC2 4           | ESIDAC2R4 | 058h   |
| ESI DAC2 5           | ESIDAC2R5 | 05Ah   |
| ESI DAC2 6           | ESIDAC2R6 | 05Ch   |
| ESI DAC2 7           | ESIDAC2R7 | 05Eh   |
| ESI TSM 0            | ESITSM0   | 060h   |
| ESI TSM 1            | ESITSM1   | 062h   |
| ESI TSM 2            | ESITSM2   | 064h   |
| ESI TSM 3            | ESITSM3   | 066h   |
| ESI TSM 4            | ESITSM4   | 068h   |
| ESI TSM 5            | ESITSM5   | 06Ah   |
| ESI TSM 6            | ESITSM6   | 06Ch   |
| ESI TSM 7            | ESITSM7   | 06Eh   |
| ESI TSM 8            | ESITSM8   | 070h   |
| ESI TSM 9            | ESITSM9   | 072h   |
| ESI TSM 10           | ESITSM10  | 074h   |
| ESI TSM 11           | ESITSM11  | 076h   |
| ESI TSM 12           | ESITSM12  | 078h   |
| ESI TSM 13           | ESITSM13  | 07Ah   |
| ESI TSM 14           | ESITSM14  | 07Ch   |
| ESI TSM 15           | ESITSM15  | 07Eh   |
| ESI TSM 16           | ESITSM16  | 080h   |
| ESI TSM 17           | ESITSM17  | 082h   |
| ESI TSM 18           | ESITSM18  | 084h   |
| ESI TSM 19           | ESITSM19  | 086h   |
| ESI TSM 20           | ESITSM20  | 088h   |
| ESI TSM 21           | ESITSM21  | 08Ah   |
| ESI TSM 22           | ESITSM22  | 08Ch   |
| ESI TSM 23           | ESITSM23  | 08Eh   |
| ESI TSM 24           | ESITSM24  | 090h   |
| ESI TSM 25           | ESITSM25  | 092h   |
| ESI TSM 26           | ESITSM26  | 094h   |
| ESI TSM 27           | ESITSM27  | 096h   |
| ESI TSM 28           | ESITSM28  | 098h   |
| ESI TSM 29           | ESITSM29  | 09Ah   |

**Table 6-81. Extended Scan Interface (ESI) Registers (Base Address: 0D00h) (continued)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| ESI TSM 30           | ESITSM30 | 09Ch   |
| ESI TSM 31           | ESITSM31 | 09Eh   |

## 6.14 Identification

### 6.14.1 Revision Identification

The device revision information is shown as part of the top-side marking on the device package. The device-specific errata sheet describes these markings. For links to all of the errata sheets for the devices in this data sheet, see [Section 8.4](#).

The hardware revision is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Hardware Revision" entries in [Section 6.12](#).

### 6.14.2 Device Identification

The device type can be identified from the top-side marking on the device package. The device-specific errata sheet describes these markings. For links to all of the errata sheets for the devices in this data sheet, see [Section 8.4](#).

A device identification value is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Device ID" entries in [Section 6.12](#).

### 6.14.3 JTAG Identification

Programming through the JTAG interface, including reading and identifying the JTAG ID, is described in detail in [MSP430 Programming With the JTAG Interface](#).

## 7 Applications, Implementation, and Layout

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 7.1 Device Connection and Layout Fundamentals

This section discusses the recommended guidelines when designing with the MSP430. These guidelines are to make sure that the device has proper connections for powering, programming, debugging, and optimum analog performance.

#### 7.1.1 Power Supply Decoupling and Bulk Capacitors

TI recommends connecting a combination of a 1- $\mu$ F plus a 100-nF low-ESR ceramic decoupling capacitor to each AVCC, DVCC, and ESIDVCC pin. Higher-value capacitors may be used but can impact supply rail ramp-up time. Decoupling capacitors must be placed as close as possible to the pins that they decouple (within a few millimeters). Additionally, TI recommends separated grounds with a single-point connection for better noise isolation from digital to analog circuits on the board and to achieve high analog accuracy.

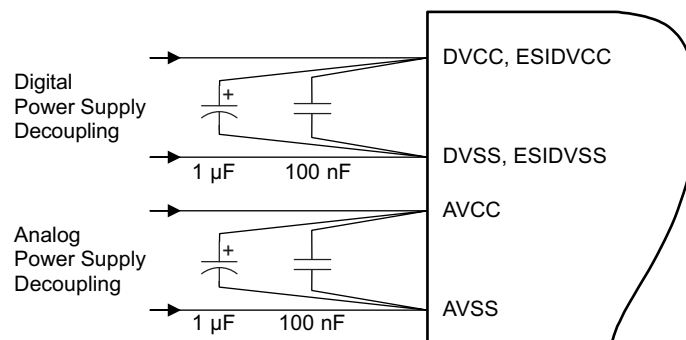


Figure 7-1. Power Supply Decoupling

#### 7.1.2 External Oscillator

Depending on the device variant (see [Section 3](#)), the device can support a low-frequency crystal (32 kHz) on the LFXT pins, a high-frequency crystal on the HFXT pins, or both. External bypass capacitors for the crystal oscillator pins are required.

It is also possible to apply digital clock signals to the LFXIN and HFXIN input pins that meet the specifications of the respective oscillator if the appropriate LFXTBYPASS or HFXTBYPASS mode is selected. In this case, the associated LFXOUT and HFXOUT pins can be used for other purposes. If they are left unused, terminate them according to [Section 4.4](#).

[Figure 7-2](#) shows a typical connection diagram.

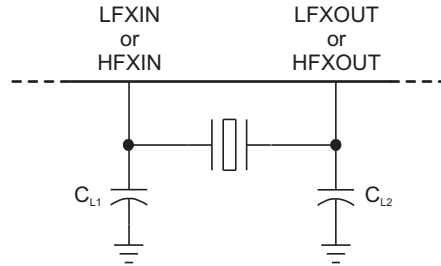


Figure 7-2. Typical Crystal Connection

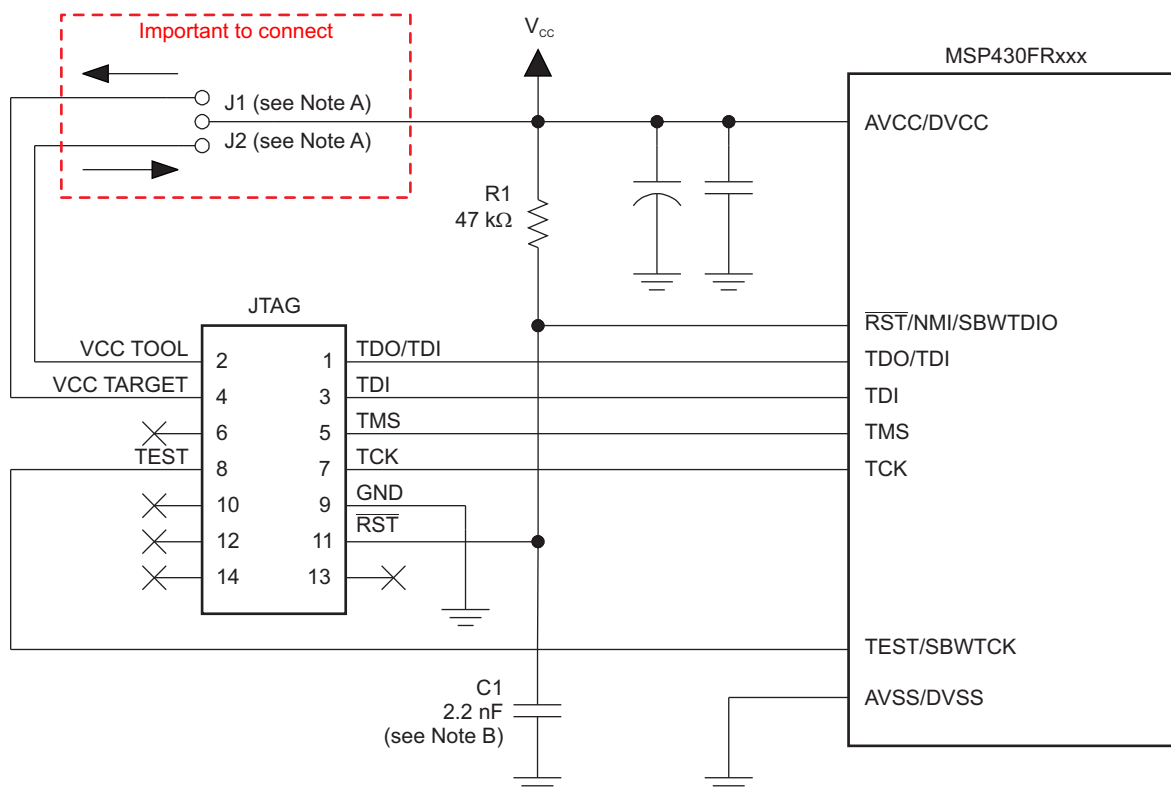
See [MSP430 32-kHz Crystal Oscillators](#) for more information on selecting, testing, and designing a crystal oscillator with the MSP430 devices.

### 7.1.3 JTAG

With the proper connections, the debugger and a hardware JTAG interface (such as the MSP-FET or MSP-FET430UIF) can be used to program and debug code on the target board. In addition, the connections also support the MSP-GANG production programmers, thus providing an easy way to program prototype boards, if desired. [Figure 7-3](#) shows the connections between the 14-pin JTAG connector and the target device required to support in-system programming and debugging for 4-wire JTAG communication. [Figure 7-4](#) shows the connections for 2-wire JTAG mode (Spy-Bi-Wire).

The connections for the MSP-FET and MSP-FET430UIF interface modules and the MSP-GANG are identical. Both can supply VCC to the target board (through pin 2). In addition, the MSP-FET and MSP-FET430UIF interface modules and MSP-GANG have a VCC sense feature that, if used, requires an alternate connection (pin 4 instead of pin 2). The VCC-sense feature senses the local VCC present on the target board (that is, a battery or other local power supply) and adjusts the output signals accordingly. [Figure 7-3](#) and [Figure 7-4](#) show a jumper block that supports both scenarios of supplying VCC to the target board. If this flexibility is not required, the desired VCC connections may be hard-wired to eliminate the jumper block. Pins 2 and 4 must not be connected at the same time.

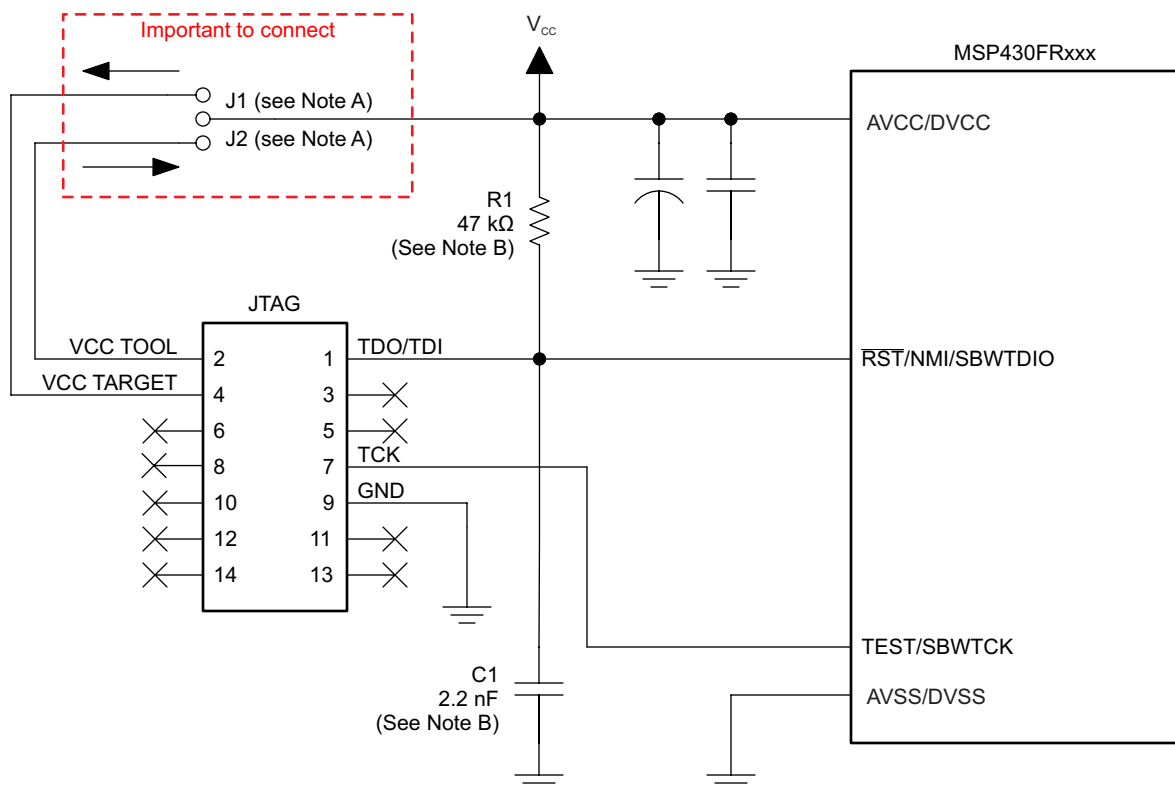
For additional design information regarding the JTAG interface, see the [MSP430 Hardware Tools User's Guide](#).



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- If a local target power supply is used, make connection J1. If power from the debug or programming adapter is used, make connection J2.
- The upper limit for C1 is 2.2 nF when using current TI tools.

**Figure 7-3. Signal Connections for 4-Wire JTAG Communication**



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- Make connection J1 if a local target power supply is used, or make connection J2 if the target is powered from the debug or programming adapter.
- The device  $\overline{\text{RST}}/\text{NMI}/\text{SBWTIO}$  pin is used in 2-wire mode for bidirectional communication with the device during JTAG access, and any capacitance that is attached to this signal may affect the ability to establish a connection with the device. The upper limit for C1 is 2.2 nF when using current TI tools.

**Figure 7-4. Signal Connections for 2-Wire JTAG Communication (Spy-Bi-Wire)**

### 7.1.4 Reset

The reset pin can be configured as a reset function (default) or as an NMI function in the Special Function Register (SFR),  $\text{SFRRPCR}$ .

In reset mode, the  $\overline{\text{RST}}/\text{NMI}$  pin is active low, and a pulse applied to this pin that meets the reset timing specifications generates a BOR-type device reset.

Setting  $\text{SYSNMI}$  causes the  $\overline{\text{RST}}/\text{NMI}$  pin to be configured as an external NMI source. The external NMI is edge sensitive, and its edge is selectable by  $\text{SYSNMIIES}$ . Setting the  $\text{NMIIE}$  enables the interrupt of the external NMI. When an external NMI event occurs, the  $\text{NMIIFG}$  is set.

The  $\overline{\text{RST}}/\text{NMI}$  pin can have either a pullup or pulldown that is enabled or not.  $\text{SYSRSTUP}$  selects either pullup or pulldown, and  $\text{SYSRSTRE}$  causes the pullup (default) or pulldown to be enabled (default) or not. If the  $\overline{\text{RST}}/\text{NMI}$  pin is unused, it is required either to select and enable the internal pullup or to connect an external 47-kΩ pullup resistor to the  $\overline{\text{RST}}/\text{NMI}$  pin with a 2.2-nF pulldown capacitor. The pulldown capacitor should not exceed 2.2 nF when using devices in Spy-Bi-Wire mode or in 4-wire JTAG mode with TI tools like FET interfaces or GANG programmers. If JTAG or Spy-Bi-Wire access is not needed, up to a 10-nF pulldown capacitor may be used.

See the [MSP430FR58xx](#), [MSP430FR59xx](#), [MSP430FR68xx](#), and [MSP430FR69xx Family User's Guide](#) for more information on the referenced control registers and bits.

### 7.1.5 Unused Pins

For details on the connection of unused pins, see [Section 4.4](#).

### 7.1.6 General Layout Recommendations

- Proper grounding and short traces for external crystal to reduce parasitic capacitance. See [MSP430 32-kHz Crystal Oscillators](#) for recommended layout guidelines.
- Proper bypass capacitors on DVCC, AVCC, and reference pins if used.
- Avoid routing any high-frequency signal close to an analog signal line. For example, keep digital switching signals such as PWM or JTAG signals away from the oscillator circuit.
- See [Circuit Board Layout Techniques](#) for a detailed discussion of PCB layout considerations. This document is written primarily about op amps, but the guidelines are generally applicable for all mixed-signal applications.
- Proper ESD level protection should be considered to protect the device from unintended high-voltage electrostatic discharge. See [MSP430 System-Level ESD Considerations](#) for guidelines.

### 7.1.7 Do's and Don'ts

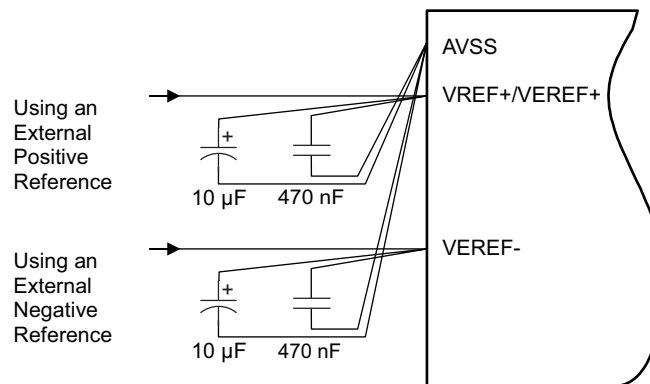
TI recommends powering the AVCC, DVCC, and ESIDVCC pins from the same source. At a minimum, during power up, power down, and device operation, the voltage difference between AVCC and DVCC must not exceed the limits specified in the [Absolute Maximum Ratings](#) section. Exceeding the specified limits may cause malfunction of the device including erroneous writes to RAM and FRAM.

## 7.2 Peripheral- and Interface-Specific Design Information

### 7.2.1 ADC12\_B Peripheral

#### 7.2.1.1 Partial Schematic

Figure 7-5 shows the recommended decoupling circuit when an external voltage reference is used.



**Figure 7-5. ADC12\_B Grounding and Noise Considerations**

#### 7.2.1.2 Design Requirements

As with any high-resolution ADC, appropriate PCB layout and grounding techniques should be followed to eliminate ground loops, unwanted parasitic effects, and noise.

Ground loops are formed when return current from the ADC flows through paths that are common with other analog or digital circuitry. If care is not taken, this current can generate small unwanted offset voltages that can add to or subtract from the reference or input voltages of the ADC. The general guidelines in [Section 7.1.1](#) combined with the connections shown in [Section 7.2.1.1](#) prevent this.

In addition to grounding, ripple and noise spikes on the power-supply lines that are caused by digital switching or switching power supplies can corrupt the conversion result. A noise-free design using separate analog and digital ground planes with a single-point connection is recommended to achieve high accuracy.

Figure 7-5 shows the recommended decoupling circuit when an external voltage reference is used. The internal reference module has a maximum drive current as specified in the Reference module's  $I_{O(VREF+)}$  specification.

The reference voltage must be a stable voltage for accurate measurements. The capacitor values that are selected in the general guidelines filter out the high- and low-frequency ripple before the reference voltage enters the device. In this case, the 10- $\mu$ F capacitor is used to buffer the reference pin and filter any low-frequency ripple. A 470-nF bypass capacitor is used to filter out any high-frequency noise.

### 7.2.1.3 Detailed Design Procedure

For additional design information, see [Designing With the MSP430FR58xx, FR59xx, FR68xx, and FR69xx ADC](#).

### 7.2.1.4 Layout Guidelines

Component that are shown in the partial schematic (see Figure 7-5) should be placed as close as possible to the respective device pins. Avoid long traces, because they add additional parasitic capacitance, inductance, and resistance on the signal.

Avoid routing analog input signals close to a high-frequency pin (for example, a high-frequency PWM), because the high-frequency switching can be coupled into the analog signal.

If differential mode is used for the ADC12\_B, the analog differential input signals must be routed closely together to minimize the effect of noise on the resulting signal.

## 7.2.2 LCD\_C Peripheral

### 7.2.2.1 Partial Schematic

Required LCD connections greatly vary by the type of display that is used (static or multiplexed), whether external or internal biasing is used, and also whether the on-chip charge pump is employed. For any display used, there is flexibility as to how the segment (Sx) and common (COMx) signals are connected to the MCU, which (assuming that the correct choices are made) can be advantageous for the PCB layout and for the design of the application software.

Because LCD connections are application specific, it is difficult to provide a single one-fits-all schematic. However, for an example of connecting a 4-mux LCD with 40 segment lines that has a total of  $4 \times 40 = 160$  individually addressable LCD segments to an MSP430FR6989, see the [Water Meter Reference Design for Two LC Sensors, Using Extended Scan Interface \(ESI\)](#).

### 7.2.2.2 Design Requirements

Due to the flexibility of the LCD\_C peripheral module to accommodate various segment-based LCDs, selecting the correct display for the application in combination with determining specific design requirements is often an iterative process. There can be well defined requirements in terms of how many individually addressable LCD segments need to be controlled, what the requirements for LCD contrast are, which device pins are available for LCD use, and which are required by other application functions, and what the power budget is, to name just a few. TI recommends reviewing the LCD\_C peripheral module chapter in the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide](#) during the initial design requirements and decision process. [Table 7-1](#) is a brief overview over different choices that can be made and their effects.

**Table 7-1. LCD Features and Use Cases**

| OPTION OR FEATURE        | IMPACT OR USE CASE                                                                                                                                                                                                                                                                                                                                                                                          |
|--------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Multiplexed LCD          | <ul style="list-style-type: none"> <li>• Enable displays with more segments</li> <li>• Use fewer device pins</li> <li>• LCD contrast decreases as mux level increases</li> <li>• Power consumption increases with mux level</li> <li>• Requires multiple intermediate bias voltages</li> </ul>                                                                                                              |
| Static LCD               | <ul style="list-style-type: none"> <li>• Limited number of segments that can be addressed</li> <li>• Use a relatively large number of device pins</li> <li>• Use the least amount of power</li> <li>• Use only V<sub>CC</sub> and GND to drive LCD signals</li> </ul>                                                                                                                                       |
| Internal bias generation | <ul style="list-style-type: none"> <li>• Simpler solution – no external circuitry</li> <li>• Independent of V<sub>LCD</sub> source</li> <li>• Somewhat higher power consumption</li> </ul>                                                                                                                                                                                                                  |
| External bias generation | <ul style="list-style-type: none"> <li>• Requires external resistor ladder divider</li> <li>• Resistor size depends on display</li> <li>• Ability to adjust drive strength to optimize tradeoff between power consumption and good drive of large segments (high capacitive load)</li> <li>• External resistor ladder divider can be stabilized through capacitors to reduce ripple</li> </ul>              |
| Internal charge pump     | <ul style="list-style-type: none"> <li>• Helps ensure a constant level of contrast despite decaying supply voltage conditions (battery-powered applications)</li> <li>• Programmable voltage levels allow software-driven contrast control</li> <li>• Requires an external capacitor on the LCDCAP pin</li> <li>• Higher current consumption than simply using V<sub>CC</sub> for the LCD driver</li> </ul> |

### 7.2.2.3 Detailed Design Procedure

A major component in designing the LCD solution is determining the exact connections between the LCD\_C peripheral module and the display itself. Two basic design processes can be employed for this step, although in reality often a balanced co-design approach is recommended:

- PCB layout-driven design
- Software-driven design

In the PCB layout-driven design process, the segment Sx and common COMx signals are connected to respective MSP430 device pins so that the routing of the PCB can be optimized to minimize signal crossings and to keep signals on one side of the PCB only, typically the top layer. For example, using a multiplexed LCD, it is possible to arbitrarily connect the Sx and COMx signals between the LCD and the MSP430 device as long as segment lines are swapped with segment lines and common lines are swapped with common lines. It is also possible to not contiguously connect all segment lines but rather skip LCD\_C module segment connections to optimize layout or to allow access to other functions that may be multiplexed on a particular device port pin. Employing a purely layout-driven design approach, however, can result in the LCD\_C module control bits that are responsible for turning on and off segments to appear scattered throughout the memory map of the LCD controller (LCDMx registers). This approach potentially places a rather large burden on the software design that may also result in increased energy consumption due to the computational overhead required to work with the LCD.

The other extreme is a purely software-driven approach that starts with the idea that control bits for LCD segments that are frequently turned on and off together should be co-located in memory in the same LCDMx register or in adjacent registers. For example, in case of a 4-mux display that contains several 7-segment digits, from a software perspective it can be very desirable to control all 7 segments of each digit through a single byte-wide access to an LCDMx register. And consecutive segments are mapped to consecutive LCDMx registers. This allows use of simple look-up tables or software loops to output numbers on an LCD, reducing computational overhead and optimizing the energy consumption of an application. Establishing of the most convenient memory layout needs to be performed in conjunction with the specific LCD that is being used to understand its design constraints in terms of which segment and which common signals are connected to, for example, a digit.

For design information regarding the LCD controller input voltage selection including internal and external options, contrast control, and bias generation, see the *LCD\_C Controller* chapter in the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide](#).

For additional design information, see [Designing With MSP430 and Segment LCDs](#).

### 7.2.2.4 Layout Guidelines

LCD segment (Sx) and common (COMx) signal traces are continuously switching while the LCD is enabled and should, therefore, be kept away from sensitive analog signals such as ADC inputs to prevent any noise coupling. TI recommends keeping the LCD signal traces on one side of the PCB grouped together in a bus-like fashion. A ground plane underneath the LCD traces and guard traces employed alongside the LCD traces can provide shielding.

If the internal charge pump of the LCD module is used, the externally provided capacitor on the LCDCAP pin should be located as close as possible to the MCU. The capacitor should be connected to the device using a short and direct trace and also have a solid connection to the ground plane that is supplying the V<sub>SS</sub> pins of the MCU.

For an example layout of connecting a 4-mux LCD with 40 segments to an MSP430FR6989 and using the charge pump feature, see the [Water Meter Reference Design for Two LC Sensors, Using Extended Scan Interface \(ESI\)](#).

## 7.2.3 Extended Scan Interface (ESI) Peripheral

### 7.2.3.1 Overview

The external connections for using the Extended Scan Interface (ESI) peripheral module depend on the ESI operating mode and the application details. For example, using the ESI in conjunction with analog LC sensors requires different connections than using the ESI with resistive sensors. Also, using optical sensors and encoders that have a digital output require different considerations.

Table 7-2 lists reference designs that use the ESI to interface with different types of sensors to perform rotation detection. These reference designs provide the hardware and software design files as well as analysis and user's guides to jumpstart your microcontroller-based projects.

**Table 7-2. Reference Designs for ESI**

| DESIGN NAME                                                                                   | LINK                                 |
|-----------------------------------------------------------------------------------------------|--------------------------------------|
| <i>Water Meter Reference Design for Two LC Sensors, Using Extended Scan Interface (ESI)</i>   | <a href="#">TIDM-LC-WATERMTR</a>     |
| <i>Water Meter Reference Design for Three LC Sensors, Using Extended Scan Interface (ESI)</i> | <a href="#">TIDM-3LC-METER-CONV</a>  |
| <i>Water Meter Reference Design for GMR Sensors, Using Extended Scan Interface (ESI)</i>      | <a href="#">TIDM-GMR-WATERMTR</a>    |
| <i>Water Meter Reference Design for Optical Sensors, Using Extended Scan Interface (ESI)</i>  | <a href="#">TIDM-OPTICALWATERMTR</a> |

For schematic information related to other types of sensors and application use cases, see the *Overview of Extended Scan Interface Applications* section in the *Extended Scan Interface (ESI)* chapter of the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide](#).

### 7.2.3.2 Design Requirements

The hardware design requirements are specific to the use case and are most affected by the specification of the interaction of the chosen analog or digital sensors with the analog front ends (AFE1 and AFE2) of the ESI. However, when designing the sensor circuit, the other digital parts of the ESI module, namely the preprocessing unit (PPU), the processing state machine (PSM) with its associated RAM, the timing state machine (TSM), and the Timer\_A output stage must also be considered to ensure that the processing as required by the application can be performed in an autonomous manner inside the ESI. See the *Extended Scan Interface (ESI)* chapter of the [MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide](#) for additional information regarding the design requirements and constraints of the module.

### 7.2.3.3 Detailed Design Procedure

TI provides a variety of collateral to aid the design and implementation of the ESI into specific applications, most of which are related to metering. The following application notes are available as of this writing. Additional application notes may be available in the device-specific product folder.

[LC Sensor Rotation Detection With MSP430 Extended Scan Interface \(ESI\)](#)

[Method to Select the Value of LC Sensor for MSP430 Extended Scan Interface \(ESI\)](#)

[Adjustment of ESIOSC Oscillator Frequency](#)

[Migrating From MSP430FW42x Scan Interface to MSP430FR6x8x/FR5x8x Extended Scan Interface](#)

For complete and fully documented reference implementations that use the ESI to interface with different types of sensors to perform rotation detection, see [Table 7-2](#).

#### 7.2.3.4 Layout Guidelines

The proper operation of the ESI and the connected sensor front end relies on a good analog board layout. Specifically in case of using the ESI analog front ends to interface with LC type or resistive sensors as typically employed in metering applications, the designer must make sure that the sensitive analog sensor signals are kept separated and guarded from any noise that might occur in the system including but not limited to the switching of LCD segment and common lines, communication signals, or any other type of digital I/O that is toggling. Failure to follow proper precautions may reduce the sensitivity of the solution or may render the application inoperable.

Customers are encouraged to study and follow one of the available TI Designs (see [Table 7-2](#)) for additional guidance. Also see [Section 7.1.6](#) for more information that is applicable to this topic.

## 8 Device and Documentation Support

### 8.1 Getting Started and Next Steps

For more information on the MSP430 family of devices and the tools and libraries that are available to help with your development, visit the [Getting Started](#) page.

### 8.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

**MSP** – Fully qualified production device

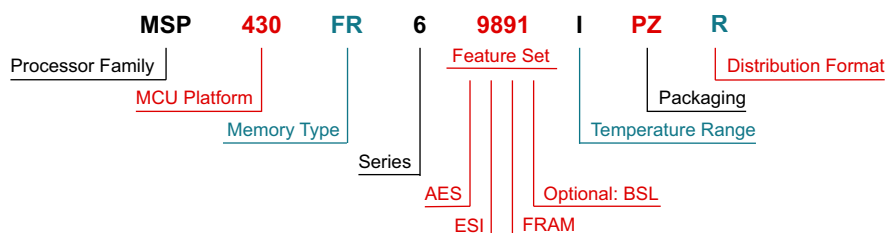
XMS devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format. [Figure 8-1](#) provides a legend for reading the complete device name.



|                            |                                                                                       |                                                                                                   |                                                                        |                                                                              |
|----------------------------|---------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|------------------------------------------------------------------------|------------------------------------------------------------------------------|
| <b>Processor Family</b>    | MSP = Mixed-Signal Processor<br>XMS = Experimental Silicon                            |                                                                                                   |                                                                        |                                                                              |
| <b>MCU Platform</b>        | 430 = TI's 16-bit MSP430 Low-Power Microcontroller Platform                           |                                                                                                   |                                                                        |                                                                              |
| <b>Memory Type</b>         | FR = FRAM                                                                             |                                                                                                   |                                                                        |                                                                              |
| <b>Series</b>              | 6 = FRAM 6 Series up to 16 MHz with LCD<br>5 = FRAM 5 Series up to 16 MHz without LCD |                                                                                                   |                                                                        |                                                                              |
| <b>Feature Set</b>         | <b>First Digit: AES</b><br>9 = AES<br>8 = No AES                                      | <b>Second Digit: Extended Scan Interface</b><br>8 = ESI<br>7 = No ESI<br>2 = No ESI, LCD, 64 pins | <b>Third Digit: FRAM (KB)</b><br>9 = 128<br>8 = 96<br>7 = 64<br>6 = 48 | <b>Optional Fourth Digit: BSL</b><br>1 = I <sup>2</sup> C<br>No value = UART |
| <b>Temperature Range</b>   | I = -40°C to 85°C                                                                     |                                                                                                   |                                                                        |                                                                              |
| <b>Packaging</b>           | <a href="http://www.ti.com/packaging">www.ti.com/packaging</a>                        |                                                                                                   |                                                                        |                                                                              |
| <b>Distribution Format</b> | T = Small reel<br>R = Large reel<br>No markings = Tube or tray                        |                                                                                                   |                                                                        |                                                                              |

NOTE: This figure does not represent a complete list of the available features and options, and does not indicate that all of these features and options are available for a given device or family.

**Figure 8-1. Device Nomenclature – Part Number Decoder**

## 8.3 Tools and Software

Table 8-1 lists the debug features supported by the MSP430FR688x(1) and MSP430FR588x(1) microcontrollers. See the [Code Composer Studio for MSP430 User's Guide](#) for details on the available features.

**Table 8-1. Hardware Features**

| MSP430<br>ARCHITECTURE | 4-WIRE<br>JTAG | 2-WIRE<br>JTAG | BREAK-<br>POINTS<br>(N) | RANGE<br>BREAK-<br>POINTS | CLOCK<br>CONTROL | STATE<br>SEQUENCER | TRACE<br>BUFFER | LPMX.5<br>DEBUGGING<br>SUPPORT | EnergyTrace++<br>TECHNOLOGY |
|------------------------|----------------|----------------|-------------------------|---------------------------|------------------|--------------------|-----------------|--------------------------------|-----------------------------|
| MSP430Xv2              | Yes            | Yes            | 3                       | Yes                       | Yes              | No                 | No              | Yes                            | Yes                         |

EnergyTrace™ technology is supported with Code Composer Studio version 6.0 and newer. It requires specialized debugger circuitry, which is supported with the second-generation onboard eZ-FET flash emulation tool and second-generation stand-alone MSP-FET JTAG emulator. For additional information, see:

[Advanced Debugging Using the Enhanced Emulation Module \(EEM\) With Code Composer Studio Version 6](#)

[MSP430™ Advanced Power Optimizations: ULP Advisor™ and EnergyTrace™ Technology](#)

### Design Kits and Evaluation Modules

**MSP430FR6989 LaunchPad™ Development Kit** The MSP-EXP430FR6989 LaunchPad Development Kit is an easy-to-use evaluation module (EVM) for the MSP430FR6989 microcontroller (MCU). It contains everything needed to start developing on the ultra-low-power MSP430FRx FRAM microcontroller platform, including onboard emulation for programming, debugging, and energy measurements.

**MSP-TS430PZ100D 100-pin Target Development Board for MSP430FRxx FRAM MCUs** The MSP-TS430PZ100D is a stand-alone 100-pin ZIF socket target board used to program and debug the MSP430 MCU in-system through the JTAG interface or the Spy-Bi-Wire (2-wire JTAG) protocol.

### 100-pin Target Development Board and MSP-FET Programmer Bundle for MSP430FRxx FRAM MCUs

The MSP-FET430U100D is a bundle featuring the MSP-FET programmer and debugger with the MSP-TS430PZ100D, a stand-alone 100-pin ZIF socket target board. This bundle can be used to program and debug the MSP430 MCU in system through the JTAG interface or the Spy-Bi-Wire (2-wire JTAG) protocol.

### Software

**MSP430Ware™ Software** MSP430Ware software is a collection of code examples, data sheets, and other design resources for all MSP430 devices delivered in a convenient package. In addition to providing a complete collection of existing MSP430 MCU design resources, MSP430Ware software also includes a high-level API called MSP Driver Library. This library makes it easy to program MSP430 hardware. MSP430Ware software is available as a component of CCS or as a stand-alone package.

**MSP430FR5x8x, MSP430FR692x, MSP430FR6x7x, MSP430FR6x8x Code Examples** C Code examples are available for every MSP device that configures each of the integrated peripherals for various application needs.

**FRAM Embedded Software Utilities for MSP Ultra-Low-Power Microcontrollers** The TI FRAM Utilities software is designed to grow as a collection of embedded software utilities that leverage the ultra-low-power and virtually unlimited write endurance of FRAM. The utilities are available for MSP430FRxx FRAM microcontrollers and provide example code to help start application development.

**FlowESI GUI for Flow Meter Configuration Using the Extended Scan Interface (ESI)** Follow the simple graphical instructions and connect up to three LC sensors to the Extended Scan Interface module. The tool provides fully functional CCS and IAR projects or source code that can be incorporated into custom projects.

**MSP430 Touch Pro GUI** The MSP430 Touch Pro Tool is a PC-based tool that can be used to verify capacitive touch button, slider, and wheel designs. The tool receives and visualizes capacitouch sensor data to help the user quickly and easily evaluate, diagnose, and tune button, slider, and wheel designs.

**MSP430 Touch Power Designer GUI** The MSP430 Capacitive Touch Power Designer enables the calculation of the estimated average current draw for a given MSP430 capacitive touch system. By entering system parameters such as operating voltage, frequency, number of buttons, and button gate time, the user can have a power estimate for a given capacitive touch configuration on a given device family in minutes.

**Digital Signal Processing (DSP) Library for MSP Microcontrollers** The Digital Signal Processing library is a set of highly optimized functions to perform many common signal processing operations on fixed-point numbers for MSP430 and MSP432 microcontrollers. This function set is typically used for applications where processing-intensive transforms are done in real-time for minimal energy and with very high accuracy. This optimal use of the MSP intrinsic hardware for fixed-point math allows for significant performance gains.

**MSP Driver Library** The abstracted API of MSP Driver Library provides easy-to-use function calls that free you from directly manipulating the bits and bytes of the MSP430 hardware. Thorough documentation is delivered through a helpful API Guide, which includes details on each function call and the recognized parameters. Developers can use Driver Library functions to write complete projects with minimal overhead.

**MSP EnergyTrace Technology** EnergyTrace technology for MSP430 microcontrollers is an energy-based code analysis tool that measures and displays the energy profile of the application and helps to optimize it for ultra-low-power consumption.

**ULP (Ultra-Low Power) Advisor** ULP Advisor™ software is a tool for guiding developers to write more efficient code to fully use the unique ultra-low-power features of MSP and MSP432 microcontrollers. Aimed at both experienced and new microcontroller developers, ULP Advisor checks your code against a thorough ULP checklist to help minimize the energy consumption of your application. At build time, ULP Advisor provides notifications and remarks to highlight areas of your code that can be further optimized for lower power.

**IEC60730 Software Package** The IEC60730 MSP430 software package was developed to help customers comply with IEC 60730-1:2010 (Automatic Electrical Controls for Household and Similar Use – Part 1: General Requirements) for up to Class B products, which includes home appliances, arc detectors, power converters, power tools, e-bikes, and many others. The IEC60730 MSP430 software package can be embedded in customer applications running on MSP430s to help simplify the customer's certification efforts of functional safety-compliant consumer devices to IEC 60730-1:2010 Class B.

**Fixed Point Math Library for MSP** The MSP IQmath and Qmath Libraries are a collection of highly optimized and high-precision mathematical functions for C programmers to seamlessly port a floating-point algorithm into fixed-point code on MSP430 and MSP432 devices. These routines are typically used in computationally intensive real-time applications where optimal execution speed, high accuracy, and ultra-low energy are critical. By using the IQmath and Qmath libraries, it is possible to achieve execution speeds considerably faster and energy consumption considerably lower than equivalent code written using floating-point math.

**Floating Point Math Library for MSP430** Continuing to innovate in the low-power and low-cost microcontroller space, TI provides MSPMATHLIB. Leveraging the intelligent peripherals of our devices, this floating-point math library of scalar functions is up to 26 times faster than the standard MSP430 math functions. Mathlib is easy to integrate into your designs. This library is free and is integrated in both Code Composer Studio IDE and IAR Embedded Workbench IDE.

## Development Tools

**Code Composer Studio™ Integrated Development Environment for MSP Microcontrollers** Code Composer Studio (CCS) integrated development environment (IDE) supports all MSP microcontroller devices. CCS comprises a suite of embedded software utilities used to develop and debug embedded applications. CCS includes an optimizing C/C++ compiler, source code editor, project build environment, debugger, profiler, and many other features.

**Command-Line Programmer** MSP Flasher is an open-source shell-based interface for programming MSP microcontrollers through a FET programmer or eZ430 using JTAG or Spy-Bi-Wire (SBW) communication. MSP Flasher can download binary files (.txt or .hex) directly to the MSP microcontroller without an IDE.

**MSP MCU Programmer and Debugger** The MSP-FET is a powerful emulation development tool – often called a debug probe – which lets users quickly begin application development on MSP low-power MCUs. Creating MCU software usually requires downloading the resulting binary program to the MSP device for validation and debugging.

**MSP-GANG Production Programmer** The MSP Gang Programmer is an MSP430 or MSP432 device programmer that can program up to eight identical MSP430 or MSP432 flash or FRAM devices at the same time. The MSP Gang Programmer connects to a host PC using a standard RS-232 or USB connection and provides flexible programming options that let the user fully customize the process.

## 8.4 Documentation Support

The following documents describe the MSP430FR688x(1) and MSP430FR588x(1) MCUs. Copies of these documents are available on the Internet at [www.ti.com](http://www.ti.com).

### Receiving Notification of Document Updates

To receive notification of documentation updates—including silicon errata—go to the product folder for your device on [ti.com](http://ti.com) (for links to product folders, see [Section 8.5](#)). In the upper right corner, click the "Alert me" button. This registers you to receive a weekly digest of product information that has changed (if any). For change details, check the revision history of any revised document.

### Errata

**MSP430FR6889 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR68891 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR6888 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR6887 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR5889 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR58891 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR5888 Device Erratasheet** Describes the known exceptions to the functional specifications.

**MSP430FR5887 Device Erratasheet** Describes the known exceptions to the functional specifications.

### User's Guides

**MSP430FR58xx, MSP430FR59xx, and MSP430FR6xx Family User's Guide** Detailed description of all modules and peripherals available in this device family.

**MSP430 FRAM Device Bootloader (BSL) User's Guide** The bootloader (BSL) on MSP430 MCUs lets users communicate with embedded memory in the MSP430 MCU during the prototyping phase, final production, and in service. Both the programmable memory (FRAM memory) and the data memory (RAM) can be modified as required.

**MSP430 Programming With the JTAG Interface** This document describes the functions that are required to erase, program, and verify the memory module of the MSP430 flash-based and FRAM-based microcontroller families using the JTAG communication port. In addition, it describes how to program the JTAG access security fuse that is available on all MSP430 devices. This document describes device access using both the standard 4-wire JTAG interface and the 2-wire JTAG interface, which is also referred to as Spy-Bi-Wire (SBW).

**MSP430 Hardware Tools User's Guide** This manual describes the hardware of the TI MSP-FET430 Flash Emulation Tool (FET). The FET is the program development tool for the MSP430 ultra-low-power microcontroller. Both available interface types, the parallel port interface and the USB interface, are described.

## Application Reports

**MSP430 FRAM Technology – How To and Best Practices** FRAM is a nonvolatile memory technology that behaves similar to SRAM while enabling a whole host of new applications, but also changing the way firmware should be designed. This application report outlines the how to and best practices of using FRAM technology in MSP430 from an embedded software development perspective. It discusses how to implement a memory layout according to application-specific code, constant, data space requirements, and the use of FRAM to optimize application energy consumption.

**MSP430 32-kHz Crystal Oscillators** Selection of the right crystal, correct load circuit, and proper board layout are important for a stable crystal oscillator. This application report summarizes crystal oscillator function and explains the parameters to select the correct crystal for MSP430 ultra-low-power operation. In addition, hints and examples for correct board layout are given. The document also contains detailed information on the possible oscillator tests to ensure stable oscillator operation in mass production.

**MSP430 System-Level ESD Considerations** System-Level ESD has become increasingly demanding with silicon technology scaling towards lower voltages and the need for designing cost-effective and ultra-low-power components. This application report addresses three different ESD topics to help board designers and OEMs understand and design robust system-level designs.

## 8.5 Related Links

**Table 8-2** lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 8-2. Related Links**

| PARTS         | PRODUCT FOLDER             | ORDER NOW                  | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|---------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| MSP430FR6889  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR68891 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR6888  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR6887  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR5889  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR58891 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR5888  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430FR5887  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

## 8.6 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### [TI E2E™ Community](#)

*TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

### [TI Embedded Processors Wiki](#)

*Texas Instruments Embedded Processors Wiki.* Established to help developers get started with embedded processors from Texas Instruments and to foster innovation and growth of general knowledge about the hardware and software surrounding these devices.

## 8.7 Trademarks

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## 8.8 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 8.9 Export Control Notice

Recipient agrees to not knowingly export or re-export, directly or indirectly, any product or technical data (as defined by the U.S., EU, and other Export Administration Regulations) including software, or any controlled product restricted by other applicable national regulations, received from disclosing party under nondisclosure obligations (if any), or any direct product of such technology, to any destination to which such export or re-export is restricted or prohibited by U.S. or other applicable laws, without obtaining prior authorization from U.S. Department of Commerce and other competent Government authorities to the extent required by those laws.

## 8.10 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms and definitions.

## 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430FR5887IPM   | ACTIVE        | LQFP         | PM                 | 64   | 160            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5887                  | <a href="#">Samples</a> |
| MSP430FR5887IPMR  | ACTIVE        | LQFP         | PM                 | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5887                  | <a href="#">Samples</a> |
| MSP430FR5887IRGCR | ACTIVE        | VQFN         | RGC                | 64   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5887                  | <a href="#">Samples</a> |
| MSP430FR5887IRGCT | ACTIVE        | VQFN         | RGC                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5887                  | <a href="#">Samples</a> |
| MSP430FR5888IPM   | ACTIVE        | LQFP         | PM                 | 64   | 160            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5888                  | <a href="#">Samples</a> |
| MSP430FR5888IRGCT | ACTIVE        | VQFN         | RGC                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5888                  | <a href="#">Samples</a> |
| MSP430FR58891IPM  | ACTIVE        | LQFP         | PM                 | 64   | 160            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR58891                 | <a href="#">Samples</a> |
| MSP430FR5889IPM   | ACTIVE        | LQFP         | PM                 | 64   | 160            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5889                  | <a href="#">Samples</a> |
| MSP430FR5889IPMR  | ACTIVE        | LQFP         | PM                 | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5889                  | <a href="#">Samples</a> |
| MSP430FR5889IRGCR | ACTIVE        | VQFN         | RGC                | 64   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5889                  | <a href="#">Samples</a> |
| MSP430FR5889IRGCT | ACTIVE        | VQFN         | RGC                | 64   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR5889                  | <a href="#">Samples</a> |
| MSP430FR6887IPN   | ACTIVE        | LQFP         | PN                 | 80   | 119            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6887                  | <a href="#">Samples</a> |
| MSP430FR6887IPZ   | ACTIVE        | LQFP         | PZ                 | 100  | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6887                  | <a href="#">Samples</a> |
| MSP430FR6888IPN   | ACTIVE        | LQFP         | PN                 | 80   | 119            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6888                  | <a href="#">Samples</a> |
| MSP430FR6888IPZ   | ACTIVE        | LQFP         | PZ                 | 100  | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6888                  | <a href="#">Samples</a> |
| MSP430FR68891IPN  | ACTIVE        | LQFP         | PN                 | 80   | 119            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR68891                 | <a href="#">Samples</a> |
| MSP430FR68891IPNR | ACTIVE        | LQFP         | PN                 | 80   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  |              | FR68891                 | <a href="#">Samples</a> |

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430FR68891IPZ  | ACTIVE        | LQFP         | PZ                 | 100  | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR68891                 | <a href="#">Samples</a> |
| MSP430FR68891IPZR | ACTIVE        | LQFP         | PZ                 | 100  | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR68891                 | <a href="#">Samples</a> |
| MSP430FR68891IPN  | ACTIVE        | LQFP         | PN                 | 80   | 119            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6889                  | <a href="#">Samples</a> |
| MSP430FR68891IPNR | ACTIVE        | LQFP         | PN                 | 80   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6889                  | <a href="#">Samples</a> |
| MSP430FR68891PZ   | ACTIVE        | LQFP         | PZ                 | 100  | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | FR6889                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

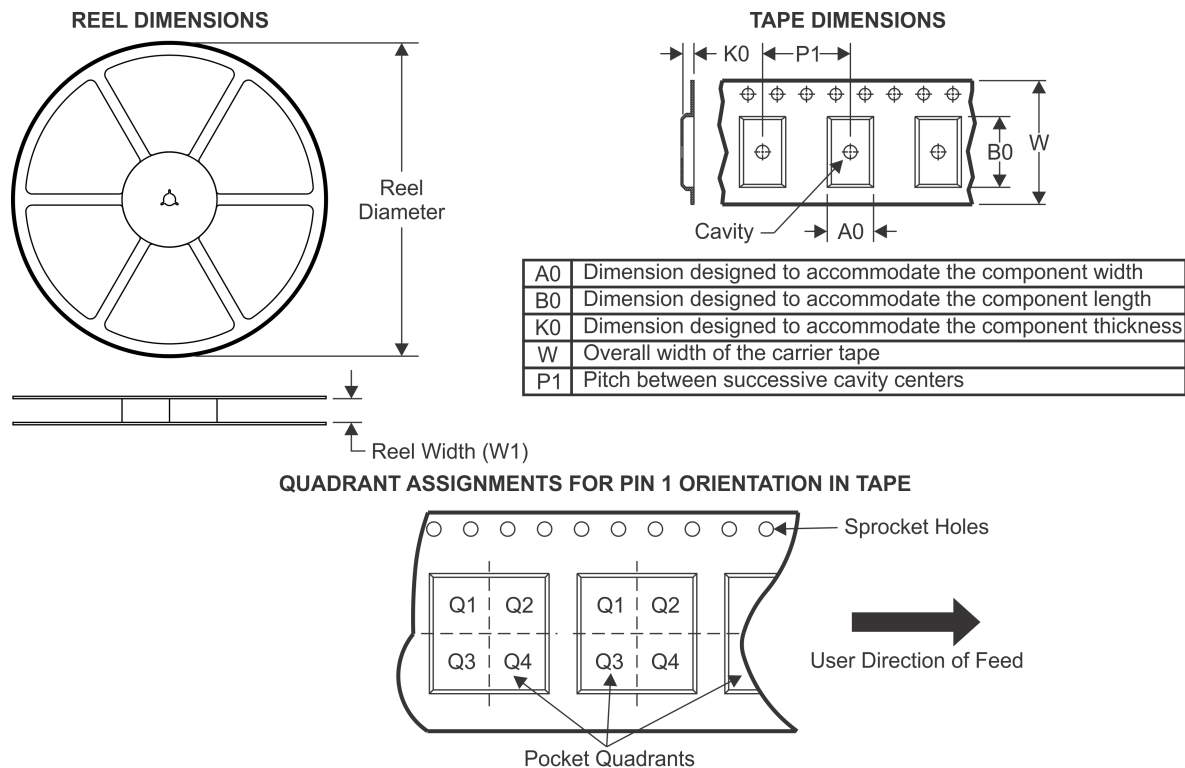
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and

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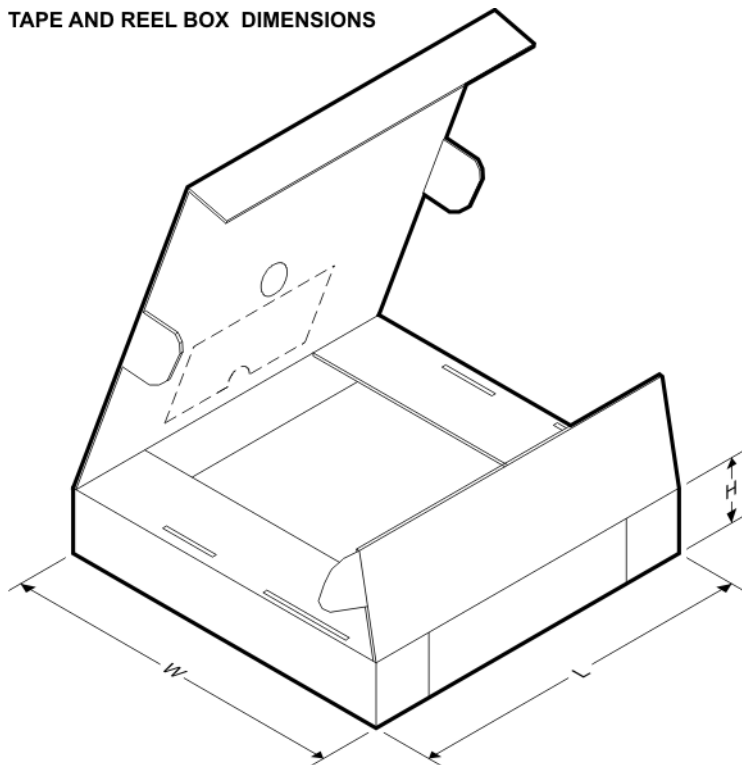
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430FR5887IPMR  | LQFP         | PM              | 64   | 1000 | 330.0              | 24.4               | 13.0    | 13.0    | 2.1     | 16.0    | 24.0   | Q2            |
| MSP430FR5887IRGCR | VQFN         | RGC             | 64   | 2000 | 330.0              | 16.4               | 9.3     | 9.3     | 1.1     | 12.0    | 16.0   | Q2            |
| MSP430FR5887IRGCT | VQFN         | RGC             | 64   | 250  | 180.0              | 16.4               | 9.3     | 9.3     | 1.1     | 12.0    | 16.0   | Q2            |
| MSP430FR5888IRGCT | VQFN         | RGC             | 64   | 250  | 180.0              | 16.4               | 9.3     | 9.3     | 1.1     | 12.0    | 16.0   | Q2            |
| MSP430FR5889IPMR  | LQFP         | PM              | 64   | 1000 | 330.0              | 24.4               | 13.0    | 13.0    | 2.1     | 16.0    | 24.0   | Q2            |
| MSP430FR5889IRGCR | VQFN         | RGC             | 64   | 2000 | 330.0              | 16.4               | 9.3     | 9.3     | 1.1     | 12.0    | 16.0   | Q2            |
| MSP430FR5889IRGCT | VQFN         | RGC             | 64   | 250  | 180.0              | 16.4               | 9.3     | 9.3     | 1.1     | 12.0    | 16.0   | Q2            |
| MSP430FR68891IPNR | LQFP         | PN              | 80   | 1000 | 330.0              | 24.4               | 15.0    | 15.0    | 2.1     | 20.0    | 24.0   | Q2            |
| MSP430FR68891IPZR | LQFP         | PZ              | 100  | 1000 | 330.0              | 24.4               | 17.0    | 17.0    | 2.1     | 20.0    | 24.0   | Q2            |
| MSP430FR6889IPNR  | LQFP         | PN              | 80   | 1000 | 330.0              | 24.4               | 15.0    | 15.0    | 2.1     | 20.0    | 24.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

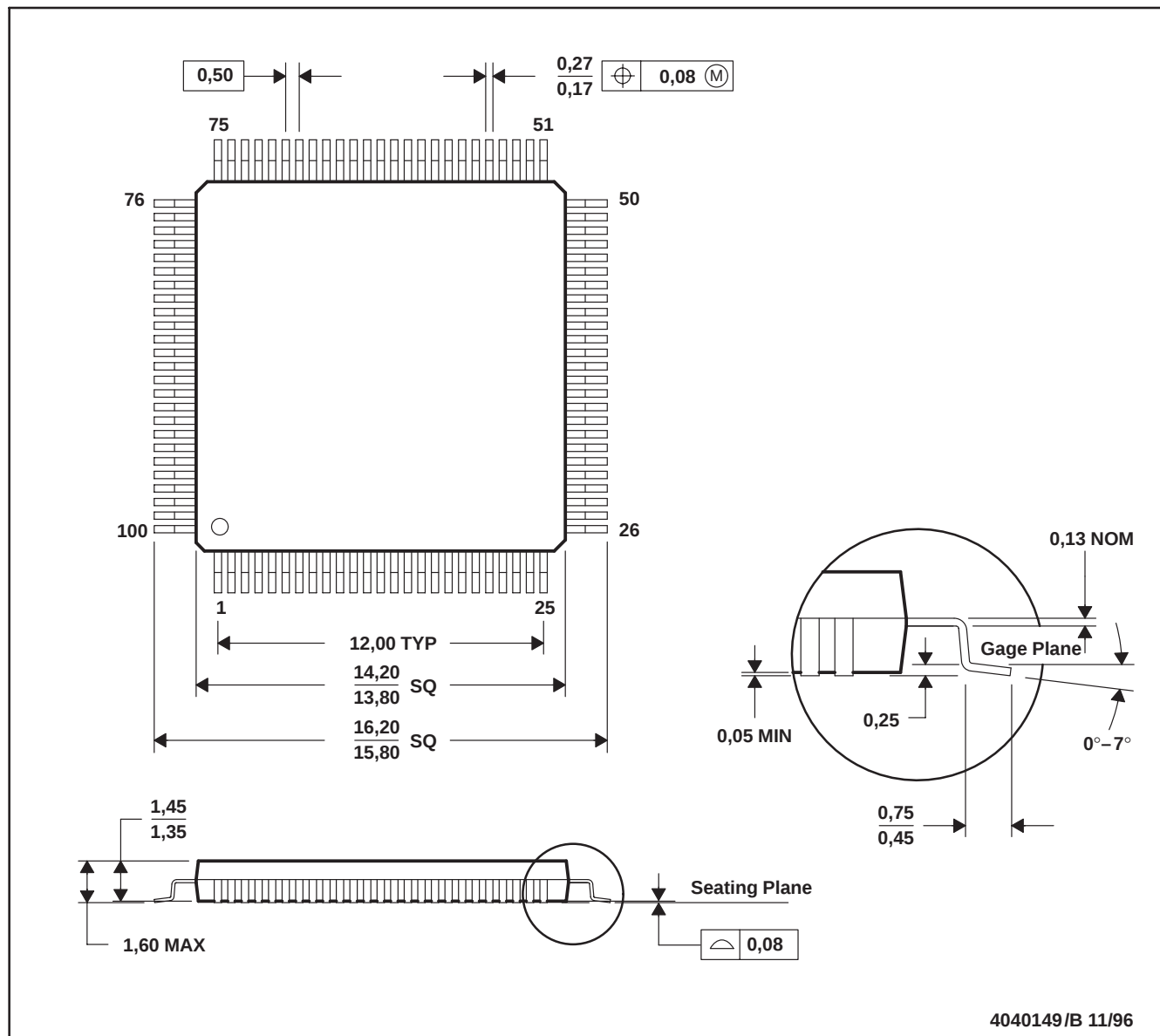


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430FR5887IPMR  | LQFP         | PM              | 64   | 1000 | 350.0       | 350.0      | 43.0        |
| MSP430FR5887IRGCR | VQFN         | RGC             | 64   | 2000 | 367.0       | 367.0      | 38.0        |
| MSP430FR5887IRGCT | VQFN         | RGC             | 64   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430FR5888IRGCT | VQFN         | RGC             | 64   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430FR5889IPMR  | LQFP         | PM              | 64   | 1000 | 350.0       | 350.0      | 43.0        |
| MSP430FR5889IRGCR | VQFN         | RGC             | 64   | 2000 | 367.0       | 367.0      | 38.0        |
| MSP430FR5889IRGCT | VQFN         | RGC             | 64   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430FR68891IPNR | LQFP         | PN              | 80   | 1000 | 350.0       | 350.0      | 43.0        |
| MSP430FR68891IPZR | LQFP         | PZ              | 100  | 1000 | 350.0       | 350.0      | 43.0        |
| MSP430FR6889IPNR  | LQFP         | PN              | 80   | 1000 | 350.0       | 350.0      | 43.0        |

## PZ (S-PQFP-G100)

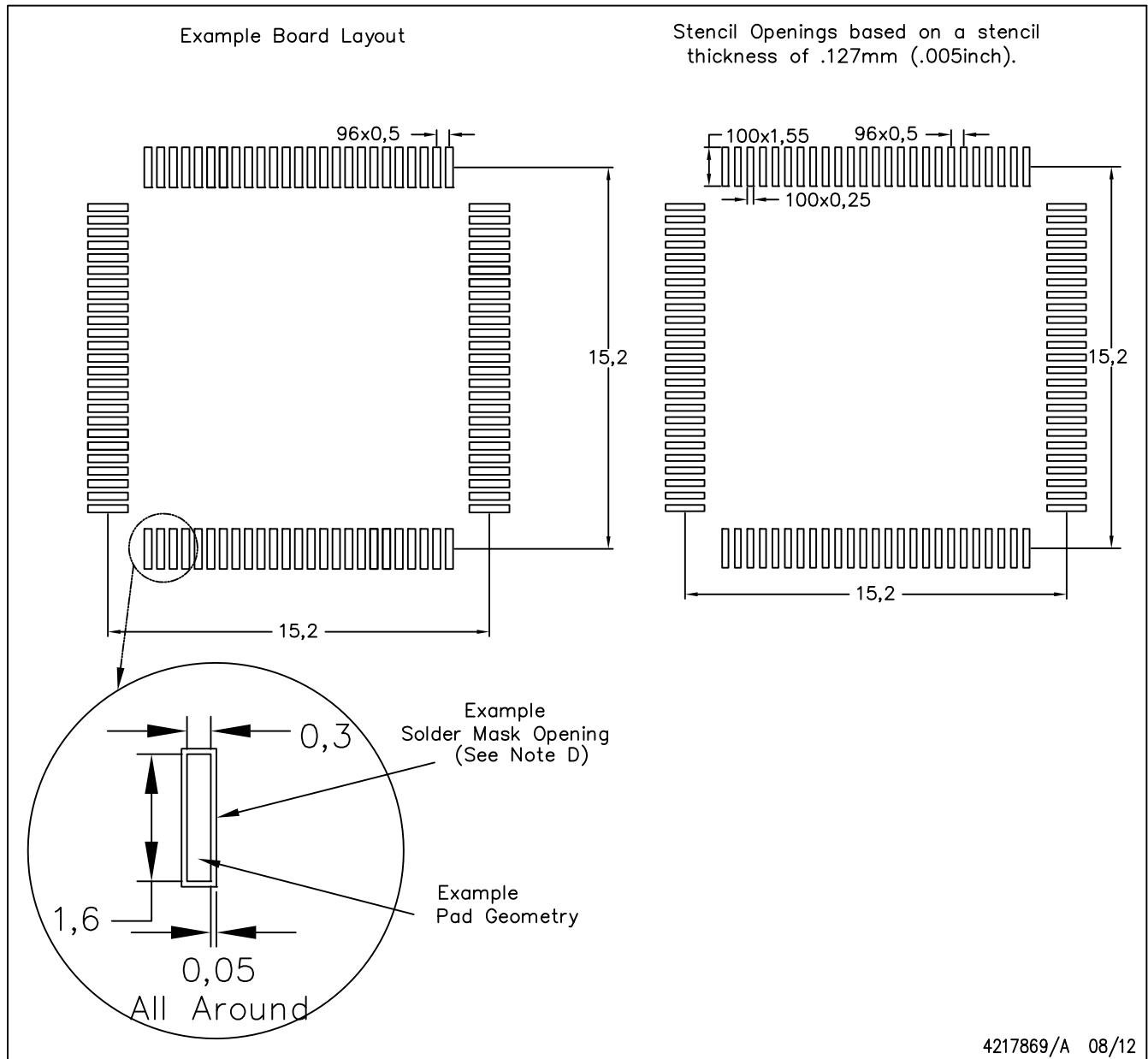
## PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

PZ (S-PQFP-G100)

PLASTIC QUAD FLAT PACK



4217869/A 08/12

NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
- Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

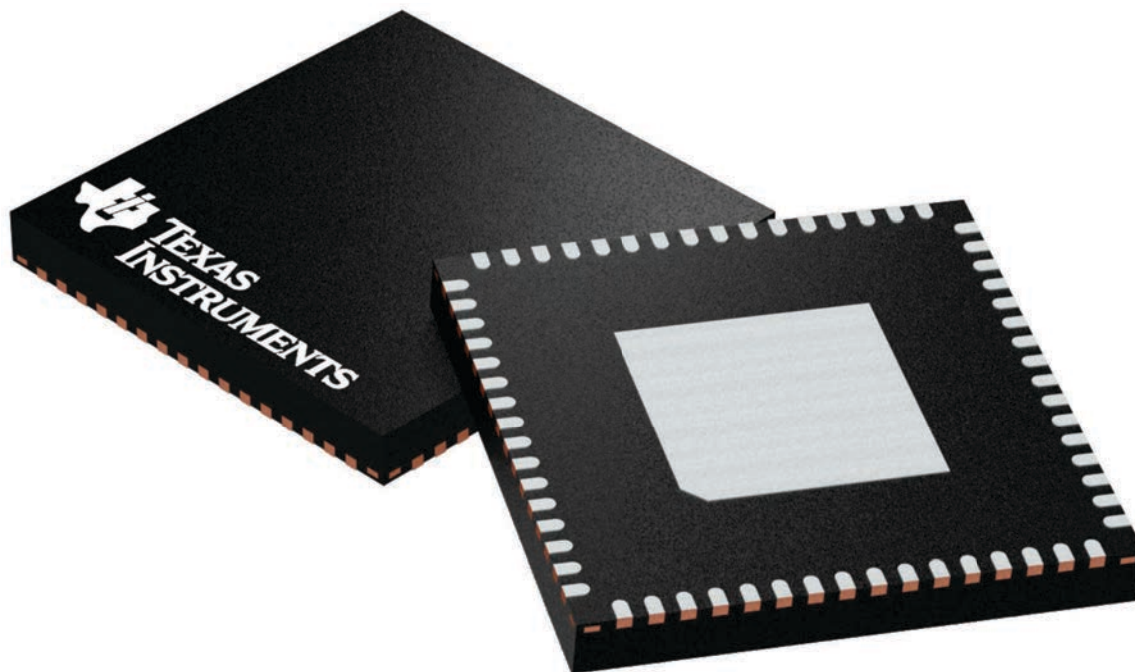
## GENERIC PACKAGE VIEW

**RGC 64**

**VQFN - 1 mm max height**

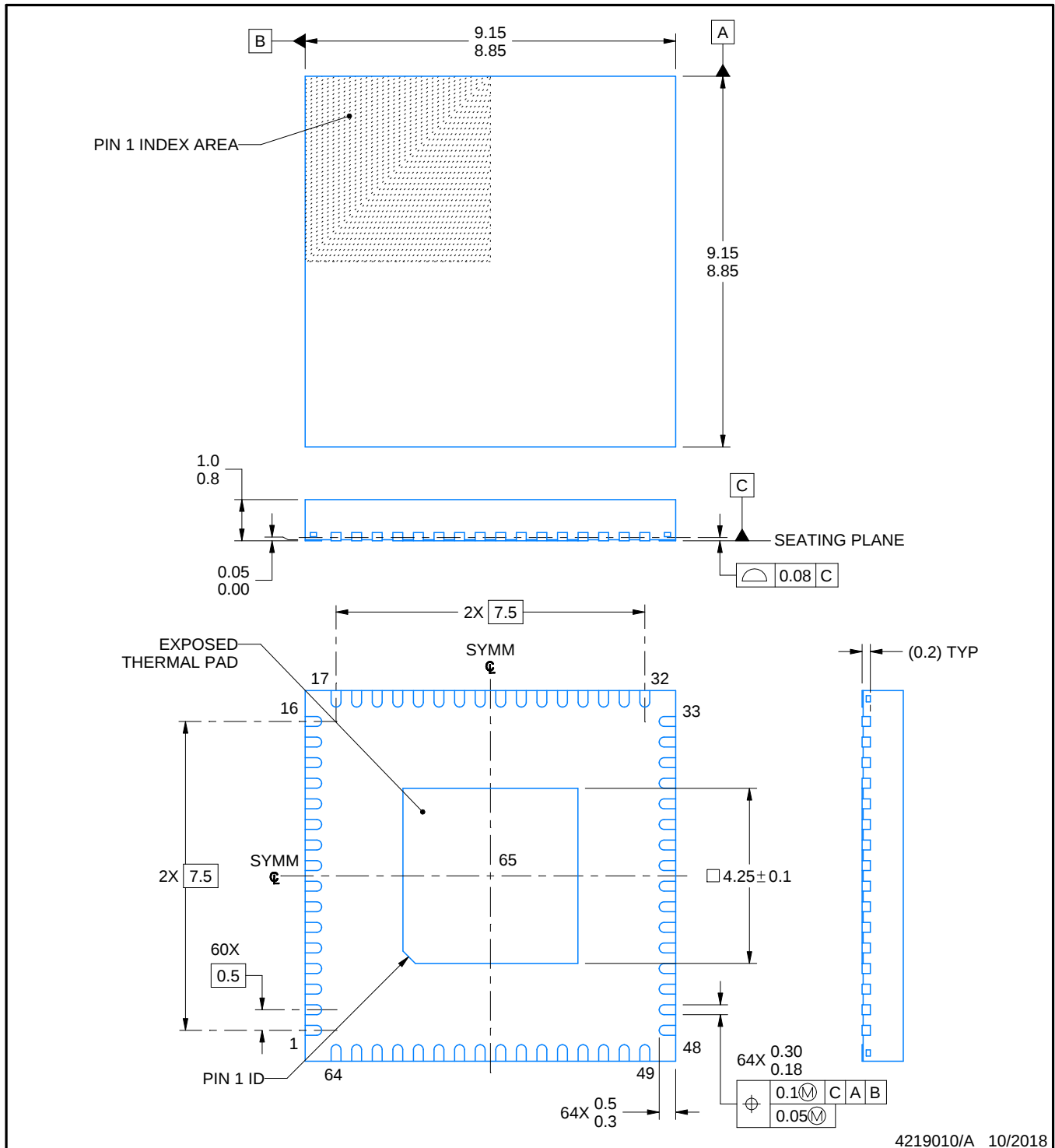
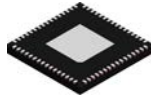
9 x 9, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224597/A



## NOTES:

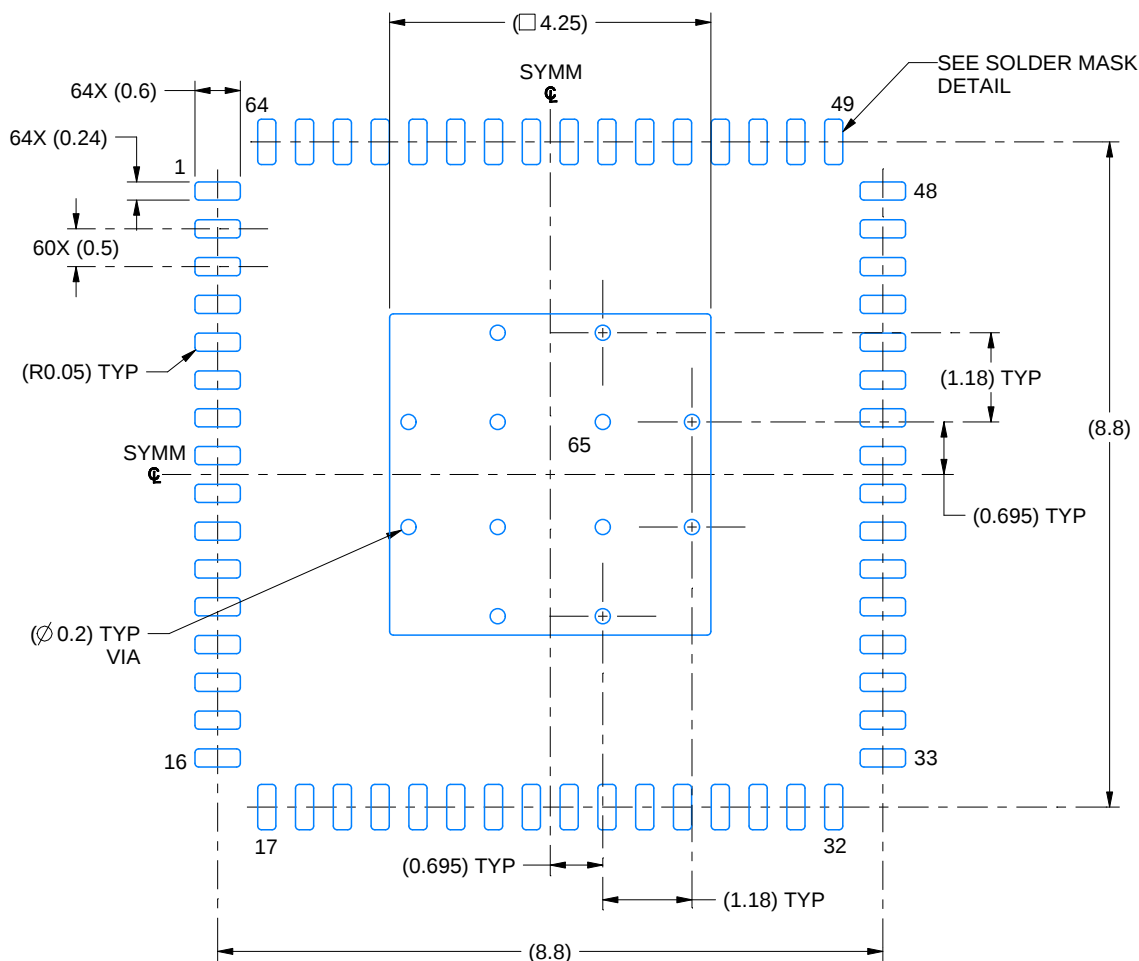
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

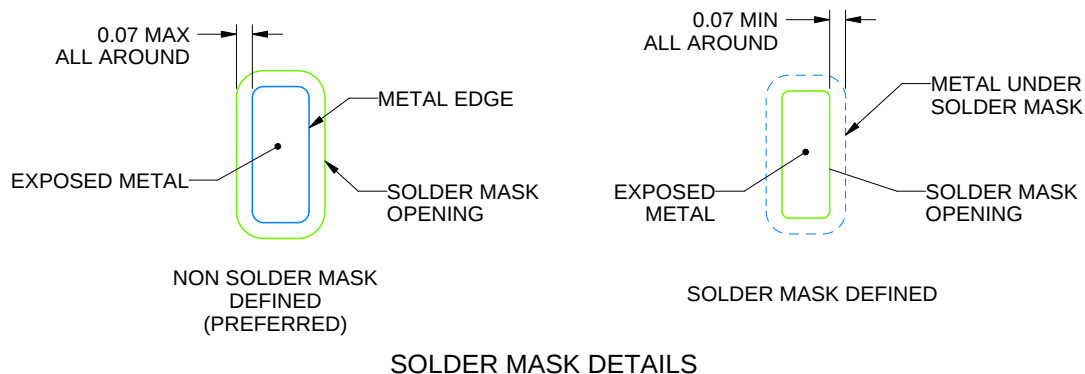
RGC0064B

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4219010/A 10/2018

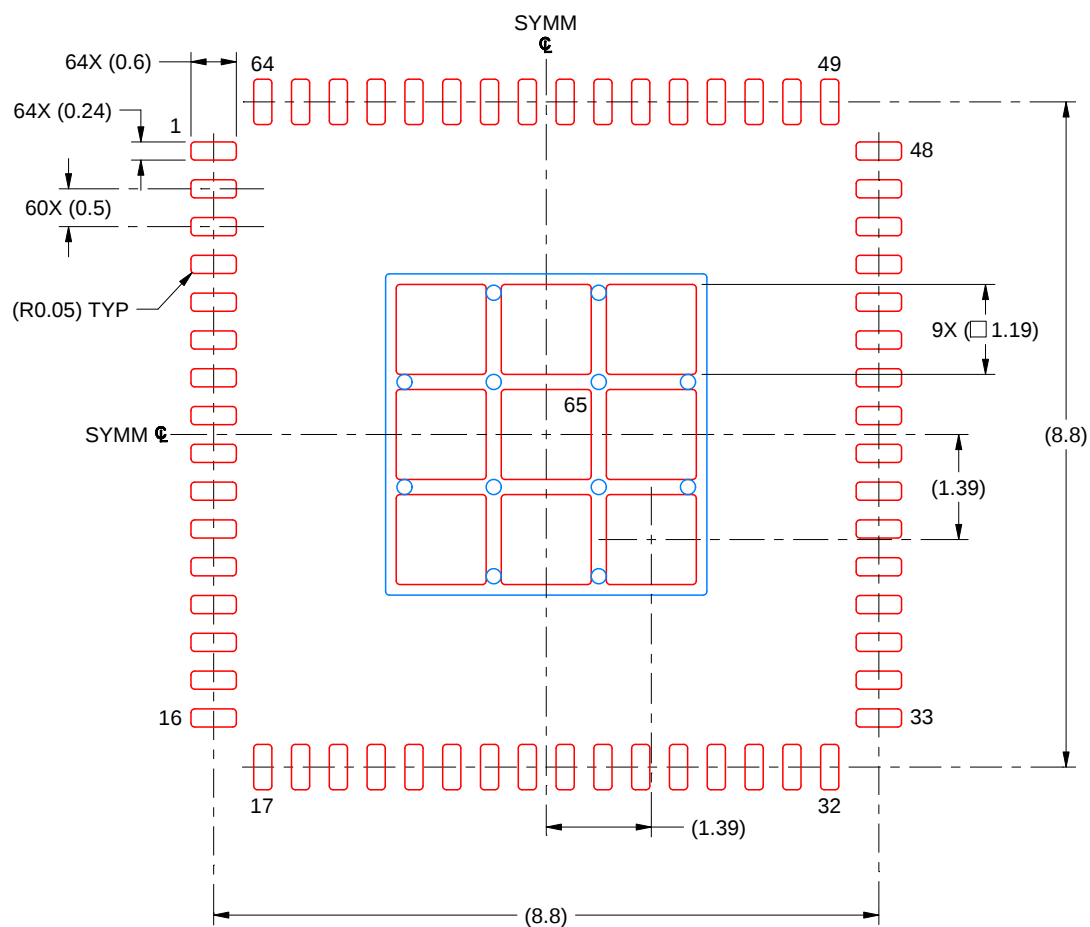
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**RG0064B**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 MM THICK STENCIL  
SCALE: 10X

EXPOSED PAD 65  
71% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

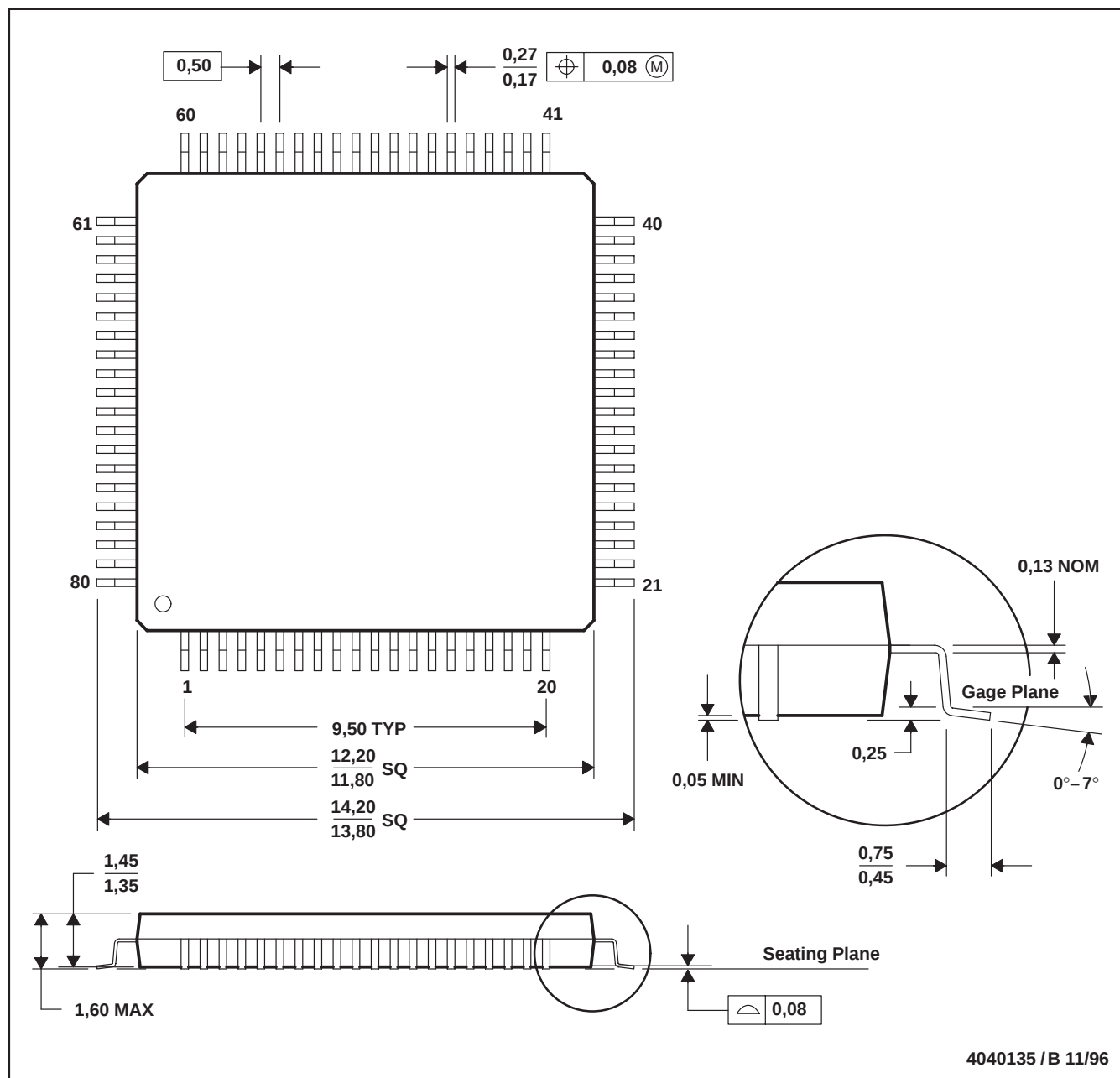
4219010/A 10/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## PN (S-PQFP-G80)

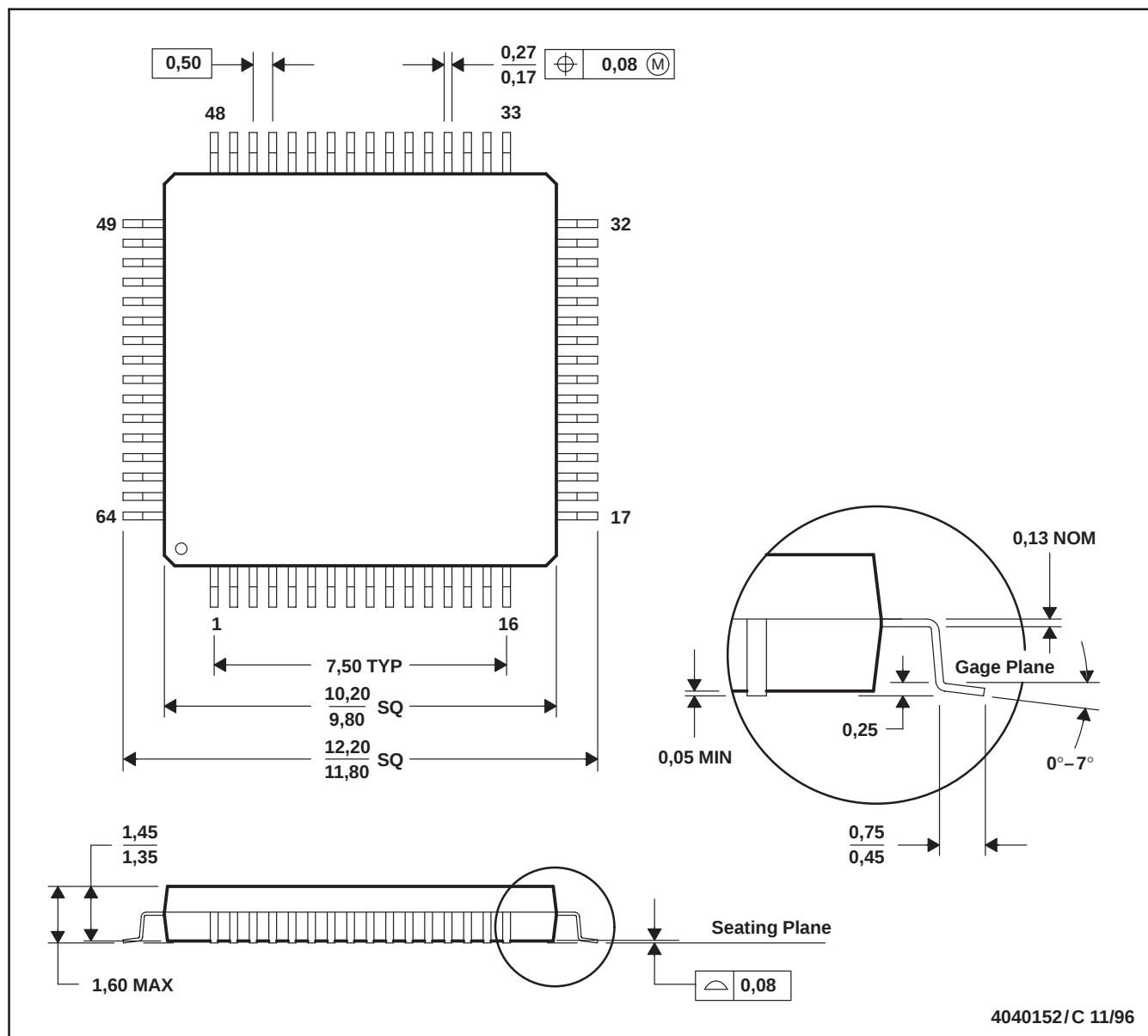
## PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

## PM (S-PQFP-G64)

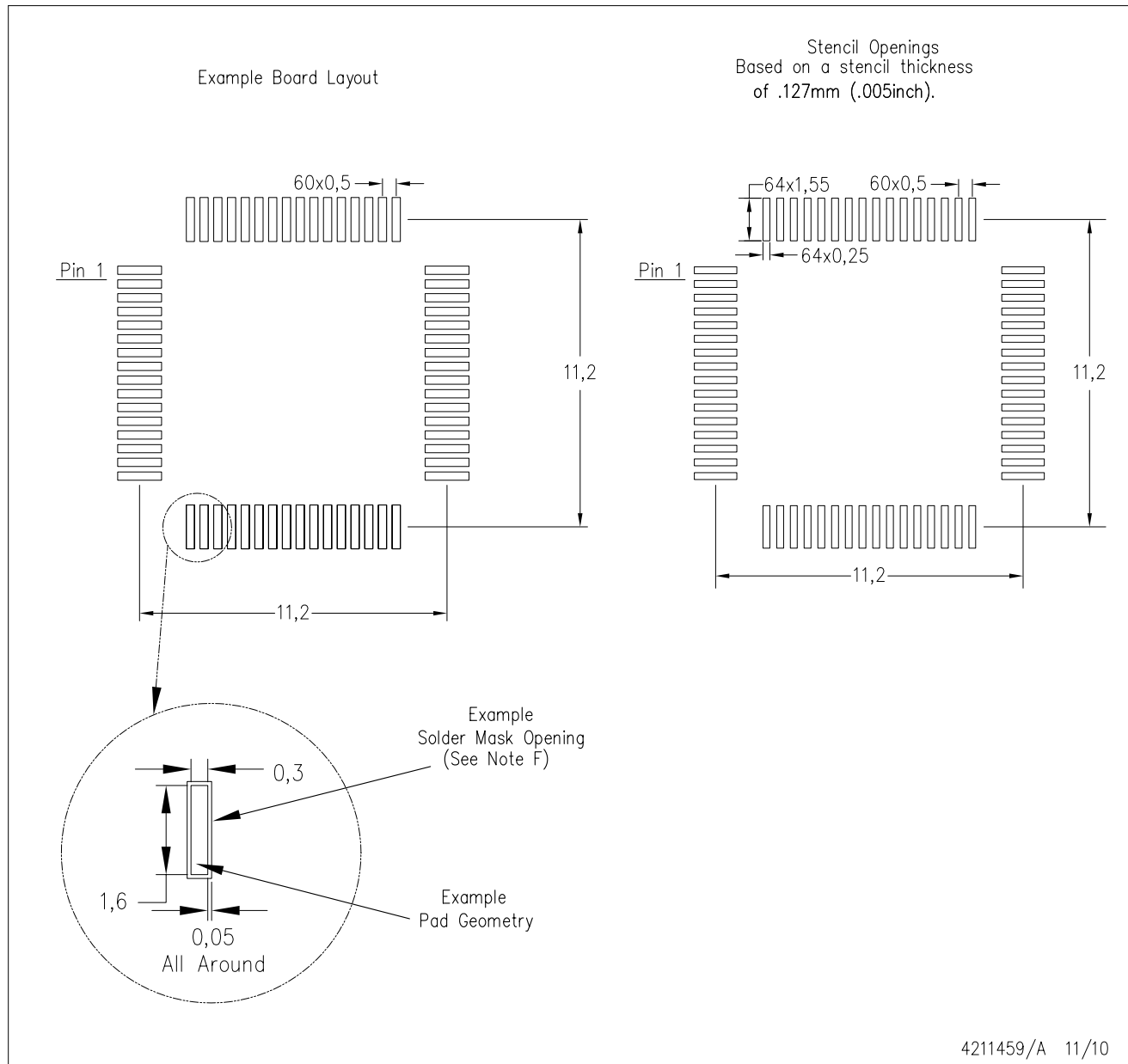
## PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-026
  - D. May also be thermally enhanced plastic with leads connected to the die pads.

PM (S-PQFP-G64)

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - D. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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